144/430 MHz, FM MULTI BANDER

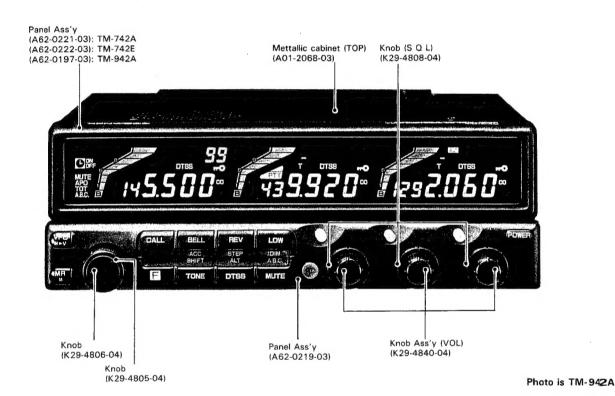
TM-742 A/E

144/430/1200 MHz FM TRIBANDER

TM-942 A SERVICE MANUAL

KENWOOD

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OVERVIEW

List of Destinations

Model	Destination	Destination code	Model	Destination	Destination code
TM-742A	North America	K	TM-942A	North America	K
TM-742A	Canada	P	TM-942A	Canada	Р
TM-742E	Europe	E	TM-942A	Other countries	M
TM-742E	Europe	E2			
TM-742E	Europe	E3	1		
TM-742A	Other countries	М			
TM-742A	Other countries	M2	1		

Units for Each Model and Destination

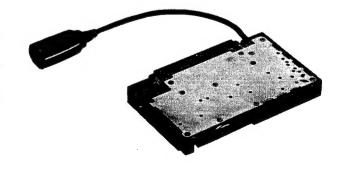
				TM	1-742	ΔÆ			TM-942A		Band Units				
Unit Name	Parts. No.	No.				110 0427			UT-28S	UT-50S	UT-220S	UT-1200			
		к	Р	E	E2	E3	M	M2	к	Р	м	M (50)	M (50)	K (50)	M (10)
Control Unit	X53-3460-11	0	0						0	0					
Control Unit	X53-3460-21						0				0				
Control Unit	X53-3460-22							0							
Control Unit	X53-3462-71			0		0									
Control Unit	X53-3462-72				0										
Display Unit	X54-3130-11	0	0	0	0	0	0	0	0	0	0				
28TX-RX	X57-3790-01											0			
50TX-RX	X57-3800-01												0		
144TX-RX	X57-3580-11								0	0	0				
144TX-RX	X57-3580-12	0	0	0	0	0	0	0							
220TX-RX	X57-3810-10													0	
440TX-RX	X57-3590-12	0	0								0			1	
430TX-RX	X57-3590-22						0	0							
430TX-RX	X57-3592-72			0	0	0			0	0					
1200TX-RX	X57-3600-11								0	0	0				0

BAND UNITS

Any of the following optional band units may be installed in the TM-742A/742E.

The same instructions apply for the Tri-Bander as for the Dual-bander.

	OPTIONAL BAND UNIT						
TM-742A U.S.A. Version	UT-28S UT-50S UT-220S UT-1200						
TM-742A	UT-28S UT-50S UT-1200						
TM-742E	UT-28S UT-50S UT-1200						



CIRCUIT DESCRIPTION

UT-28S

28 TX-RX Unit Frequency Configuration

The 28 MHz unit incorporates a variable frequency oscillator (VFO), based on a phase-locked-loop (PLL) synthesizer system, that allows a channel step of 5, 10, 15, 20, or 25 kHz to be selected. The frequency in the receive signal channel is mixed with a first local oscillation frequency of 36.83-38.525 MHz to produce a first intermediate frequency (IF) of 8.83 MHz.

This frequency is then mixed with a second local oscillation frequency of 9.285 MHz to produce a second IF of 455 kHz. This is called a double-conversion system. The signal in the transmission channel is produced by direct oscillation, is frequency-divided by a PLL circuit, amplified by a linear amplifier, then transmitted.

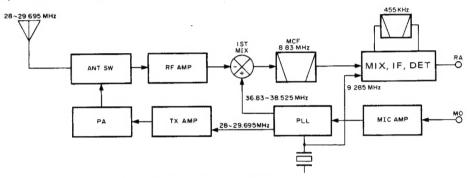


Fig. 1 Frequency configuration

28 TX-RX Unit Receive Signal Channel

Outline

The received signal from the antenna passes through a low-pass filter in the final transmission stage and then through a transmission/reception selection diode switch to the receiving front end. The signal then passes through an antenna matching coil and is amplified to high frequencies by a MOS field-effect transistor. The unwanted components of the signal are eliminated by a bandpass filter consisting of a three-stage variable capacitor. The resulting signal goes to the first mixer, is mixed with the first local signal from the PLL circuit, then converted to the first IF of 8.83 MHz. The unwanted near-by signal components are then eliminated by a two-

ltem	Rating
Center frequency (fo)	8830 kHz
Pass bandwidth	± 6 kHz or more at 3 dB
Attenuation bandwidth	± 20 kHz or less at 40 dB ±40 kHz or less at 60 dB
Guaranteed attenuation	70 dB or more within Fo ± 1 MHz (Spurious: 40 dB or more)
Ripple	1 dB or less
Insertion loss	2 dB or less
Terminating impedance	4.7 kΩ//0pF

Table 1 MCF (L71-0422-05) (28TX-RX unit XF1)

stage MCF.

The first IF signal is amplified and input to FM IF HIC IC6 (KCD04). This signal is then mixed with the second local oscillation frequency of 9.285 MHz to produce the second IF signal of 455 kHz. The unwanted near-by signal components are then eliminated by an FM ceramic filter. The resulting signal is input to IC6 again, amplified to the second IF signal, and detected to produce an audio signal.

Signal-strength meter

The signal-strength meter output voltage of FM IF HIC IC6 (KCD04) is supplied to the control unit.

ltem	Rating
Nominal center frequency	455KHz
6 dB bandwidth	± 6 kHz or more (from 455 kHz)
50 dB bandwidth	± 12.5 kHz or less (from 455kHz)
Ripple (within ± 5 kHz of 455 kHz	3 dB or less
Insertion loss (at maximum output point)	6 dB or less
Guaranteed attenuation (within ± 100 kHz of 455 kHz)	35 dB or more
I/O matcing impedance	2.0kΩ

Table 2 Ceramic filter CFWM455F (L72-03)Z-05) (28TX-RX unit CF1)

CIRCUIT DESCRIPTION

Shift-register circuit

The ES, CK, and DT serial data from the control unit

are sent to C1 (BU4094BF) to perform the control operation outlined in the following table:

Pin No.	Name	Function	Pin No.	Name	Function
1	Strobe	Enable input	9	Qs	
2	Data	Serial data input	10	Q's	
3	Clock	Clock input	11	Ω8	TX/RX selection. High when TX is set.
4	Q1	TX/RX selection. Low when TX is set	12	Q7	ATT switching: High when ATT is on
5	Q2	TX power selection. Low when middle and low. "H" when high.	13	Q6	High for AM; low for FM; High for narrow; low for wide
6	O3	TX power selection. Low when high and low. "H" when middle.	14	Ω5	High when off band
7	Q4	Low when off band	15	OE	8V
8	Vss	GND	16	VDD	8V

Table 3

ATT circuit

If there is cross modulation, the ATT circuit operates

to attenuate the received signal before it enters Q2 (FET for high-frequency amplification).

28 TX-RX Unit Transmit Signal Channel

Outline

In the transmission channel, the desired frequency is produced by direct oscillation, and is directly frequency modulated by means of a varicap diode.

Modulator circuit

The audio signal from the control unit is input to microphone amplifier HIC IC3 (KCA04). IC4 consists of a preemphasis circuit, amplifier, limiter, and splatter circuit that eliminates unwanted high-frequency components. The voltage-controlled oscillator (VFO) signal is directly frequency modulated by means of a varicap diode in the frequency modulator circuit.

Younger-stage circuit

The signal output from the VCO is input to drive circuit HIC IC16 (KCB16). The amplifier can obtain a stable drive output without adjustment because it has a large bandwidth. An APC circuit controls the collector voltage in the Younger final stage.

Power amplifier circuit

The drive signal is amplified to the specified level by a discrete transistor. Q2 performs class B amplification, and the collector output voltage is controlled by an APC circuit. Q202 amplifies the power by class C operation, improving the efficiency of the final stage.

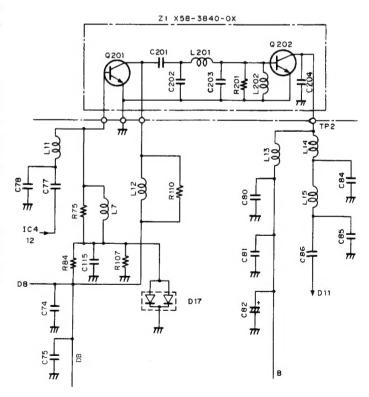


Fig. 2 Power amplifier circuit

CIRCUIT DESCRIPTION

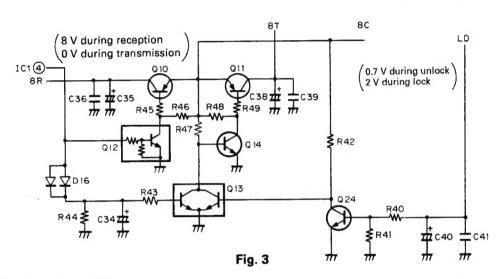
APC circuit

The automatic transmission output control circuit (APC) detects and partially amplifies the power amplifier output with a diode, and controls the output control voltage. The control voltage is output in inverse proportion to the output, so the control voltage output is always constant. To protect the radio against excessive temperature rise, the high-power unit has a thermal switch. The high-power unit is automatically set to a low power by the thermal switch if it exceeds the specified temperature.

8T (8 V during transmission) and unlock signal

The signal output from pin 4 of IC1 is high during reception, Q13 is turned on, and Q14 and Q11 are turned off. No voltage appears at the collector (8T) of Q11. Serial data is output from the control unit during transmission and input to shift register IC1. Pin 4 of IC1 is then made low. Therefore, Q13 is turned off, and 14 and Q11 are turned on. An 8 V voltage is applied to the collector (8T) of Q11.

If the PLL circuit is unlocked during transmission, the LD pin goes low, Q24 is turned off, Q13 is turned on, Q14 is turned off, Q11 for 8T switching control is turned off, and the 8T line does not operate.



28 TX-RX Unit PLL Synthesizer

The VCO and PLL circuits are housed in a solid shielding case as a hybrid integrated circuit. Comparison frequencies are produced by dividing a 9.285 MHz reference oscillation frequency by 1857 to correspond to the 5, 10, 15, 20, and 25 kHz channel steps.

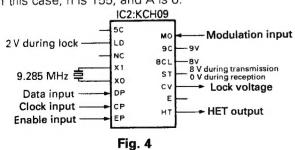
For 28 MHz, the relationship between f_{vco} (RX) and each frequency division ratio is given by

 $f_{VCO} = (28+8.83) = \{(nx64) + A\}xf_{OSC}/R$

Where: f_{vco}=VCO output frequency

n: Binary 10-bit programmable counter setting value A: Binary 6-bit programmable counter setting value f_{osc}: Reference oscillation frequency of 9.285 MHz R: Binary 16-bit programmable counter setting value 1857

In this case, n is 155, and A is 6.



Therefore, $f_{VCO} = \{(115 \times 64) + 6\} \times 9285 / 1857 = (7360 + 6) \times 5 = 36.83 \text{ MHz}$

The following table lists the pin functions of the PLL circuit:

Pin name	Function	Pin name	Function
5C	5V	МО	Modulation signal input
LD	Lock signal (2 V during locking)	9c	9v
NC	Unused	8CL	8 V (ripple filter)
XI XO	9.285 MHz crystal	ST	8 V during transmission; 0 V during reception
.,,,	oscillation	CV	Lock voltage output
DP	Data input	E	GND
СР	Clock input	НТ	HET output
EP	Enable input		

Table 4 PLL circuit pin functions

CIRCUIT DESCRIPTION

UT-50S

50 TX-RX Unit Frequency Configuration

The 50 MHz unit incorporates a variable frequency oscillator (VFO), based on a phase-locked-loop (PLL) synthesizer system, that allows a channel step of 5, 10, 15, 20, or 25 kHz to be selected. The frequency in the receive signal channel is mixed with a first local oscillation frequency of 60.595-64.590 MHz to produce a first in-

termediate frequency (IF) of 10.595 MHz. This frequency is then mixed with a second local oscillation frequency of 11.05 MHz to produce a second IF of 455 kHz. This is called a double-conversion system. The signal in the transmission channel is produced by direct oscillation, and is frequency-divided by a PLL circuit, amplified by a linear amplifier, then transmitted.

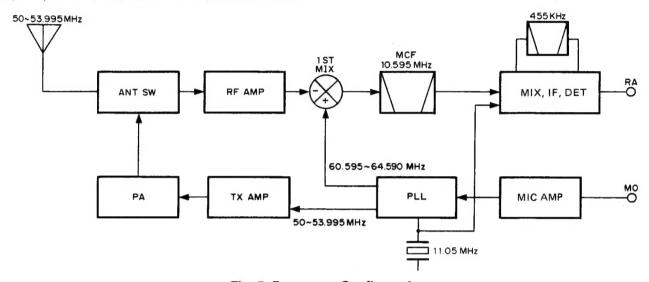


Fig. 5 Frequency Configuration

50 TX-RX Unit Receive Signal Channel

Outline

The received signal by the antenna passes through a low-pass filter in the final transmission stage and then through a transmission/reception selection diode switch to the receiving front end. The signal then passes through an antenna matching coil and is amplified to high frequencies by a GaAs (gallium arsenide) field-effect transistor. The unwanted components of the signal are eliminated by a bandpass filter consisting of a three-stage variable capacitor. The resulting signal goes to the first mixer, is mixed with the first local signal from the PLL circuit, then converted to the first IF of 10.595 MHz.

ltem	Rating
Center frequency	10.595 MHz
Pass bandwidth	±6.5 kHz or more at 3 dB
Attenuation bandwidth	±23 kHz or less at 40 dB ±40 kHz or less at 60 dB
Guaranteed attenuation	70 dB or more within Fo ±1 MHz (Spurious: 40 dB or more)
Ripple	1 dB or less
Insertion loss	1.5 dB or less
Terminating impedance	2.9 kΩ//0pF

Table 5 MCF (L71-0421-05) (50TX-RX unit XF1)

The unwanted near-by signal components are then eliminated by a two-stage MCF.

The first IF signal is amplified and input to FM IF HIC IC6 (KCD04). This signal is then mixed with the second local oscillation frequency of 11.05 MHz to produce the second IF signal of 455 kHz. The unwanted near-by signal components are then eliminated by an FM ceramic filter. The resulting signal is input to IC6 again, amplified to the second IF signal, and detected to produce an audio signal.

Item	Rating
Nominal center frequency	455KHz
6 dB bandwidth	±6.0 kHz or more (from 455 kHz)
50 dB bandwidth	±12.5 kHz or less (from 455 kHz)
Ripple (within ±5 kHz of 3455 kHz)	3 dB or less
Insertion loss (at maximum output point)	6 dB or less
Guaranteed attenuation (within ±100 kHz of 455 kHz)	35 dB or more
Terminating impedance	2.0 kΩ

Table 6 Ceramic filter CFWM455F (L72-0372-05) (50TX-RX unit CF1)

CIRCUIT DESCRIPTION

Signal-strength meter

The signal-strength meter output voltage of FM IF HIC IC6 (KCD04) is supplied to the control unit.

• Shift-register circuit

The ES, CK, and DT serial data from the control unit are sent to IC1 (BU4094BF) to perform the control operation outlined in the following table:

Pin No.	Name	Function	Pin No.	Name	Function
1	Strobe	Enable input	9	Qs	
2	Data	Serial data input	10	Q's	
3	Clock	Clock input	11	Ω8	TX/RX selection. High when TX is set.
4	Ω1	TX/RX selection. Low when TX is set	12	Q7	ATT switching: High when ATT is on
5	Ω2	TX power selection. Low when middle and low. "H" when high.	13	Ω6	High for AM; low for FM
6	O3	TX power selection. Low when high and low. "H" when middle.	14	Ω5	High when off band
7	Q4	Low when off band	15	OE	8V
8	Vss	GND	16	VDD	8V

Table 7

ATT circuit

If there is cross modulation, the ATT circuit operates

to attenuate the received signal before it enters Q2 (FET for high-frequency amplification).

50 TX-RX Unit Transmit Signal Channel

Outline

In the transmission channel, the desired frequency is produced by direct oscillation, and is directly frequency modulated by means of a varicap diode.

Modulator circuit

The audio signal from the control unit is input to microphone amplifier HIC IC3 (KCA04). IC4 consists of a preemphasis circuit, amplifier, limiter, and splatter circuit that eliminates unwanted high-frequency components. The voltage-controlled oscillator (VFO) signal is directly frequency modulated by means of a varicap diode in the frequency modulator circuit.

Younger-stage circuit

The signal output from the VCO is input to drive circuit HIC IC4 (KCB18). The amplifier can obtain a stable drive output without adjustment because it has a large bandwidth. An APC circuit controls the collector voltage in the Younger final stage.

• Power amplifier circuit

The drive signal is amplified to the specified level by a discrete transistor. Q201 performs class B amplification, and the collector output voltage is controlled by an APC circuit. Q202 amplifies the power by class C operation, improving the efficiency of the final stage.

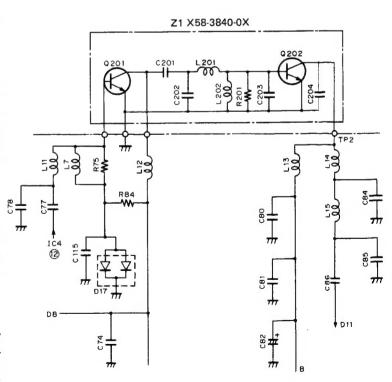


Fig. 6 Power amplifier circuit

CIRCUIT DESCRIPTION

APC circuit

The automatic transmission output control circuit (APC) detects and partially amplifies the power amplifier output with a diode, and controls the output control voltage. The control voltage is output in inverse proportion to the output, so the control voltage output is always constant. To protect the radio against excessive temperature rise, the high-power unit has a thermal switch. The high-power unit is automatically set to a low

power by the thermal switch if it exceeds the specified temperature.

LPF circuit

The low-pass filter sets the pole to the second and third harmonics, and cuts the frequency, by having the polar Chebyshev characteristics. To cut high frequencies, a filter with Chebyshev characteristics is used before the antenna.

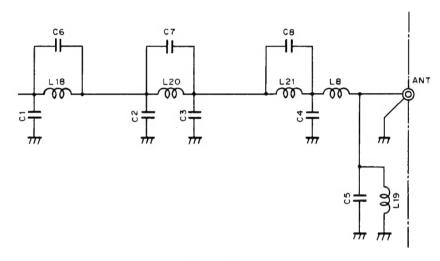


Fig. 7 LPF Circuit

• 8T (8 V during transmission) and unlock signal

The signal output from pin 4 of IC1 is high during reception, Q13 is turned on, and Q14 and Q11 are turned off. No voltage appears at the collector (8T) of Q11. Serial data is output from the control unit during transmission and input to shift register IC1. Pin 4 of IC1 is then made low. Therefore, Q13 is turned off, Q14 and

Q11 are turned on. An 8 V voltage is applied to the collector (8T) of Q11.

If the PLL circuit is unlocked during transmission, the LD pin goes low, Q24 is turned off, Q13 is turned on, Q14 is turned off, Q11 for 8T switching control is turned off, and the 8T line does not operate.

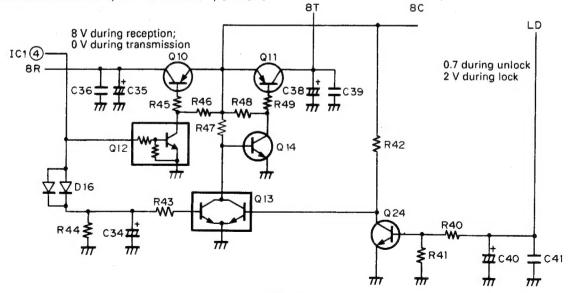


Fig. 8

CIRCUIT DESCRIPTION

50 TX-RX Unit PLL Synthesizer

The VCO and PLL circuits are housed in a solid shielding case as a hybrid integrated circuit. Comparison frequencies are produced by dividing a 11.05 MHz reference oscillation frequency by 2210 to correspond to the 5, 10, 15, 20, and 25 kHz channel steps.

For 50 MHz, the relationship between f_{vco} (RX) and each frequency division ratio is given by f_{vco} =(50+10.595)={(nx64)+A}x f_{osc} /R Where: f_{vco} =VCO output frequency n: Binary 10-bit programmable counter setting value

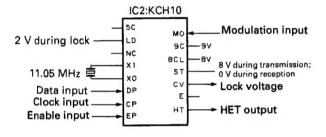


Fig. 9

A: Binary 6-bit programmable counter setting value f_{osc}: Reference oscillation frequency of 11.05 MHz R: Binary 16-bit programmable counter setting value In this case, n is 189, and A is 23.

Therefore, $f_{VCO} = \{(189x64) + 23\}x11050/2210$ = (12096 + 23)x5= 60.595 MHz

The following table lists the pin functions of the PLL circuit:

Pin name	Function	Pin name	Function
5C	5V	МО	Modulation signal input
LD	Lock signal (2 V during locking)	9C	9V
NC	Unused	8CL	8 V (ripple filter)
XI XO	11.05 MHz crystal oscillation	ST	8 V during transmission; 0 V during reception
	Data input	CV	Lock voltage output
DP	Clock input	E	GND
СР	Enable input	HT	HET output
EP			

Table 8 PLL circuit pin functions

CIRCUIT DESCRIPTION

144 TX-RX Unit Frequency Configuration

The 144 MHz unit incorporates a digital variable-frequency oscillator (VFO) that can freely select a channel step of 5, 10, 12.5, 15, 20, or 25 kHz with a Phase-Locked-Loop (PLL) synthesizer system.

The frequency in the receive signal channel is mixed with a first local oscillation frequency of 133.300-137.295 MHz to produce a first intermediate frequency of 10.7

MHz. This frequency is then mixed with a second local oscillation frequency of 10.245 MHz to produce a second intermediate frequency of 455 kHz. This is called a double-conversion system.

The signal in the transmission channel is directly oscillated and frequency-divided by a PLL circuit, amplified by a straight amplifier, then transmitted.

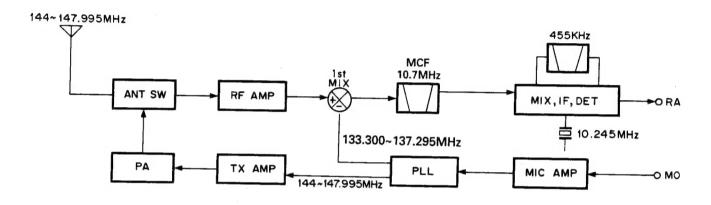


Fig. 10 Frequency configuration

144 TX-RX Unit Receive Signal Channel

Outline

For the 144 MHz unit, the received signal from an antenna is passed through a low-pass filter in the final transmission stage and sent through a transmission/reception selection diode switch to the receiving front end. The signal is then passed through an antenna matching coil and amplified to high frequencies by a

GaAs (gallium arsenide) field-effect transistor. The unwanted components of the signal are eliminated by a bandpass filter consisting of a three-stage variable capacitor. The resultant signal is sent to the first mixer, mixed with the first local signal from a PLL circuit, then converted to a first intermediate frequency of 10.7 MHz. The unwanted near-by signal components are then eliminated by a two-stage MCF.

ltem	Rating
Nominal center frequency (fo)	10.7MHz
Pass band width	±7.5kHz or less at 3dB
Attenuation band width	±25kHz or less at 40dB ±45kHz or less at 60dB
Ripple	1.0dB or less
Insertion loss	1.5dB or less
Guaranteed attenuation	70dB or more within ±1MHz (Spurious : 40dB or more at fo ~ fo + 500kHz) 80dB or more at fo ~ (900 – 920kHz)
Terminating impedance	3kΩ/0pF

Table 9 MCF (L71-0228-05) (144 TX-RX unit XF1)

İtem	Rating
Nominal center frequency	455kHz ± 1kHz
6dB bandwidth	±6kHz or more (from 455kHz)
50dB bandwidth	±12.5kHz or less (from 45.5kHz
Ripple (within ±4kHz of 455kHz)	3dB or less
Insertion loss	6dB or less
Guaranteed attenuation (within ±100kHz of 455kHz)	35dB or more
I/O matching impedance	2.0kΩ

Table 10 Ceramic filter CFWM455F (L72-037 2-05) (144 TX-RX unit CF1)

CIRCUIT DESCRIPTION

The first intermediate-frequency signal is amplified and input to FM IF HIC IC5 (KCD04). This signal is then mixed with a second local oscillation frequency of 10.245MHz to produce a second intermediate-frequency signal of 455 kHz. The unwanted near-by signal components are then eliminated by an FM ceramic filter. The resultant signal is input to IC5 again, amplified to a second intermediate-frequency signal, and detected to produce an audio signal.

Signal-strength meter

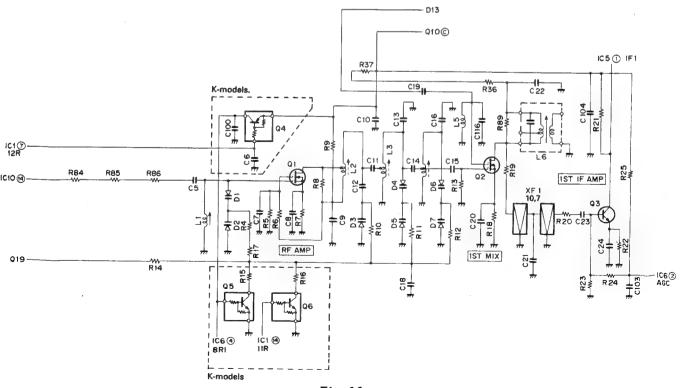
The signal-strength meter output voltage of FM IF HIC IC5 (KCD04) is supplied to the control unit.

• Shift-register circuit

The ES, CK, and DT serial data from the control unit are sent to IC1 (BU4094BF) to perform the control operation outlined in the following table:

Pin NO.	Name	Function	Pin No.	Name	Function
1	Strobe	Enable input	9	Q _s	
2	Data	Serial data input	10	Q's	
3	Clock	Clock input	11	Q8	TX/RX selection. "H" when TX is set.
4	Q1	TX/RX selection. "L" when TX is set	12	Q7	439/144 MHz selection. "H" when 144MHz is set.
5	Q2	TX power selection. "L" when middle and low. "H" when high.	13	Ω6	
6	Ω3	TX power selection. "L" when high and low. "H" when middle.	14	Q5	
7	Q4		15	OE	8V
8	Vss	GND	16	V _{DD}	8V

Table 11



CIRCUIT DESCRIPTION

144 TX-RX Unit Transmit Signal Channel

Outline

In the transmission channel, the desired frequency is directly oscillated and directly frequency modulated by means of a varicap diode.

Modulator circuit

The audio signal from the control unit is input to microphone amplifier HIC IC7 (KCA04). IC4 consists of a preemphasis circuit, amplifier, limiter, and splatter circuit that eliminate unwanted high-frequency components. The voltage-controlled oscillator (VCO) signal is directly frequency modulated by means of a varicap diode in the frequency modulator circuit.

Younger-stage circuit

The signal output from the VCO is input to drive circuit HIC IC8 (KCB11). The amplifier can obtain a stable drive output without adjustment because it has a wide band. An APC circuit controls the collector voltage in the younger final stage.

ampimou to the op

Power amplifier circuit

A drive signal is input to power module IC10 and amplified to the specified level.

APC circuit

The automatic transmission output control circuit (APC) detects and partially amplifies the power module output with a diode and controls the output control voltage. The control voltage is output in inverse proportion to the output, so the control voltage output is always constant. To protect the set against excessive temperature rise, the high-power unit has a thermal switch. The high-power unit is automatically set to a low power by the thermal switch when it exceeds the specified temperature.

144 TX-RX Unit PLL Synthesizer

The VCO and PLL circuit are housed in a solid shielding case as a hybrid integrated circuit. Comparison frequencies of 6.25 kHz and 5 kHz are produced by dividing a 12.8 MHz reference oscillation frequency by 2048 and 2560 to correspond to 5, 10, 12.5, 15, 20, and 25 kHz channel steps.

For 144 MHz, the relationship between f_{VCO} (Rx) and each frequency division ratio is given by f_{VCO} =(144 - 10.7)= {(n x 128) + A} x f_{OSC} + R Where: f_{VCO} = VCO output frequency n:Binary 10-bit programmable counter setting value A:Binary 7-bit programmable counter setting value f_{OSC} : Reference oscillation frequency of 12.8 MHz

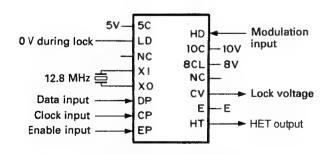


Fig. 12 IC11 KCH05

R: Binary 14-bit programmable counter setting value 2048

In this case, n is 208, and A is 36.

Therefore, $f_{VCO} = \{(208 \times 128) + 36\} \times 12800 / 2560$

 $= \{26624 + 37\} \times 5$

= 133300 kHz = 133.300 MHz

The following table lists the pin functions of the PLL circuit:

Pin name	Function	Pin name	Function
5C	5V	МО	Modulation signal input
ГD	Lock signal (on during lock)	10C	10V
NC	Unused	8CL	8V (ripple filter)
XI -	12.8 MHz crystal	NC	Unused
хо	scillation	CV	Lock voltage output
DP	Data input	E	GND
СР	Clock input	нт	HET output
EP	Enable input		

Table 12

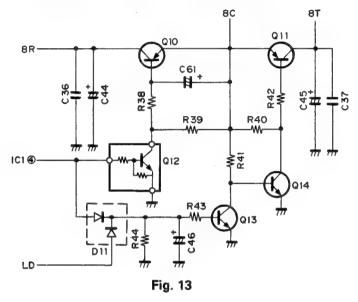
CIRCUIT DESCRIPTION

8T (8 V during transmission) and unlock signal

A 0.7 V voltage is applied to the base of Q13 during reception, Q13 is set on, Q14 is set off, and Q11 is set off. No voltage appears at the collector (8T) of Q11. Serial data is output from the control unit during transmission and input to shift register IC1. Pin 4 of IC1 is then set low. Therefore, Q13 is changed from on to off, Q14 from off to on, and Q11 from off to on. An 8 V

voltage is applied to the collector (8T) of Q11.

An unlock circuit is activated only during transmission. The LD signal output from the PLL circuit is ORed with the signal at pin 4 of IC1 using D11 as shown in the figure, so the LD signal is set high during unlock. Therefore, no voltage appears at the collector (8T) of Q11 and no transmission wave is output to the reception state.



UT-220S

220 TX-RX Unit Frequency Configuration

The 220 MHz unit incorporates a variable frequency oscillator (VFO), based on a phase-locked-loop (PLL) synthesizer system, that allows a channel step of 5, 10, 12.5, 15, 20, or 25 kHz to be selected. The frequency in the receive signal channel is mixed with a first local oscillation frequency of 189.175-194.17 MHz to produce

a first intermediate frequency (IF) of 30.825 MHz. This frequency is then mixed with a second local oscillation frequency of 30.37 MHz to produce a second F of 455 kHz. This is called a double-conversion system. The signal in the transmission channel is produced by direct oscillation, and is frequency-divided by a PLL circuit, amplified by a linear amplifier, then transmitted.

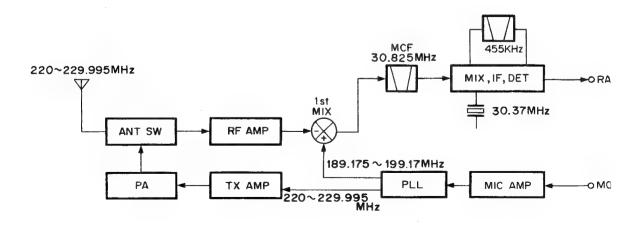


Fig. 14 Frequency configuration

CIRCUIT DESCRIPTION

220 TX-RX Unit Receive Signal Channel

Outline

The received signal from the antenna passes through a low-pass filter in the final transmission stage and then through a transmission/reception selection diode switch to the receiving front end. The signal then passes through an antenna matching coil and is amplified to high frequencies by a GaAs (gallium arsenide) field-effect transistor. The unwanted components of the signal are eliminated by a bandpass filter consisting of a three-stage variable capacitor. The resulting signal goes to the first mixer (GaAs field-effect transistor), is mixed with the first local signal from the PLL circuit, then converted to a first If of 30.825 MHz. The unwanted near-by signal components are then eliminated by a two-stage MCF.

The first IF signal is amplified and input to FM IF HIC IC5 (KCD04). This signal is then mixed with the second local oscillation frequency of 30.37 MHz to produce the second IF signal of 455 kHz. The unwanted near-by signal components are then eliminated by an FM ceramic filter. The resulting signal is input to IC5 again, amplified to the second IF signal, and detected to produce an audio signal.

ltem	Rating
Center frequency (fo)	30,825 MHz
Pass bandwidth	± 7.5 kHz or more at 3 dB
Attenuation bandwidth	± 28 kHz or less at 40 dB
Guaranteed attenuation	60 dB or more within Fo ± 1 MHz (Spurious: 40 dB or more)
Ripple	1.5 dB or less
Insertion loss	3 dB or less
Terminating impedance	4.7 kΩ//0pF

Table 13 MCF (L71-0420-05) (220 TX-RX unit XF1)

ltem	Rating
Nominal center frequency	455KHz
6 dB bandwidth	± 6 kHz or more (from 455 kHz)
50 dB bandwidth	± 12.5 kHz or less (from 455 kHz)
Ripple (within ± 5 kHz of 455 kHz)	3 dB or less
Insertion loss (at maximum output point)	6 dB or less
Guaranteed attenuation (within ± 100 kHz of 455 kHz)	35 dB or more
I/O matcing impedance	2.0kΩ

Table 14 Ceramic filter CFWM455F (L72-0372-05) (220TX-RX unit CF1)

• Signal-strength meter

The signal-strength meter output voltage of FM IF HIC IC5 (KCD04) is supplied to the control unit.

• Shift-register circuit

The ES, CK, and DT serial data from the control unit are sent toIC1 (BU4094BF) to perform the control operation outlined in the following table:

Pin No.	Name	Function
1	Strobe	Enable input
2	Data	Serial data input
3	Clock	Clock input
4	Q1	TX/RX selection. Low when TX is set.
5	Q2	TX power selection. Low when middle and low. High when high.
6	Q 3	TX power selection. Low when high and low. High when middle.
7	Q4	
9	O3	
10	Q3	
11	Q8	
12	Q7	
13	.Q6	
14	Ω5	
15	QE	8V

Table 15

CIRCUIT DESCRIPTION

220 TX-RX Unit Transmit Signal Channel

Outline

In the transmission channel, the desired frequency is produced by direct oscillation, and is directly frequency modulated by means of a varicap diode.

Modulator circuit

The audio signal from the control unit is input to microphone amplifier HIC IC7 (KCA04). IC4 consists of a preemphasis circuit, amplifier, limiter, and splatter circuit that eliminates unwanted high-frequency components. The voltage-controlled oscillator (VFO) signal is directly frequency modulated by means of a varicap diode in the frequency modulator circuit.

Younger-stage circuit

The signal output from the VCO is input to drive circuit HIC IC8 (KCB15). The amplifier can obtain a stable drive output without adjustment because it has a large bandwidth. An APC circuit controls the collector voltage in the Younger final stage.

Power amplifier circuit

The drive signal is input to power module IC10 and amplified to the specified level.

220 TX-RX Unit PLL Synthesizer

The VCO and PLL circuits are housed in a solid shielding case as a hybrid integrated circuit. Comparison frequencies are produced by dividing a 12.8 MHz reference oscillation frequency by 2248 and 2560 to correspond to the 5, 10, 12.5, 15, 20, and 25 kHz channel steps.

For 220 MHz, the relationship between f_{vco} (RX) and each frequency division ratio is given by

 $f_{VCO} = (220 + 30.825) = \{(nx128) + A\}xf_{OSC}/R$

Where: f_{vco}=VCO output frequency

n: Binary 10-bit programmable counter setting value A: Binary 7-bit programmable counter setting value f_{osc} : Reference oscillation frequency of 12.8 MHz R: Binary 10-bit programmable counter setting value

In this case, n is 295, and A is 75.

Therefore, $f_{VCO} = \{(295x128) + 75\}x12800/2560$

=(33760+75)x5

= 189.175 MHz

The following table lists the pin functions of the PLL circuit:

APC circuit

The automatic transmission output control circuit (APC) detects and partially amplifies the power amplifier output with a diode and controls the output control voltage. The control voltage is output in inverse proportion to the output, so the control voltage output is always constant.

• 8T (8 V during transmission) and unlock signal

A 0.7 V voltage is applied to the base of Q13 during reception, Q13 is turned on, and Q14 and Q11 are turned off. No voltage appears at the collector (8T) of Q11. Serial data is output from the control unit during transmission and input to shift register IC1. Pin 4 of IC1 is then made low. Therefore, Q13 is turned off, and Q14 and Q11 are turned on. An 8 V voltage is applied to the collector (8T) of Q11.

The unlock circuit is activated only during transmission. The LD pin signal output from the PLL circuit is ORed with the signal at pin 4 of IC1 using D11, as shown in the figure, so the LD signal is made high during unlock. Therefore, no voltage appears at the collector (8T) of Q11, and no transmission signal is output during reception.

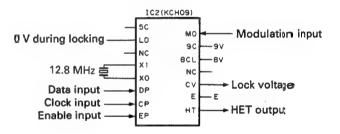


Fig. 15

Pin name	Function	Pin name	Functio n
5C	5V	МО	Modulation signal input
LD	Lock signal (0 V during locking)	9C	9V
NC	Unused	8CL	8 V (ripple fiter)
ΧI	12.8 MHz crystal	NC	
ХО	oscillation	CV	Lock voltage output
DP	Data input	E	GND
СР	Clock input	нт	HET output
EP	Enable input		

Table 16 PLL circuit pin functions

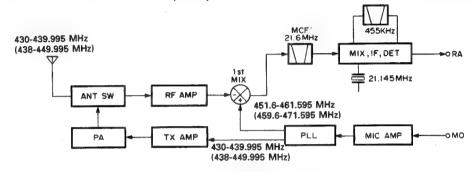
CIRCUIT DESCRIPTION

430 TX-RX Unit Frequency Configuration

The 430 MHz unit incorporates a digital variable-frequency oscillator (VFO) that can freely select a channel step of 5, 10, 12.5, 15, 20, or 25 kHz with a PLL synthesizer system. The frequency in the receive signal channel is mixed with a first local oscillation frequency of 451.6-461.595 MHz (459.6-471.595 MHz for K-models) to produce a first intermediate frequency

of 21.6 MHz. The frequency is then mixed with a second local oscillation frequency of 21.145 MHz to produce a second intermediate frequency of 455 kHz. This is called a double-conversion system.

The signal in the transmission channel is directly oscillated and frequency-divided by a PLL circuit, amplified by a straight amplifier, then transmitted.



* The alphanumeric characters enclosed in parentheses are used for K-models.

Fig. 16 Frequency Configuration

430 TX-RX Unit Receive Signal Channel

Outline

A 430 MHz band antenna input signal is passed through the antenna selection diode in the final stage and sent through a front-stage antenna matching coil to the high-frequency two-stage amplifier and helical block of a GaAs (gallium arsenide) FET and junction FET. The signal is then input to the first mixer. The first mixer input signal is mixed with the first local signal from the PLL circuit and converted to a first intermediate-frequency signal of 21.6 MHz. The unwanted near-by signal components are then eliminated by a two-stage MCF.

The first intermediate-frequency signal is amplified and input to FM IF HIC IC1 (KCD04). This signal is then mixed with a second local oscillation frequency of

21.145 kHz to produce a second intermediate frequency of 455 kHz. The unwanted near-by components of the intermediate-frequency signal are eliminated by an FM ceramic filter. The intermediate-frequency signal is input to IC1 again. The second intermediate-frequency signal is amplified and detected by IC1 to produce an audio signal.

• Signal-strength meter

The signal-strength meter output voltage of FM IF HIC IC1 (KCD04) is supplied to the control unit.

Shift-register circuit

The ES, CK, and DT serial data from the control unit are sent to IC3 (BU4094BF) to perform the control operation outlined in the following table:

Pin No.	Name	Function	Pin No.	Name	Function
1	Strobe	Enable input	9	Q _s	
2	Data	Serial data input	10	Q's	
3	Clock	Clock input	11	Q8	
4	Q1	TX/RX selection. "L" when TX is set	12	Q7	
5	Q2	TX power selection. "L" when middle and low. "H" when high.	13	Q6	
6	O 3	TX power selection. "L" when high and low. "H" when middle.	14	Ω5	
7	Q4		15	OE	8V
8	V ₅₅	GND	16	V _{DD}	8V

CIRCUIT DESCRIPTION

430 TX-RX Unit Transmit Signal Channel

Outline

In the transmission channel, the desired frequency is directly oscillated and directly frequency modulated by means of a varicap diode.

Modulator circuit

The audio signal from the control unit is input to microphone amplifier HIC IC2 (KCA04). IC4 consists of a preemphasis circuit, amplifier, limiter, and splatter circuit that eliminate unwanted high-frequency components. The VCO signal is directly frequency modulated by a varicap diode in the frequency modulator circuit.

Younger-stage circuit

The signal output from the VCO is input to drive circuit HIC IC6 (KCB14). The amplifier can obtain a stable drive output without adjustment because it has a wide

band. An APC circuit controls the collector voltage in the younger final stage.

• Power amplifier circuit

A drive signal is input to power module IC7 and amplified to the specified level.

APC circuit

The automatic transmission output control circuit (APC) detects and partially amplifies the power module output with a diode and controls the output control voltage. The control voltage is output in inverse proportion to the output, so the control voltage output is always constant. To protect the set against excessive temperature rise, the high-power unit has a thermal switch. The high-power unit is automatically set to a low power by the thermal switch when it exceeds the specified temperature.

430 TX-RX Unit PLL Synthesizer

The VCO and PLL circuit are housed in a solid shielding case as a hybrid integrated circuit. Comparison frequencies of 6.25 and 5 kHz are produced by dividing a 12.8 MHz reference oscillation frequency by 2048 and 2560 to correspond to 5, 10, 12.5, 15, 20, or 25 kHz channel steps.

For 430 MHz, the relationship between $\rm f_{vco}$ (RX) and each frequency division ratio is given by

 $f_{VCO} = (430 + 21.6) = \{(n \times 128) + A\} \times f_{OSC} + R$ Where: $f_{VCO} = VCO$ output frequency

n: Binary 10-bit programmable counter setting value A: Binary 7-bit programmable counter setting value f_{OSC} = Reference oscillation frequency of 12.8 MHz

R: Binary 14-bit programmable counter setting value 2560 (in 5, 10, 15,and 20 kHz steps) 2048 (in 12.5 and 25 kHz steps)

In 5, 10, 15, and 20 kHz steps, n is 705 and A is 80.

Therefore, $f_{VCO} = \{705 \times 128\} \times 12800 / 2560$

 $= \{90240 + 80\} \times 5$

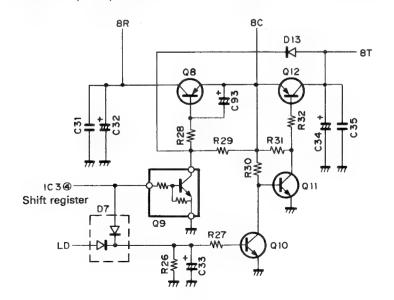
= 451600

= 451.6 MHz

See the 144 MHz band unit (X57-3580-00) for the function of each pin of IC10 in the PLL circuit.

• 8T (8 V during transmission) and unlock signal

See the 144 TX/RX unit description on page 13. (The figure on the under indicates the 430 MHz unit.)



17

CIRCUIT DESCRIPTION

TM-942A/UT-1200

1200 TX-RX Unit Frequency Configuration

The 1200 MHz unit incorporates a digital variable-frequency oscillator (VFO) that freely can select a channel step of 10, 12.5, 20, or 25 kHz with a PLL synthesizer system.

The frequency in the receive signal channel is mixed with a frequency of 1200.3 to 1240.20 MHz obtained when a first local oscillation frequency of 600.15 to 620.145 MHz is multiplied by 2 to produce a fist

intermediate frequency of 59.7 MHz. This frequency is then mixed with a second local oscillation frequency of 59.245 MHz to produce a second intermediate frequency of 455 kHz. This is called a double-conversion system.

The signal in the transmission channel is oscillated and frequency-divided by a PLL circuit, then multiples the frequency of 630 to 649.995 MHz by two to produce a frequency of 1260 to 1299.99 MHz. This signal is amplified by a straight amplifier, then transmitted.

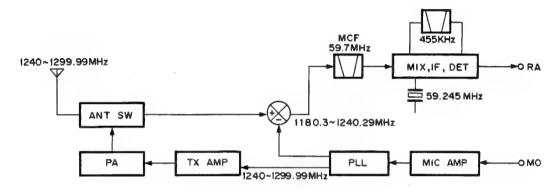


Fig. 18 Frequency Configuration

1200 TX-RX Unit Receive Signal Channel

Outline

The received signal from an antenna is passed through a low-pass filter in the transmission final stage and sent through a transmission/reception selection diode switch to the receiving front end. The signal is then amplified to high frequencies by a microwave GaAs (gallium arsenide) FET and sent to a dielectric filter. The unwanted components of the signal are eliminated by a microwave transistor in another stage and the dielectric filter. The resultant signal is input to the first mixer. The front end block is matched by a microstrip line to ensure high sensitivity and high reliability. A GaAs FET is used in the first mixer to obtain a good two-signal characteristic. This signal is mixed with the first local signal from a PLL circuit by the first mixer and converted to a first intermediate frequency of 59.7 MHz. The unwanted near-by signal components are eliminated by a two-stage MCF. The

resultant signal is produced as a first intermediate-frequency signal.

The first intermediate-frequency signal is amplified and input to FM IF HIC IC2 (KCD04). This signal is then mixed with a second local oscillation frequency of 59.245 kHz to produce a second intermediate frequency of 455 kHz. The intermediate-frequency signal is passed through a ceramic filter to obtain a sharp characteristic. The signal is then input to an HIC again, amplified, then demodulated and output from the HIC.

• Signal-strength meter

The signal-strength meter output voltage of FM IF HIC IC2 (KCD04) is supplied to the control unt.

• Shift-register circuit

The FS, CK, and DT serial data from the control unit are sent to IC5 (BU4094BF) to perform the control operation outlined in the following table:

CIRCUIT DESCRIPTION

Pin No.	Name	Function	Pin No.	Name	Function
1	Strobe	Enable input	9	O _s	
2	Data	Serial data input	10	Q's	
3	Clock	Clock input	11	Ω8	TX/RX selection. "L" when TX is set (Set low faster than Q1).
4	Q1	TX/RX selection. "L" when TX is set	12	Q7	ALT. "H" when on.
5	Q2	TX power selection. "L" when middle and low. "H" when high.	13	Q6	
6	Q3	TX power selection. "L" when high and low. "H" when middle.	14	Q5	
7	Q4		15	QE	8V
8	V _{sa}	GND	16	V _{DD}	8V

Table 18

1200 TX-RX Unit Transmit Signal Channel

Outline

In the transmission channel, the desired frequency is oscillated by half and directly frequency modulated by means of a varicap diode.

Modulator circuit

The audio signal from the control unit is input to microphone amplifier HIC IC4 (KCA04). IC4 consists of a preemphasis circuit, amplifier, limiter, and splatter circuit that eliminate unwanted high-frequency components. The VCO signal is directly frequency modulated by means of a varicap diode in the frequency modulator circuit.

Younger-stage circuit

The signal output from the VCO is input to predrive circuit IC7 (KCB09). The amplifier can obtain a stable drive output without adjustment because it has a wide band.

Power amplifier circuit

The signal amplified in the predrive stage is amplified again by drive circuit HIC IC8 (KCB10), then input to power module IC10 and amplified to the specified level.

APC circuit

The automatic transmission output control circuit (APC) detects and partially amplifies the power module output with a diode and controls the output control voltage. The control voltage is output in inverse proportion to the output, so the control voltage output is always constant.

• Antenna selection circuit

Figure 19 shows the antenna selection circuit. The receiver circuit obtains a low insertion loss and isolation with a two-stage breaker circuit consisting of a ¼4 strip circuit.

The pin diode used as a switching device has a low junction capacitance. The high-frequency capacitance of the diode does not depend on the reverse bias voltage.

Figure 20 shows the equivalent circuit during transmission. A current flows through each diode using 8T. The impedance becomes very low. At that time, the receiver side uses a $\mathcal{N}4$ strip circuit. Therefore, the impedance becomes very high when the receiver side is viewed from point (A). The voltage from a power module is transferred to the antenna.

Figure 21 shows the equivalent circuit during reception. The bias is switched off, so each dode is in a high-resistance state. The antenna and receiving circuit are connected by a strip line.

CIRCUIT DESCRIPTION

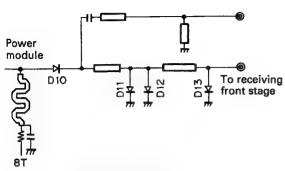


Fig. 19 Antenna Selection Circuit

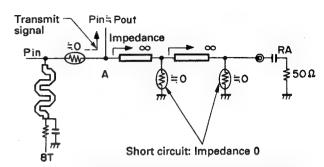


Fig. 20 Equivalent Circuit during Transmission

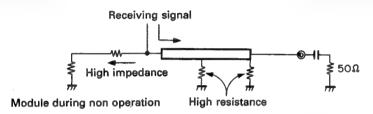


Fig. 21 Equivalent Circuit during Reception

1200 TX-RX Unit PLL Synthesizer

The VCO and PLL circuit are housed in .2 solid shielding case as a hybrid integrated circuit. This reduces the electrical and mechanical influence and ensures frequency stability.

The VCO and PLL circuit double the higher harmonics by oscillating and locking a 600 MHz frequency to produce a 1200 MHz band frequency. Comparison frequencies of 5 kHz and 6.25 kHz are produced by dividing a 12.8 MHz frequency of the TCXD by 2560 and 2048 to correspond to 10, 12.5, 20, and 25 kHz channel steps.

The relationship between f_{vco} (RX) and each frequency division is given by

frequency division is given by f_{vco} (RX) = $(f_{RX} - 59.7) / 2 = {(n \times 128) + A} \times f_{osc} + R$

MO Modulation input LD 90 90 80 **BCL** 0 V during 12.8MHz ΧI ST transmission 80R CV Lock voltage Data input DP F Clock input CP ► HET output HT Enable input

The same as for the 144 MHz unit except 8 V shown in the figure above.

Fig. 22 PLL pin description

Where: $f_{VCO}(RX)$ = Previous output frequency that is multiplied by 2 during VCO reception

f_{RX}: Reception frequency

n: Binary 10-bit programmable counter setting value A: Binary 7-bit programmable counter setting value fosc: Reference oscillation frequency of 12.8 MHz (TXCO)

R: Binary 14-bit programmable reference counter setting value

2048 (in 12.5 and 25 kHz steps)

2560 (in 10 and 20 kHz steps)

For 1260 MHz,

$$f_{VCO}(RX) = (1260 - 59.7)$$

 $= \{(n \times 180) + A\} \times 12800 + 2560$

 $= 600.15 \, MHz$

In this case, n is 937 and A is 94.

Pin name	Function	Pin name	Function
5C	5V	МО	Modulation si gnal input
LD	Lock signal (on during lock)	9C	9V
NC	Unused	8CL	8V (ripple fil⊜r)
ΧI	12.8 MHz crystal oscillation	ST	0 V during transmission
80R		CV	Lock voltage
DP	Data input	E	GND
СР	Clock input	HT	HET outpu
EP	Enable input		

Table 19

CIRCUIT DESCRIPTION

Unlock circuit

When a PLL circuit is unlocked during transmission, the LD pin of a IC11 set low and Q12 is set off. Q11 is then set on. The 8T line is not activated when 8T switching control circuit Q13 is set off.

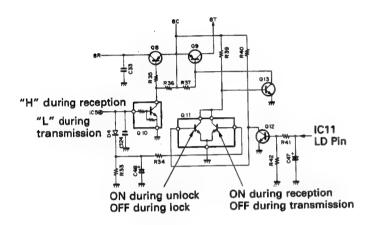


Fig. 23 Unlock Circuit

• Predrive circuit HIC (KCB09)

The VCO output is amplified by Q22, then input to pre-drive circuit HIC IC7. An average 22 to 23 dBm output is obtained by inputting 0 dBm through three-stage (2SC4093 and 2SC3357 x 2) amplification. An alumina board and hybrid integrated circuit are used to ensure stable circuit operation.

• Drive circuit HIC (KCB10)

The VCO output is amplified by KCB09, then input to drive circuit HIC. An average 29 dBm output is obtained by inputting 20 dBm through one-stage (2SC3814) amplification. An integrated radiation plate and alumina board are used to attain a stable output against heating.

• ALT (Automatic Frequency Locked Tuning) Circuit

The block diagram of the ALT unit is shown in **Fig. 24**The ALT system uses a portion of the second local oscillator signal, mixer, and the FM IF HIC: KCD04 module to form a feed-back circuit that is used to provide analog automatic frequency control.

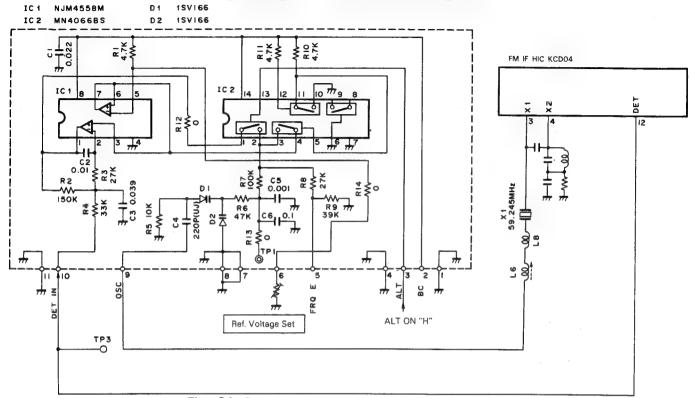
When the first IF (59.7 MHz) changes due to a shift in the transmitter frequency a corresponding shift will occur in the second intermediate frequency. A portion of this second IF signal is detected. This correction voltage is amplified (NJM4558M) and is used to control D1 and D2 via analog switch MN4066BS. TP1 can be used to check the value of this control voltage. D1 and D2 are in series with the 59.245 MHz oscillator circuit and provide voltage control of this oscillator (VCXO, Voltage controlled oscillator). Therefore, fluctuations of the second IF cause a corresponding change in the second local oscillator circuit, which keeps the frequency of the second IF within the bandwidth of the IF filter. This system main-

tains close agreement between the transmit and receive frequency bandwidths. (In practice, the receiver frequency and transmit frequency are automatically maintained in close agreement.) The center voltage of the vari-cap diode is set by a voltage divider circuit. Stability of this voltage is maintained by a voltage follower circuit. When the ALT circuit is off, the control voltage applied to the vari-cap diode is switched to this fixed voltage divider circuit in order to set the second local oscillator frequency.

The control voltage for the vari-cap diode is subject to one additional voltage divider stage. During receive this DC signal is applied from the RM line to the micro processor terminal PTH02 which turns on the tuning indicator light. Switching is performed by the 8R line.

The relationship between the input voltage on the PTH02 terminal and the tuning indicator, and the relationship between the RM voltage and the eviation during receive is shown in Table 20 and Fig. 25

CIRCUIT DESCRIPTION



Block diagram of the ALT unit

PTH02 input voltage	ALT indicator
0~1.48 V	Only ⊲ turns ON
1.48~2.79 V	Both ⊲ and ⊳ turn OFF
2.79~5.0 V	Only ⊳ turns ON

Table 20 Relationship between PTH02 input voltage and the Tindicator

S Fixed voltage when ALT is OFF +10 Deviation f (kHz)

Fig. 25 Relationship between the RM voltage and deviation during receive

CLOCK IC INITIALIZATION

SYSTEM RESET

The POWER ON CLEAR function works automatically and all logics are initialized in this IC (S-3520CF) when the power is turned ON. The system is reset because the POWER ON CLEAR bit (D2 of the CNT2 register) is stuck at "1".

DIGITAL CONTROL UNIT OUTLINE

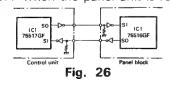
The digital control unit consists of the panel unit which comprises the keys, rotary encoder circuit and display circuit, as well as the control unit which comprises the reset backup circuit, the DTMF circuit, the microphone key input circuit, the dimmer circuit, etc.

DATA COMMUNICATION CIRCUIT OF THE PANEL **CONTROL UNIT**

Figure 26 shows the data communication circuit of the panel control unit. So is the serial data output, SI is the serial data input, and an inverter is located between them to protect the ports of the microprocessor.

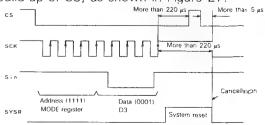
The data communication system is asynchronous. and a communication rate of 31250bps is realized.

Since the connection is checked once every 0.5 second by the microprocessor of the control unit side, the power turns OFF when the panel unit is removed.



SYSTEM RESET

All logics are initialized when the SYSCR bit is set to "1". When cancelling the reset, SCK falls down after the build-up of CS, as shown in Figure 27.



Reset cancellation timing Fig. 27

CIRCUIT DESCRIPTION

• INITIAL SETTING MODE SETTING REGISTER

The clock mode is selected by entering the address 1111 and data 0000 (Ordinary-mode/Clock-mode selection) from Sin. (Refer to DATA WRITE for the entry of data).

CONTROL REGISTER 1

Address 1101 and data 1001 (reference signal output waveform 1 Hz, 24-hour display system) is entered from Sin.

DATA CONTROL

DATA READ

The read mode is set by sticking CS at "L" and WR at "H". The serial address is entered from Sin, at the leading edge of the upper 4 bits of the SCK clock. (The other 4 bits have nothing to do with this operation). When WR is fetched at the 8th leading edge of the SCK clock, the entered address and its data are outputted from Sout, synchronized with the leading edge of the SCK clock. (Figures 28, 29).

• DATA WRITE

The WRITE mode is set by sticking CS to "L" and WR to "L". When the serial address and the data to be written (it is not necessary to write it in the counter) are entered from Sin, they are fetched at the leading edge of the SCK clock. When WR is fetched with the 8th leading edge fo the CSK clock, the following data is written in the entered address.

Counter: Increment of the data Register: 4-bit data entered form Sin Figure 30, 31 shows the writing timing.

• EXAMPLE OF DATA WRITING

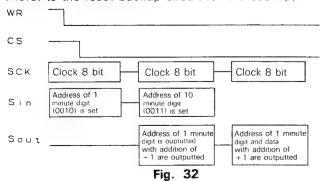
Example of counter writing.

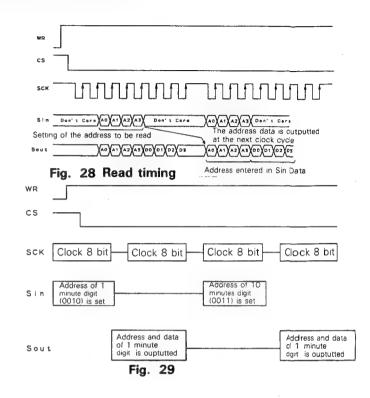
Figure 32 shows the example which consists of writing the "minute" column.

Example of register writing.

Figure 33 shows the example which consists of writing in the control register 1.

(Refer to the reset backup circuit for the backup).





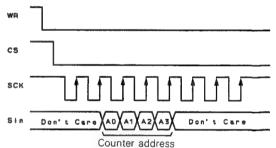
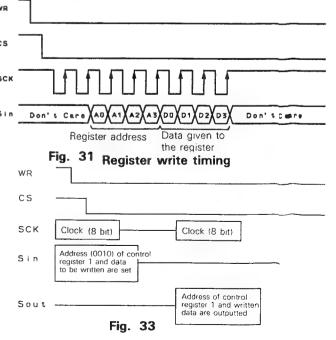


Fig. 30 Counter write timing



CIRCUIT DESCRIPTION

PANEL UNIT

• KEY ROTARY ENCODER INPUT CIRCUIT

Each key of the panel unit is inputted in one port. Moreover, the rotary encoder is directly inputted in the microprocessor.

DISPLAY CIRCUIT

The display circuit consists of two LCD dirvers located at the panel unit and their peripheral circuits (Figure 34), and all processings are carried out by the microcomputer located at the panel side.

The LCD features dynamic lighting up with 1/2 duty, and the lighting up contents are sent from the CPU (IC1:

HD404719A26H) to the LCD by serial data transfer. The LCD display consists of 158 segments.

• DESCRIPTION OF THE OPERATION

Normally, the CLOCK line is stuck at "L" and the DATA line is stuck at "H".

Since the shift register consists of 160 + 160 bits = 320 bits in series, it must be given 320 bit data every time

For the ENABLE signal to be outputted, the DATA line is switched H/L 4 times at the point (A) (B), with the CLOCK line stuck at "H" after transmitting 320 bits for MSM5265,

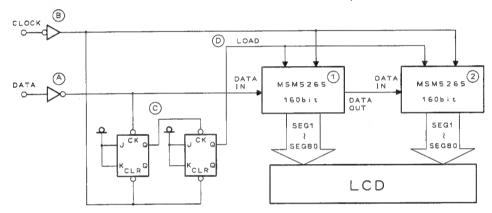


Fig. 34 Display Circuit

• DIMMER CIRCUIT

The dimmer circuit changes the brightness of the lamps in 6 steps

Figure 35 shows the dimmer circuit, which is built into the IC114 (HIC).

A voltage changeable in 6 steps is outputted from the LB port through the combination of the various LB ports (Q1 to Q3) of the shift register. (Refer to the Shift Register Port Table for the logic).

The display does not light up when the power is turned OFF, because the LB line is switched by means of the LB switch: Q2.

Control band LED lighting circuit

The LED brightness is changed by switching the current to one of two ports for each LED. It is changed in two steps corresponding to lamp dimmers d1, d2, and d3, d4.

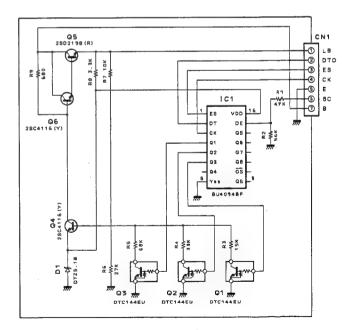


Fig. 35 Dimmer Circuit

CIRCUIT DESCRIPTION

Squelch volume input

The squelch volume for each band works by converting the voltage output by dividing 5 V applied to the variable resistor at the analog port of the microprocessor, and so reads the rotation angle. If the rotation angle changes, a command corresponding to the value is sent to the control unit.

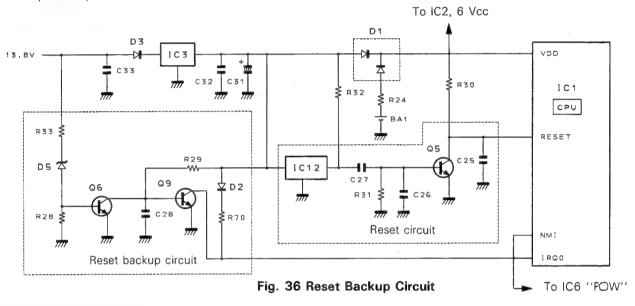
CONTROL UNIT

• RESET BACKUP CIRCUIT

The "L" level pulse with duration of approximately 20ms is outputted by the RESET IC (IC12) and the RESET

SW (Q5) when the power is turned ON. The CPU is reset by means of this pulse.

When the power is turned OFF, the voltage drop of the 13.8V line is detected, Q6 of the backup circuit turns OFF, Q9 turns ON, and the IRQ terminal is stuck at the "L" level. As a result, the CPU gets in the backup operation. At that time, the voltage VDD is supplied by BAI vis R24/D1. Moreover, the backup circuit is also connected to the clock IC: IC6 (S-3520CF), and it gets in the access inhibit (backup) state when the "L" level is entered. Refer to the Port List for IC6.



• MICROPHONE/KEY INPUT CIRCUIT

The UP/DOWN keys and the function keys of the microphone are connected to the analog inputs of the microprocessor, and the various functions are operated by the voltage applied when the key is ON. (Figure 37)

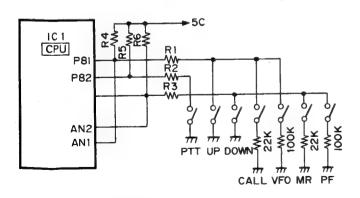


Fig. 37 Microphone key input circuit

• SHIFT REGISTER

Processing of the dimmer, squelch and level functions is carried out by passing serial data from the microprocessor through the shift registers located in IC113 and IC114 (BU4094BF).

The dimmer and the squelch levels are set by 24-bit control, by using 3 shift registers.

The first 8 bits of the 24 bits are the dimmer level setting data (shift register C), and the remaining 16 bits are the squelch level setting data (shift registers A, B). (Figure 38)

CIRCUIT DESCRIPTION

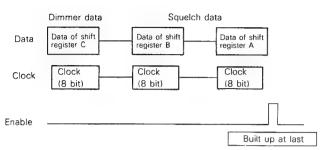
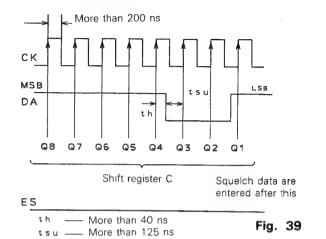


Fig. 38

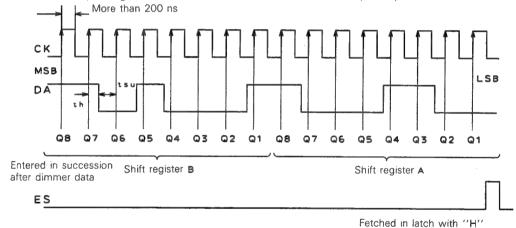
The dimmer level setting is carried out by using 3 bits out of the 8 bits of the shift register. The remaining 5 bits (Q4 to Q8) are open ports, and they are stuck at $^{\prime\prime}$ H $^{\prime\prime}$ during data transmission. (Figure 39)

The squelch level is set by using the 16-bit data that



follow the 8-bit data used for setting the dimmer level. (Figure 40)

Refer to the SHIFT REGISTER PORT SPECIFICATION LIST for the port specifications of each shift register.



tsu — More than 40 ns tsu — More than 125 ns

Fig. 40

SHIFT REGISTER PORT SPECIFICATION LIST (VOL, SQ HIC) CONTROL UNIT (X53-346X-XX)

SHIFT REGISTER A 4094: BUILT INTO IC113

S. Reg Port	Pin No.	Port Data Name	SA VE	Bac kup	Function	Circuit Terminal
Q1	4	PDRDMUT			RD mute 0: ON 1: OFF	RD MUTE
Q2	5	PD_SQA0			BAND A squelch level adjustment (bit 0) 0: There is resistance 1: No resistance	
Q3-	6	PD_SQA1			BAND A squelch level adjustment (bit 1) 0: There is resistance 1: No resistance	
04	7	PD_SQA2			BAND A squelch level adjustment (bit 2) 0: There is resistance 1: No resistance	
Q5	14	PD_SQA3			BAND A squelch level adjustment (bit, 3) 0: There is resistance 1: No resistance	
Q6	13	PD_SQA4			BAND A squelch level adjustment (bit 4) 0: There is resistance 1: No resistance	
Q7	12	PD_SQB0		-	BAND B squelch level adjustment (bit 0) 0: There is resistance 1: No resistance	
Ω8	11	PD_SQB1			BAND B squelch level adjustment (bit 1) 0: There is resistance 1: No resistance	

CIRCUIT DESCRIPTION

Shfit registor B 4094

S. Reg Port	Pin No.	Port Data Name	SA VE	Bac kup	Function	Circuit Terminal name
Q1	4	PD_SQB2			Band B squelch level adjustment (bit 2) 0: There is resistance 1: No resistance	
Q2	5	PD_SQB3			BAND B squelch level adjustment (bit 3) 0: There is resistance 1: No resistance	
Ω3	6	PD_SQB4			BAND B squelch level adjustment (bit 4) 0: There is resistance 1: No resistance	
Q4	7	PD_SQC0			BAND C squelch level adjustment (bit 0) 0: There is resistance 1: No resistance	
Q5	14	PD_SQC1			BAND C squelch level adjustment (bit 1) 0: There is resistance 1: No resistance	
Ω6	13	PD_SQC2			BAND C squelch level adjustment (bit 2) 0: There is resistance 1: No resistance	
Q7	12	PD_SQC3			BAND C squelch level adjustment (bit 3) 0: There is resistance 1: No resistance	
Ω8	11	PD_SQC4			BAND C squelch level adjustment (bit 4) 0: There is resistance 1: No resistance	

All bits are stuck at "H" (H'IF) when MONI ON.

Data coming from the panel are inverted when they enter the shift register.

CONTROL UNIT (X53-346X-XX) SHIFT REGISTER C 4094: BUILT INTO IC114

S. Reg Port	Pin No.	Port Data Name	SA VE	Bac kup	Function	Circuit Ter- minal name
Q1	4	PD			For dimmer level adjustment (Bit 0) Refer to the table below for the logic.	
,Q2	5	PD_			For dimmer level adjustment (Bit 1) Refer to the table below for the logic.	
Q3	6	PD			For dimmer level adjustment (Bit 2) Refer to the table below for the logic.	
Q4	7	PD			Open port, the bit is stuck at "1"	
Q5	14	PD			1	
Q6	13	PD			↑ · · · · · · · · · · · · · · · · · · ·	
Q7	12	PD			1	
Q8	11	PD			1	

Data coming from the panel are inverted when they enter the shift register.

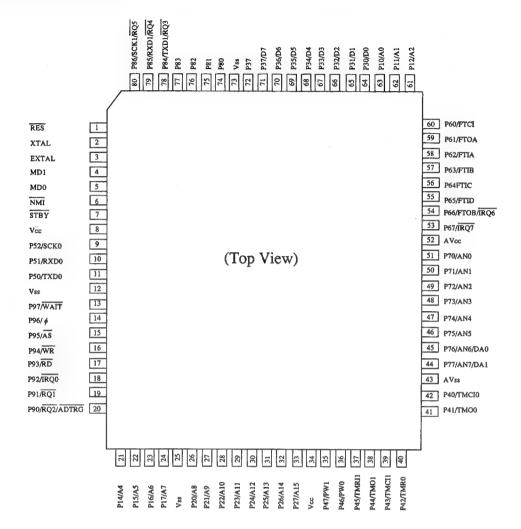
Port logic versus dimmer level correspondence lit

Dimmer level	Q3 (bit 2)	Q2 (bit 1)	Q1 (bit 0)
d1	0	1	0
d2	0	1	1
d3	1	0	0
d4	1	0	1
d5	1	1	0
d6	1	1	1

CIRCUIT DESCRIPTION

I/O PORT SPECIFICATION LIST

CONTROL UNIT (X53-346X-XX): IC1 (HD6433388A04F)



HD6433388A04F I/O PORT LIST: IC1

	HD0433300A04F I/O PORT LIST: ICT									
μCOM Port	Port Name	I/O	Pull up	Back up	Control	Circuit Terminal name				
RES	PRES	l			Reset terminal 0: Reset state 1: Ordinary state					
MD1	P_MD1	- 1			Operation mode (Mode 2) setting. Set to 1					
MD0	P_MD0	1			Operation mode (Mode 2) setting. Set to 0					
STBY		ı			Set to 1					
P10 A0	PA0	0			External RAM, I/O Expander Address					
P11 A1	PA1	0			1					
P12 A2	PA2	0		ı	1					

CIRCUIT DESCRIPTION

HD6433388A04F1/O PORT LIST

μCOM Port	Port Name	I/O	Pull up	Back up	Contents	Circuit Terminal name
P13 A3	PA3	0		. 1	External RAM Address	
P14 A4	PA4	0		I	↑	
P15 A5	PA5	0		l	↑	
P16 A6	PA6	0		1	1	
P17 A7	PA7	0		ı	1	
P20 A8	PA8	0		ı	↑	
P21 A9	PA9	0		l	↑ ·	
P22 A10	PA10	0		I	1	
P23 A11	PA11	0		ı	↑	
P24 A12	PA12	.0		1	↑	
P25 A13	PRAMCE2	0			External RAM CE2	CE2
P26 A14	P_RAMCE11	0			External RAM CE1 Input composing AND with P_RAMCE12	CE1
P27 A15	PRAMCE12	0		l	External RAM CE1 Input composing AND with P_RAMCE11	↑
P30 D0	PDATO	1/0		1	External RAM, I/O Expander data	
P31 D1	PDAT1	I/O		ı	1	
P32 D2	PDAT2	1/0		ı	1	
P33 D3	PDAT3	I/O		ı	↑	

CIRCUIT DESCRIPTION

HD6433388A04FI/O PORT LIST

μCOM Port	Port Name	I/O	Pull up	Back up	Content	Circuit Terminal name
P34 D4	P_DAT4	1/0		l	External RAM, I/O Expander data	
P35 D5	P_DAT5	1/0		ı	1	
P36 D6	P_DAT6	1/0			†	
P37 D7	PDAT7	1/0		ı	†	
P40 TMC10	P_CKCS	0		I	Clock chip select 0: Selected state S3520CF CS 1: High impedance	
P41 TMO0	P_CKSOUT	1		ı	Clock data input S3520CF SOUT	
P42 TMRI0	PCKWR	0		ı	Clock write select 0: Write S3520CF WR 1: Read	
P43 TMCI1	P_CKSIN	0		. 1	Clock data output/CTCSS Unit Data S3520CF SIN	
P44 TMO1	P_BEEP	0		l	''Beep'' sound output terminal (Effect sound) Stuck at the ''L'' level when there is no output of the ''Beep'' sound.	BZ
P45 TMRI0	P_PSW	0		1	Power switch. 0: Power ON 1: Power OFF	PSW
P46 PW0	PTONE	0		ı	Sub-tone	
P47 PW1	P_CKSCK	0		l	Clock synchronism signal output (\$3520Cf SCK)/Serial→ Parallel conversion (HD74HC165F)/CTCSS Unit Clock	
P50 TXD0	P_SO	0	•		Panel microprocessor SI	
P51 RXD0	PSI	I	•		Panel microprocessor SO	
P52 SCK0	P_Q165	-			Parallel→Serial conversion (HD74HC165F) input Destination, repeater function provided/not-provided, FAN SW, etc.	
P60 FTC1	PDTDA0	1/0		ı	DTMF Data (D4/Q1)	
P61 FTOA	P_DTDA1	I/O		l	DTMF Data (D3/Q2)	

CIRCUIT DESCRIPTION

HD6433388A04F I/O PORT LIST

μCOM Port	Port Name	I/O	Pull up	Back up	Content	Circuit Terminal name
P62 FTIA	P_DTDA2	1/0		ı	DTMF Data (D2/Q3)	
P63 FTIB	P_DTDA3	1/0			DTMF Data (D1/Q4)	
P64 FTIC	P_STD	ı		1	DTMF detection 0: No signal (LC7385 StD) 1: Signal detected	DV
P65 FTID	PDTSEL	0			DTSS unit switching 0: Detection output 1: MIC	DTSEL
P66 FT0B IRQ6	PDTCE	0		1	DTMF tone generator TC35219 TOE 0: No output a: Tone output	CE
P67 IRQ7	PDTOE	0		ı	DTMF receiver LC7385 TOE O: High impedance 1: Enable	EN
P70 AN0	P_DOWN	0	•		Mic. DOWN MR, PF (Port shared with RXD1)	
P71 AN1	P_UP		•	1	Mic. UP CALL, VFO (Port shared with SCK1)	
P72 AN2	P_ALTA	l			BAND Unit A ALT input	
P73 AN3	PALTB			ı	BAND Unit B ALT input	
P74 AN4	P_ALTC	I			BAND Unit C ALT input	
P75 AN5	P_SMA	1		1	BAND Unit A S meter input	
P76 AN6	P_SMB				BAND Unit B S meter input	
P77 AN7	P_SMC	1		l	BAND Unit C S meter input	

CIRCUIT DESCRIPTION

HD6433388A04F I/O PORT LIST

	TIDOTSSSOCACTI I/O TOTT LIST							
μCOM Port	Port Name	I/O	Pull up	Back up	Content	Circuit Terminal name		
P80	PET	0	•		CTCSS Unit Enable conenection check 0: CONNECT 1: NO CONNECT	ET		
P81	PCTCSS	l		ı	CTCSS DETECT 0. Tone coincidence 1: No tone coincidence	SD0		
P82	P_MMUTE	0		1	Mic MUTE 0: MUTE OFF 0: MUTE ON			
P83	P_KBRD	I	•	l	CONTROLLER CHECK 1 NEW KENWOOD BUS (RD)	KBRD		
P84 TXD1 IRQ3	P_KBSO (P_PTT)	I/O	•	I	NEW KENWOOD BUS (SO) 0 Mic. PTT 1	KBSO		
P85 RXD1 IRQ4	PKBSI		•	1	NEW KENWOOD BUS (SI) 1 Shared with Mic. DOWN terminal (ANO)	KBSI		
P86 SCK1 IRQ5	P_KBCK	1/0	•	J	NEW KENWOOD BUS (Clock) 1 Shared with Mic. UP terminal (AN1)	KBCK		
P90 ADTRG IRQ2	PRPTON	0		ı	Operation of REPEATER 0: ON function 1: OFF			
P91 IRQ1	P_TPOUT	ı		ı	Clock reference signal input S-3520 TPout			
P92 IRQ0	PVF	I		ı	Power check 0: During backup 1: During operation			
P93 RD	P_RD	0		ı	External RAM, I/O Expander read control signal O: External read 1: Inhibit			
P94 WR	P_WR	0		ı	Externla RAM, I/O Expander write control signal O: External read 1: Inhibit			

Δ: Pull-up only when checked by software. (Care must be taken, because P_ET is stuck at "H" during check).

O: Pull-up only when stuck at "H", during input with software.

^{• :} Pull-up with hardware.

^{▲:} Pull-down with hardware.

CIRCUIT DESCRIPTION

I/O EXPANDER PORT SPECIFICATION LIST

CONTROL UNIT (X53-346X-XX)

CXD1095Q I/O PORT LIST IC101

Port	I/O	Backup	Content	Circuit terminal name
PA0			Operation unit switching of CTCSS *1	CTC1
PA1			Operation unit switching of CTCSS *1	CTC2
PA2	0		Detection output connection unit switching *3	RD1
PA3			Detection output connection unit switching *3	RD2
PA4			Operation unit switching of DTSS *2	DTS1
PA5			Operation unit switching of DTSS *2	DTS2
PA6	0		FAN ON/OFF 0: OFF 1: ON	FANSW
PA7	•		Power switch other than 5C 0: OFF 1: ON	PWS2
PB0			Volume, squelch HIC Data	VOLSQDA
PB1			Volume, squelch HIC Clock	VOLSQCK
PB2	0		Squelch Enable 0: No change 1: Data fetched in latch	SQES
PB3			Electronic volume 2 Enable. Data latch at (1→0)	VOLCSA
PB4			Electronic volume 1 Enable. Data latch at leading edge (1→0)	VOLCSB
PB5			BEEP MUTE BAND A O: MUTE OFF 1: MUTE ON	MUTEA
PB6	0	i	BEEP MUTE BAND C O: MUTE OFF 1: MUTE ON	MUTEC
PB7			BEEP MUTE BAND B O: MUTE OFF 1: MUTE ON	MUTEB
PC0			BAND Unit A busy input 0: BUSY 1: CLOSE	SCA
PC1	1		BNAD Unit B Busy input 0: BUSY 1: CLOSE	SCB
PC2			BNAD Unit C Busy input 0: BUSY 1: CLOSE	SCC
PC4			BAND Unit A shift Register Enable	ESA
PC5	1		BAND Unit A PLL/Shift Register Data *1	DTA
PC6	1/0		BAND Unit A PLL/Shift Register Clock*1	CKA
PC7			BAND Unit A PLL Enable *1	EPA
PD0			BAND Unit B Shift Register Enable	ESB
PD1	1		BAND Unit B PLL/Shift Register Data *2	DIB
PD2	1/0		BAND Unit B PLL/Shift Register Clock*2	CKB
PD3	1		BAND Unit B PLL Enable *2	EFB
PD4			BAND Unit C Shift Register Enable	ESC
PD5	1		BAND Unit C PLL/Shift Register Data *3	DTC
PD6	1/0		BAND Unit C PLL/Shift Register Clock*3	CKC
PD7			BAND Unit C PLL Enable *3	EPC

CIRCUIT DESCRIPTION

CXD1095Q I/O PORT LIST

Port	1/0	Backup	Content	Circuit terminal name
PEO	0		Shift Register (HD74HC165F) S/L terminal O: Latch asynchronous with clock 1: Latch at loading edge of clock	LOAD165
PE1	0		AF MUTE BAND A 0: MUTE OFF 1: MUTE ON	
PE2	0		AF MUTE BAND B 0: MUTE OFF 1: MUTE ON	
PE3	0		AF MUTE BAND C 0: MUTE OFF 1: MUTE ON	

*1, *2, *3 Types of band units

BAND Unit	EP X	CK X	DT X	Unit No.	Number after conversion
No unit	0	0	0	0	0
28 MHz BAND	0	0	1	1	1
50 MHz BAND	0	1	1	3	2
144 MHz BAND	1	1	0	6	3
220 MHz BAND	0	1	0	2	4
430 MHz BAND	1	0	1	5	5
1200 MHz BAND	1	0	0	4	6

NOTE: X is A, B or C

The number after conversion is used on the program

*1, *2, *3

СТС2	CTC1	CTCSS operation unit
DT\$2	DTS1	DTSS operation unit
RD2	RD1	Detected output connection unit
0	0	Α
0	1	В
1	X	С

CIRCUIT DESCRIPTION

TERMINAL LIST OF CLOCK IC (S-3520CF)
CONTROL UNIT (X53-346X-XX)

SERIAL TIME CLOCK (S-3520CF): IC6

Terminal No.	Name	Function	H8/337 connection terminal name
4	SCK	Synchronous signal input terminal of serial I/O 8 clocks/cycle	P47
5	Sin	Serial address/data input terminal Entry of address of counter or address/data of register/RAM.	P43
9	Sout	Serial address/data output terminal.	P41
6	WR	Write selection terminal. WR = ''L'': Write WR = ''H'': Read	P42
11	CS	Chip select terminal CS = ''L'': Selected state CS = ''H'': Sout gets at high impedance state	P40
10	PDW	System power supply leading edge check signal. Connected to power down detection circuit Stuck at "H" when PDW is not used Access disable irrespective of CS when fixed PSW = "L". (Sout, TPout get at high impedance state).	_
8	TPout	Reference signal output terminal, 1 Hz/1024Hz switching output.	P9 1

Control Unit (X53-346X-XX): IC6 (S-3520CF) ADDRESS CORRESPONDENCE LIST

Address (A3 to A0)	Clock mode (MODE 0)	
0000	1-second column counter	
0001	10-second column counter	
0010	1-minute column counter	
0011	10-minute column counter	
0100	1-hour column counter	
0101	10-hour column counter	
0110	Day (of the week) counter	
0111	1-day column counter	
1000	10-day column counter	
1001	1-month column counter	
1010	10-month column counter	
1011	1-year column counter	
1100	10-year column counter	
1101	Control register 1	
1110	Control register 2	
1111	Mode setting register	

The contents of the counter and the register can be read and rectified by handling the 4-bit address and data as a set. The addresses are allocated as shwon in the table below.

REGISTER CONTROL

• MODE SETTING REGISTER

Switches the clock mode and the SRAM mode, and resets the system. $\,$

MODE SETTING REGISTER (MODE, 1111)

	D3	D2	D1	D0
5	SYSR	TEST	MS1	MS0

0 fixed Clock mode selected "00" entered

SYSR is used to clear the counter and the register. The system is reset when it is stuck at "1", and gets at the ordinary mode when it is stuck at "0".

MS0 and MS1 are used to switch the mode. § ince the clock mode is used this time, "0""0" is entered in these registers

CONTROL REGISTER 1 (CNT1, 1101)

D3	D2	D1	DO
TPS	30ADJ	CNTR	24/12

CIRCUIT DESCRIPTION

TPS is used to select the reference signal output waveform, 1 Hz is outputted when it is "1", and 1024Hz is outputted when it is "0", Since 1Hz output is selected this time, it is stuck at "1".

30ADJ is used to carry out \pm 30-second adjustment, and \pm 30-second adjustment is carried out when it is stuck at "1". The operation gets at the ordinary mode when it is stuck at "0".

CNTR is used to reset the counter. The operation gets in the reset mode when it is stuck at "1", and after that the content of the specified counter is reset. The operation gets at the ordinary mode when it is stuck at "0".

24/12 is used to switch the display mode. The 24-hour display mode is selected when it is stuck at "1", and the 12-hour display mode is selected when it is stuck at "0".

This time it is stuck at "1", because the 24-hour display mode is selected.

• CONTROL REGISTER 2

This is the flat used to detect the state when the operation is in the clock mode.

CONTROL REGISTER 2 (CNT2, 1110)

D3	D2	D1	D0
STA	DET	0	0

STA is used to check the end-around carry of the time and the calendar. It is stuck at "1" when end-around carry is in progress, and at "0" when there is no end-around carrry.

DET is used to check the power ON clear detection. It is stuck at "1" when power ON clear is detected, and at "0" in thordinary mode.

LIST OF TERMINALS OF THE PARALLEL→SERIAL CONVERTER IC (PARALLEL IN, SERIAL OUT) CONTROL UNIT (X53-346X-XX)

8-bit Shift Register (HD74HC165F): IC7

Terminal Name		Function	I/O Expander terminal name
1	S/L	Data shift/load selection terminal S/L = ''L'': Data entered in the 8 inputs (A to H) are stored in the various registers, asynchronously with the clock. S/L = ''H'': Successive shift operations are carried out at the leading edge of the various flip-flops.	PB5
2	CLOCK	Data shift synchronization signal input terminal	PB1
14	D (P_B3)	Parallel input terminal (bit 3). Destination data (bit 3) 0: Destination bit "0" 1: Destination bit "1"	
13	C (PB2)	Parallel input terminal (bit 2). Destination data (bit 2) 0: Destination bit "0" 1: Destination bit "1"	
12	PB1)	Parallel input terminal (bit 1). Destination data (bit 1) O: Destination bit "0" 1: Destination bit "1"	
11	A (P_B0)	Parallel input terminal (bit 0). Destination data (bit 0) 0: Destination bit "0" 1: Destination bit "1"	
9	QΗ	Serial data output terminal	PC3
10	SI	Serial data input terminal	
6	H (P_RPT)	Parallel input terminal (bit 7). Existence of repeater function 0: No repeater function 1: Repeater function	
5	G (P_FANDL I)	Parallel input terminal (bit 6). FAN delay time setting (bit 1) *1 The time is set in combination with terminal No.4.	

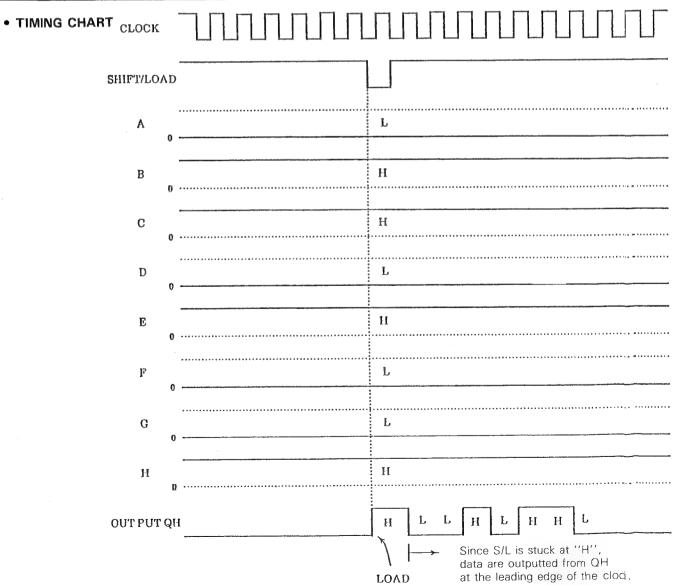
CIRCUIT DESCRIPTION

8-bit Shift Register (HD74HC165F): IC7

Terminal No.	Name	Function	I/O Expander terminal name
4	F (P_FANDLO)	Parallel inptu terminal (bit 5). FAN delay time setting (bit 0) *1 The time is set in combination with terminal No.5.	
3	E (P_MDFY)	Parallel input terminal (bit 4). Transmission remodeling data (bit 4) 0: Remodeling 1: No remodeling	

*1 FAN Delay Time setting input

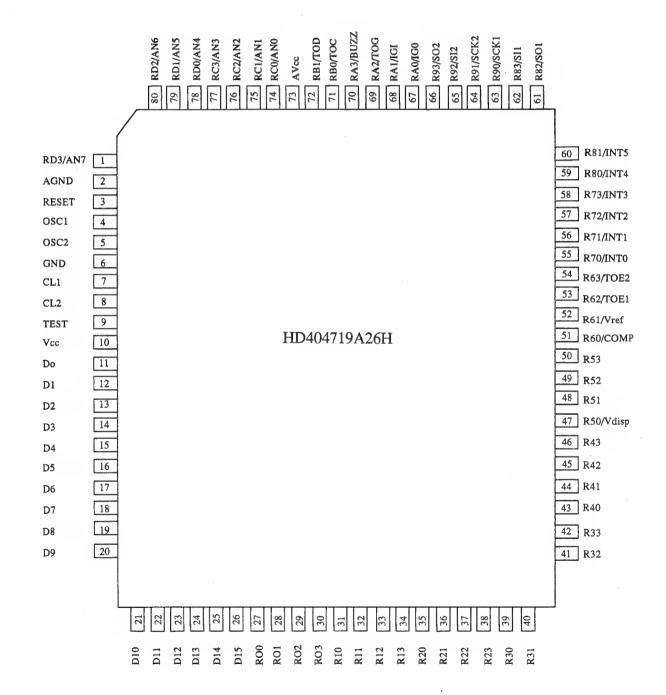
FAN control	P_FANDL 1	P_FANDL 0
Permanently ON when POWER is ON	0	0
ON during transmission	0.	1
ON during transmission + ON during 1 minute after and of transmission	1	0
ON during transmission +ON during 2 minutes after end of transmission	1	1



CIRCUIT DESCRIPTION

I/O PORT SPECIFICATION LIST

DISPLAY UNIT (X54-3130-11): IC1 (HD404719A26H)



CIRCUIT DESCRIPTION

HD404719A26H I/O PORT LIST: IC1

			I/	0	Pull	
PIN NO.	μ COM Port	Port name	PS ON	PS OFF	Up	Content
1	RD3/AN7		1	ı		GND (DONT USE)
2	AGND					GND
3	RESET		ı	1	O 5 M	RESET
4	OSC1		ı			4 MHz Xtal ①
5	OSC ₂		0	0		4 MHx Xtal ②
6	GND					GND
7	CL1		ı	1		NC (Vcc)
8	CL2		0	0		NC (OPEN)
9	*TEST		I	ı		5 V (5M)
10	Vcc					5 V (5M)
11	Do	PDoPSW	ı	ı		PSW L: ON
12	D1	PD ₀ VFO	ı	ı		VFO
13	D ₂	PDoMR	ı	ı		MR
14	D3	PD ₀ CALL	1	ı		CALL
15	D4	PDoF	ı	I		F
16	D ₅	PD ₀ BELL	ı	ı		BELL.
17	D6	PD ₀ TONE	ı	I		TONE
18	D7	PDoREV	ı	1		REV
19	D8	PD ₀ DTSS	ı	ı		DTSS
20	De	PD ₀ LOW	1	1		LOW
21	D10	PD ₀ MUTE	1	ı		MUTE
22	D11	PD ₀ LINK	ı	ı		RC
23	D12	PDoMHZ	ı	ı		MHz
24	D13	PD ₀ CSA	ı	1		C SEL A
25	D14	PD ₀ CSB	1	1		C SEL B
26	D15	PD ₀ CSC	ı			C SEL C
27	ROo	PD ₀ BSA	ı	ı		B SEL A
28	RO ₁	PD ₀ BSB		ī		B SEL B
29	RO ₂	PD ₀ BSC	ı	1		B SEL C

CIRCUIT DESCRIPTION

HD404719A26H I/O PORT LIST: IC1

				/O			
PIN NO.	μ COM Port	Port name	PS ON	PS OFF	Pull Up	Content	
30	RO3/AN7		I	I		NC (Vcc)	
31	Rio		0	O(L)		CS LED A GRN ① *I	
32	RI1		0	O(L)		CS LED A GRN ② *I	
33	RI2		0	O(L)		CS LED A RED ① *I	
34	RI3		0	O(L)		CS LED A RED ② *I	
35	R20		0	O(L)		CS LED B GRN ① *I	
36	R21	:	0	O(L)		CS LED B GRN ② *I	
37	R22		0	O(L)		CS LED B RED ① *I	
38	R23		0	O(L)		CS LED B RED ② *I	
39	R30		0	O(L)		CS LED C GRN ① *I	
40	R31		0	O(L)		CS LED C GRN ② *I	
41	R32		0	O(L)		CS LED C RED ① *I	
42	R33		0	O(L)		CS LED C RED ② *I	
43	R40		0	O(L)		Function LED L: ON H: OFF	
44	R41		0	O(L)		NC (OPEN)	
45	R42			O(L)		NC (Vcc)	
46	R43		_	O(L)		NC (Vcc)	
47	R5o/Vdisp		1	1		NC (GND)	
48	R51		ı	ı		NC (GND)	
49	R52		ı	1		NC (GND)	
50	R53		ŀ			NC (GND)	
51	R6o/COMP		0	1		DISPLAY CK	
52	R61/Vref		0	. 1		DISPALY DT	
53	R62/TOE1		0	ı		NC (OPEN)	
54	R63/TOE2		0	ı		NC (OPEN)	
55	R7o/*INTo		I	ı		SI INT (\sum_(\sum_Interruption)	
56	R71/*INT1			ı	PULL DOWN	PS (/*Interruption)	
57	R72/*INT2		ı	ı		ENCODERDT	

CIRCUIT DESCRIPTION

HD404719A26H I/O PORT LIST

			1/0			
PIN NO.	μ COM Port	Port name	PS ON	PS OFF	Pull Up	Content
58	R73/*INT3		ı	ı		ENCODERCK (₹ > Interruption)
59	R80/*INT4		ı	1		NC (GND)
60	R81/*INT5		ı	1		NC (GND)
61	R82/SO1		0	O(H)		so
62	R83/SI1		1	ı		SI
63	R9o/*SCK1		I			SCK
64	R91/*SCK2		ı	1		NC (GND)
65	R92/Sl2		ı	ı		NC (GND)
66	R93/SO2		1	-		NC (GND)
67	RAo/ICTo		0	O(H)		CLK OUT
68	RA1/ICT1		1	ı		NC (GND)
69	RA ₂ /TOG		ı	ŀ		NC (GND)
70	RA3/BUZZ		ı	1		NC (GND)
71	RBo/TOC		I	1		NC (GND)
72	RB1/TOB		ı	1		NC (GND)
73	AVcc					5 V (5 C)
74	RCo/ANO		ı	1		VOL A
75	RC ₁ /AN1		ı	1		VOL B
76	RC ₂ /AN ₂		ı	1		VOL C
77	RC3/AN3	-	ı	1		SQL A
78	RDo/AN4		I	1		SQL B
79	RD1/AN5		ı	ı		SQL C
80	RD ₂ /AN ₆		1	1		B VOLTAGE

O: Pull-up with the hardware

^{*1:} DIMMER control of the various LED of CSEL is carried out means of 2 ports. The brightness is shown below.

Port	OFF	Dark	Bright
1	Н	L	L
2	Н	Н	L

^{*:} LOW active

CIRCUIT DESCRIPTION

LCD DRIVER (MSM5265) LIST DISPLAY UNIT (X54-3130-11): IC201 No. 1

LCD IC IC LCD SEG. Term. No. Pin No. Pin Name COM₁ COM₂ COM1 COM₂ 30 S80 A TIMER 2 29 S79 (A) ON A OFF 28 S78 (A) ALRM 3 ♠ TOT 4 27 S77 A ABC 26 S76 A MUTE APO 5 6 7 A) S7 A) S5 25 S75 A ON AIR 8 A BUSY 24 S74 23 S73 A L A SI 9 A) S2 10 22 S72 A M A) S3 11 21 S71 A 1-5-9 (A) S6 12 20 S70 (A) S4 19 S69 A BELL 13 18 S68 \triangle < A ALT 14 17 S67 A IGbc 15 ♠ R-16 S66 ♠ L-16 A) 100Ma A 100Mf 17 15 S65 A 100Md S64 A 100Me 18 14 19 13 S63 (A) 100Mc (A) 100Mg 20 12 S62 (A) 100Mb A PTT 21 S61 A CONT 11 10 S60 (A) 10Ma A 10Mf 22 9 \$59 (A) 10Md A) 10Me 23 8 S58 A) 10Mc 24 A 10Mb A 10 Mg 7 S57 6 S56 \triangle > A + 26 S55 \triangle T (A) C CSS 27 5

IC	IC	LCD	SEG.	LCD
Pin No.	Pin Name	СОМ1	COM2	Term. No.
4	S54 _.	(A) IMa		28
3	S53	(A) IMd	(A) IMe	29
2	S52		(A) IMdp	30
1	S51	(A) IMb	(A) IMg	31
100	S50	A DTSS	♠ REV	32
99	S49	A 100Ka	♠ 100Kf	33
98	S48	♠ 100Kd	A 100Ke	34
97	S47	A 100Kc		35
96	S46	(A) CLKdp	100Kdp	36
95	S45	(A) 100Kb	♠ 100Kg	37
94	S44	A Burst1	A Burst2	38
93	S43	(A) 10Ka	♠ 10Kf	39
92	S42	♠ 10Kd	♠ 10Ke	40
91	S41	A 10Kc	♠ 10Kdp	41
90	S40	A 10Kb	♠ 10Kg	42
89	S39·	A ☆	♠ F	43
88	S38	♠ 1Ka	△ 1Kf	44
87	S37	♠ 1Kd	A 1Ke	45
86	S36	A 1Kc	♠ 05 K	46
85	S35	A 1Kb	♠ 1Kg	47
84	S34	A +U	⊕ co	48
83	S33	(A) MRHa	(A) MRHf	49
82	S32	(A) MRHd	A MRHe	50
81	S31	(A) MRHc	A LOCK	51
80	S30	(A) MRHb	A MRHg	52
79	S29	(A) MRLa	A MRLf	53
78	S28	A MRLd	A MRLe	54
77	S27	A MRLc		55
76	S26	(A) MRLb	A MRLg	56
				57

CIRCUIT DESCRIPTION

No. 3

				No. 3
IC IC		LCD :	SEG.	LCD
Pin No.	Pin Name	COM1	COM2	Term.No.
75	\$25	® \$7	® \$5	58
74	S24	® ONAIR	B BUSY	59
73	S23	® L	B SI	60
72	S22	ВМ	® S2	61
71	S21	® 1-5-9	® S3	62
70	S20	B S6	® S4	63
69	S19		B BELL	64
68	S18	® <	® ALT	65
67	S17	® IGa	® IGf	66
66	S16	® IGd	® IGe	67
65	S15	® IGc		68
64	S14	® IGb	® IGg	69
63	S13	B L-	® R-	70
62	S12	B 100Ma	B 100Mf	71
61	S11	B 100Md	B 100Me	72
60	S10	B 100Mc		73
59	S9	B 100Mb	B 100Mg	74
58	S8	® CONT	® PTT	75
57	S7		B 10Mf	76
56	S6			77
55	S5	B 10Mc		78
54	S4		B 10Mg	79
53	S3	B >	B +	80
52	\$2	® T	® C CSs	81
51	S1	® IMa	® IMf	82
48	COM-A			
49	сом-в			

DISPLAY UNIT (X54-3130-11): IC202 No. 1

IC	IC	LCD	LCD	
Pin No.	Pin Name	COM1	COM2	Term.No.
				COM1
				сом2
30	S80	B IMd	® IMe	83
29	S79	B IMc	B IMdp	84
28	S78	B IMb	® IMg	85
27	S77	® DTSS	® REV	86
26	S76			87
25	S75		B 100Ke	88
24	S74	B 100Kc		89
23	S73	® CLKdp		90
22	S72	® 100Kb		91
21	S71	B Burst1	B Burst2	92
20	S70		B 10Kf	93
19	S69			94
18	S68	® 10Kc	® 10Kdp	95
17	S67	® 10Kb	® 10Kg	96
16	S66	® ☆	® F	97
15	S65	® 1Ka	® 1Kf	98
14	\$64	® 1Kd	® 1Ke	99
13	S63	® IKc	® 05K	1 00
12	S62	® 1Kb	® 1Kg	1 01
11	S61	B +U	® co	1 02
10	S60	® MRHa	® MRHf	1 03
9	S59	® MRHd	® MRHe	1 04
8	\$58	® MRHc	® LOCK	1 05
7	S57	® MRHb	® MRHg	1 06
6	S56	® MRLa	® MRLf	1 07
5	S55	® MRLd	® MRLe	1 08

CIRCUIT DESCRIPTION

DISPLAY UNIT (X54-3130-11): IC202 No. 2

IC	IC	LCD	LCD	
Pin No.	Pin Name	COM1	COM2	Term. No.
4	S54	® MRLc		109
3	\$53	® MRLb	® MRLg	110
				111
2	S52	© S7	© S5	112
1	S51	© ONAIR	© BUSY	113
100	S50	© L	© S1	114
99	S49	©м	© S2	115
98	S48	© 1-5-9	© S3	116
97	S47	© S6	© S4	117
96	S46		© BELL	118
95	S45	© <	© ALT	119
94	S44		© 1Gbc	120
93	S43	© L-	© R-	121
92	S42	© 100Ma	© 100Mf	122
91	S41	© 100Md	© 100Me	123
90	S40	© 100Mc		124
89	S39	© 100Mb	© 100Mg	125
88	S38	© CONT	© PTT	126
87	S37	© 10Ma	© 10Mf	127
86	S36	© 10Md	© 10Me	128
85	S35	© 10Mc		129
84	S34	© 10Mb	© 10Mg	130
83	S33	© >	© +	131
82	S32	© T	© c css	132
81	S31	© 1Ma	© 1Mf	133
80	S30	© 1Md	© 1Me	134
79	S29	© 1Mc	© 1Mdp	135
78	S28	© 1Mb	© 1Mg	136
77	S27	© DTS	© REV	137
76	S26	© 100Ka	© 100Kf	138

IC	IC	LCD	SEG.	LCD
Pin No.	Pin Name	СОМ1	COM2	Term. No.
75	S25	© 100Kb	© 100Ke	139
74	S24	© 100Kc	© 100Kdp	140
73	S23	© CLKdp		141
72	S22	© 100Kb	© 100Kg	142
71	S21	© Burst1	© Burst2	143
70	S20	© 10Ka	© 10Kf	144
69	S19	© 10Kd	© 10Ke	145
68	S18	© 10Kc	© 10Kdp	146
67	S17	© 10Kb	© 10Kg	147
66	S16	© #	© F	148
65	S15	© 1Ka	© 1Kf	149
64	S14	© 1Kd	© 1Ke	150
63	S13	© 1Kc	© 05K	151
62	S12	© 1Kb	© 1Kg	152
61	S11	© +U	© co	153
60	S10	© MRHa	© MRHf	154
59	S9	© MRHd	© MRHe	155
58	S8	© MRHc	© LOCK	156
57	S7	© MRHb	© MRHg	157
56	S6	© MRLa	© MRLf	158
55	S5	© MRLd	© MRLe	159
54	S4	© MRLc		160
53	S3	© MRLb	© MRLg	161
52	S2			
51	S1			
48	COM-A			
49	COM-B			

CIRCUIT DESCRIPTION

• TONE OUTPUT

The TONE output is obtained by outputting, from CPU, the pulse corresponding to the preset tone, and by filtering it. (Figure 41)

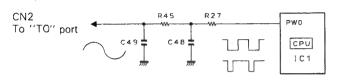


Fig. 41

• INPUT/OUTPUT OF CTCSS (OPTION TSU-7)

Data to the CTDSS unit is outputted by P80, P47 and P43. Moreover, since P80 has also the function of checking the connection it becomes an input when the power is turned ON, and after checking the connection it becomes an output. CTCSS does not turn ON when there is no connection. Figure 42 shows the data transmission format, and Figure 44 shows the data configuration. The "L" level, obtained when the tone is detected from the CTCSS unit and its coincidence is confirmed, is entered in P81 of the microprocessor, and then the squelch is opened.

Each CTCSS unit is able to cope with 3 bands. This operation is executed by switching the low frequency signal outputted by the band unit. (Figure 43).

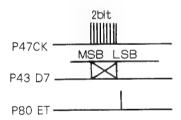


Fig. 42 CTCSS Data Transfer Format

LIST OF PORTS OF IC11: LC7385M

Pin No.	Name	1/0	Function description		
1	IN+	1	Non-inverted input of the input amplifier		
2	IN-	1	Inverted input of the input amplifier		
3	GS	0	Output of the output amplifier		
4	VREF	0	Reference voltage output of Vpb/2		
5	B/H	1	Selects the output format of Q1 to Q4. Binary (2 of 8) code when stuck at "H". Hexadecimal code when stuck at "L".		
6	PD	1	Operation switched to pweor down mode when stuck at "H".		
7	OSC1	i	An osciallator circuit is composed by connecting a 3 569545MHz quartz oscillator between		
8	OSC2	0	these terminals.		
9	Vss		Power supply terminal, normally OV		
10	TOE	1	Controls the 3 state output of Q1 to Q4. Enabled when stuck at "H". High impedance when stuck at "L".		
11	Q1				
12	Qz				
13	Q3	0	3 state received data output		
14	Q4				
15	StD	0	Stuck at "H" when the connection time of the effective tone pari esceeds the preset time preset by the add-on CR.		
16	ESt	0	Stuck at "H" when the effective tone pari is detected.		
17	St/GT	1/0	The guard time is preset by connecting CR.		
18	Voo		Power supply terminal. Normally 5V.		

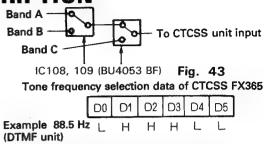


Fig. 44 CTCSS Data Configuration • INPUT/OUTPUT OF DTMF

Data to DTMF is outputted by P66, 67 and P60 to P63 of the microprocessor.

P60 to P63 are the data in the case of the encoder, and tones corresponding to each data are outputted from the TONE terminal) of IC10 (TCD35219F) while P66 is stuck at "H".

As for the decoder, the detected signals corresponding to each band are switched at IC108, 109, in the same way as in CTCSS, and after that it passes through the analog switch IC8 and is entered in the DTMF decoder IC11 (LC7385M). When an effective tone is detected, the terminal STD is stuck at "H", and P67 of the microprocessor is enabled. As a result, data are entered in P60 to P63, and the coincidence with the preset DTSS codes is checked by the microcomputer.

On the other hand, the input from the DTMF microphone is read and controlled by switching the input of IC11 by means of Q7 and the microprocessor. The ports of IC11 are shown in the following table.

PLL data output

The PLL data is passed through I/O expander IC101 (CXD 1095Q) from the microcomputer and output to each band unit with EP, CK, and DT signals and three serial data items.

A PLL IC (M56760FP) is used in common with the 144 and 430 TX/RX units. Figure 45 shows the data configuration. Figure 46 and 47 shows the PLL data transfer format.

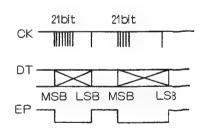


Fig. 45 PLL Data Configuration

CIRCUIT DESCRIPTION

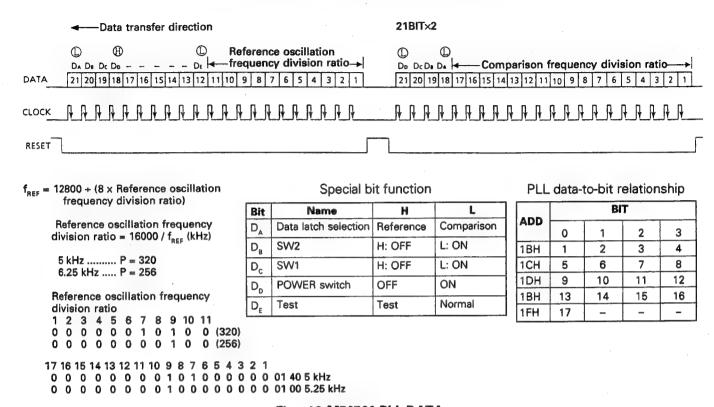


Fig.	46	M567	60	PLL	DATA	

	8	12	16	20	3
5	9	13	17	21	4
1F	1E	1D	1C	1B	1A
_	215	211	27	23	D _D
-	214	210	2 ⁶	22	D _c
_	213	29	2 ⁶	21	D.

1C

14

15

1B

18

19

20

1A 1

2

1F

1E 1D

6

7

10

11

216	212	28	24	20	DA	
For	frequi	ancy c	livision	ratio	cettino	

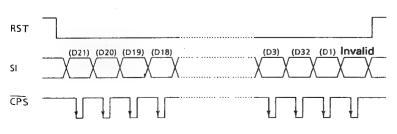
1F	1E	1D	1C	1B	1A
-	×	D _€	27	2 ³	D _D
-	×	210	2 ⁶	2²	D _c
-	×	2°	2 ⁵	2¹	De
×	×	2 ⁸	24	2º	DA

For comparison frequency

Data	01-1-
D _€	State
L	Normal
Η	Test

Data	PLL
D _E	POWER switch
L	ON
Н	OFF

Da	Data		ut port
DH	D _c	SW2	SW1
L	L	ON	ON
Н	L	OFF	ON
L	Н	ON	OFF
Н	Ι	OFF	OFF



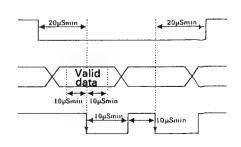
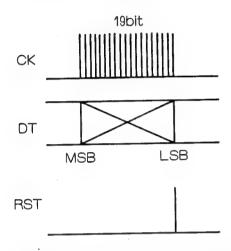


Fig. 47 M56760 PLL DATA OUTPUT

CIRCUIT DESCRIPTION

The PLL and reference frequency-division ratio data input to the 1200 TX/RX unit are output from P21 (CK), P22 (DT), and P23 (EP1) of the CPU. The reference frequency-division ratio data (R) is output only when the power is switched on and when 10 and 12.5 kHz reference frequencies are changed.



DT MSB LSB

Fig. 48 PLL Frequency-Division Ratio Data Transfer Format

Fig. 49 Reference Frequency-Division Ratio Data Transfer Format

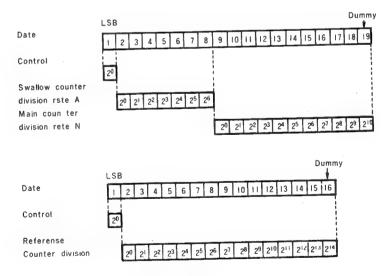


Fig. 50 Data Configuration

CIRCUIT DESCRIPTION

AF SIGNAL SYSTEM

OUTLINE

Signals coming from the detected signal RA of each band unit pass through the electronic potentiometer, are added at the mute circuit and buzzer circuit, and after passing through the speaker switching circuit they are outputted to the power amplifier and to the speakers.

Each band has an independent AF signal, and any arbitrary combination can be outputted through the speaker, depending on the position where the speaker jack is plugged.

VOLUME/BUZZER CIRCUIT

The angles of the potentiometers of the various bands, that are located on the panel unit, are transformed to 5 bit data through A/D conversion executed by the microprocessor of the panel unit, and are sent to the microprocessor of the control unit. These data are outputted by the I/O expander: IC101 to IC112(HIC) as serial data

The buzzer sound heard when the key is pressed is outputted from the IC(P44) of the control unit, MIXed with the DTMF monitor output, and is outputted to IC112.

IC112 carries out the LEVEL/MUTE processing of the audio signal in conformity with the received data, and after that the signal is outputted to the speaker changeover switch: IC106. (Figure 51).

The volume level is set for the speaker output and buzzer sound ("beep" sound) of each band, by using the 2 electronic potentiometers (MB87032) built into IC112.

The data have 28 bit composition, with 20 bits used to set the level. (The remaining 8 bits are used as commands and other applications).

The data are fetched at the trailing edge of the clock. (Figure 52).

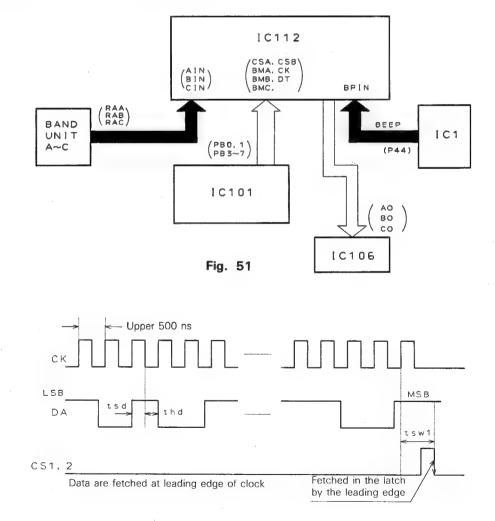


Fig. 52

CIRCUIT DESCRIPTION

• SPEAKER SWITCHING CIRCUIT

Four speaker jacks are provided in total, one in each band unit (rear) and one in the control unit (side).

As for the functions of the various terminals, the speaker jack of the band unit outputs the AF signal of the band in question when the speaker is connected.

The speaker jack of the control unit outputs the signal obtained by mixing the remaining AF signals. This signal is outputted by the internal speaker when there is no speaker connected to the speaker jack, Figure 53 shows the main circuit.

When there is nothing connected to the speaker jack, the signal is entered in the adder of IC103. The level of the adder does not change, irrespective of the number of signals (1 to 3) that are added.

For example, when one wants to mix the signals of speakers A and C of band B and to output the obtained result from the remaining speaker, it is possible to execute this operation by connecting with the jack of band B and the jack of the control unit.

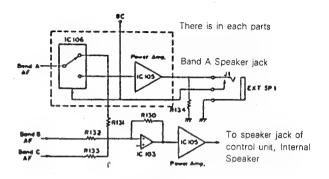


Fig. 53

SQUELCH CIRCUIT

Squelch can be preset at each band by means of the squelch potentiometer located in the panel unit. The squelch potentiometer signal is converted to 5 bit data through A/D conversion at the microprocessor of the panel unit.

Data are sent from the panel unit to the microprocessor of the control unit, and after data conversion they are sent as serial data from IC101 of the control unit to IC113 (HIC). (Refer to the SHIFT REGISTER section for the logic). D/A conversion is carried out at IC113 through the combination of the shift register and the analog switch, and the control voltage of IC110 is generated by the RDSQ terminal to carry out the control of the RD line. (Figure 54).

The setting of the squelch level turns the analog switch ON/OFF by means of the 5 bit data of the various bands (Refer to the LIST OF PORTS of the shift registers A and B).

Since a resistance is connected between the two terminals of the analog switch, the resistance value is changed by the combination of the ON/OFF states of the switches. The voltage level of the SQ output can be controlled as a result. (Figure 55)

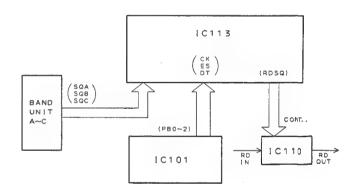


Fig. 54

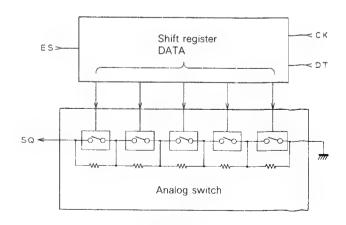


Fig. 55

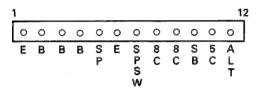
CIRCUIT DESCRIPTION

Connector Connecting the Band Unit and Control Unit

Outline

The pin assignments of the connector that connects the control unit and band unit are common in three

bands. The band unit is also used to check which band unit is connected.



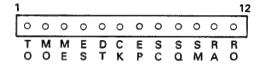


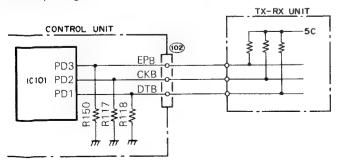
Fig. 56 Connector Connecting the Band Unit and Control Unit

Pin No.	Name	Function	Pin No.	Name	Function
1	E	GND	1	то	67.0 to 250.3 Hz subtone output
2	В		2	МО	Audio signal from microphone (including DTMF)
3	В	13.8 V input	3	ME	Microphone ground
4	В		4	ES	Shift-register enable output
5	SP	AF signal is output when speaker jack is connected.	5	CK	Shift-register PLL clock
6	E	GND	6	DT	Shift-register PLL data
7	SPSW	Speaker jack connection and detection. "H" during connection.	7	EP	PLL enable
8	8C	OV:	8	SC	"L" when squelch input is busy.
9	8C	8 V is output during the power-on sequence.	9	SQ	50 k ohms when squelch D/A output is tight.
10	SB	13.8 V is output during the power-on sequence.	10	SM	Signal-strength meter voltage input
11	sc	5 V is output during the power-on sequence.	11	RA	Detection input (squelch circuit)
12	ALT	ALT voltage input	12	RD	Detection input (no squelch circuit)

Table 20 Pin functions (as viewed from the control unit)

Band retrieval

Each band is retrieved through the EP, CK, and DT pins. Data is input for retrieval when the power is switched on and when the memory is cleared. Data is then output again.



The control unit is pulled down as shown in Figure 57. Therefore, the DT, CK, and EP pins are set low when no band unit is connected. Pins set high as listed in Table 21 are pulled up when any band unit is connected. The type of connected band unit is then judged.

BAND Unit	DT	CK	EP
No Unit	L	L	L
28	Н	L	L
50	Н	Н	L
144	L	Н	Н
430	Н	L	Н
1200	L	L	Н

Table 21 Band Retrieval

TM-742 A/742 E/942 A **DESCRIPTION OF COMPONENTS**

CONTROL UNIT (X53-346X-XX)

Device number	Use, function	Operation, condition, interchangeability
IC1	Microprocessor	Refer to circuit description
IC2	SRAM memory	
IC3	6VAVR	3 terminal regulator 13.8 V
IC4	Address decoder	For chip selector (I/O expander)
IC5	Address decoder	For chip selector (SRAM)
IC6	Serial time clock	Refer to circuit description
IC7	Parallel → Serial converter IC	Refer to circuit description
IC8	Analog switch	For DTHF receiver
IC9	Low frequency amplifier-adder	Mic. amplifier DTMF modulation system adder
IC10	DTMF encoder	Refer to the circuit description
IC11	DTMF decoder	Refer to the circuit description
IC12	Reset IC	
IC13, 14	Serial data inverter buffer	For serial data
IC15	Analog switch	For switching during backup, (RD, WR)
IC16	Analog switch	For switching during backup (CK)
IC101	I/O expander	Refer to the circuit description
IC102	8V AVR	3 terminal regulator 13.8 V BV (OUT)
IC103	Adder	For internal speaker. For level compensation
IC104, 105	Low frequency amplification	① Input (IC104-Band B, IC105-Common) ⑥ Output (IC104-Band B, IC105-Common) ⑦ 13.8V ④, ⑩, ⑫, GND ⑧ Output (IC104-Band C, IC105-Band A) ③ Input (IC104-Band C, IC105-Band A)

DESCRIPTION OF COMPONENTS

CONTROL UNIT (X53-346X-XX)

Device number	Use, function	Operation, condition, interchangeability
		Band C AF input Band A AF input Band B AF input Band B internal SP output, Band A internal SP output
IC106	Analog switch for speaker switching	Band A Internal SP output Band B external SP output,
IC108, 109	Analog switch	For CTCSS, DTSS, RD switching. (Refer to the circuit description)
IC110	Analog switch	For RD switching
IC112	HIC for electronic potentiometer	Refer to the circuit description
IC113	HIC for SQ	Refer to the circuit description
IC114	HIC for dimmer	Refer to the circuit description
Q1	Low frequency amplification	Mic. amplifier
Q2	Buffer amplifier	For mic. RD
Q3	For mic. line muting	Mic. muting during ON (During DTMF signal transmission)
Q4	5C switch	Switch for 5C line
Q5	Switch	For RESET
Q6, 9	Switch	Power detection circuit, for backup
Ω7	Switch	For and dual and single tone switching of the DTMF sigral
Q8	Mute switch	
Q10	Buffer amplifier	For DTMF
Q11	Switch	For controlling IC15-16 during backup
Q101, 102	SB system power switch	Q101, 102 are ON when power is ON, Q101, 102 are CFF when power is OFF
Q103, 104	Mute switch	Q103 instantaneously ON when POWER ON, Q104 instantaneously ON when POWER OFF.
Q105	Fan motor switch	Fan operates when switch is ON, fan does not operate when switch is OFF
Q106	Reset switch .	For I/O expander resetting

DESCRIPTION OF COMPONENTS

CONTROL UNIT (X53-346X-XX)

No. 3

Device number	Use, function	Operation, condition, interchangeability
IC107, 108, 109	Mute switch	Q107 for band C, Q108 for band A, Q109 for band B
D1	Back flow prevention, lithium battery switching	Lithium battery OFF when power supply is connected.
D2 _,	Voltage compensation	
D3	Back flow prevention	
D4	Surge protection	
D5	Reset detection	
D6	Back flow prevention	

DISPLAY UNIT (X54-3130-11)

Device number	Use, function	Operation, condition, interchangeability
IC1	Microprocessor	Refer to circuit description
IC2	5V AVR, reset	
IC3, 4, 5, 6, 203, 206	Serial data inverter buffer	IN — OUT
IC201, 202	LCD driver	
IC204	Flip-flop	Enable generation circuit
IC205	5V AVR	For LCD driver, flip-flop, inverter
Q1	5V power switch	ON when Q3 is ON
Q2	5V power switch	ON when Q4 is ON
Q3	5V power switch	Turned ON by port DO of microcomputr when PS OIJ
Ω4	5V power switch	ON when Q1 is ON
Q5	Reset switch	
Q101	LED switch for function	ON during function
D1 .	Back-flow prevention	
D2	Back-flow prevention	Prevention of back-flow when common terminal is connected by mistake with CN3.
D3, 4	LED for illumination	Green
D101,102,103 104, 105	LED for function	Red
D107,108,109, 110 11.1,112, 114	LED for illumination	Yellow

DESCRIPTION OF COMPONENTS

28TX-RX unit (X57-3790-01): UT-28S(M)

Component	Use/Function	Operation/Condition/Compatibility
IC1	Shift register	See Circuit Description.
IC2	VCO, PLL	2 V during locking 5C MD 90 90 8CL XI ST AND B V during transmission; 0 V during reception Clock input Enable input The property of the property o
IC3	Low-frequency amplifier, limiter	Microphone amplifier
IC4	28-MHz band transmission	Operation during transmission 28 - 29.695 MHz
	Drive	① Input ® Output
IC5	APC	
IC6	Second local oscillator, mixer	① First IF input 8.83 MHz
	IF amplifier, detector	3 Second local oscillator input 9.285 MHz
	Low-frequency amplifier	Squelch output, busy signal, 0 V while busy
	Noise detector	Noise detection voltage output (DC)
	Squelch switch	① Signal-strength meter output
		Detection output
		(M) RD output
		® AF OUT
IC7	9V AVR	9V
IC8	Out-of-band reception	① HET input 2 IF output ③ 8 V (8 V outside band; 0 V within band)
	Mixer, RF amplifier	RF output 8 V (8 V within band; 0 V outside band) RF input
Q1	High-frequency amplifier	Operation during reception, 28-MHz band
Ω2	First mixer	Operation during reception
Q3	First IF amplifier	Operation during reception 8.83 MHz
Q4	ATT switch	ON when ATT is ON
Q5	First mixer selection switch	OFF during out-of-band reception

DESCRIPTION OF COMPONENTS

Component	Use/Function	Operation/Condition/Compatibility
Q6~7	In-band/out-of-band power switch	Q6 OFF, Q7 ON: In-band reception; Q6 ON, Q7 OFF: Out-of-band reception
Ω8	Second local oscillator buffer	Operation during reception 9.285 MHz
Ω9	Squelch hysterisis switch	ON while busy
Q10~Q14 Q24	8V during reception 0V during transmission ICI (4) R44 R44 C34 R44 R44 C34 R43	2V while locked; 0.7V while unlocked R48 R49 # # # # # # # # # # # # # # # # # # #
		Q10, Q12, Q13, Q24 ON, Q11, Q14 OFF: During reception
Q15~17	Inverter	
Q18	Modulation system mute	ON during reception
Q19	CV line buffer	
Q20	HET output amplifier	28-29.695 MHz: During transmission; 36.83-38.525 MHz: During reception
Q21	VCO 8V ripple filter	
Q22	Middle (not for 10 W), LOW Power switch	1C5 — VR3 D10 — C68 VR4 R81 B H: 7.5V M: 0V L: 0V L: 0V H: 0V M: 7.5V L: 0V
Q23	APC control	Operation during transmission
Q25~Q26	AM/FM selection switch	Q25 and Q26 OFF: During FM reception Q25 and Q26 ON: During AM reception

DESCRIPTION OF COMPONENTS

Component	Use/Function	Operation/Condition/Compatibility
Q27	Transmission band selection switch	ON: Narrow OFF: Wide
D1~D2	ATT selection switch	D1 OFF and D2 ON: When ATT ON D1 ON and D2 OFF: When ATT OFF
D3~D6	Varicap tuner	
D7	HET selection switch	
D8	Reverse-flow prevention	
D9	HET selection switch	
D10	Temperature compensation	APC
D11, D12	Antenna transmit/receive switch	ON: Transmit; OFF: Receive
D13, D14	Power detection	APC
D15	Reverse-power connection prevention	
D16	Reverse-flow prevention	
D17	Temperature compensation	

DESCRIPTION OF COMPONENTS

50 TX-RX Unit (X57-3800-01): UT-50S(M)

Component	Use/Function	Operation/Condition/Compatibility
IC1	Shift register	See Circuit Description.
IC2	VCO, PLL	2 V during locking 5C LD 9C 9C 8CL 8V during transmission; 0 V during reception XO Clock input Clock input EP HT Modulation input 9V 8V during transmission; 0 V during reception Lock voltage E HET output
IC3	Low-frequency amplifier, limiter	Microphone amplifier
IC4	50 MHz band transmission	Operation during transmission 50 - 53.995 MHz
	Drive	① Input ② Output
IC5	APC	
IC6	Second local oscillator, mixer	① First IF input 10.595 MHz
	IF amplifier, detector	3 Second local oscillator input 11.05 MHz
	Low-frequency amplifier	Squelch output, busy signal, 0 V while busy
	Noise detector	Noise detection voltage output (DC)
	Squelch switch	Signal-strength meter output
		Detection output
		(4) RD output
		® AF OUT
IC7	9V AVR	9V ————————————————————————————————————
IC8	Out-of-band reception	① HET input 2 IF output ③ 8 V (8 V outside band; 0 V within band)
	Mixer, RF amplifier	(§) RF output (§) 8 V (8 V within band; 0 V outside band) (§) RF input
Q1	High-frequency amplifier	Operation during reception, 50 MHz band
Q2	First mixer	Operation during reception
Q3	First IF amplifier	Operation during reception 10.595 MHz
Q4	ATT switch	ON when ATT is ON
Q5	First mixer selection switch	OFF during out-of-band reception

DESCRIPTION OF COMPONENTS

Component	Use/Function	Operation/Condition/Compatibility
Q6~7	In-band/out-of-band power switch	Q6 OFF, Q7 ON: In-band reception; Q6 ON, Q7 OFF: Out-of-band reception
Q8	Second local oscillator buffer	Operation during reception 11.05 MHz
Q9	Squelch hysterisis switch	ON while busy
Q10~Q14 Q24	8V during reception: 0V during transmission Ict (4) BR C36 R44 C34 R44 R44 C34 R44 R44	Q10, Q12, Q13 OFF, Q11, Q14, Q24 ON: During transmission
Q15~17	inverter	Q10, Q12, Q13, Q24 ON, Q11, Q14 OFF: During reception
Q18	Modulation system mute	ON during reception
Q19	CV line buffer	ON during reception
Q20	HET output amplifier	50 - 53.995 MHz: During transmission; 60.595 - 64.590 MHz: During reception
Q21	VCO 8V ripple filter	
Q22		
	Middle (not for 10 W),	1
	Middle (not for 10 W), LOW Power switch	1C5 — KR3 D10 — C68 VR4 R81 B H: 75V M: 0V L: 0V L: 0V
Q23	·	D10 C68 VR4 R81 B H: 75V M: 0V M: 75V
	LOW Power switch	B

DESCRIPTION OF COMPONENTS

Component	Use/Function	Operation/Condition/Compatibility
D1~D2	ATT selection switch	D1 OFF and D2 ON: When ATT ON D1 ON and D2 OFF: When ATT OFF
D3~D6	Varicap tuner	
D7	HET selection switch	
D8	Reverse-flow prevention	
D9	HET selection switch	
D10	Temperature compensation	
D11, D12	Antenna transmit/receive switch	APC
D13, D14	Power detection	ON: Transmit; OFF: Receive
D15	Reverse-power connection prevention	APC
D16	Reverse-flow prevention	
D17	Temperature compensation	

DESCRIPTION OF COMPONENTS

144TX-RX Unit (X57-3580-XX)

Reference No.	Function	Description
IC1	Shift register	See the circuit description.
IC2	10V AVR	10 13.8 1
IC5	Second local oscillation, mixer, IF amplification, detection, low-frequency amplification, noise amplification, noise detection, and squelch switching	10.7 MHz first IF input 3,
IC7	Low-frequency amplification and limiter	Microphone amplifier
IC8	144 MHz band transmission driver	Operation during transmission. 144 to 148 MHz band (i) Input (i) Output
IC9	APC	
IC10	Power module	
IC11	VCO.PLL	0 V during lock — LD HD 100 100 100 100 100 100 100 100 100 10
Q1	High-frequency amplification	Operation during reception. 144 MHz band
Q2	First mixer	Operation during reception
Q3	First IF amplification	Operation during reception. 10.7 MHz

DESCRIPTION OF COMPONENTS

Reference No.	Function	No. 2 Description
Q10 ~ Q14	Transmission and reception power selection	(0 V during lock) (0 V during lock) (10, Q12, and Q13 are set "OFF" during transmission. Q11 and Q14 are set "ON" during reception. Q11 and Q14 are set "OFF" during reception. Q11 and Q14 are set "OFF" during reception.
Q15, Q16, Q17	Inverter	
Q18	Modulation muting	ON during reception
Q19	CV line buffer	144 MHz band
Q20	PLL output amplification	1C9Ø——↓≸Ĕ
Q21	PLL 8 V ripple filter	1c9Ø——↓≸Ğ
Q22	Middle/low POWER switch	Middle and low POWER switches are set ON when high.
Q23	APC control	Operation during transmission
Q24	Squelch hysteresis switch	OFF when busy
D1 ~ D7	Varicap diode tuning	
D11	Antireverse current	
D12	Antireverse current	
D13	PLL output switch	
D14	Temperature compensation	APC
D15, D16	Antenna transmission and reception selection	ON during transmission. OFF during reception.
D17, D18	Power detection	APC
D19	Power reverse connection protection	

DESCRIPTION OF COMPONENTS

220 TX-RX Unit (X57-3810-10): UT-220S(K)

Component	Use/Function	Operation/Condition/Compatibility
IC1	Shift register	See Circuit Description.
IC2	9V AVR	9V - 13 8V
IC5	Second local oscillator, mixer	① First IF input 30.825 MHz
	IF amplifier, detector	3 Second local oscillator 30.37 MHz
	Low-frequency amplifier	Squelch output, busy signal, 0 V while busy
	Noise detector	Noise detection voltage output (DC)
	Squelch switch	Signal-strength meter output
		® RD output
		® AF OUT
IC7	Low-frequency amplifier, limiter	Microphone amplifier
IC8	220-MHz band transmission	Operation during transmission 220 - 224.995 MHz
	Drive	① Input ② Output
IC9	APC	
IC10	Power module	5C MD Modulation input
IC11	VCO, PLL	2 V during locking Data input Clock input Enable input DENABLE ST COUNTY
Q1	Ligh fraguency amplifier	Operation during reception, 220 MHz band
	High-frequency amplifier First mixer	
<u>Q2</u>		Operation during reception
Q3	First IF amplifier	Operation during reception 30.825 MHz

DESCRIPTION OF COMPONENTS

No. 2

Component	Use/Function	Operation/Condition/Compatibility
Q10~Q14	Transmit/receive power switch	8V during reception: 0V during transmission Q10, Q12, Q13 OFF, Q11, Q14 ON: During transmission Q10, Q12, Q13, ON, Q11, Q14 OFF: During reception
Q15~Q17	Inverter	
Q18	Modulation system mute	ON during reception
Q19	CV line buffer	
Q20	HET output amplifier	220 - 224.995 MHz: During transmission: 189.175 - 194.17 MHz: During reception
Q21	VCO 8V ripple filter	
Q22	Middle/low power switch	DIO C68 VR4 R81 B WR4 R81 B WR5 R81
Q23	APC control	Operation during transmission
Q24	Squelch hysterisis switch	ON while busy
D3, 5, 7, 20	Varicap tuner	
D11,12	Reverse-flow prevention	
D13	HET selection switch	
D14	Temperature compensation	APC
D15, 16	Antenna transmit/receive switch	ON: Transmit; OFF: Receive
D17, 18	Power detection	
D19	Reverse-power connection prevention	

DESCRIPTION OF COMPONENTS

430 TX-RX Unit (X57-3590-XX)

Reference No.	Function	Description
IC1	Second local oscillation, mixer, IF amplification, detection, low-frequency amplification, noise amplification, noise detection, and squelch switching	21.6 MHz first IF input 3,
IC2	Low-frequency amplification and limiter	Microphone amplifier
IC3	Shift register	See the circuit description.
IC4	10V AVR	10V - 13.8V
IC5	APC	
IC6	430 MHz band transmission driver	① Output ⑤ Input
IC7	Power module	
IC10	VCO.PLL	0 V during lock — 5v — 5c
Q1, Q2	High-frequency amplification	Operation during reception
Q3	First mixer	Operation during reception
Q5	First IF amplification	Operation during reception. 21.6 MHz

DESCRIPTION OF COMPONENTS

Reference No.	Function	Description
Q8~Q12	Transmission/reception power selection	(0V during transmission) (0V during lock) (0V during lock) (0V during lock) (0V during transmission. (0N, Q9, and Q10 are set "OFF" during transmission. (0N, Q9, and Q10 are set "ON" during transmission. (0N, Q9, and Q10 are set "ON" during reception. (0N, Q9, and Q10 are set "OFF" during reception. (0N, Q9, and Q10 are set "OFF" during reception.
Q13, Q14, Q15	Inverter	
Q16	Modulation muting	ON during reception
Q17	PLL B V ripple filter	IC5 ③
Q18	PLL output amplification	1
Q19	Middle/low POWER switch	Middle and low POWER switches are ON when high.
Ω20	APC control	Operation during transmission
Q21	Squelch hysteresis switch	OFF when busy
D1	Antenna switch	OFF during reception
D4	PLL output switch	
D5	Temperature compensation	APC
D6, D7	Antireverse current	
D8, D9	Antenna transmission/reception selection	ON during transmission
D10,D11	Power detection	APC
D12	Power reverse connection protection	
D13	Antireverse current	8T pulse rise is faster during transmission and reception.
D14	IF level limiter	

DESCRIPTION OF COMPONENTS

1200TX-RX Unit (X57-3600-11): TM-942A, UT-1200 (M)

Reference No.	Function	Description
IC2	Second local oscillation, mixer, IF amplification, detection, low-frequency amplification, noise amplification, noise detection, and squelch switching	59.7 MHz first IF input 3,
IC3	ALT	② 8 V ③ "H" during ALT ⑩ Detection input (DC)
IC4	Low-frequency amplification and limiter	Microphone amplifier
IC5	Shift register	See the circuit description.
IC6	9V AVR	9V
IC7	Predrive	1 Input 1 Output
IC8	Drive	① Output ③ Input
IC9	APC	·
IC10	Power module	
IC11	VCO.PLL	LD SC MD Modulation input 12.8 MHz ST SC WD SC SC ST WITH MITH MITH MITH MITH MITH MITH MITH M
IC12	5V AVR	Three-terminal regulator 13.8 V 5V (OUT)
Q1, Q2	High-frequency amplification	Operation during reception
Q3	First mixer	Operation during reception
Q6	Receiving PLL output amplification	Operation during reception
Q7	First IF amplification	Operation during reception. 59.7 MHz

DESCRIPTION OF COMPONENTS

Reference No.	Function	Description
Q8 ~ Q13	Transmission/reception power selection	O V during transmission. O8, Q10, and Q11 (b) are set "OFF" during transmission. O9, Q12, and Q13 are set "ON" during transmission. O8, Q10, Q11 (b), and Q12 are set "ON" during reception. Q9, Q11 (a), and Q13 are set "OFF" during reception.
Q15, Q16, Q17	Inverter	
Q18	Modulation muting	ON during reception
Q19, Q20	8T voltage selection	OFF when low
Q21	PLL output amplification	
Q22	Transmitting PLL output amplification	Operation during transmission
Q23	8 V ripple filter	
Q24	APC control	Operation during transmission
Q25	Lower-power switch	ON when high
Q26	Squelch hysteresis switch	OFF when busy
Q28	Q1 POWER switch	ON during transmission
D3	IF level limiter	
D4, D17	Antireverse current	
D5, D15	Constant voltage circuit	
D6	Temperature compensation	APC
D7	Temperature compensation	Drive
D8	Overvoltage prevention	
D9	Power detection	APC
D10 ~ D13	Antenna switch	ON during transmission
D14	Power reverse connection protection	

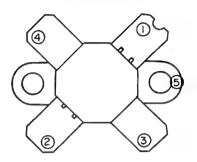
SEMICONDUCTOR DATA

Power Transistor 2SC3240(28 TX-RX Unit)

• Electrical characteristics

Item	Conditions	Maximum value
Vсво		50V
VEBO		5V
VCEO	RBE = ∞	20V
IC		25A
Pc	Tc = 25°C	270W
Tj		+175°C
Tstg		-55 ~ +175°C
Та	25 ±3°C	

External view



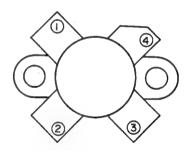
- ① Collector
- 2 Base
- 3 Emitter
- 4 Emitter
- 5 Flange (Emitter)

Power Transistor MRF492 (50 TX-RX Unit)

Electrical characteristics

ltem	Conditions	Maximum value
Vсво		36V
VEBO		4.0V
VCEO		18V
IC .		20A
PD	Tc = 25°C	250W
Tstg		-65 ~ +150°C

External view

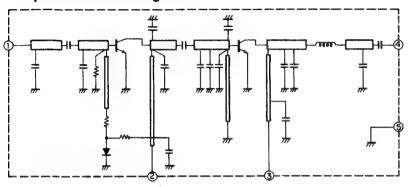


- 1 Emitter
- 2 Base
- 3 Emitter
- 4 Collector

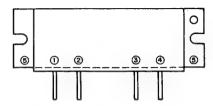
SEMICONDUCTOR DATA

Power module S-AV17 (144 TX-RX UNIT)

• Equivalent circuit diagram



External view



- 1 Input terminal
- 2 First power supply terminal
- 3 End power supply terminal
- 4 Output terminal
- (5) Fin (earth)

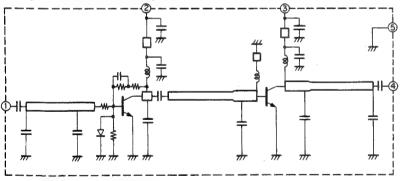
• Electrical characteristics

ltem		T (00)	0 - 1141		15-14		
	Symbol	Tc (°C)	Conditions	Minimum	Standard	Maximum	Unit
Frequency	f			144		148	ИHz
Output power	Po	25	Vcc = 12.5V, Pin = 400mW, Zg = ZI = 50Ω			65	W
Combined effeciency	ηT	25	Same as above	45			%
Harmonics	HRM	25	Same as above		-30	-25	dB

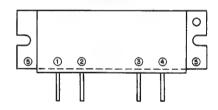
Power module M57774 (220 TX-RX UNIT)

• Equivalent circuit diagram

Electrical characteristics



• External view



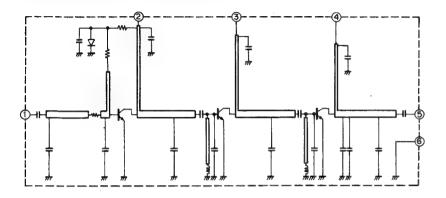
- 1 Input terminal
- ② First power supply terminal
- 3 End power supply terminal
- 4 Output terminal
- (5) Fin (earth)

		T 1001	0		1		
ltem	Symbol	Tc (°C)	Conditions	Minimum	Standard	Maximum	Venit
Frequency	f			220		225	MHz
Output power	Po	25	$ \begin{array}{c} \text{Vcc} = 12.5 \text{V,} \\ \text{Pin} = 0.3 \text{W, Zg} = \text{ZI} = 50 \Omega \\ \end{array} $	30	33	40	~
Combined effeciency	ηТ	25	Same as above	43	48		%
Secondary spurious strength		25	Same as above			-30	1B
Tertiary spurious strength		25	Same as above			-35	1B

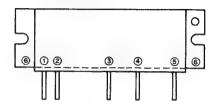
SEMICONDUCTOR DATA

Power module M57788M(430 TX-RX UNIT)

• Equivalent circuit diagram



External view



- 1 Input terminal
- 2 First power supply terminal
- 3 Driver power supply terminal
- 4 End power supply terminal
- ⑤ Output terminal
- 6 Fin (earth)

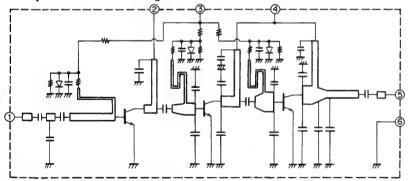
Electrical characteristics

	0	T- 4001	0	S	4.5		
item	Symbol	Tc (°C)	Conditions	Minimum	Standard	Maximum	Unit
Frequency	f			430		450	MHz
Output power	Ро	25	$ \begin{array}{c} \text{Vcc} = \text{12.5V,} \\ \text{Pin} = \text{400mW, Zg} = \text{ZI} = \text{50} \\ \Omega \end{array} $	40	45		W
Combined effeciency	ηΤ	25	Same as above	40	45		%
Secondary spurious strength		25	Same as above			-30	dB
Tertiary spurious strength		25	Same as above			-30	dB

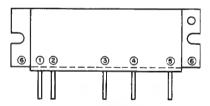
Power module M67711 (1200 TX-RX UNIT)

• Equivalent circuit diagram

Electrical characteristics



External view



- 1 Input terminal
- ② First power supply terminal
- 3 Driver power supply terminal
- 4 End power supply terminal
- ⑤ Output terminal
- 6 Fin (earth)

	Combal	Tc (°C)		Standard value			11-4
Item	Symbol	16 (°C)		Minimum	Standard	Maximum	Unit
Frequency	f			1.24		1.3	GHz
Output power	Po	25	Vcc = 12.5 V, Vbb = 10 V Pin = 1 W, Zg = Z1 = 50Ω	16	17		W
Combined effeciency	ηТ	25	Same as above	30	35		%
Secondary spurious strength		25	Same as above			-45	dB

PARTS LIST

CAPACITORS

CC 45 TH 1H 220 J 1 2 3 4 5 6

 Capacitor value Color* CC45 0 1 0 = 1pF

1 0 3 = 0.01µF

2 2 0 = 22pF 1st number | Multiplier

1 = Type ceramic, electrolytic, etc. 4 = Voltage rating

2 = Shaperound, square, etc. 3 = Temp. coefficient

5 ≃ Value 6 = Tolerance

1 0 1 = 100pF

1 0 0 = 10pF

1 0 2 = $1000pF = 0.001\mu F$

± 30 ppm/°C ± 60 ± 120

Example CC45TH = -470±60 ppm/°C

· Temperature Coefficient

1st Word	С	L	Р	R	S	T	U
Color*	Black	Redi	Orange	Yellow	Green	Blue	Violet
ppm/°C	0	-80	-150	-220	-330	-470	~750

Tolerance

Code	С	D	G	J	K	М	×	Z	Р		No code
(%)	± 0.25	± 0.5	± 2	± 5	± 10	± 20	+ 40	+ 80	+ 100	More	10µF-10~+50
,							-20	-20	-0	Less than	$4.7\mu\text{F}-10\sim+75$

Code	В	С	D	F	G
(pF)	± 0.1	± 0.25	± 0.5	± 1	± 2

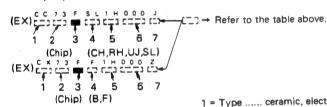
Less than 10 pF

Rating voltage

2nd word 1st word	A	В	С	D	E	F	G	н	J	К	٧
0	1.0	1.25	1.6	2.0	2.5	3.15	4.0	5.0	6.3	8.0	
1	10	12.5	16	20	25	31.5	40	50	63	80	35
2	100	125	160	200	250	315	400	500	630	800	-
3	1000	1250	1600	2000	2500	3150	4000	5000	6300	8000	

Chip capacitors

RESISTORS



Chip resistor (Carbon)

(EX) R 0 7 3 E B 2 B 0 0 0 C 1 2 3 4 5 6 7 (Chip) (B,F)

Carbon resistor (Normal type)

1 = Type ceramic, electrolytic, etc.

2 = Shape round, square, etc.

3 = Dimension

4 = Temp. coefficient

5 = Voltage rating

6 = Value

7 = Tolerance.

Dimension

Dimension code	L	W	Т
Empty	5.6 ± 0.5	5.0 ± 0.5	Less than 2.0
E	3.2 ± 0.2	1.6 ± 0.2	Less than 1.25
F	2.0 ± 0.3	1.25 ± 0.2	Less than 1.25

Dimension

Dimension code	L	W	Т	Wattage
E	3.2 ± 0.2	1.6 ± 0.2	0.57	28
F	2.0 ± 0.3	1.25 ± 0.2	0.45	2A

Rating wattage

Cord	Wattage	Cord	Wattage	Cord	Wattage
2A	1 /10W	2E	1/ 4W	3A	1W
28	1/ 8W	2H	1/ 2W	3D	2W
· 2C	1/ 6W				



× New Parts

PARTS LIST

Parts without Parts No. are not supplied.

Les articles non mentionnes dans le Parts No. ne sont pas fournls.

Teile ohne Parts No. werden nicht geliefert.

TM-742

Ref. No.	Address		Parts No.	Description		Re-
参照番号	位置	Parts 新	部品番号	部品名/規格		備考
		•	TM	-742		
1 2 3 4 5	1 A 3 A 2 F 2 E 3 C	* * * *	A01-2068-03 A01-2069-03 A13-1601-02 A62-0206-02 A62-0219-03	METALLIC CABINET(UPPER) METALLIC CABINET(BOTTOM) FREM PANEL (BODY) PANEL ASSY (LOWER)		
6 6 7 8	2C 2C 2D 3D	* * * *	A62-0221-03 A62-0222-03 A82-0012-02 A82-0013-02	PANEL ASSY (742A) PANEL ASSY (742E) BACK PANEL (UPPER) BACK PANEL (LOWER)	KPMM2 EE2E3	
10 14 15 16	2D 2D 1A,1B 1B	*	B03-0577-04 B41-0696-04 B42-2455-04 B42-3343-04 B42-3394-04	DRESSING PLATE CAUTION LABEL LABEL(M4x8 MAX) LABEL(S/NO) LABEL(FCC)	КР	
18 18 18 19	1B 1B 1B 2D 3J	*	B42-3484-04 B42-3485-04 B42-3485-04 B42-3554-04 B44-2163-04	LABEL(SP,ANT) LABEL(SP,ANT) LABEL(SP,ANT) LABEL(M2.6x5 MAX) UPC CODE LABEL(ITEM CARTON)	KP EE2E3 MM2	
22 22 22 23	1J 1J 1J 1J	*	B44-2165-04 B46-0410-30 B46-0419-00 B46-0422-00 B59-0466-00	UPC CODE LABEL(QUTER CARTON) WARRANTY CARD WARRANTY CARD WARRANTY CARD SUB-INSTRUCTION MANUAL	K EE2E3 P	
24 25 25 30 27	1J 1J 1J 1I 1B	* * * *	B62-0287-10 B62-0288-00 B62-0289-00 B62-0345-00 B72-0504-04	INSTRUCTION MANUAL INSTRUCTION MANUAL INSTRUCTION MANUAL INSTRUCTION MANUAL(FRANCE) MODEL NAME PLATE(TM-742A)	MM2E3 EE2 PMM2E3 KP	
27 27	1 B 1 B	*	B72-0505-04 B72-0506-04	MODEL NAME PLATE(TM-742A) MODEL NAME PLATE(TM-742E)	MM2 EE2E3	
28	1 E	*	D32-0417-04	STOPPER		
29 - 31 32 33	1A,2B 2I 2A,2D 2E	*	E23-0676-04 E30-3006-08 E30-3034-05 E30-3135-15 E37-0006-05	TERMINAL CURL CORD DC CORD (ACSY) CONNECTING WIRE(COMMON-PANEL) CONNECTING WIRE(SPEAKER)		والمراجعة والمستعدمة واستعدد والمستعدد والمستعد والمستعدد والمستعد
34 35	2F 2F	*	E37-0325-05 E37-0326-05	FLAT CABLE(16P) CONNECTING WIRE(FAN)		
36 37 38 39 40	3E 3E 1B 3D 1D,2E	* *	F01-0992-03 F01-0993-04 F07-1203-13 F07-1232-04 F07-1345-04	HEAT SINK(COMMON AVR,SP) HEAT SINK COVER(FAN) COVER(PANEL · · UPPER) COVER(PANEL · · LOWER)		parameter de la del description de la faction de la factio
42	21	*	F15-0679-04 F51-0017-05 F51-0018-05	SHADE PLATE(8 KEYS) FUSE(15A+ACSY) FUSE(20A+DC C@RD)		
44 50 51	1E 2E 1B		G01-0833-04 G02-0505-05 G02-0716-04 G10-0663-04	COMPRESSION SPRING LEAF SPRING (VOL KNOB) FLAT SPRING(SPEAKER) NON-WOVEN FABRIC(100X85)		

A: TM-742 K, P, M, M2, E, E2, E3

B: TM-942 K, P, M

PARTS LIST

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TM-742

Ref. No.	Address	New Parts	Parts No.	Description	Desti- Re	e- arks
参照番号	位 置	新	部品番号	部 品 名 / 規 格	仕 向備	考
52 53 54 - 56	1A,3A 1E,2F 1B	*	G10-0686-04 G10-0700-04 G10-0709-04 G10-0724-04 G11-0680-03	NON-WOVEN FABRIC(130X5) NON-WOVEN FABRIC(60X10) NON-TOVEN FABRIC(145X5) NON-WOVEN FABRIC(CASE) SHEET(PANEL··UPPER)		
57 - 59 60	3D 3B,2E 3I	* * *	G11-0681-13 G11-0688-04 G11-0690-14 G53-0508-04 H10-2696-12	SHEET(PANEL ·· LOWER) SHEET(CPU · · · · 50X25) SHEET(30X30 ·· ENCODER) NON-WEVEN FABRIC(30X10) POLYSTYRENE FORMED FIXTURE		
61 61 47 47	1 I 1 I 1 I 1 I 1 J	* * *	H11-0856-24 H11-0856-24 H11-0857-24 H11-0857-24 H13-0861-04	PACKING FIXTURE PACKING FIXTURE PACKING FIXTURE PACKING FIXTURE PACKING FIXTURE	PMM2 EE2E3 PMM2 EE2E3 K	
62 - - 63 64	31 21 21	* *	H13-0897-04 H13-0901-04 H13-0901-04 H25-0029-04 H25-0079-04	PROTECTION BOARD(150X30) PROTECTION BOARD(260X325) PROTECTION BOARD(260X325) PROTECTION BAG PROTECTION BAG(200,X200)	PMM2 EE2E3 KP	
65 49 49 66 66	2J 1I 1I 3J 3J	*	H25-0723-04 H25-0750-04 H25-0750-04 H52-0370-04 H52-0371-04	PROTECTION BAG(230X400) PROTECTION BAG(170X270) PROTECTION BAG(170X270) ITEM CARTON BOX(TM-742A,440M) ITEM CARTON BOX(TM-742A,430M)	PMM2 EE2E3 KP MM2	
66 - -	3J	* *	H52-0372-04 H62-0323-04 H62-0324-04	ITEM CARTON BOX(TM-742E) OUTER CARTON BOX(TM-742A) OUTER CARTON BOX(TM-742E)	EE2E3 KPMM2 EE2E3	
67 68 69 70 71	2I 1B 1B,3B 1E 2D	*	J20-0319-24 J21-4308-14 J21-4352-03 J21-4404-04 J21-4405-04	MIC FOOK(ACSY) MOUNTING HARDWARE(FAN) MOUNTING HARDWARE MOUNTING HARDWARE(RELEASE) MOUNTING HARDWARE(PANEL)	KP	
72 73	2J 1B		J29-0454-03 J42-0452-05	WIRING BOARD (ACSY) BUSHING		
86 87 89 90	3C 3C 3C 3C	* * *	K29-4805-04 K29-4806-04 K29-4808-04 K29-4840-04	KNOB ENCODER KNOB(BUTTON) MHZ KNOB SQL KNOB ASSY VOL		
-			L15-0310-25	LOW-FREQUENCY CHOKE COIL		
A C E F G	2A,2B 2B,3B 2A,2B 1A,1B 1B		N09-2084-05 N30-3030-46 N32-2606-46 N33-2606-45 N33-2614-45	SCREW (PLUS TERMINAL) PAN HEAD MACHINE SCREW(UNIT) FLAT HEAD MACHINE SCREW(TX-RX) OVAL HEAD MACHINE SCREW(CASE) OVAL HEAD MACHINE SCREW(FAN)		
H I J K L	1E 2I 2D,3D 1D 2A,2D	*	N35-2605-45 N46-3010-46 N80-2006-45 N80-2008-45 N80-2605-45	BINDING HEAD SCREW (PANEL) PAN HEAD TAP SCREW (MIC HOOK) PAN HEAD TAPTITE SCREW(PANEL) PAN HEAD TAPTITE SCREW(PANEL) PAN HEAD TAPTITE SCREW(PANEL)	КР	
M N ©	1A,1B 2F,3F 3E		N86-2606-45 N87-2606-46 N87-2608-46	SCREW (CASE) BRAZIER HEAD TAPTITE SCREW BRAZIER HEAD TAPTITE SCREW		

A: TM-742 K, P, M, M2, E, E2, B B: TM-942 K, P, M

PARTS LIST

* New Parts

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TM-742 TM-942

Ref. No.	Address	New Parts	Parts No.	Description	Desti- nation	Re- mark
参照番号	位 置	新	部品番号	部 品 名 / 規 格	仕 向	備者
Р	31		N89-2005-46 N99-0331-05	PAN HEAD TAP SCREW (RELEASE) SCREW SET(ACSY)		
SP1 FAN MIC MIC MIC	2E 1B 1I 1I		T07-0286-05 T42-0310-25 T91-0396-05 T91-0397-05 T91-0398-05	SPEAKER FAN MOTOR MICROPHONE MICROPHONE (DTMF) MICROPHONE	MM2 KP EE2E3	
92	21		W01-0414-04	SPANNER(ACSY)		
93 93 93 93 93	3 E E E E E E E E E E E E E E E E E E E	* * * * *	X53-3460-11 X53-3460-21 X53-3460-22 X53-3462-71 X53-3462-72	CONTROL UNIT CONTROL UNIT CONTROL UNIT CONTROL UNIT CONTROL UNIT	KP M M2 EE3 E2	
94 95 96 96	1 D 2B 2B 2B 2B 2B	* *	X54-3130-11 X57-3580-12 X57-3590-12 X57-3590-22 X57-3592-72	DISPLAY UNIT TX-RX UNIT(144M 50W) TX-RX UNIT(440M 35W) TX-RX UNIT(430M 35W) TX-RX UNIT(430M 35W)	KP MM2 EE2E3	
-			490-0160-05 490-0010-05	SHEET (FRONT GLASS) SHEET (FPC)		
_	1			942		I
1 2 3 6 4	1 A 3 A 2 F 2 C 2 E	* * * *	A01-2068-03 A01-2069-03 A13-1601-02 A62-0197-03 A62-0206-02	METALLIC CABINET(UPPER) METALLIC CABINET(BOTTOM) FRAME PANEL ASSY (UPPER) PANEL (BODY)		
5 7 8	3C 2D 3D	* *	A62-0219-03 A82-0012-02 A82-0013-02	PANEL ASSY (LOWER) BACK PANEL (UPPER) BACK PANEL (LOWER)		
10 14 15 16	2D 2D 1A,1B 1B	*	B03-0577-04 B41-0696-04 B42-2455-04 B42-3343-04 B42-3394-14	DRESSING PLATE CAUTION LABEL LABEL (M4×8 MAX) LABEL (S/NO) LABEL (FCC)	KP	
18 18 19 20	1B 1B 2D 3J	*	B42-3412-04 B42-3440-04 B42-3554-04 B44-2163-04 B44-2165-04	LABEL (SP.ANT) LABEL (SP,ANT) LABEL (M2.6×5 MAX) UPC CODE LABEL(ITEM CARTON) UPC CODE LABEL(OUTER CARTON)	M KP	
22 22 23 24 25	1J 1J 1I,1J 1I,1J	* * *	B46-0410-30 B46-0422-00 B59-0466-00 B62-0287-10 B62-0288-00	WARRNTY CARD WARRNTY CARD SUB INSTRUCTION MANUAL INSTRUCTION MANUAL INSTRUCTION MANUAL	K P	
30 27 27	1 I 1 B 1 B	* *	B62-0345-00 B72-0476-04 B72-0477-04	INSTRUCTION MANUAL(FRANCE) MODEL NAME PLATE (942A) MODEL NAME PLATE (942A)	MP KP M	mayora da da mayora
28	1 E	*	D32-0417-04	STOPPER		
29 - 31 32	1A,2B 2I 2A,2D	*	E23-0657-04 E30-3006-08 E30-3034-05 E30-3135-15	TERMINAL CURL CODE DC CODE (ACSY) CONNECTING WIRE(PANEL)		

A: TM-742 K, P, M, M2, E, E2, E3 B: TM-942 K, P, M

PARTS LIST

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TM-942

Ref. No.	Address		Parts No.	Description		Re- marks
参照番号	位置	Parts 新	部品番号	部 品 名/規 格		備考
33 34 35	2F 2F 2F	*	E37-0006-05 E37-0325-05 E37-0326-05	CONNECTING WIRE(SPEAKER) FLAT CABLE (16P) CONNECTING WIRE (FAN)		
36 37 38 39 40	3E 3E 1B 3D 1D,2E	* *	F01-0992-03 F01-0993-04 F07-1203-13 F07-1232-04 F07-1345-04	HEAT SINK (AVR,SP) HEAT SINK COVER (FAN) COVER (PANEL ·· LOWER) COVER (PANEL ·· UPPER)		
42	21		F51-0017-05 F51-0018-05	FUSE (15A··ACSY) FUSE (20A··DC CODE)		
44 50 51 52	1E 2E 1B 1A,3A		G01-0833-04 G02-0505-05 G02-0716-04 G10-0663-04 G10-0686-04	COMPRESSION SPRING LEAF SPRING (VOL KNOB) FRAT SPRING (SPEAKER) NON-WOVEN FABRRIC(100X85) NON-WOVEN FABRRIC(130X5)		
53 56 57 -	1E,2F 1D 3D	* * *	G10-0700-04 G11-0680-03 G11-0681-13 G11-0688-04 G11-0690-14	NON-WOVEN FABRRIC(60X10) SHEET (PANEL ·· UPPER) SHEET (PANEL ·· LOWER) SHEET (50×25··CPU) SHEET (30X20··ENCODER)		
59	3B, 2E		G53-0508-04	NON-WOVEN FABRIC(30X10)		
60 61 47 -	3I 1I 1I	* * * *	H10-2696-12 H11-0856-24 H11-0857-24 H13-0861-04 H13-0901-04	POLYSTYRENE FOAMED FIXTURE PACKING FIXTURE PACKING FIXTURE PROTECTION BOARD PROTECTION BOARD	PM PM K PM	
62 63 64 65	31 21 21 3J	*	H13-0897-04 H25-0029-04 H25-0079-04 H25-0723-04 H25-0750-04	PROTECTION BOARD(150X30) BAG BAG (200X200) BAG (230X400) BAG (170X270)	KP PM	
66 66	3J 3J	* *	H52-0334-04 H52-0335-04 H62-0291-04	ITEM CARTON BOX(942A) ITEM CARTON BOX(942A) OUTER CARTON BOX	KP M	
67 68 70 71 72	2I 1B 1E 2D 2J	* *	J20-0319-24 J21-4308-14 J21-4404-04 J21-4405-04 J29-0454-03	MIC FOOK (ACSY) MOUNTING HARDWAEE(FAN) MOUNTING HARDWARE(RELEASE) MOUNTING HARDWARE(PANEL) WIRING BOARD(ACSY)	KP	
73	3B		J69-0325-05	© RING (NUT)		
86 87 89 90	3C 3C 3C 3C	* * *	K29-4805-04 K29-4806-04 K29-4808-04 K29-4840-04	KNOB (ENCODER) KNOB (MHz) KNOB (SOL) KNOB ASSY (VOL)		
			L15-0310-25	LOW-FREGENCY CHOKE COIL		
A B D E F	2A,2B 3B 2B 2A,2B 1A,1B		N09-2084-05 N10-2030-46 N30-3040-46 N32-2606-46 N33-2606-45	SCREW (PULS TERMINAL) HEXAGON NUT(BAND UNIT) PAN HEAD MACHIN SCREW FLAT HEAD MACHIN SCREW OVAL HEAD MACHIN SCREW		
G	1B		N33-2614-45	OVAL HEAD MACHIN SCREW		

A: TM-742 K, P, M, M2, E, E2, E3

× New Parts

PARTS LIST

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TM-942 CONTROL UNIT (X53-3460-XX)

Ref. No. Address New Parts No. Description						
Ref. No. 参照番号		Parts	Parts No. 部品番号	Description 部 品 名 / 規 格		Re- mark
多照香芍	152. 188.	新	副 和 黄 写	部 品 名 / 規 格	仕 向	備考
r K I H	1E 2I 2D,3D 1D 2A,2D	*	N35-2605-45 N46-3010-46 N80-2006-45 N80-2008-45 N80-2605-45	BINDING HEAD MACHINE SCREW PAN HEAD TAPPING SCREW PAN HEAD TAPTITE SCREW(PANEL) PAN HEAD TAPTITE SCREW(PANEL) PAN HEAD TAPTITE SCREW(PANEL)	Κ₽	
M N O P	1A,1B 3E,2F 3E		N86-2606-45 N87-2606-46 N87-2608-46 N89-2005-46 N99-0331-05	SCREW (CASE) BRAZIER HEAD TAPTITE SCREW BRAZIER HEAD TAPTITE SCREW PAN HEAD TAPTITE SCREW(RELEASE SCREW SET (ACSY))	
SP1 FAN MIC MIC	2E 1B 1I 1I	*	T07-0268-05 T42-0310-25 T91-0396-05 T91-0397-05	LOUDSPEAKER(FULLRANGE) FAN MOTOR MICROPHONE MICROPHONE	M KP	
92	21		W01-0414-04	SPANNER (ACSY)		
93 93 94 95 96	3F 3F 1D,3D 2B 2B	* *	X53-3460-11 X53-3460-21 X54-3130-11 X57-3580-11 X57-3590-13	CONTROL CIRCUIT UNIT CONTROL CIRCUIT UNIT DISPLAY UNIT TX-RX UNIT (144MHZ 50W) TX-RX UNIT (440MHZ 35W)	KP M	
96	2B		X57-3590-23	TX-RX UNIT (430MHZ 35W)	M	
97	2B		X57-3600-11	TX-RX UNIT (1200MHZ 10W) (X53-3460-XX)		
C1 -4			CK73FB1H102K	CHIP C 1000PF K		
C5 C6 C7 C8			CK73FB1E104K CK73FF1C105Z CK73FB1E223K CK73FB1H102K	CHIP C 0.10UF K CHIP C 1.0UF Z CHIP C 0.022UF K CHIP C 1000PF K		
C9 C10 C11 C12 C13			CK73FB1E104K CK73FB1H102K CK73FB1E104K CK73FB1H102K CK73FF1C105Z	CHIP C 0.10UF K CHIP C 1000PF K CHIP C 0.10UF K CHIP C 1000PF K CHIP C 1.0UF Z		
C14 C15 C16 ,17 C18 C19			CK73FB1E104K C92-0507-05 CC73FSL1H101J CK73FB1H472K CC73FCH1H120J	CHIP C 0.10UF K CHIP TAN 4.7UF 6.3WV CHIP C 100PF J CHIP C 4700PF K CHIP C 12PF J		
C20 C21 ,22 C23 C24 C25			CK73FB1H123K CC73FCH1H22OJ CK73FB1H182K CC73FCH1H151J CC73FSL1H101J	CHIP C 0.012UF K CHIP C 22PF J CHIP C 1800PF K CHIP C 150PF J CHIP C 100PF J		
C26 C27 C28 C29 ,30 C31			CK73FB1H102K CK73FF1C105Z CK73FB1E223K CK73FF1C105Z CE04EW1A221M	CHIP C 1000PF K CHIP C 1.0UF Z CHIP C 0.022UF K CHIP C 1.0UF Z ELECTRO 220UF 10WV		
C32 -34 C35 C36 C37 C38			CK73FB1H102K CK73FB1E104K CC73FCH1H121J CC73FCH1H390J CC73FCH1H330J	CHIP C 1000PF K CHIP C 0.10UF K CHIP C 120PF J CHIP C 39PF J CHIP C 33PF J		

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

Parts without Parts No. are not supplied.

Les articles non mentionnes dans le Parts No. ne sont pas fournis.

Telle ohne Parts No. werden nicht geliefert.

CONTROL UNIT (X53-3460-XX)

		nt gellerert.		CONTROL UNIT (
	dress New Parts		_	scription	440	nation	Re- marks
参照番号 位	置新	部品看号	歌 品	名 / 規	14	仕 向	備考
C39 -41 C42 C43 C44 C45		CK73FB1E103K CK73FB1H102K CK73FB1E104K CK73FB1E103K CK73FB1H332K	CHIP C CHIP C CHIP C CHIP C	0.01UF 1000PF 0.10UF 0.01UF 3300PF	K K K K		
C46 C47 C48 C49 C50 -52		CC73FSL1H101J CK73FB1E103K CK73FB1E223K CK73FB1E103K CK73FB1H102K	CHIP C CHIP C CHIP C CHIP C CHIP C	100PF 0.01UF 0.022UF 0.01UF 1000PF	J K K K		
C53 C101 C102,103 C104 C105		CK73FB1E104K CK73FF1C105Z CK73FB1H102K CE04EW1C470M CK73FB1H102K	CHIP C CHIP C CHIP C ELECTRO CHIP C	0.10UF 1.0UF 1000PF 47UF 1000PF	K Z K 16WV K		
C106 C107,108 C109 C110 C111		CE04EW1A470M CK73FB1E123K C92-0507-05 CK73FB1H682K CK73FF1C105Z	ELECTRO CHIP C CHIP TAN CHIP C CHIP C	47UF 0.012UF 4.7UF 6800PF 1.0UF	10WV K 6.3WV K Z		
C112 C113 C114 C115-117 C118		CK73FB1H102K CK73FB1E103K CK73FB1H102K CK73FB1E104K CK73FF1C105Z	CHIP C CHIP C CHIP C CHIP C CHIP C	1000PF 0.01UF 1000PF 0.10UF 1.0UF	K K K K Z		
C119 C120 C121 C122 C123		CK73FB1H102K CC73FSL1H101J CK73FB1H102K CK73FB1E123K CK73FB1E104K	CHIP C CHIP C CHIP C CHIP C CHIP C	1000PF 100PF 1000PF 0.012UF 0.10UF	К Ј К К		
C124,125 C126 C127,128 C129 C130-133		CE04EW1A470M CE04EW1A471M CE04EW1A470M CE04EW1C101M CE04EW1A470M	ELECTRO ELECTRO ELECTRO ELECTRO ELECTRO	47UF 470UF 47UF 100UF 47UF	10WV 10WV 10WV 16WV 16WV		
C134 C135-137 C138 C139 C140,141		CE04EW1C101M CE04EW1A471M CE04EW1C470M CK73FF1C105Z CK73FB1H102K	ELECTRO ELECTRO ELECTRO CHIP C CHIP C	100UF 470UF 47UF 1.0UF 1000PF	16WV 10WV 16WV Z K		
C142 C143-145 C146,147 C148 C149		CK73FB1E223K CK73FB1E104K CK73FF1C105Z C90-2167-05 CE04EW1A101M	CHIP C CHIP C CHIP C ELECTROLYTIC ELECTRO	0.022UF 0.10UF 1.0UF CAPACITO 100UF	K K Z DR(LEAD) 10WV		
C151-153 C154 IC101		CC73FSL1H101J CE04EW1A471M CXD1095Q	CHIP C ELECTRO	100PF 470UF	J 10WV		
CN1 CN2 CN3 CN4 CN5		E40-5425-05 E40-5224-05 E40-3246-05 E40-3248-05 E40-5343-05	PIN CONNECTOR PIN CONNECTOR PIN CONNECTOR PIN CONNECTOR PIN CONNECTOR	R FOR INS R FOR INS R FOR INS	SIDE SIDE SIDE		
CN101-106		E40-5452-05	PIN CONNECTOR	R FOR INS	SIDE		

A: TM-742 K, P, M, M2, E, E2, E3 B: TM-942 K, P, M

PARTS LIST

× New Parts

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Teile ohne Parts No. werden nicht gellefert.

CONTROL UNIT (X53-3460-XX)

Ref. No.	Address		Parts No.	Description	Desti- Re nation mar
参照番号	位 置	Parts 新	部品番号	部品名/規格	仕 向備
CN107 CN108 CN109 J1 J2			E40-5224-05 E40-5408-05 E40-3299-05 E11-0448-05 E08-0876-05	PIN CONNECTOR FOR INSIDE PIN CONNECTOR FOR INSIDE PIN CONNECTOR FOR INSIDE PHONE JACK RECTANGULAR RECEPTACLE	
W101		*	E37-0329-05	CONNECTING WIRE	
F101		*	F53-0095-05	FUSE(1.2A)	
		*	G11-0691-04 G13-1396-04	AUXILIARY PART FORMED PLATE	
			J30-0563-05	SPACER	
IC102 L1 X1 X2 X3		*	L7808CV L92-0131-05 L77-1516-05 L77-1441-05 L78-0301-05	RESONATOR CORE CRYSTAL RESONATOR CRYSTAL RESONATOR RESONATOR(3.5795MHZ)	
X4			L78-0089-05	RESONATOR(480KHZ)	
CP1 ,2 CP3 ,4 R1 -3 R4 -6 R7		*	R90-0729-05 R90-0727-05 RK73FB2A102J RK73FB2A473J RK73FB2A102J	MULTIPLE COMPONENTS (C.R.L) MULTIPLE COMPONENTS (C.R.L) CHIP R 1.0K J 1/10W CHIP R 47K J 1/10W CHIP R 1.0K J 1/10W	
R8 R9 R10 R11 R12			RK73FB2A472J RK73FB2A102J RK73FB2A154J RK73FB2A223J RK73FB2A102J	CHIP R 4.7K J 1/10W CHIP R 1.0K J 1/10W CHIP R 150K J 1/10W CHIP R 22K J 1/10W CHIP R 1.0K J 1/10W	
R13 R13 R14 R14 R15			RK73FB2A332J RK73FB2A561J RK73FB2A392J RK73FB2A822J RK73FB2A183J	CHIP R 3.3K J 1/10W CHIP R 560 J 1/10W CHIP R 3.9K J 1/10W CHIP R 8.2K J 1/10W CHIP R 18K J 1/10W	KPMM2 EE2E3 KPMM2 EE2E3
R16 R17 R18 R19 R20			RK73FB2A104J RK73FB2A182J RK73FB2A221J RK73FB2A123J RK73FB2A823J	CHIP R 100K J 1/10W CHIP R 1.8K J 1/10W CHIP R 220 J 1/10W CHIP R 12K J 1/10W CHIP R 82K J 1/10W	
R21 R22 R23 R24 R25			RK73FB2A224J RK73FB2A184J RK73FB2A105J RK73FB2A472J RK73FB2A103J	CHIP R 220K J 1/10W CHIP R 180K J 1/10W CHIP R 1.0M J 1/10W CHIP R 4.7K J 1/10W CHIP R 10K J 1/10W	
R26 R27 R28 R29 ,30 R31			RK73FB2A473J RK73FB2A472J RK73FB2A103J RK73FB2A474J RK73FB2A474J	CHIP R 47K J 1/10W CHIP R 4.7K J 1/10W CHIP R 10K J 1/10W CHIP R 470K J 1/10W CHIP R 56K J 1/10W	
R32 R33 R34 R35 R36			RK73FB2A474J RK73FB2A472J RK73FB2A334J RK73FB2A684J RK73FB2A473J	CHIP R 470K J 1/10W CHIP R 4.7K J 1/10W CHIP R 330K J 1/10W CHIP R 680K J 1/10W CHIP R 47K J 1/10W	

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

* New Parts

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CONTROL UNIT (X53-3460-XX)

Ref. No.	Address		Parts No.	Description	Desti- Re	
参照番号	位置	Parts 新	部品番号	部品名/規	格	nation mar 仕 向 備
R37 R38 R39 R40 R41			RK73FB2A334J R92-0670-05 RK73FB2A101J RK73FB2A103J RK73FB2A152J	CHIP R 330K CHIP R 0 0HM CHIP R 100 CHIP R 10K CHIP R 1.5K	J 1/1 J 1/1 J 1/1 J 1/1	low low
R42 R43 R44 R45 R46			RK73FB2A102J RK73FB2A394J RK73FB2A473J RK73FB2A472J R92-1291-05	CHIP R 1.0K CHIP R 390K CHIP R 47K CHIP R 4.7K FIXED RESISTOR	J 1/1 J 1/1 J 1/1 J 1/1	low
R47 R48 R49 R50 R51 -53			RK73FB2A153J RK73FB2A333J RK73FB2A223J RK73FB2A474J RK73FB2A473J	CHIP R 15K CHIP R 33K CHIP R 22K CHIP R 470K CHIP R 47K		IOW
R54 -57 R58 R59 R60 R61			R92-0670-05 RK73FB2A472J RK73FB2A103J RK73FB2A473J RK73FB2A473J	CHIP R 0 0HM CHIP R 4.7K CHIP R 10K CHIP R 47K CHIP R 47K	J 1/1	IOW
R62 R64 R64 R65 ,66 R67			RK73FB2A473J RK73FB2A473J RK73FB2A473J RK73FB2A473J RK73FB2A473J	CHIP R 47K	J 1/1 J 1/1 J 1/1 J 1/1 J 1/1	LOW KPMM2 LOW EE3
R67 R68 R69 R70 ,71 R72			RK73FB2A473J RK73FB2A474J RK73FB2A121J RK73FB2A474J RK73FB2A682J	CHIP R 47K CHIP R 470K CHIP R 120 CHIP R 470K CHIP R 6.8K	J 1/1 J 1/1 J 1/1 J 1/1 J 1/1	LOW
R73 R74 R74 R75 R76			RK73FB2A473J RK73FB2A473J RK73FB2A473J RK73FB2A473J RK73FB2A473J	CHIP R 47K	J 1/1 J 1/1 J 1/1	KPMEE2 KP LOW EE2E3 LOW KPMM2
R77 R80 R81 ,82 R83 R101			RK73FB2A473J RK73FB2A473J RK73FB2A121J RK73FB2A102J RK73FB2A563J	CHIP R 47K CHIP R 47K CHIP R 120 CHIP R 1K CHIP R 56K	J 1/1 J 1/1 J 1/1	10W E2 10W EE3 10W 10W
R102-104 R105 R106,107 R108 R109			RK73FB2A223J RK73FB2A101J RK73FB2A332J RK73FB2A474J RK73FB2A183J	CHIP R 22K CHIP R 100 CHIP R 3.3K CHIP R 470K CHIP R 18K	J 1/1 J 1/1 J 1/1	10W 10W 10W 10W 10W
R110 R111 R112-114 R115 R116			RK73FB2A472J R92-0685-05 RK73FB2A102J RK73FB2A183J RK73FB2A472J	CHIP R 4.7K CHIP R 22 CHIP R 1.0K CHIP R 18K CHIP R 4.7K	J 1/2 J 1/1 J 1/1	10W 2W 10W 10W
R117,118 R119 R120 R121 R122-124			RK73FB2A183J RK73FB2A472J RK73FB2A103J R92-1215-05 RK73FB2A103J	CHIP R 18K CHIP R 4.7K CHIP R 10K CHIP R 470 CHIP R 10K	J 1/1 J 1/1 J 1/2	LOW LOW LOW LOW

A: TM-742 K, P, M, M2, E, E2, E3

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PARTS LIST

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CONTROL UNIT (X53-3460-XX)

Ref. No.	Addres		Parts No.	Description	Desti- Re-
参照番号	位置	Parts 新	部品番号	部品名/規格	nation mark 仕 向備者
R125-129 R130-133 R134 R135 R136,137			RK73FB2A104J RK73FB2A183J RK73FB2A4R7J RK73FB2A473J RK73FB2A101J	CHIP R 100K J 1/10W CHIP R 18K J 1/10W CHIP R 4.7 J 1/10W CHIP R 47K J 1/10W CHIP R 100 J 1/10W	
R138,139 R140,141 R142 R143-145 R146			RK73FB2A473J RK73FB2A101J RK73FB2A473J RK73FB2A4R7J RK73FB2A4R7J	CHIP R 47K J 1/10W CHIP R 100 J 1/10W CHIP R 47K J 1/10W CHIP R 4.7 J 1/10W CHIP R 4.7 J 1/10W J 1/10W	
R147,148 R149 R150 R151			RK73FB2A183J RK73FB2A332J RK73FB2A474J RK73FB2A472J	CHIP R 18K J 1/10W CHIP R 3.3K J 1/10W CHIP R 470K J 1/10W CHIP R 4.7K J 1/10W	EE2E3
D1 D2 -4 D5 D6 D101-103		*	DAN202U MA112 DTZ9.1(A) MA112 DA204U	DIODE DIODE DIODE DIODE	
IC1 IC2 IC3 IC4 IC5		*	HD6433388A04F LC3564PML-12 TA78L06F TC74HC133AF TC74HC00AF	IC(CPU) IC(8192 X8 RAM) IC IC IC IC(2-INPUT NAND GATE)	
IC6 IC7 IC8 IC9 IC10		*	S-3520CF HD74HC165FP BU4066BF NJM4558E TC35219F	IC IC IC(ANALOG SWITCH X4) IC(OP AMP) IC	
IC11 IC12 IC13,14 IC15 IC16		*	LC7385M PST7030MT TC4S11F TC4W66F TC4S66F	IC(DTMF DECODER) IC IC(2 INPUT NAND GATE) IC IC(BILATERAL SWITCH)	
IC103 IC104,105 IC106 IC108,109 IC110		:	NJM4558E LA4446 BU4053BF BU4053BF TC4S66F	IC(QP AMP) IC(AF POWER AMP) IC(ANALOG MULTIPLEXER) IC(ANALOG MULTIPLEXER) IC(BILATERAL SWITCH)	
IC112 IC113 IC114 01	The state of the s	* *	KCC06 KCX04 KCC07 2SC3722K(S) 2SC4116(Y)	IC IC IC TRANSISTOR TRANSISTOR	
03 04 05 ,6 07 08		*	DTC114EU 2SB815(6,7) 2SC4116(Y) DTC114EU 2SD1757K	DIGITAL TRANSISTOR TRANSISTOR TRANSISTOR DIGITAL TRANSISTOR TRANSISTOR	
09 ,10 011 0101 0102 0103			2SC4116(Y) DTA144EU 2SC4116(Y) 2SA1641(S,T) DTC144EK	TRANSISTOR DIGITAL TRANSISTOR TRANSISTOR TRANSISTOR DIGITAL TRANSISTOR	

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

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Ref. No. Address New			Parts No.	DISPLAY UNIT (X Description	Desti- Re-
参照番号	位 置	Parts 新	部品番号	部品名/規格	nation mar 仕 向備
0104 0105 0106 0107-109			DTA144EK DTD143EK 2SC4116(Y) 2SD1757K	DIGITAL TRANSISTOR DIGITAL TRANSISTOR TRANSISTOR TRANSISTOR	
BA1			W09-0573-05	LITHIUM BATTERY	
				(X54-3130-XX)	
151 152	2D 1C	*	B11-1070-04 B11-1071-04	FILTER(LCD) FILTER(LCD)	
C1 C2 C3 C4 C5			CK73GB1H102K C92-0004-05 CK73GB1H102K C92-0045-05 CK73GB1H102K	CHIP C 1000PF K ELECTRO 1.0UF 16WV CHIP C 1000PF K ELECTRO 22UF 6.3WV CHIP C 1000PF K	
C6 ,7 C8 ,9 C10 -18 C19 ,20 C21 ,22			CC73GSL1H101J CC73GCH1H330J CK73GB1H102K CK73GB1H472K CK73GB1H102K	CHIP C 100PF J CHIP C 33PF J CHIP C 1000PF K CHIP C 4700PF K CHIP C 1000PF K	
C23 C101-103 C201 C202,203 C204,205			CK73GB1E103K CK73GB1H102K CK73GB1H102K CC73GSL1H101J CK73GB1E103K	CHIP C 0.010UF K CHIP C 1000PF K CHIP C 1000PF K CHIP C 100PF J CHIP C 0.010UF K	
C206-207 C208 C209			CK73GB1H102K C92-0047-05 CK73GB1E103K	CHIP C 1000PF K BLECTRO 47UF 6.3WV CHIP C 0.010UF K	
CN1 CN2 CN3		* *	E29-1112-14 E37-0309-05 E40-3262-05 E40-5587-05 E40-3262-05	CONNECTOR&TERMINAL PIN CONNECTOR FOR INSIDE PIN CONNECTOR FOR INSIDE PIN CONNECTOR FOR INSIDE	
CN101 CN201		*	E40-5587-05 E40-3262-05	PIN CONNECTOR FOR INSIDE PIN CONNECTOR FOR INSIDE	
153	10	*	G11-0688-04	AUXILIARY PART	
154 155	20 10	*	J21-4409-03 J30-0563-05	MOUNTING HARDWARE(LCD) SPACER	
X 1		*	L77-1504-05	CRYSTAL RESONATOR(4MHZ)	
0	3C,3D		N14-0552-05	NUT (ENC, VOL)	
CP1 -5 R1 R2 R3 R4			R90-0720-05 RK73FB2A102J RK73GB1J681J RK73GB1J102J RK73GB1J681J	MULTI COMP 100K CHIP R 1.0K J 1/10W CHIP R 680 J 1/16W CHIP R 1.0K J 1/16W CHIP R 680 J 1/16W	
R5 R6 R7 R8 R9			RK73GB1J102J RK73GB1J681J RK73GB1J102J RK73GB1J681J RK73GB1J102J	CHIP R 1.0K J 1/16W CHIP R 680 J 1/16W CHIP R 1.0K J 1/16W CHIP R 680 J 1/16W CHIP R 1.0K J 1/16W	
R10 R11			RK73GB1J681J RK73GB1J102J	CHIP R 680 J 1/16W CHIP R 1.0K J 1/16W	

A: TM-742 K, P, M, M2, E, E2, E3

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PARTS LIST

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DISPLAY UNIT (X54-3130-XX) 144M TX-RX UNIT (X57-3580-XX)

		1	nt gellefert.	144M TX-RX UNIT (X57-3580-X
Ref. No.	Address	Parts	Parts No.	Description Desti- Re-
参照番号	位置	新	部品香号	部品名/規格 仕向備
R12 R13 R14 ,15 R16 R17			RK73GB1J681J RK73GB1J102J RK73GB1J103J RK73FB2A222J RK73GB1J331J	CHIP R 680 J 1/16W CHIP R 1.0K J 1/16W CHIP R 10K J 1/16W CHIP R 2.2K J 1/10W CHIP R 330 J 1/16W
R18 R19 R20 R21 R101			RK73GB1J473J RK73GB1J470J RK73GB1J100J RK73GB1J105J RK73FB2A561J	CHIP R 47K J 1/16W CHIP R 47 J 1/16W CHIP R 10 J 1/16W CHIP R 1.0M J 1/16W CHIP R 560 J 1/10W
R102 R103 R104 R105 R106			RK73FB2A102J RK73GB1J473J RK73FB2A272J RK73FB2A182J RK73FB2A272J	CHIP R 1.0K J 1/10W CHIP R 47K J 1/16W CHIP R 2.7K J 1/10W CHIP R 1.8K J 1/10W CHIP R 2.7K J 1/10W
R201-203 R204,205 R206 R207 R208,209		*	RK73GB1J3R3J RK73GB1J100J RK73GB1J105J RK73GB1J104J RK73GB1J222J	CHIP R 3.3 J 1/16W CHIP R 10 J 1/16W CHIP R 1.0M J 1/16W CHIP R 100K J 1/16W CHIP R 2.2K J 1/16W
R210 R211,212 VR1 -3		*	RK73GB1J223J RK73GB1J100J R23-9409-05	CHIP R 22K J 1/16W CHIP R 10 J 1/16W POTENTIOMETER
S101-112 S113-115			S70-0408-05 S70-0409-15	TACT SWITCH
D1 D2 D3 ,4 D101-105		* *	B38-0379-05 MA112 MA720 B30-2025-05 B30-2048-05	DISPLAY ASSY LED LED
D107-112 D114 IC1 IC2 IC3 -6		* * *	B30-2053-05 B30-2053-05 HD404719A26H L78LR05B-FA TC4S11F	LED LED IC(CPU) IC IC(2 INPUT NAND GATE)
IC201,202 IC203 IC204 IC205 IC206		*	MSM5265GS-V1K TC4S11F TC74HC73AF NJM78L05UA TC4S11F	IC(LCD DRIVER) IC(2 INPUT NAND GATE) IC IC(VOLTAGE REGULATOR/ +5V) IC(2 INPUT NAND GATE)
PL1 -6 91 92 93		*	B30-0865-15 2SA1745(6,7) 2SB1119(S) DTC114EU	LAMP, LED DIGITAL TRANSISTOR
94 ,5			DTC144EU	DIGITAL TRANSISTOR
9101			DTC114EU	DIGITAL TRANSISTOR
S1		*		FRONT END UNIT, ELECTRIC UNIT
200	14 2G	14IV		(57-3580-XX) -11: K -12: P, M
200	3G		B42-2437-04	LABEL(S/NO)
C5			CC73FCH1H040C	CHIP C 4PF C

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

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144M TX-RX UNIT (X57-3580-XX)

Ref. No.	Address New	Parts No.			Desti- Re	
参照番号	位 置 新	部品書号	部	品 名/規	格	nation mar 仕 向備
C6 C7 -9 C10 C11 C12		CK73FB1H102K CK73FB1H102K CK73FB1E103K CC73FCH1H0R5C CC73FCH1H151J	CHIP C CHIP C CHIP C CHIP C	1000PF 1000PF 0.01UF 0.5PF 150PF	К К К С	
C13 C14 C15 C16 C18		CC73FCH1H030C CC73FCH1H0R5C CC73FCH1H150J CC73FCH1H020C CK73FB1H102K	CHIP C CHIP C CHIP C CHIP C CHIP C	3PF 0.5PF 15PF 2.0PF 1000PF	C C C K	
C19 C20 C21 C22 C23		CC73FCH1H060D CK73FB1H102K CC73FCH1H050C CK73FB1B103K CK73FB1H102K	CHIP C CHIP C CHIP C CHIP C CHIP C	6PF 1000PF 5PF 0.01UF 1000PF	D K C K K	
C24 C25 C26 C29 C30		CK73FB1E103K CC45SL2H020C CK73FB1H102K CK73FB1E103K CC73FCH1H390J	CHIP C CERAMIC CHIP C CHIP C CHIP C	0.01UF 2PF 1000PF 0.01UF 39PF	К С К Ј	
C31 C32 C33 C34 ,35 C36 ,37		CC73FCH1H101J CK73FB1H102K CK73FB1E104K CK73FB1E105Z CK73FB1E103K	CHIP C CHIP C CHIP C CHIP C	100PF 1000PF 0.10UF 1.0UF 0.01UF	J K K Z K	
C39 C44 ,45 C46 C47 C48		CC73FCH1H010C CE04NW1C470M C92-0504-05 CE04NW1C470M C92-0003-05	CHIP C ELECTRO CHIP TAN ELECTRO CHIP TAN	1PF 47UF 0.68UF 47UF 0.47UF	C 16WV 20WV 16WV 25WV	
C49 C50 C51 ,52 C53 ,54 C55		CE04NW1E100M CE04NW1C470M CK73FB1E103K CK73FB1H102K CK73EF1C105Z	ELECTRO ELECTRO CHIP C CHIP C CHIP C	10UF 47UF 0.01UF 1000PF 1.0UF	25WV 16WV K K Z	
C56 C57 C58 C59 ,60 C61		CC73FUJ1H150J CK73FB1H102K CC73FUJ1H220J CK73FB1H102K CE04NW1C470M	CHIP C CHIP C CHIP C CHIP C ELECTRO	15PF 1000PF 22PF 1000PF 47UF	J K J K 16WV	
C62 C63 C64 C65 C66		CK73FB1H102K CK73FB1E103K CE04NW1E100M CE04NW1A330M CK73FB1E103K	CHIP C CHIP C ELECTRO ELECTRO CHIP C	1000PF 0.01UF 10UF 33UF 0.01UF	K K 25WV 10WV K	
C67 C68 C69 C70 C71 -73		CK73FB1H102K CC73FCH1H100D CC73FCH1H100D CK73FB1E103K CK73FB1H102K	CHIP C CHIP C CHIP C CHIP C	1000PF 10PF 10PF 0.01UF 1000PF	K D D K K	
C74 C75 C76 C77 ,78		CK73FB1H223K CE04NW1C101M CK73EF1C105Z CK73FB1H102K CK73EF1C105Z	CHIP C ELECTRO CHIP C CHIP C CHIP C	0.022UF 100UF 1.0UF 1000PF 1.0UF	K 16WV Z K Z	

A: TM-742 K, P, M, M2, E, E2, E)

× New Parts

PARTS LIST

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Telle ohne Parts No. werden nicht geliefert.

144M TX-RX UNIT (X57-3580-XX)

Ref. No.	Address New Parts No.			De	scription		Re-	
参照番号	位置	Parts 新	部品番号	部		名/規	格	mark 備考
C80 C81 C82 C83 C84			CC73FCH1H050C CC45SL2H120J CK73FB1H102K CK45B2H102K CM73F2H330J	CHIP C CERAMIC CHIP C CERAMIC CHIP C		5PF 12PF 1000PF 1000PF 33PF	С Ј К К Ј	
C85 C86 C87 C88 C89			CC73FCH1H220J CC73FCH1H0R5C CC73FCH1H020C CC45SL2H560J CC45SL2H470J	CHIP C CHIP C CHIP C CERAMIC CERAMIC		22PF 0.5PF 2.0PF 56PF 47PF	J C J J	
C90 -92 C93 C94 C95 C96	,		CK73FB1H102K CC73FCH1H0R5C CM73F2H300J CC73FCH1H020C CK73FB1E103K	CHIP C CHIP C CHIP C CHIP C		1000PF 0.5PF 30PF 2.0PF 0.01UF	K C C K	
C98 C99 C100 C101 C103			CK73FB1H102K CE04NW1E100M CK73FB1H102K CE04NW1E100M CK73FB1H102K	CHIP C ELECTRO CHIP C ELECTRO CHIP C		1000PF 10UF 1000PF 10UF 1000PF	K 25WV K 25WV K	
C104 C105 C110 C111 C112			CK73FB1E103K CK73FB1H223K CC73FCH1H030C CK73FB1E103K CE04NW1A221M	CHIP C CHIP C CHIP C CHIP C BLECTRO		0.01UF 0.022UF 3PF 0.01UF 220UF	K K C K 10WV	
C113 C114,115 C116 C119 C120-127			CC73FCH1H100D CC73FSL1H101J CC73FCH1H080D CE04NW1E100M CC73FSL1H101J	CHIP C CHIP C CHIP C BLECTRO CHIP C		10PF 100PF 8PF 10UF 100PF	D J D 25WV J	,
C128,129 C130 TC1			CK73FB1H102K CE04EW1C102M C05-0345-05	CHIP C ELECTRO TRIMMING C	AP	1000PF 1000UF 10PF	K 16WV	
203 202 CN1 ,2	3H 1H		E22-0672-04 E22-0673-04 E30-2145-15 E30-3007-05 E40-5461-05	TERMINAL E TERMINAL E ANT CABLE DC POWER C PIN CONNEC	OAF	RD(+)		А
J1 J2 J3			E11-0442-05 E23-0619-05 E23-0619-05	PHONE JACK TERMINAL TERMINAL				B B A
205 204 -	2G 1G		F05-1531-05 F10-1446-04 F10-2010-03 F10-2012-04 F20-1008-04	FUSE SHIELDING SHIELDING SHIELDING INSULATION	CAS	VER Se(VCO-PI		
208	1H		F51-0017-05	FUSE(15A)				Α
209	3G		G02-0600-14 G02-0705-04 G02-0715-04 G02-0718-04 G09-0426-05	FLAT SPRIN FLAT SPRIN LEAF SPRIN FLAT SPRIN SPRING(DC	G G(A G(V	APC TR) /CO)	SW)	Α
-			G11-0654-04	CUSHION(VC	0)			

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

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Teile ohne Parts No. werden nicht geliefert.

144M TX-RX UNIT (X57-3580-XX)

0110 01110 7 4110	No. werden nic		144M TX-RX UNIT (X	1	
Ref. No.	Address New Parts		Description	nation n	Re- mark
参照番号	位置新	部品番号	部 品 名 / 規 格	仕 向	備考
211 215 -	3G 3G	G11-0655-04 G11-0660-04 G11-0661-04 G13-0841-04 G13-1325-04	CUSHION(CN1,CN2) CUSHION(VCO) INSULATION SHEET(APC TR) FORMED PLATE(XTAL) FORMED PLATE(VCO)		
- 216 214	3G 1G	G13-1337-04 G13-1349-04 G53-0508-04	CUSHION(VCO) CUSHION(VCO) NON-WOVEN FABRIC		
-		J30-0564-05	SPACER		
CD1 CF1 L1 -4 L5 L6		L79-1013-05 L72-0372-05 L34-4252-05 L40-1582-19 L34-4251-05	FILTER CERAMIC FILTER(CFWM455F) COIL SMALL FIXED INDUCTOR(0.15UH) COIL(1ST IF)		
L8 L10 L11 L12 L13		L34-1185-05 L40-3382-19 L34-1239-05 L34-0895-05 L34-0742-05	COIL(2.5T) SMALL FIXED INDUCTOR(0.33UH) COIL(10.5T) COIL(6T) COIL(6T)		
L14 L15 -17 L19 L20 X1		L34-0908-05 L34-0499-05 L40-8272-48 L40-1001-19 L77-1405-05	COIL(9.5T) COIL(4.5T) SMALL FIXED INDUCTOR(82NH) SMALL FIXED INDUCTOR(10UH) CRYSTAL RESONATOR(12.8MHZ)		
X2 XF1		L77-1473-05 L71-0228-05	CRYSTAL RESONATOR(10.245MHZ) CRYSTAL FILTER(10.7MHZ)		
W N U		N09-2077-05 N87-2606-46 N88-2606-46	SCREW(MODULE) BRAZIER HEAD TAPTITE SCREW(ANT FLAT HEAD TAPTITE SCREW		
R4 R5 R6 R7 R8		RK73FB2A103J RK73FB2A333J RK73FB2A274J RK73FB2A101J RK73FB2A103J	CHIP R 10K J 1/10W CHIP R 33K J 1/10W CHIP R 270K J 1/10W CHIP R 100 J 1/10W CHIP R 10K J 1/10W		
R9 R10 -12 R13 R14 R15		RK73FB2A101J RK73FB2A103J RK73FB2A473J RK73FB2A104J RK73FB2A683J	CHIP R 100 J 1/10W CHIP R 10K J 1/10W CHIP R 47K J 1/10W CHIP R 100K J 1/10W CHIP R 68K J 1/10W		
R16 R17 R18 R19 R20		RK73FB2A823J R92-0670-05 RK73FB2A470J RK73FB2A102J RK73FB2A152J	CHIP R 82K J 1/10W CHIP R 0 0HM CHIP R 47 J 1/10W CHIP R 1.0K J 1/10W CHIP R 1.5K J 1/10W		
R21 R22 R23 R24 R25		RK73FB2A471J RK73FB2A101J RK73FB2A103J RK73FB2A473J RK73FB2A103J	CHIP R 470 J 1/10W CHIP R 100 J 1/10W CHIP R 10K J 1/10W CHIP R 47K J 1/10W CHIP R 10K J 1/10W		
R30 R31 R33,34 R35		R92-0670-05 RK73FB2A394J R92-0670-05 RK73FB2A222J	CHIP R 0 0HM CHIP R 390K J 1/10W CHIP R 0 0HM CHIP R 2.2K J 1/10W		

A: TM-742 K, P, M, M2, E, E2, E3

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144M TX-RX UNIT (X57-3580-XX)

Ref. No.	Address	New	Parts No.	Parts No.					Desti-	Re-
参照番号	位 潼	Parts 新		部		scription 名 / 規	格		nation	mark 備考
R36 R37 R38 R39 -41			RK73FB2A101J R92-0670-05 RK73FB2A182J RK73FB2A103J RK73FB2A182J	CHIP R CHIP R CHIP R CHIP R CHIP R		100 0 0HM 1.8K 10K 1.8K	J J J	1/10W 1/10W 1/10W 1/10W		
R43 R44 R45 R46 R47			RK73FB2A223J RK73FB2A273J RK73FB2A473J RK73FB2A472J R92-0670-05	CHIP R CHIP R CHIP R CHIP R CHIP R		22K 27K 47K 4.7K 0 0HM]]	1/10W 1/10W 1/10W 1/10W		
R49 R50 R52 -54 R55 R56			RK73FB2A223J RK73FB2A124J RK73FB2A473J RK73FB2A471J RK73FB2A104J	CHIP R CHIP R CHIP R CHIP R CHIP R		22K 120K 47K 470 100K	J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R57 R58 R59 R60 R61			RK73FB2A105J RK73FB2A473J R92-0670-05 RK73FB2A103J RK73FB2A471J	CHIP R CHIP R CHIP R CHIP R CHIP R		1.0M 47K 0 OHM 10K 470	J J J	1/10W 1/10W 1/10W 1/10W		
R62 R63 ,64 R65 ,66 R67 R68			R92-0670-05 RK73FB2A222J R92-0670-05 RK73FB2A122J RK73FB2A220J	CHIP R CHIP R CHIP R CHIP R CHIP R		0 OHM 2.2K 0 OHM 1.2K 22	J J	1/10W 1/10W 1/10W		
R69 R71 R73 R74 R75			RK73FB2A470J R92-0670-05 RK73FB2A104J R92-0670-05 RK73FB2A103J	CHIP R CHIP R CHIP R CHIP R CHIP R		47 0 OHM 100K 0 OHM 10K	J J	1/10W 1/10W 1/10W		
R76 R78 R79 ,80 R81 R82			R92-0670-05 R92-1213-05 RK73FB2A223J RK73FB2A471J R92-0685-05	CHIP R CARBON CHIP R CHIP R CHIP R		0 QHM 100 22K 470 22	J J	1/2W 1/10W 1/10W 1/2W		
R83 R84 -86 R89 R90 R91			R92-0670-05 R92-0670-05 RK73FB2A332J RK73FB2A221J RK73FB2A473J	CHIP R CHIP R CHIP R CHIP R CHIP R		0 0HM 0 0HM 3.3K 220 47K	J	1/10W		
R92 R93 R98 ,99 R101 VR1			R92-0679-05 RK73FB2A104J RK73FB2A103J RK73FB2A102J R12-6429-05	CHIP R CHIP R CHIP R CHIP R TRIM POT.		O OHM 100K 10K 1.0K 100K	J J	1/10W 1/10W 1/10W		·
VR2 VR3 VR4			R12-6427-05 R12-6423-05 R12-6423-05	TRIM POT. TRIM POT. TRIM POT.		47K 10K 10K				
TS1			S79-0401-05	THERMAL S	WIT	CH(95°C)			1	
D1 D2 D3 ,4 D5			1SV164 1SV166 1SV164 1SV166 1SV164	DIODE DIODE DIODE DIODE DIODE						

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

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144M TX-RX UNIT (X57-3580-XX) 430/440M TX-RX UNIT (X57-3590-XX)

Ref. No.	Address	1 1		Description		Re-
参照番号	位置	Parts 新	部品番号	部品名/規格	t 向	mark 備考
D7 D11 D12 D13			1SV166 1SS184 1SS184 DAN235(K) 1SS181	DIQDE DIQDE DIQDE DIQDE DIQDE		
D15 D16 D17 ,18 D19 IC1			MI407 MI308 1SS226 DSA3A1 BU4094BF	DIODE DIODE DIODE DIODE IC(SHIFT/STORE REGISTER)		
IC1 IC2 IC5 IC6 IC7			XRU4094BF LA5010M KCD04 KCD05 KCA04	IC IC(LOW SATURATION REGULATOR) IC(FM IF) IC(AM IF) IC(MIC AMPLIFIER)		
IC8 IC9 IC10 IC11			KCB11 KCC04 S-AV17 KCH05 3SK184(S)	IC(DRIVER) IC(APC) IC(POWER MODULE FOR 144MHZ) IC(144MHZ VCO PLL) FET		
92 93 94 95 ,6			3SK131(V12) 2SC2714(Y) DTA114YK DTC123JK DTC143EK	FET TRANSISTOR DIGITAL TRANSISTOR DIGITAL TRANSISTOR DIGITAL TRANSISTOR		
010 011 012 013 ,14 015 -17			2SA1362(Y) 2SB1119(S) DTC144WK 2SC2712(Y) DTC144EK	TRANSISTOR TRANSISTOR DIGITAL TRANSISTOR TRANSISTOR DIGITAL TRANSISTOR	-	
918 919 920 921 922			2SD1757K 2SK208(Y) 2SC2714(Y) 2SC2712(Y) FMG1	TRANSISTOR FET TRANSISTOR TRANSISTOR TRANSISTOR TRANSISTOR		
923 924			2SD1902R 2SJ106(GR)	TRANSISTOR FET		
	430/	440	M TX-RX UNIT	(X57-3590-XX) -11: K, P -21: N	Л	
200	2G		A10-1316-01	CHASSIS		
201	3G		B42-2437-04	LABEL(S/NO)		
C1 C2 -4 C5 C6 C7			CC73FCH1H030C CK73FB1H102K CC73FCH1H1R5C CC73FCH1H390J CK73FB1H102K	CHIP C 3PF C CHIP C 1000PF K CHIP C 1.5PF C CHIP C 39PF J CHIP C 1000PF K		
C8 C9 C9 C9 C10			CK73FB1H102K CC73FCH1H010C CC73FCH1H010C CC73FCH1H020C CC73FCH1H390J	CHIP C 1000PF K CHIP C 1PF C CHIP C 1PF C CHIP C 2PF C CHIP C 39PF J	MM2 EE2E3 KP	B
C11 C12 C13 ,14			CK73FB1H102K CK73FB1H102K CK73FB1H102K	CHIP C 1000PF K CHIP C 1000PF K CHIP C 1000PF K		

A: TM-742 K, P, M, M2, E, E2, 13

× New Parts

PARTS LIST

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430/440M TX-RX UNIT (X57-3590-XX)

Ref. No.	Address New	Parts No.	Description	Desti- Re-
参照番号	位置新	部品番号	部品名/規格	nation marks 仕 向 備考
C15 C16 ,17 C18 C19 ,20 C21		CC73FCH1H050C CK73FB1H102K CC73FCH1H060D CK73FB1H102K CC73FCH1H560J	CHIP C 5PF C CHIP C 1000PF K CHIP C 6PF D CHIP C 1000PF K CHIP C 56PF J	КР
C21 C21 C22 C22 C22		CC73FCH1H330J CC73FCH1H330J CC73FCH1H180J CC73FCH1H330J CC73FCH1H330J	CHIP C 33PF J CHIP C 33PF J CHIP C 18PF J CHIP C 33PF J CHIP C 33PF J	MM2 EE2E3 B KP MM2 EE2E3 B
C23 C24 C25 C26 C27		CK73FB1H102K CE04NW1C470M CK73FB1H102K CK73FF1C105Z C92-0003-05	CHIP C 1000PF K ELECTRO 47UF 16WV CHIP C 1000PF K CHIP C 1.0UF Z CHIP TAN 0.47UF 25WV	
C28 ,29 C30 C31 C32 C33		CK73FF1C105Z CK73FB1H102K CK73FB1H102K CE04NW1C470M C92-0504-05	CHIP C 1.0UF Z CHIP C 1000PF K CHIP C 1000PF K ELECTRO 47UF 16WV CHIP TAN 0.68UF 20WV	
C34 C35 C36 C37 C38		CE04NW1C470M CK73FB1H102K CE04NW1C470M CK73FB1H102K CK73FB1H822K	ELECTRO 47UF 16WV CHIP C 1000PF K ELECTRO 47UF 16WV CHIP C 1000PF K CHIP C 8200PF K	
C39 C40 C41 ,42 C43 C44		CK73FB1H102K CK73FF1C105Z CC73FUJ1H180J CK73FB1H102K CC73FCH1H060D	CHIP C 1000PF K CHIP C 1.0UF Z CHIP C 18PF J CHIP C 1000PF K CHIP C 6PF D	
C45 C46 C47 C48 C49		CK73FB1H102K CC73FCH1H150J CK73FB1H102K CE04NW1C101M CK73FB1H102K	CHIP C 1000PF K CHIP C 15PF J CHIP C 1000PF K BLECTRO 100UF 16WV CHIP C 1000PF K	
C50 C51 ,52 C53 C54 -58 C60		CE04NW1A330M CK73FB1H102K CE04NW1C101M CK73FB1H102K CE04NW1C220M	ELECTRO 33UF 10WV CHIP C 1000PF K ELECTRO 100UF 16WV CHIP C 1000PF K ELECTRO 22UF 16WV	
C62 C64 ,65 C66 C66		CK73FB1H102K CK73FB1H102K CM73F2H050D CM73F2H060D CM73F2H060D	CHIP C 1000PF K CHIP C 1000PF K CHIP C 5.0PF D CHIP C 6.0PF D CHIP C 6.0PF D	KP MM2 EE2E3 B
C67 C68 C69 C70		CC73FCH1H070D CC45SL2H150J CC45SL2H220J CC45SL2H220J CC73FCH1H0R5C	CHIP C 7PF D CERAMIC 15PF J CERAMIC 22PF J CERAMIC 22PF J CHIP C 0.5PF C	
C72 C73 C74 C75 C76		CC73FCH1H020C CC45SL2H080D CC45SL2H100D CC73FCH1H0R5C CC73FCH1H020C	CHIP C 2.0PF C CERAMIC 8.0PF D CERAMIC 10PF D CHIP C 0.5PF C CHIP C 2.0PF C	

A: TM-742 K, P, M. M2, E, E2, E3

PARTS LIST

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430/440M TX-RX UNIT (X57-3590-XX)

Ref. No.	Address	New Parts No.		De	scription			Re- marks
参照番号	位置	#	部品番号	部品	名/規	格	仕 向	備考
C77 C78 -80 C81 C82 -85 C86			CM73F2H060D CK73FB1H102K C90-2092-05 CC73FSL1H101J CK73FB1H102K	CHIP C CHIP C ELECTRO CHIP C CHIP C	6.0PF 1000PF 10UF 100PF 1000PF	D K: 16WV J K		
C87 C88 C89 -91 C92 C93			CK73FB1H333K CE04NW1A221M CK73FB1H102K CK73FB1H471K CE04NW1C470M	CHIP C ELECTRO CHIP C CHIP C ELECTRO	0.033UF 220UF 1000PF 470PF 47UF	K 10WV K K 16WV		
C94 C96 C97 C98 C99			CC73FCH1H030C CK73FB1H102K CK73FB1E104K CC73FCH1H040C CC73FCH1H020C	CHIP C CHIP C CHIP C CHIP C	3PF 1000PF 0.10UF 4PF 2.0PF	С К К С		
C100 C100 C100 C102 C103,104			CC73FCH1H060D CC73FCH1H070D CC73FCH1H070D CE04NW1C100M CK73FB1H102K	CHIP C CHIP C CHIP C ELECTRO CHIP C	6PF 7PF 7PF 10UF 1000PF	D D D 16WV K	KP MM2 EE2E3	В
C105-110 C111 C112 C113 C114			CC73FSL1H101J CK73FB1H103K CK73FB1H102K CC73FCH1H020C CK73FB1E223K	CHIP C CHIP C CHIP C CHIP C	100PF 0.010UF 1000PF 2.0PF 0.022UF	K C		
C115 C118 C21,22 TC1 ,2 TC3			CK73FB1H102K CC73FCH1H150J CC73FCH1H330J CO5-0346-05 CO5-0371-05	CHIP C CHIP C CHIP C TRIM CAP TRIM CAP	1000PF 15PF 33PF	K J J 10PF	EMM2	
203 203 202	3H 3H 1H		E22-0672-04 E72-0406-04 E30-3009-15 E30-3010-15 E30-3007-05	TERMINAL BOAR TERMINAL BOAR ANT CABLE ANT CABLE DC CABLE			KPMM2 EE2E3	B B
CN1 .2 J1 TP1			E40-5461-05 E11-0442-05 E04-0154-05	PIN ASSY(12P PHONE JACK RF COAXIAL C		EPTACLE		
204 205 - 208	1G 2G 1H		F10-1444-03 F10-1446-04 F10-1477-24 F10-2012-04 F51-0017-05	SHIELDING PL SHIELDING PL SHIELDING CA SHIELDING CA FUSE(15A)	ATE ATE	LL)		В
209 - 210	3H 2G		G02-0599-04 G02-0600-14 G02-0704-04 G02-0705-04 G09-0426-05	FLAT SPRING(FLAT SPRING(EARTH SPRING EARTH SPRING SPRING(DC CO	THERMAL	SW)		В
211 212 215	3G 1G 3G		G11-0655-04 G11-0656-14 G11-0660-04 G11-0661-04 G13-0841-04	CUSHION(CN1, CONDUCTIVE R CUSHION(VCO) INSULATION S CUSHION(12.8	UBBER(MC HEET(DB	TR)		
216	3G		G13-1319-04	CUSHION(VCO)				

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

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430/440M TX-RX UNIT (X57-3590-XX)

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A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

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430/440M TX-RX UNIT (X57-3590-XX)

Ref. No.	Address		Parts No.	De	scription			Desti- nation	Re-
参照番号	位置	Parts 新	部品番号	部品	名/規	格			備考
R33 -35 R36 R37 R38 R40			RK73FB2A473J RK73FB2A154J RK73FB2A273J RK73FB2A152J RK73FB2A221J	CHIP R CHIP R CHIP R CHIP R CHIP R	47K 150K 27K 1.5K 220	J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R42 R43 R44 R45,46 R47			R92-0670-05 RK73FB2A471J RK73FB2A103J RK73FB2A222J RK73EB2B220J	CHIP R CHIP R CHIP R CHIP R CHIP R	0 0HM 470 10K 2.2K 22	J J J	1/10W 1/10W 1/10W 1/8W		
R48 R49 R51 R52 R53			R92-0670-05 RK73FB2A102J RK73FB2A562J RK73FB2A104J R92-0685-05	CHIP R CHIP R CHIP R CHIP R CHIP R	0 0HM 1.0K 5.6K 100K 22	J J J	1/10W 1/10W 1/10W 1/2W		
R55 R58 R59 R60 ,61 R62			R92-0670-05 R92-0679-05 R92-1214-05 RK73FB2A103J RK73FB2A221J	CHIP R CHIP R CHIP R CHIP R CHIP R	0 0HM 0 0HM 120 10K 220	J J J			
R63 R64 R65 R66 R67,68			RK73FB2A473J RK73FB2A104J RK73FB2A472J RK73FB2A473J RK73FB2A103J	CHIP R CHIP R CHIP R CHIP R CHIP R	47K 100K 4.7K 47K 10K	J J J J	1/10W 1/10W		
R72 VR1 VR2 VR3 ,4			RK73FB2A102J R12-6429-05 R12-6427-05 R12-6423-05	CHIP R TRIMMING POT TRIM POT. TRIM POT.	1 K 100 K 47 K 10 K	J	1/10W		
TS1			559-0444-05	THERMAL SWIT	CH(90°C)				
D1 D2 D3 D4 D5			HSK277 1SV128 1SS184 MA862 1SS181	DIODE DIODE DIODE DIODE					
D6 D7 D8 D9 D10 ,11			1SS184 1SS184 MI407 MI308 MA716	DIODE DIODE DIODE DIODE DIODE					
D12 D13 D14 D15 IC1			DSA3A1 1SS184 MA716 MA862 KCD04	DIODE DIODE DIODE DIODE IC(FM IF)					:
IC2 IC3 IC3 IC4 IC5			KCAO4 BU4094BF XRU4094BF LA5010M KCCO4	IC(MIC AMPLI IC(SHIFT/STO IC IC(LOW SATUR IC(APC)	RE REGIS				
IC6 IC7 IC8 IC9			KCB14 M57788M KCB12 KCB13	IC(DRIVER) IC(POWER MOD IC(400MHZ PR IC(800MHZ FR	E AMPLIE	IER:			

A: TM-742 K, P, M, M2, E, E2, E3 B: TM-942 K, P, M

× New Parts

PARTS LIST

Parts without Parts No. are not supplied.

Les articles non mentionnes dans le Parts No. ne sont pas fournis.

Telle ohne Parts No. werden nicht gellefert.

430/440M TX-RX UNIT (X57-3590-XX)
1200M TX-RX UNIT (X57-3600-11)

Ref. No.	Address	New	Parts No.	De	escription		Desti-	Re-
参照番号	位 置	Parts 新	部品番号	部品	名/規	格		marks 備考
IC10 91 92 93			KCH07 3SK184(S) 2SK582 3SK184(S) DTC114EK	IC(430MHZ VC FET FET FET DIGITAL TRAN				
95 96 ,7 98 99 910 ,11			2SC2714(Y) FMA5 2SA1362(Y) DTC144WK 2SC2712(Y)	TRANSISTOR TRANSISTOR TRANSISTOR DIGITAL TRAN TRANSISTOR	SISTOR			
012 013 -15 016 017 018			2SB1119(S) DTC144EK 2SD1757K 2SC2712(Y) 2SC3123	TRANSISTOR DIGITAL TRAN TRANSISTOR TRANSISTOR TRANSISTOR	SISTOR			
919 920 921			FMG1 2SD1760(0) 2SJ106(GR)	TRANSISTOR TRANSISTOR FET				
		1	1200M TX-RX U	NIT (X57-36	00-11)			
200	2G		A10-1316-01	CHASSIS				
201	3G		B42-2437-04	LABEL(S/NO)				
C1 C2 -5 C7 C8 C9			CC73FCH1H22OJ CK73FB1H471K CC73FCH1H10OD CC73FSL1H101J CC73FCH1H1R5B	CHIP C CHIP C CHIP C CHIP C CHIP C	22PF 470PF 10PF 100PF 1.5PF	J K D J B		
C10 ,11 C12 C13 C14 C15			CC73FCH1H470J CK73FB1E103K CC73FCH1H1R5B CC73FSL1H101J CK73FB1H471K	CHIP C CHIP C CHIP C CHIP C CHIP C	47PF 0.01UF 1.5PF 100PF 470PF	J K B J K		
C17 C18 C19 C21 ,22 C23			CC73FSL1H101J CC73FCH1H1R5B CE04NW1C470M CK73FB1H471K CC73FCH1H030C	CHIP C CHIP C ELECTRO CHIP C CHIP C	100PF 1.5PF 47UF 470PF 3PF	J B 16WV K C		
C24 C25 C26 C27 C28			CC73FCH1H1R5C CK73FB1H102K CK73FB1H471K CK73FB1E223K CC73FCH1H080D	CHIP C CHIP C CHIP C CHIP C CHIP C	1.5PF 1000PF 470PF 0.022UF 8PF	C K K K D		
C29 C30 C31 C32 C33			CK73FB1E103K CC73FCH1H030C CC73FSL1H101J CC73FCH1H030C CK73FB1H471K	CHIP C CHIP C CHIP C CHIP C CHIP C	0.01UF 3PF 100PF 3PF 470PF	C C K		
C34 C35 C36 C37 C38 -41			CK73FB1H472K CK73FB1H102K CC73FCH1H150J CC73FCH1H220J CK73FB1E103K	CHIP C CHIP C CHIP C CHIP C	4700PF 1000PF 15PF 22PF 0.01UF	K K J K		
C42 C43,44			CE04NW1C470M CK73EF1C105Z	ELECTRO CHIP C	47UF 1.OUF	16WV Z		

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

* New Parts

Parts without Parts No. are not supplied.

Les articles non mentionnes dans le Parts No. ne sont pas fournis.

Telle ohne Parts No. werden nicht geliefert.

1200M TX-RX UNIT (X57-3600-11)

Ref. No.	Address	- 1	Parts No.		De	scription		Re-
参照番号	位置	Parts 新	部品番号	部	品	名/規	格	mark: 備考
C45 C46 C47 C48 C49			C92-0002-05 CK73FB1E104K CK73FB1H471K C92-0504-05 C92-0004-05	CHIP TAN CHIP C CHIP C CHIP TAN ELECTRO		0.22UF 0.10UF 470PF 0.68UF 1.0UF	35WV K K 20WV 16WV	-
C50 C51 C52 C53 C54			CK73FB1E223K CK73EF1C105Z CC73FCH1H030C CK73FB1E473K CE04NW1C470M	CHIP C CHIP C CHIP C CHIP C ELECTRO		0.022UF 1.0UF 3PF 0.047UF 47UF	K Z C K 16WV	
C55 C56 C57 C58 ,59 C60			CK73EF1C105Z CK73FB1E223K CK73FB1H471K CE04NW1C101M CK73FB1H471K	CHIP C CHIP C CHIP C ELECTRO CHIP C		1.0UF 0.022UF 470PF 100UF 470PF	Z K K 16WV K	
C61 C62,63 C64 C65 C66			CE04NW1A330M CK73FB1E103K CE04NW1C101M CC73GCH1H030C CC73GCH1H101J	ELECTRO CHIP C ELECTRO CHIP C CHIP C		33UF 0.01UF 100UF 3PF 100PF	10WV K 16WV C J	
C67,68 C69 C70 C71 C72			CC73GCH1H020C CC73GCH1H101J CC73GCH1H050C CK73EF1C105Z CE04NW1E100M	CHIP C CHIP C CHIP C CHIP C ELECTR®		2.0PF 100PF 5PF 1.0UF	C J C Z 25WV	
C73 ,74 C75 C76 C77 C78 -80			CK73FB1H471K CK73GB1H471K CK73FB1H471K CK73FB1E103K CK73FB1H471K	CHIP C CHIP C CHIP C CHIP C		470PF 470PF 470PF 0.01UF 470PF	K K K K	
C81 C82 -83 C84 C85 C86			CK73EF1C105Z CK73FB1H471K CK73FB1H471K CE04NW1E100M CK73EF1C105Z	CHIP C CHIP C CHIP C ELECTRO CHIP C		1.0UF 470PF 470PF 10UF 1.0UF	Z K K 25₩V Z	
C87 ,88 C89 ,90 C91 C92 C93 ,94			CK73GB1H471K CK73FB1H471K CE04NW1C470M CC73FCH1H470J CK73FB1H471K	CHIP C CHIP C ELECTRO CHIP C CHIP C		470PF 470PF 47UF 47PF 470PF	K K 16WV J K	
C95 C96 C97 C98			CC73FCH1H010C CC73FCH1H100D CK73FB1H471K CM73F2H470J CC73FSL1H101J	CHIP C CHIP C CHIP C CHIP C CHIP C		1PF 10PF 470PF 47PF 100PF	C D K J	
C100 C101 C102-104 C105 C106			CK73FB1E103K CC73FCH1H080D CK73FB1H471K CC73FCH1HR75B CK73FB1H471K	CHIP C CHIP C CHIP C CHIP C		0.01UF 8PF 470PF 0.75PF 470PF	K D K B K	
C107 C108-110 C111 C112 C113			CC73FSL1H101J CK73FB1H471K CC73FSL1H101J CK73FB1H471K CK73FB1H102K	CHIP C CHIP C CHIP C CHIP C		100PF 470PF 100PF 470PF 1000PF	J K J K K	

A: TM-742 K, P, M, M2, E, E2, 🗵

* New Parts

PARTS LIST

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Teile ohne Parts No. werden nicht geliefert.

1200M TX-RX UNIT (X57-3600-11)

Ref. No.	Address		Parts No.	Description Desti- R	Re-
参照番号	位置	Parts 新	部品番号	部晶名/規格 仕向f	iai K s
C114-116 C117 C118 C119 C120			CK73FB1H471K CK73GB1H102K CK73FB1E103K CC73FSL1H101J CC73FUJ1H221J	CHIP C 470PF K CHIP C 1000PF K CHIP C 0.01UF K CHIP C 100PF J CHIP C 220PF J	
C123-125 C126-130 C131 C132 C133			CK73FB1H471K CK73FB1H471K CK73GB1H103K CK73GB1H471K CK73FB1E103K	CHIP C 470PF K CHIP C 470PF K CHIP C 0.01UF K CHIP C 470PF K CHIP C 0.01UF K	
C134-137 C138 C139 C140 C141,142			CK73FB1H471K CE04NW0J470M CC73FSL1H101J CK73FB1E104K CK73FB1H471K	CHIP C 470PF K ELECTRO 47UF 6.3WV CHIP C 100PF J CHIP C 0.10UF K CHIP C 470PF K	
C144,145 C147-156 C157 C158 C159			CC73FSL1H101J CC73GCH1H101J CK73GB1H102K CK73FB1H102K CC73FSL1H101J	CHIP C 100PF J CHIP C 100PF J CHIP C 1000PF K CHIP C 1000PF K CHIP C 100PF J	
- - 203 CN1 , 2	3H		E22-0672-04 E22-0673-04 E23-0467-05 E30-3011-05 E40-5461-05	TERMINAL BOARD(-) TERMINAL BOARD(+) TERMINAL ANT. CABLE PIN CONNECTOR(12P)	
J1			E11-0442-05	PHONE JACK	
204 - 205 - 207	3H 2G 1G		F10-1444-03 F10-1445-04 F10-1446-04 F10-1457-14 F10-1475-04	SHIELDING COVER SHIELDING(VCO) SHIELDING(MODULE) SHIELDING CASE SHIELDING COVER(MODULE)	
- - 211 215	3G 3G		G02-0599-04 G02-0706-04 G11-0654-04 G11-0655-04 G11-0660-04	FLAT SPRING(IC) FLAT SPRING(ANT) SHEET(VC@ 30X20) SHEET(CN1,CN2 55X8) SHEET(VC@ 25X10)	
- - 214	1G		G11-0661-04 G13-1319-04 G53-0508-04	INSULATION SHEEON FORMED PLATE NON-WEVERN FABRIC	
217	2H		J42-0471-04	DC CORD BUSHING	
CD1 CF1 L1 ,2 L4			L79-1013-05 L72-0366-05 L79-1015-05 L34-4259-05 L71-0280-05	FILTER CERAMIC FILTER FILTER COIL MCF	
L6 L7 L8 X1 X2			L34-2034-05 L40-3982-19 L40-5682-19 L77-1375-05 L77-1376-25	COIL(VXO) SMALL FIXED INDUCTOR(0.39UH) SMALL FIXED INDUCTOR(0.56UH) CRYSTAL RESONATOR(59.245MHZ) TCXO(12.8MHZ)	
W N U	2G		N09-2077-05 N87-2606-46 N88-2606-46	SCREW BRAZIER HEAD TAPTITE SCREW FLAT HEAD TAPTITE SCREW	

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

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1200M TX-RX UNIT (X57-3600-11)

Ref. No.	Address N				Description			Desti-	Re-
参照番号	位	Par		部		格		nation 仕 向	mark 備考
R1 ,2 R4 R5 R6 R7			RK73FB2A222J RK73FB2A473J RK73GB1J473J RK73FB2A560J RK73FB2A221J	CHIP R CHIP R CHIP R CHIP R CHIP R	2.2K 47K 47K 56 220	J J J	1/10W 1/10W 1/16W 1/10W		
R9 R10 R11 R13 R14			RK73FB2A472J RK73FB2A153J RK73FB2A471J R92-0670-05 RK73GB1J180J	CHIP R CHIP R CHIP R CHIP R	4.7K 15K 470 O OHM 18	J J J	1/10W 1/10W 1/10W		
R15 R16 R17 R19 R20			RK73FB2A101J RK73FB2A331J RK73FB2A100J RK73FB2A151J RK73FB2A101J	CHIP R CHIP R CHIP R CHIP R	100 330 10 150 100	J J J	1/10W 1/10W		
R21 R22 R23 R24 R25			R92-0670-05 RK73FB2A331J RK73FB2A224J RK73FB2A561J RK73FB2A103J	CHIP R CHIP R CHIP R CHIP R	0 0HM 330 220K 560 10K	J J	1/10W		
R26 R27			RK73FB2A473J RK73FB2A471J	CHIP R	47K 470	J J			
R29 R30 R31			R92-0670-05 RK73FB2A221J RK73FB2A472J	CHIP R CHIP R CHIP R	0 0HM 220 4.7K	J J	1/10W 1/10W		
R32 R33 R34 R35 R36 ,37			RK73FB2A222J RK73FB2A334J RK73FB2A223J RK73FB2A182J RK73FB2A103J	CHIP R CHIP R CHIP R CHIP R CHIP R	2.2K 330K 22K 1.8K 10K	J J J	1/10W 1/10W 1/10W		
R38 R39 -41 R42 R43 -45 R46			RK73FB2A102J RK73FB2A103J RK73FB2A474J RK73GB1J472J RK73FB2A684J	CHIP R CHIP R CHIP R CHIP R CHIP R	1.0K 10K 470K 4.7K 680K	J J J	1/10W 1/10W 1/16W		
R47 R48 R49 R50 R51			RK73FB2A823J RK73FB2A331J RK73FB2A102J RK73FB2A472J RK73FB2A472J	CHIP R CHIP R CHIP R CHIP R CHIP R	82K 330 1.0K 4.7K 1.0K]]]	1/10W 1/10W 1/10W		
R52 R53 R54 R55 R56			RK73FB2A560J RK73GB1J271J RK73GB1J103J RK73GB1J222J RK73GB1J471J	CHIP R CHIP R CHIP R CHIP R CHIP B	56 270 10K 2.2K 470	I I I	1/16W 1/16W		
R57 R58 R59 R60 R61 ,62			RK73FB2A100J RK73FB2A152J RK73FB2A683J R92-0670-05 RK73FB2A220J	CHIP R CHIP R CHIP R CHIP R	10 1.5K 68K 0 ©HM 22	J J	1/10W		
R63 R64 R65 R66 ,67 R68			RK73GB1J472J RK73GB1J222J RK73GB1J471J RK73FB2A180J R92-0670-05	CHIP R CHIP R CHIP R CHIP R CHIP R	4.7K 2.2K 470 18 0 @HM]]]	1/16W 1/16W		

A: TM-742 K, P, M, M2, E, E2, E3

× New Parts

PARTS LIST

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Teile ohne Parts No. werden nicht gellefert.

1200M TX-RX UNIT (X57-3600-11)

Ref. No. Address No.			Parts No.	Description	Re-
参照番号	位置	Parts 新	部品番号	部品名/規格	mark 備考
R69 R70 R71 R72 R73			RK73FB2A333J R92-1201-05 R92-0670-05 R92-1264-05 RK73FB2A472J	CHIP R 33K J 1/10W SILID 220 1/2W CHIP R 0 0HM FIXED RESISTOR CHIP R 4.7K J 1/10W	i
R74 R75 R76 R77 R78			R92-0700-05 RK73FB2A470J RK73FB2A222J R92-0670-05 RK73GB1J271J	CHIP R 180 1/2W CHIP R 47 J 1/10W CHIP R 2.2K J 1/10W CHIP R 0 0HM CHIP R 270 J 1/16W	
R79 ,80 R81 R82 R83 VR1			RK73FB2A103J RK73FB2A471J R92-0670-05 RK73FB2A4R7J R12-6429-05	CHIP R 10K J 1/10W CHIP R 470 J 1/10W CHIP R 0 0HM CHIP R 4.7 J 1/10W TRIMMING POT.100K	
VR2 VR3 VR4 VR5			R12-6421-05 R12-6427-05 R12-6423-05 R12-6427-05	TRIM POT. 4.7K TRIM POT. 47K TRIM POT. 10K TRIM POT. 47K	
D1 D3 D4 D5 D6			MA862 MA716 1SS193 02CZ6.2(X,Y) 1SS193	DIQDE DIQDE DIQDE DIQDE DIQDE	
D7 D8 D9 D10 -13			155187 02CZ12(X,Y) HSK151 MI808 DSA3A1	DIQDE DIQDE DIQDE DIQDE	
D15 D17 D19 IC2 IC3			02CZ3.6(Y,Z) DAP202U MI808 KCD04 KCX03	DIODE DIODE DIODE IC(FM IF) IC(AUTO LOCK TUNING(ALT))	
IC4 IC5 IC5 IC6 IC7			KCA04 BU4094BF XRU4094BF LA5009M KCB09	IC(MIC AMPLIFIER) IC(SHIFT/STORE REGISTER) IC(SHIFT/STORE REGISTER) IC(LOE SATURATION REGULATOR) IC(1200MHZ PRE DRIVE)	
IC8 IC9 IC10 IC11 IC12			KCB10 KCC04 M67711 KCH03 NJM78L05UA	IC(POWER AMP) IC(APC) IC(POWER MODULE/ 1.24-1.3BHZ) IC(1.2GHz VCO PLL) IC(VOLTAGE REGULATOR/ +5V)	
IC12 91 92 93 96			RC78L05UA MGF1502 2SC4095(R47.6) 3SK184(S) 2SC3356	IC IC TRANSISTOR FET TRANSISTOR	
97 98 99 910 911			2SC3120 2SA1362(Y) 2SB1302(S) DTC144WK FMW1	TRANSISTOR TRANSISTOR TRANSISTOR DIGITAL TRANSISTOR TRANSISTOR	

A: TM-742 K, P, M, M2, E, E2, E3 B: TM-942 K, P, M

PARTS LIST

× New Parts

Parts without Parts No. are not supplied.

Les articles non mentionnes dans le Parts No. ne sont pas fournis.

Telle ohne Parts No. werden nicht geliefert.

1200M TX-RX UNIT (X57-3600-11)

Ref. No. Address Ne			Parts No.	Description	Desti- nation	mark
参照番号	位置	新	部品番号	部品名/規格	仕 向	備考
912 ,13 915 -17 918 919 920			2SC2712(Y) DTC144EU 2SD1757(K) 2SA1362(Y) DTC124EK	TRANSISTOR DIGITAL TRANSISTOR TRANSISTOR TRANSISTOR DIGITAL TRANSISTOR		
921 ,22 923 924 925 926			2SC4226(R23,24) 2SC2712(Y) 2SD1760(0) FMG1 2SJ106(GR)	TRANSISTOR TRANSISTOR TRANSISTOR TRANSISTOR FET		
928			DTC114EK	DIGITAL TRANSISTOR		
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A: TM-742 K, P, M, M2, E, E2, t3

× New Parts

PARTS LIST

Parts without Parts No. are not supplied.

Les articles non mentionnes dans le Parts No. ne sont pas fournls.

Teile ohne Parts No. werden nicht geliefert.

28M TX-RX UNIT (X57-3790-01)

Ref. No.	Address	lew Parts No.	Description	on ·	Desti- Re
参照番号	P	arts 新 部 品 番 号	部品名/		nation man 仕 向備
		28M TX-RX UI	NIT (X57-3790-01)		
200	2G	A10-1325-11	CHASSIS	-	
201	3G	B42-2437-04	LABEL(S/NO,UNIT)		
C1 C2 ,3 C4 C5 C9		CC45SL2H18/1J CC45SL2H221J CC45SL2H271J CC45SL2H151J CK778GB1H103K	CERAMIC 180PF CERAMIC 220PF CERAMIC 270PF CERAMIC 150PF CHIP C 0.01U]]	
C10 C11 ,12 C13 C14 ,15 C16		CK73FB1E103K CK73GB1H103K CK73FB1E103K CK73GB1H103K CK73FB1E103K	CHIP C 0.01U	F K F K F K	
C17 C18 C19 C20 C21 -24		CC73GCH1H22OJ CK73GB1H1O3K CC73FCH1HO3OC CK73GB1H1O3K CK73FB1E1O3K	CHIP C 22PF CHIP C 0.01U CHIP C 3PF CHIP C 0.01U CHIP C 0.01U	C F K	
C25 C26 C28 C29 C30 ,31		CC73FSL1H101J CK73FB1E103K CE04NW1C470M CK73GB1H103K CK73EF1C105Z	CHIP C 100PF CHIP C 0.01U ELECTRO 47UF CHIP C 0.01U CHIP C 1.0UF	F K 16WV F K	
C32 C33 C34 C35 C36		C92-0003-05 CK73FB1E104K C92-0504-05 CE04NW1C470M CK73FB1E103K	CHIP TAN 0.47U CHIP C 0.10U CHIP TAN 0.68U ELECTRO 47UF CHIP C 0.01U	F K F 20WV 16WV	
C37 C38 C39 C40 C41		CC73GCH1H330J CE04NW1C470M CK73FB1E103K C92-0004-05 CK73FB1E103K	CHIP C 33PF ELECTRO 47UF CHIP C 0.01U ELECTRO 1.0UF CHIP C 0.01U	16WV	
C42 C43 ,44 C45 C46 C47		CE04NW1E100M CK73FB1E103K CK73FB1E103K CE04NW1C470M CK73FB1E103K	ELECTR® 10UF CHIP C 0.01U CHIP C 0.01U ELECTR® 47UF CHIP C 0.01U	F K 16WV	
C48 C49 C50 C51 C52		CK73FB1H822K CK73FB1H102K CC73FCH1H270J CC73FUJ1H100D CK73EF1C105Z	CHIP C 8200P CHIP C 1000P CHIP C 27PF CHIP C 10PF CHIP C 1.0UF	F K J D	
C53 C54 C55 -57 C58 C59		CK73FB1E103K CK73FB1H102K CK73FB1E103K CE04NW1E100M CE04NW1A330M	CHIP C 0.01U CHIP C 1000P CHIP C 0.01U ELECTRO 10UF ELECTRO 33UF	F K	
C60 C61 C62 C63 C64		CK73FB1E103K CE04NW1A221M CC73FCH1H030C CK73FB1E103K CK73FB1E103K	CHIP C 0.01U ELECTRO 220UF CHIP C 3PF CHIP C 0.01U CHIP C 0.01U	10WV C F K	

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

Parts without Parts No. are not supplied.

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Telle ohne Parts No. werden nicht geliefert.

28M TX-RX UNIT (X57-3790-01)

Ref. No. Address N			Parts No.	D	escription		Re- mark
号 番 服 参	位置	Parts 新	部品番号	部 品	名/規	格	備者
C65 C66 C67 C68 ,69			CC73FCH1H180J CK73FB1E103K CE04NW1C101M CK73FB1E103K CK73FB1H223K	CHIP C CHIP C ELECTRO CHIP C CHIP C	18PF 0.01UF 100UF 0.01UF 0.022UF	J K 16WV K	
C71 C72 C73 C74 C75			CK73FB1E103K CK73EF1C105Z CE04NW1E100M CK73FB1E103K CK73EF1C105Z	CHIP C CHIP C ELECTRO CHIP C CHIP C	0.01UF 1.0UF 10UF 0.01UF 1.0UF	K Z 25WV K Z	
C76 C77 C79 ,80 C81 C82			CK73FB1H223K CK73FB1E103K CK73FB1E103K CK73FB1H102K CE04NW1E330M	CHIP C CHIP C CHIP C CHIP C ELECTRO	0.022UF 0.01UF 0.01UF 1000PF 33UF	K K K 25WV	
C83 C84 C85 C86 C87			CK73FB1E103K CM73F2H102J CM73F2H271J C93-0509-05 CC73FCH1H330J	CHIP C CHIP C CHIP C CERAMIC CHIP C	0.01UF 1000PF 270PF 6800PF 33PF] K	
C88 C89 C90 C91 C92 -96			C93-0509-05 CK73FB1E103K CC73FCH1H040C CC73FCH1H0R5C CK73FB1E103K	CERAMIC CHIP C CHIP C CHIP C CHIP C	6800PF 0.01UF 4PF 0.5PF 0.01UF	К С С К	
C97 C98 C99 C100 C101			CC73FCH1H080C CC73FSL1H101J CC73FCH1H820J CK73FB1E103K CC73FCH1H0R5C	CHIP C CHIP C CHIP C CHIP C CHIP C	8.0PF 100PF 82PF 0.01UF 0.5PF	C J K C	
C102-111 C112,113 C114 C115 C116			CC73FSL1H101J CK73FB1E103K CK73GB1H103K CK73FB1E103K CK73FB1E103K	CHIP C CHIP C CHIP C CHIP C	100PF 0.01UF 0.01UF 0.01UF 0.01UF	Ј К К К	
C117 C118 C119 C120 C121			CK73FB1H102K CE04NW1E100M CK73FB1E103K CC73GCH1H680J CC73GCH1H151J	CHIP C ELECTRO CHIP C CHIP C CHIP C	1000PF 10UF 0.01UF 68PF 150PF	K 25WV K J J	
C122,123 C124,125 C126 C127 C129			CC73GCH1H151J CK73FB1E103K CK73GB1H102K CK73FB1E103K CC73FCH1H560J	CHIP C CHIP C CHIP C CHIP C	150PF 0.01UF 1000PF 0.01UF 56PF	Ј К К К Ј	
C133 C137 C138 TC1			CC73FCH1H680J CC73FCH1H040C CC73GCH1H181J C05-0345-05	CHIP C CHIP C CHIP C TRIMMING CA	68PF 4PF 180PF P 10PF	l C l	
203 CN1 ,2 J1 TP2	3H		E22-0673-04 E30-3009-15 E40-5461-05 E11-0442-05 E23-0465-05	TERMINAL BO ANT CABLE PIN ASSY(12 PHONE JACK TERMINAL(TP	P)		

A: TM-742 K, P, M, M2, E, E2, E3

× New Parts

PARTS LIST

Parts without Parts No. are not supplied.

Les articles non mentionnes dans le Parts No. ne sont pas fournis.

Telle ohne Parts No. werden nicht geliefert.

28M TX-RX UNIT (X57-3790-01)

	T 1	28M IX-RX UNII (A5						
Ref. No.	Address New Parts		Description	nation	Re- marks			
参照番号	位置新	部品番号	部品名/規格	仕 向	備考			
205 - 204 -	2H 1G	F10-2006-14 F10-2009-04 F10-2010-03 F10-2012-04 F12-0421-04	SHIELDING PLATE(FINAL) SHIELDING PLATE(L TYPE) SHIELDING COVER SHIELDING CASE (VCO-PLL) CONDUCTIVE SHEET(25.4X43)					
- -		F12-0422-04 F20-1008-04 F20-1090-04	CONDUCTIVE SHEET(25.4X15) INSULATING BOARD(APC) INSULATING BOARD(60X22)					
209	3G 3G	G02-0600-14 G02-0715-04 G02-0718-04 G02-0720-04 G11-0655-04	FLAT SPRING(THERMAL SWITCH) FLAT SPRING(APC TR) FLAT SPRING(VCO) FLAT SPRING(FRONT) CONDUCTIVE RUBBER(CN1,CN1 55X8					
- - 216	3G	G11-0661-04 G13-0841-04 G13-1319-04 G13-1337-04	INSULATING SHEET(APC TR) CUSHION(XTAL) CUSHION(VCO) CUSHION(VCO)					
206 217	2H 2H	J30-0583-14 J42-0471-04	SPACER(FINAL) DC CORD BUSHING					
CD1 CF1 L1 L2 -4 L5		L79-1013-05 L72-0372-05 L34-4283-05 L34-4284-05 L34-4285-05	FILTER CERAMIC FILTER(CFWM455F) COIL(7.5T) COIL(10.5T) COIL(1ST IF)					
L6 L7 L8 L9 L10		L40-6891-19 L40-1001-19 L34-1355-05 L40-6882-19 L40-3982-19	SMALL FIXED INDUCTOR(6.8UH) SMALL FIXED INDUCTOR(10UH) COIL(10.5T) SMALL FIXED INDUCTOR(0.68UH) SMALL FIXED INDUCTOR(0.39UH)					
L11 L12 L13 L14 L15		L34-1361-05 L34-1354-05 L34-1352-05 L34-1363-05 L34-1351-05	COIL(4.5T) COIL(8.5T) COIL(8T) COIL(2T) COIL(7T)					
L16 L17 L18 L19 L20 ,21		L34-1364-05 L34-1356-05 L34-1355-05 L33-0741-05 L34-1355-05	COIL COIL COIL CHOKE COIL COIL(10.5T)					
L22 ,23 L24 L25 L27 X1		L40-5691-19 L40-3982-19 L40-1001-19 L40-1892-19 L77-1465-05	SMALL FIXED INDUCTOR(5.6UH) SMALL FIXED INDUCTOR(0.39UH) SMALL FIXED INDUCTOR(10UH) SMALL FIXED INDUCTOR(1.8UH) CRYSTAL RESONATOR(9.285MHZ)					
XF1		L71-0422-05	CRYSTAL FILTER(8.83MHZ)					
T N Ø U	1H 2H,3G,3H 2H 1G,1H	N09-2179-05 N87-2606-46 N87-2608-46 N88-2606-46	SCREW(x3) BRAZIER HEAD TAPTITE SCREW BRAZIER HEAD TAPTITE SCREW FLAT HEAD TAPTITE SCREW		-			
R1 R2 R3 R4		RK73FB2A472J RK73FB2A103J RK73FB2A472J RK73FB2A680J	CHIP R 4.7K J 1/10W CHIP R 10K J 1/10W CHIP R 4.7K J 1/10W CHIP R 68 J 1/10W					

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

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28M TX-RX UNIT (X57-3790-01)

Ref. No.	Address		Parts No.		Description				Re- mark
参照者号	位置	Parts 新	部品番号	部	品 名/規	格		t 向	備考
R5 R6 R7 ,8 R9			RK73FB2A271J RK73FB2A680J RK73GB1J104J RK73GB1J682J RK73GB1J154J	CHIP R CHIP R CHIP R CHIP R	270 68 100K 6.8K 150K	J J J	1/10W 1/10W 1/16W 1/16W 1/16W		
R11 R12 R13 -15 R16 R17			RK73GB1J470J RK73GB1J103J RK73GB1J104J RK73GB1J100J RK73FB2A101J	CHIP R CHIP R CHIP R CHIP R CHIP R	47 10K 100K 10 100	J J J	1/16W 1/16W 1/16W 1/16W 1/10W		
R18 R19 ,20 R21 R22 R23			RK73FB2A473J RK73FB2A102J RK73FB2A223J RK73GB1J152J RK73FB2A101J	CHIP R CHIP R CHIP R CHIP R CHIP R	47K 1.0K 22K 1.5K 100	J J J	1/10W 1/10W 1/10W 1/16W 1/10W		
R24 R25 R26 R27 R28			RK73FB2A472J RK73FB2A391J RK73FB2A563J RK73FB2A223J RK73FB2A331J	CHIP R CHIP R CHIP R CHIP R CHIP R	4.7K 390 56K 22K 330	J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R29 R30 R31 R32 R33			RK73FB2A334J RK73FB2A222J RK73FB2A274J RK73FB2A101J RK73FB2A221J	CHIP R CHIP R CHIP R CHIP R CHIP R	330K 2.2K 270K 100 220	J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R34 R35 R36 R37 R38 ,39			RK73FB2A103J RK73FB2A104J RK73FB2A473J RK73FB2A471J RK73FB2A471J	CHIP R CHIP R CHIP R CHIP R CHIP R	10K 100K 47K 470 4.7K]]] J			
R40 R41 R42 R43 R44			RK73FB2A103J RK73FB2A474J RK73FB2A103J RK73FB2A223J RK73FB2A223J	CHIP R CHIP R CHIP R CHIP R CHIP R	10K 470K 10K 22K 27K	J J J			
R45 R46 -48 R49 R50 R51			RK73FB2A182J RK73FB2A103J RK73FB2A182J RK73FB2A184J RK73FB2A223J	CHIP R CHIP R CHIP R CHIP R CHIP R	1.8K 10K 1.8K 180K 22K	J J J	1/10W 1/10W 1/10W		
R52 R53 R54 ,55 R56 -58 R60			RK73FB2A103J RK73FB2A223J RK73FB2A102J RK73FB2A473J RK73FB2A471J	CHIP R CHIP R CHIP R CHIP R CHIP R	10K 22K 1.0K 47K 470	I I I	1/10W		
R61 R62 R63 R64 ,65 R66			RK73FB2A105J RK73FB2A104J RK73FB2A103J RK73FB2A222J RK73FB2A102J	CHIP R CHIP R CHIP R CHIP R CHIP R	1.0M 100K 10K 2.2K 1.0K	J J J	1/10W 1/10W 1/10W		
R67 R68 R69 R70 R72			RK73FB2A122J RK73FB2A220J R92-0670-05 RK73FB2A104J RK73FB2A221J	CHIP R CHIP R CHIP R CHIP R CHIP R	1.2K 22 0 WHM 100K 220	J J	1/10W 1/10W		

A: TM-742 K, P, M, M2, E, E2, E3

* New Parts

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28M TX-RX UNIT (X57-3790-01)

Ref. No.	Address				Desti- I	Re-
参照番号	位 置	Parts 新	部品番号	部品名/規格 仕		備考
R73 R74 R75 R77 R78 ,79			RK73FB2A220J RK73FB2A221J RK73FB2A470J R92-1213-05 RK73FB2A223J	CHIP R 22 J 1/10W CHIP R 220 J 1/10W CHIP R 47 J 1/10W CARBON 100 J 1/2W CHIP R 22K J 1/10W		
R80 R81 R82 R83 R84			R92-0699-05 RK73FB2A103J RK73GB1J222J RK73FB2A471J R92-1215-05	SOLID 10 1/2W CHIP R 10K J 1/10W CHIP R 2.2K J 1/16W CHIP R 470 J 1/10W CHIP R 470 J 1/2W		
R85 R88 R89 -92 R93 ,94 R95			RK73FB2A123J RK73FB2A102J R92-1252-05 R92-0670-05 R92-0679-05	CHIP R 12K J 1/10W CHIP R 1.0K J 1/10W CHIP R 0 0HM CHIP R 0 0HM CHIP R 0 0HM		
R96 -98 R99 R100-103 R104 R105,106			R92-0670-05 R92-1217-05 R92-0670-05 RK73FB2A472J R92-0670-05	CHIP R 0 0HM CHIP R 0 CHIP R 0 0HM CHIP R 4.7K J 1/10W CHIP R 0 0HM		
R108 R111 R115,116 VR1 VR2			RK73FB2A681J R92-0670-05 R92-0670-05 R12-6429-05 R12-6427-05	CHIP R 680 J 1/10W CHIP R 0 0HM CHIP R 0 0HM TRIMMING POT.100K TRIM POT. 47K		
VR3 VR4			R12-6421-05 R12-6423-05	TRIM POT. 4.7K TRIM POT. 10K		
TS1			S79-0401-05	THERMAL SWITCH(95°C)		
D1 ,2 D3 -6 D7 D8			MA77 1SV228 DAN235(K) 1SS184 DAN235(K)	DIODE DIODE DIODE DIODE		
D10 D11 D12 D13 ,14			1SS181 UM9401 MI308 1SS226 DSA3A1	DIQDE DIQDE DIQDE DIQDE		
D16 ,17 IC1 IC1 IC2 IC3			1SS184 BU4094BF XRU4094BF KCH09 KCA04	DIODE IC(SHIFT/STORE REGISTER) IC IC(28MHZ PLL)PLL) IC(MIC AMPLIFIER)		
IC4 IC5 IC6 IC7 IC8			KCB16 KCC04 KCD04 LA5009M KCB17	IC(DRIVE AMP (28-30MHZ)) IC(APC) IC(FM IF) IC(LOE SATURATION REGULATOR) IC(PRE AMP(50M BAND))		
IC9 91 92 93 94 ,5			KCD05 3SK179(L) 3SK131(V12) 2SC2714(Y) DTC144EU	IC(AM IF) FET FET TRANSISTOR DIGITAL TRANSISTOR		

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

Parts without Parts No. are not supplied.

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28M TX-RX UNIT (X57-3790-01) 28 SUB UNIT (X58-3840-01) 50 TX-RX UNIT (X57-3800-01)

Ref. No.	Address Ne		Description	Desti- Re- nation marks
参照番号	Par 位置		部品名/規格	仕 向 備考
96 ,7 98 99 910 911		DTA114EK 2SC2714(Y) 2SJ106(GR) 2SA1362(Y) 2SB1119(S)	DIGITAL TRANSISTOR TRANSISTOR FET TRANSISTOR TRANSISTOR	
012 013 014 015 -17		DTC144WK FMW1 2SC2712(Y) DTC144EK 2SD1757(K)	DIGITAL TRANSISTOR TRANSISTOR TRANSISTOR DIGITAL TRANSISTOR TRANSISTOR	
919 920 921 922 923		2SK208(Y) 2SC2714(Y) 2SC2712(Y) FMG1 2SD1902R	FET TRANSISTOR TRANSISTOR TRANSISTOR TRANSISTOR TRANSISTOR	
924 925 926 927		2SC2712(Y) DTA114EK DTC143EK DTC144EK	TRANSISTOR DIGITAL TRANSISTOR DIGITAL TRANSISTOR DIGITAL TRANSISTOR	
Z1		X58-3840-01	SUB UNIT(28MHZ 50W)	
C201	Т	CC73FCH1H471J	CHIP C 390PF J	SUB28
C202,203 C204		CK73FB1H152K CM73F2H241J	CHIP C 1500PF K CHIP C 240PF J	SUB28 SUB28
L201 L202		L34-1357-05 L40-1001-19	COIL (2T) SMALL FIXED INDUCTOR(10UH)	SUB28 SUB28
R201		R92-0686-05	CHIP R 33 J 1/2W	SUB28
9201 9202		2SC1971 2SC3240	TRNSISTOR TRNSISTOR	SUB28 SUB28
		50 TX-RX UNI	Γ (X57-3800-01)	
200	2G	A10-1325-11	CHASSIS	
201	3G	B42-2437-04	LABEL(S/NO,UNIT))	
C1 C2 C3 C4 C5		CC45SL2H750J CC45SL2H560J CC45SL2H680J CC45SL2H101J CC45SL2H680J	CERAMIC 75PF J CERAMIC 56PF J CERAMIC 68PF J CERAMIC 100PF J CERAMIC 68PF J	
C6 C7 C8 C9		CC45SL2H12OJ CC45SL2H15OJ CC45SL2H03OC CK73GB1H103K CK73FB1E103K	CERAMIC 12PF J CERAMIC 15PF J CERAMIC 3.0PF C CHIP C 0.01UF K CHIP C 0.01UF K	
C11 ,12 C13 C14 ,15 C16 C17		CK73GB1H103K CK73FB1E103K CK73GB1H103K CK73FB1E103K CC73GCH1H120J	CHIP C 0.01UF K CHIP C 0.01UF K CHIP C 0.01UF K CHIP C 0.01UF K CHIP C 12PF J	
C18 C19 C20 C21 -24		CK73GB1H103K CC73FCH1H060D CK73GB1H103K CK73FB1E103K	CHIP C 0.01UF K CHIP C 6PF D CHIP C 0.01UF K CHIP C 0.01UF K	

A: TM-742 K, P, M, M2, E, E2, E3

× New Parts

PARTS LIST

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Telle ohne Parts No. werden nicht geliefert.

50 TX-RX UNIT (X57-3800-01)

elle onne Parts No. werden nicht geliefert.						50 IX-	KX UNIT	IT (X57-3800-0		
Ref. No.		Parts	Parts No.			scription	**	Desti- nation	Re- mark	
参照番号	位置	新	部品番号	部	益	名/規	格	仕 向	備考	
C25 C26 C27 C28 C29			CK73FB1H102K CK73FB1E103K CC73FCH1H040C CE04NW1C470M CK73GB1H103K	CHIP C CHIP C CHIP C ELECTRO CHIP C		1000PF 0.01UF 4PF 47UF 0.01UF	K K C 16WV K			
C30 ,31 C32 C33 C34 C35			CK73EF1C105Z C92-0003-05 CK73FB1E104K C92-0504-05 CE04NW1C470M	CHIP C CHIP TAN CHIP C CHIP TAN BLECTRO		1.0UF 0.47UF 0.10UF 0.68UF 47UF	Z 25WV K 20WV 16WV			
C36 C37 C38 C39 C40			CK73FB1E103K CC73GCH1H100D CE04NW1C470M CK73FB1E103K C92-0004-05	CHIP C CHIP C ELECTRO CHIP C ELECTRO		0.01UF 10PF 47UF 0.01UF 1.0UF	K D 16WV K 16WV			
C41 C42 C43 ,44 C45 C46			CK73FB1E103K CE04NW1E100M CK73FB1E103K CK73FB1E103K CE04NW1C470M	CHIP C ELECTRO CHIP C CHIP C ELECTRO		0.01UF 10UF 0.01UF 0.01UF 47UF	K 25WV K K 16WV			
C47 -49 C50 C51 C52 C53			CK73FB1E103K CC73FCH1H270J CC73FCH1H120J CK73EF1C105Z CK73FB1E103K	CHIP C CHIP C CHIP C CHIP C CHIP C		0.01UF 27PF 12PF 1.0UF 0.01UF	K J Z K			
C54 C55 -57 C58 C59 C60			CK73FB1H102K CK73FB1E103K CE04NW1E100M CE04NW1A330M CK73FB1E103K	CHIP C CHIP C ELECTRO ELECTRO CHIP C		1000PF 0.01UF 10UF 33UF 0.01UF	K K 25WV 10WV K			
C61 C62 C63 ,64 C65 C66			CE04NW1A221M CC73FCH1H100D CK73FB1E103K CC73FCH1H150J CK73FB1E103K	ELECTRO CHIP C CHIP C CHIP C CHIP C		220UF 10PF 0.01UF 15PF 0.01UF	10WV D K J K			
C67 C68 ,69 C70 C71 C72			CE04NW1C101M CK73FB1E103K CK73FB1E223K CK73FB1E103K CK73EF1C105Z	ELECTRO CHIP C CHIP C CHIP C CHIP C		100UF 0.01UF 0.022UF 0.01UF 1.0UF	16WV K K K Z			
C73 C74 C75 C76 C77			CE04NW1E100M CK73FB1E103K CK73EF1C105Z CK73FB1E223K CK73FB1H681K	ELECTRO CHIP C CHIP C CHIP C CHIP C		10UF 0.01UF 1.0UF 0.022UF 680PF	25WV K Z K K			
C78 C79 ,80 C81 C82 C83			CC73FCH1H221J CK73FB1E103K CK73FB1H102K CE04NW1E330M CK73FB1E103K	CHIP C CHIP C CHIP C ELECTRO CHIP C		220PF 0.01UF 1000PF 33UF 0.01UF	J K K 25WV K			
C84 C85 C86 C87 C88			CM73F2H391J CM73F2H82OJ C93-0509-05 CC73FCH1H390J C93-0509-05	CHIP C CHIP C CERAMIC CHIP C CERAMIC		390PF 82PF 0.0068U 39PF 0.0068U	J		- The state of the	

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

* New Parts

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Teile ohne Parts No. werden nicht gellefert.

50 TX-RX UNIT (X57-3800-01)

Ref. No.	Address		Parts No.	De	scription		Desti- nation	Re- marks
参照番号	位置	Parts 新	部品番号	部品	名/規	格		備考
C89 C90 C91 C92 -96 C97			CK73FB1E103K CC73FCH1H02OC CC73FCH1H0R5C CK73FB1E103K CC73FCH1H02OC	CHIP C CHIP C CHIP C CHIP C	0.01UF 2.0PF 0.5PF 0.01UF 2.0PF	K C C K C		
C98,99 C100 C101 C102-111 C112-113			CC73FCH1H390J CK73FB1E103K CC73FCH1H0R5C CC73FSL1H101J CK73FB1E103K	CHIP C CHIP C CHIP C CHIP C CHIP C	39PF 0.01UF 0.5PF 100PF 0.01UF	J K C J K		
C114 C115,116 C117 C118 C119			CK73GB1H103K CK73FB1E103K CK73FB1H102K CE04NW1E100M CK73FB1E103K	CHIP C CHIP C CHIP C ELECTRO CHIP C	0.01UF 0.01UF 1000PF 10UF 0.01UF	K K K 25₩V K		
C124,125 C126 C127 C128 C130,131			CK73FB1E103K CK73GB1H102K CK73FB1E103K CC73GCH1H270J CC73FCH1H1R5C	CHIP C CHIP C CHIP C CHIP C	0.01UF 1000PF 0.01UF 27PF 1.5PF	К К К Ј		
C132 C133 C134 C135 C136			CC73FCH1H150J CC73FCH1H560J CC73GCH1H050C CC73FSL1H101J CK73FB1E104K	CHIP C CHIP C CHIP C CHIP C CHIP C	15PF 56PF 5PF 100PF 0.10UF	J C J K		
C138 C139,140 TC1			CC73GCH1H151J CC73FCH1H470J CO5-0345-05	CHIP C CHIP C TRIMMING CAP	150PF 47PF .10PF	J		
203 CN1 ,2 J1 TP2	3H		E22-0673-04 E30-3009-15 E40-5461-05 E11-0442-05 E23-0465-05	TERMINAL(+) ANT CABLE PIN ASSY(12P PHONE JACK TERMINAL(TP)				
205	2H 1G		F10-2006-14 F10-2009-04 F10-2010-03 F10-2012-04 F20-1008-04	SHIELDING PL SHIELDING PL SHIELDING CO SHIELDING CA INSULATING S	ATE(L T) VER SE(VCO-F	/PE) PLL)		
-			F20-1090-04	INSULATING S	HEET(60)	(22)		
209	3G 3G		G02-0600-14 G02-0705-04 G02-0715-04 G02-0718-04 G11-0655-04	FLAT SPRING(FLAT SPRING(FLAT SPRING(FLAT SPLING(CONDUCTIVE R	BPF COIL APC TR) VCO)	_)		
- - 216 214	3G 1G		G11-0661-04 G13-0841-04 G13-1319-04 G13-1337-04 G53-0508-04	INSULATING S CUSHION(XTAL CUSHION(VCO CUSHION(BPF PACKING) 22X15)			
206 217	2H 2H		J30-0583-14 J42-0471-04	SPACER(FINAL DC CORD BUSH				
CD1 CF1			L79-1013-05 L72-0372-05	FILTER CERAMIC FILT	ER(CFWM	455F)		

A: TM-742 K, P, M, M2, E, E2, E3 B: TM-942 K, P, M

* New Parts

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Telle ohne Parts No. werden nicht geliefert.

50 TX-RX UNIT (X57-3800-01)

Ref. No.	Address No		Description	Desti- Re-
参照番号	位置		部品名/規格	仕 向 備考
L1 L2 -4 L5 L6		L34-4281-05 L34-4283-05 L34-4251-05 L40-1582-19 L40-1001-19	COIL(YELLOW) COIL(WHITE) COIL(1ST IF) SMALL FIXED INDUCTOR(0.15UH) SMALL FIXED INDUCTOR(10UH)	
L8 L9 L10 L11 L12		L34-1347-05 L40-4782-19 L40-1882-19 L34-1344-05 L34-1354-05	COIL (6.5T) SMALL FIXED INDUCTOR(0.47UH) SMALL FIXED INDUCTOR(0.18UH) COIL (2.5T) COIL (8.5T)	
L13 L14 L15 L16 L17		L34-1352-05 L34-1345-05 L34-1346-05 L34-1364-05 L34-1349-05	COIL (8T) COIL (1T) COIL (4T) COIL (20.5T) COIL (5.5T)	
L18 L19 L20 ,21 L25 L26		L34-1348-05 L33-0742-05 L34-1347-05 L40-1001-19 L40-1582-19	COIL (5.5T) SMALL FIXED INDUCTOR(10UH) COIL (6.5T) SMALL FIXED INDUCTOR(10UH) SMALL FIXED INDUCTOR(0.15UH)	
L27 L28 X1 XF1		L40-1592-19 L40-2282-19 L77-1464-15 L71-0421-05	SMALL FIXED INDUCTOR(0.15UH) SMALL FIXED INDUCTOR(0.22UH) CRYSTAL RESONATOR(11.05MHZ) CRYSTAL FILTER(10.595MHZ)	
T N O U		N09-2179-05 N87-2606-46 N87-2608-46 N88-2606-46	SCREW (X3) BRAZIER HEAD TAPTITE SCREW BRAZIER HEAD TAPTITE SCREW FLAT HEAD TAPTITE SCREW	
R1 R2 R3 R4 R5		RK73FB2A472J RK73FB2A103J RK73FB2A472J RK73FB2A680J RK73FB2A271J	CHIP R 4.7K J 1/10W CHIP R 10K J 1/10W CHIP R 4.7K J 1/10W CHIP R 68 J 1/10W CHIP R 270 J 1/10W	
R6 R7 ,8 R9 R10 R11		RK73FB2A680J RK73GB1J104J RK73GB1J562J RK73GB1J154J RK73GB1J101J	CHIP R 68 J 1/10W CHIP R 100K J 1/16W CHIP R 5.6K J 1/16W CHIP R 150K J 1/16W CHIP R 100 J 1/16W	
R12 R13 -15 R16 R17 R18		RK73GB1J103J RK73GB1J104J RK73GB1J100J RK73FB2A101J RK73FB2A473J	CHIP R 10K J 1/16W CHIP R 100K J 1/16W CHIP R 10 J 1/16W CHIP R 10 J 1/16W CHIP R 47K J 1/10W	
R19,20 R21 R22 R23 R24		RK73FB2A102J RK73FB2A223J RK73GB1J152J RK73FB2A101J RK73FB2A152J	CHIP R 1.0K J 1/10W CHIP R 22K J 1/10W CHIP R 1.5K J 1/16W CHIP R 100 J 1/10W CHIP R 1.5K J 1/10W	
R25 R26 R27 R28 R30		RK73FB2A391J RK73FB2A563J RK73FB2A223J RK73FB2A331J RK73FB2A222J	CHIP R 390 J 1/10W CHIP R 56K J 1/10W CHIP R 22K J 1/10W CHIP R 330 J 1/10W CHIP R 2.2K J 1/10W	
R31		RK73FB2A274J	CHIP R 270K J 1/10W	

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

* New Parts

Parts without Parts No. are not supplied.

Les articles non mentionnes dans le Parts No. ne sont pas fournis.

Teile ohne Parts No. werden nicht geliefert.

50 TX-RX UNIT (X57-3800-01)

Ref. No.	Address		Parts No.	. De	escription			Desti- nation	Re- mark
参照番号	位置	Parts 新	部品番号	部品	名/規	格			備考
R32 R33 R34 R35 R36			RK73FB2A101J RK73FB2A221J RK73FB2A103J RK73FB2A334J RK73FB2A473J	CHIP R CHIP R CHIP R CHIP R CHIP R	100 220 10K 330K 47K	J J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R37 R38 R40 R41 R42			RK73FB2A471J RK73FB2A472J RK73FB2A103J RK73FB2A474J RK73FB2A103J	CHIP R CHIP R CHIP R CHIP R CHIP R	470 4.7K 10K 470K 10K	J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R43 R44 R45 R46 -48 R49			RK73F82A223J RK73F82A273J RK73F82A182J RK73F82A103J RK73F82A103J	CHIP R CHIP R CHIP R CHIP R CHIP R	22K 27K 1.8K 10K 1.8K	J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R50 R51 R52 R53 R54 ,55			RK73FB2A154J RK73FB2A223J RK73FB2A103J RK73FB2A223J RK73FB2A102J	CHIP R CHIP R CHIP R CHIP R CHIP R	150K 22K 10K 22K 1.0K	J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R56 -58 R59 ,60 R61 R62 R63			RK73FB2A473J RK73FB2A470J RK73FB2A105J RK73FB2A472J RK73FB2A183J	CHIP R CHIP R CHIP R CHIP R CHIP R	47K 47 1.0M 4.7K 18K	J J J	1/10W 1/10W 1/10W 1/10W 1/10W		
R64 ,65 R66 R67 R68 R69			RK73FB2A222J RK73FB2A102J RK73FB2A122J RK73FB2A220J R92-0670-05	CHIP R CHIP R CHIP R CHIP R CHIP R	2.2K 1.0K 1.2K 22 0 OHM	J J J	1/10W 1/10W 1/10W 1/10W		
R70 R72 R73 R74 R75			RK73FB2A104J RK73FB2A471J RK73FB2A120J RK73FB2A471J RK73FB2A470J	CHIP R CHIP R CHIP R CHIP R CHIP R	100K 470 12 2 470 47	J A J J	1/10W 1/10W 1/10W 1/10W		
R76 R77 R78 ,79 R80 R81			RK73FB2A472J R92-1213-05 RK73FB2A223J R92-0685-05 RK73FB2A222J	CHIP R CARBON CHIP R CHIP R CHIP R	4.7K 100 22K 22 2.2K	J J J J	1/10W 1/2W 1/10W 1/2W 1/10W		
R82 R83 R84 R86 R88			RK73GB1J332J RK73FB2A471J R92-1215-05 R92-1252-05 RK73FB2A102J	CHIP R CHIP R CHIP R CHIP R	3.3K 470 470 0 OHM 1.0K	J J J	1/16W 1/10W 1/2W		
R90 R93 ,94 R95 R96 -98 R99			RK73GB1J105J R92-0670-05 R92-0679-05 R92-0670-05 R92-1217-05	CHIP R CHIP R CHIP R CHIP R CHIP R	1.0M 0 0HM 0 0HM 0 0HM 0	J	1/16W		
R100-103 R104 R105,106 R108 R109			R92-0670-05 RK73FB2A472J R92-0670-05 RK73FB2A102J RK73GB1J473J	CHIP R CHIP R CHIP R CHIP R CHIP R	0 00HM 4.7K 0 0HM 1.0K 47K	J J	1/10W 1/10W 1/16W		

A: TM-742 K, P, M, M2, E, E2, 3

* New Parts

PARTS LIST

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50 TX-RX UNIT (X57-3800-01)

R110 R111 R112-114 R12-6429-05 R12-6427-05 R12-6427-05 R110 R110 R110 R110 R110 R110 R110 R1	
R110 R111 R112-114 VR1 VR2 R12-6427-05 R12-6427-05 R10 RK73FB2A221J RH73FB2A221J RH	间调写
R111 R112-114 VR1 VR2 R92-0670-05 R92-1252-05 R12-6429-05 R12-6427-05 CHIP R 0 0HM TRIM POT. 100K TRIM POT. 47K	
VR3 R12-6421-05 TRIM POT. 4.7K VR4 R12-6423-05 TRIM POT. 10K	
TS1 S59-0444-05 THERMAL SWITCH(90°C)	
D1 ,2 D3 -6 D7 D8 D9 D100E D100E D100E D100E D100E D100E D100E D100E D100E	
D10 D11 D12 D13,14 D15 D15 D10DE D10DE D10DE D10DE D10DE D10DE D10DE D10DE D10DE	
D16 ,17	
IC4	
IC9	
05 06 ,7 08 DTC144EU DIGITAL TRANSISTOR DTA114EK DIGITAL TRANSISTOR 2SC2714(Y) TRANSISTOR 09 2SJ106(GR) FET 2SA1362(Y) TRANSISTOR	
O11	
918	
923 2SD1902R TRNSISTOR 924 2SC2712(Y) TRNSISTOR 925 DTA114EK DIGITAL TRNSISTOR 926 DTC143EK DIGITAL TRNSISTOR	
Z1 X58-3840-03 SUB UNIT(50M 50W)	

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

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50 SUB UNIT (X58-3840-03) 220M TX-RX UNIT (X57-3810-10)

			it gener					ZUIVI I A-	RX UNIT ()	137-301	0-10
Ref. No.	Address	New Parts	P	arts	No.		Des	scription		Desti- nation	Re-
参照番号	位置	新	部	品	番 号	部	品	名/規	格		備考
			50 \$	SUB	UNIT	(X58-3840)-0	3)			
C201 C202 C203 C204				CH1F B1H4		CHIP C CHIP C CHIP C		390PF 220PF 470PF 91PF	J J K J	SUB50 SUB50 SUB50 SUB50	
L201 L202			L34-1 L40-1			COIL (2T) SMALL FIXE	D I	NDUCTOR	(10UH)	SUB50 SUB50	
9201 9202			25C19			TRNSISTOR TRNSISTOR				SUB50 SUB50	
		2:	20M ⁻	TX-I	RX UNI	T (X57-38	10	-10)			
200	2 G		A10-1	316-	-11	CHASSIS					
201	3 G		B42-2	437-	-04	LABEL(S/NO	, UN	IIT)			
C5 C7 -9 C10 C11 C12			CC73F CK73F CK73F CC73F CC73F	B1H1 B1E1 CH1H	102K 103K 10R5C	CHIP C CHIP C CHIP C CHIP C		3PF 1000PF 0.01UF 0.5PF 56PF	C K C J		
C14 C15 C17 C18 C19			CC73F CC73F CC73F CK73F CC73F	CH1F CH1F B1H1	1120J 1120J 102K	CHIP C CHIP C CHIP C CHIP C CHIP C		0.5PF 12PF 12PF 1000PF 6PF	C J J K D		
C20 C21 C22 C24 C25			CK73F CC73F CK73F CK73F CC45S	CH1H B1E1 B1E1	1060D 103K 103K	CHIP C CHIP C CHIP C CHIP C CERAMIC		1000PF 6PF 0.01UF 0.01UF 3.0PF	K D K K C		
C26 C29 C30 C31 C33			CK73F CK73F CC73F CK73F CK73F	B1E1 CH1F B1H1	103K 1150J 102K	CHIP C CHIP C CHIP C CHIP C CHIP C		1000PF 0.01UF 15PF 1000PF 0.10UF	к к Ј к		
C34 ,35 C36 ,37 C44 ,45 C46 C47			CK73E CK73E CE04N C92-0 CE04N	B1E1 W1C4)504-	103K 170M -05	CHIP C CHIP C ELECTRO CHIP TAN ELECTRO		1.0UF 0.01UF 47UF 0.68UF 47UF	Z K 16WV 20WV 16WV		
C48 C50 C51 ,52 C53 ,54			C92-0 CE04N CK73F CK73F CK73E	W1C4 B1E1 B1H1	170M 103K 102K	CHIP TAN ELECTRO CHIP C CHIP C CHIP C		0.47UF 47UF 0.01UF 1000PF 1.0UF	25WV 16WV K K Z		
C56 C57 C58 C59 ,60 C61			CC73F CK73F CC73F CK73F CE04N	B1H1 UJ1H B1H1	02K 1200J 102K	CHIP C CHIP C CHIP C CHIP C ELECTRO		15PF 1000PF 20PF 1000PF 47UF	J K J K 16WV		
C62 C63 C64 C65 C66			CK73F CK73F CE04N CE04N CK73F	B1E1 W1E1 W1A3	03K 100M 330M	CHIP C CHIP C ELECTRO ELECTRO CHIP C		1000PF 0.01UF 10UF 33UF 0.01UF	K K 25WV 10WV K		

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

* New Parts

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220M TX-RX UNIT (X57-3810-10)

Ref. No.	Address		Parts	No.		Description	on	Desti-	Re-
参照番号	位 置	Parts 新	部品	番号	部	品 名/	規格	nation 仕 向	mark 備考
C67 C68 ,69 C70 C71 -73 C74			CK73FB1H CC73FCH1 CK73FB1E CK73FB1H CK73FB1H	H100D 103K 102K	CHIP C CHIP C CHIP C CHIP C	1000P 10PF 0.01U 1000P 0.022	D F K F K		
C75 C76 C77 ,78 C79 C81			CE04NW1C CK73EF1C CK73FB1H CK73EF1C CC45SL2H	105Z 1102K 1105Z	ELECTRO CHIP C CHIP C CHIP C CERAMIC	100UF 1.0UF 1000P 1.0UF 18PF	Z F K		
C82 C83 C84 C85 C86			CK73FB1H CK45B2H1 CC45SL2H CC73FCH1 CC73FCH1	02K 1040C H0R5C	CHIP C CERAMIC CERAMIC CHIP C CHIP C	1000P 1000P 4.0PF 0.5PF 0.5PF	F K C C		
C87 C88 C89 C90 -92 C93			CC73FCH1 CC45SL2H CC45SL2H CK73FB1H CC73FCH1	1220J 1180J 1102K	CHIP C CERAMIC CERAMIC CHIP C CHIP C	2.0PF 22PF 18PF 1000P 0.5PF	J J F K		
C94 C95 C96 C97 C98			CM73F2HC CC73FCH1 CK73FB1E CC73FCH1 CK73FB1F	H020C 103K H150J	CHIP C CHIP C CHIP C CHIP C	5.0PF 2.0PF 0.01U 15PF 1000P	F K J		
C99 C100 C101 C102 C103			CE04NW1E CC73FCH1 CE04NW1E CC73FCH1 CK73FB1F	H010C 100M H470J	ELECTRO CHIP C ELECTRO CHIP C CHIP C	10UF 1PF 10UF 47PF 1000P	25WV C 25WV J		
C104 C105 C106 C108 C109,110			CK73FB1E CK73FB1E CC73FCH1 CC73FCH1 CK73FB1E	1223K 1H470J 1H390J	CHIP C CHIP C CHIP C CHIP C CHIP C	0.01U 0.022 47PF 39PF 1000P	UF K J J		
C111 C112 C113 C114,115 C116			CK73FB1E CE04NW1A CC73FSL1 CC73FSL1	1221M 1H100D 1H101J	CHIP C ELECTRO CHIP C CHIP C CHIP C	0.01U 220UF 10PF 100PF 6PF	1 O W V		
C119 C120-127 C128,129 C130 C131			CE04NW1E CC73FSL1 CK73FB1F CE04EW10 CC73FCH1	H101J H102K C102M	ELECTRO CHIP C CHIP C ELECTRO CHIP C	10UF 100PF 1000P 1000U 7PF	F K		
C133 C134 C135-137 C140 TC1			CC73FCH1 CK73FB1E CK73FB1E CC73FCH1 CO5-0371	103K 1102K 1H010C	CHIP C CHIP C CHIP C CHIP C TRIM CAP	10PF 0.01U 1000P 1PF			
203 - CN1 ,2 J1 J2	3Н		E30-3009 E72-0400 E40-5461 E11-0442 E23-0619	5-04 1-05 2-05	ANT CABLE TERMINAL E PIN ASSY(1 PHONE JACK TERMINAL(1	80ARD(+ 2P))		

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

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220M TX-RX UNIT (X57-3810-10)

Ref. No.	Address		Parts No.	Description		Re-
参照番号	位置	Parts 新	部品番号	部品名/規格	nation 仕 向	mark 備考
205 204 -	2G 1G		F10-1446-04 F10-2010-03 F10-2012-04 F20-1008-04	SHIELDING PLATE SHIELDING COVER SHIELDING CASE (VCO-PLL) INSULATING SHEET(APC)		
209	3G 3G		G02-0600-14 G02-0705-04 G02-0715-04 G02-0718-04 G11-0655-04	FLAT SPRING(THERMAL SWITCH) FLAT SPRING FLAT SPRING(APC TR) FLAT SPRING(VC0) SHEET(CN1,CN2 55X8)		
212 - - - 216	1 G 3 G		G11-0656-14 G11-0661-04 G13-0841-04 G13-1337-04 G13-1349-04	CONDUCTIVE RUBBER INSULATING SHEET(APC TR) CUSHION(XTAL) CUSHION(VCO) CUSHION(VCO) 22X7)		
213	3G		G13-1351-04	CUSHION(55X8)		
217	2H		J42-0471-04	DC CORD BUSHING		
CD1 CF1 L1 -4 L5 L6			L79-1013-05 L72-0372-05 L34-4279-05 L40-1082-19 L34-4280-05	FILTER CERAMIC FILTER(CFWM455F) COIL(1ST IF) SMALL FIXED INDUCTOR(0.1UH) COIL		
L10 L11 L12 L13 L14			L40-1582-19 L34-1239-05 L34-1207-05 L34-1208-05 L34-0908-05	SMALL FIXED INDUCTOR(0.15UH) COIL COIL COIL COIL		
L15 ,16 L19 L20 L21 L22			L34-0641-05 L40-8272-48 L40-1001-19 L40-1092-19 L40-3372-48	COIL SMALL FIXED INDUCTOR(82NH) SMALL FIXED INDUCTOR(10UH) SMALL FIXED INDUCTOR(1UH) SMALL FIXED INDUCTOR(33NH)		
X1 X2 XF1			L77-1405-05 L77-1463-05 L71-0420-05	CRYSTAL RESONATOR(12.8MHZ) CRYSTAL RESONATOR(30.37MHZ) CRYSTAL FILTER(30.825MHZ)		
W N U			N09-2077-05 N87-2606-46 N88-2606-46	SCREW(MODULE) BRAZIER HEAD TAPTITE SCREW FLAT HEAD TAPTITE SCREW		
R5 R6 R7 R8 R9			RK73FB2A333J RK73FB2A104J RK73FB2A101J RK73FB2A103J RK73FB2A101J	CHIP R 33K J 1/10W CHIP R 100K J 1/10W CHIP R 100 J 1/10W CHIP R 10K J 1/10W CHIP R 10K J 1/10W CHIP R 100 J 1/10W		
R10 -12 R13 R14 R18 R19			RK73FB2A104J RK73FB2A473J RK73FB2A103J RK73FB2A151J R92-0670-05	CHIP R 100K J 1/10W CHIP R 47K J 1/10W CHIP R 10K J 1/10W CHIP R 150 J 1/10W CHIP R 0 0HM		
R20 R21 R22 R23 R24			RK73FB2A122J RK73FB2A471J RK73FB2A101J RK73FB2A103J RK73FB2A473J	CHIP R 1.2K J 1/10W CHIP R 470 J 1/10W CHIP R 100 J 1/10W CHIP R 10K J 1/10W CHIP R 47K J 1/10W		

A: TM-742 K, P, M, M2, E, E2, 13

* New Parts

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220M TX-RX UNIT (X57-3810-10)

Ref. No.	Address	New Parts	Parts No.	Descri	iption		Desti- nation	Re- marks
参照番号	位置	新 新	部品番号	部品名	/規格			備考
R25 R31 R32 R33 ,34 R35			RK73FB2A103J RK73FB2A394J RK73FB2A103J R92-0670-05 RK73FB2A222J	CHIP R 100 CHIP R 100 CHIP R 100 CHIP R 100 CHIP R 2.5	DHW J	1/10W 1/10W 1/10W		-
R36 R37 R38 R39 -41 R42			RK73FB2A101J R92-0670-05 RK73FB2A182J RK73FB2A103J RK73FB2A182J	CHIP R 100 CHIP R 1.0 CHIP R 1.0 CHIP R 1.0 CHIP R 1.0	0HM 8K J K J	1/10W 1/10W 1/10W 1/10W		
R43 R44 R45 R46 R47			RK73FB2A223J RK73FB2A273J RK73FB2A473J RK73FB2A472J R92-0670-05	CHIP R 221 CHIP R 27 CHIP R 47 CHIP R 4. CHIP R 0	K J	1/10W 1/10W 1/10W 1/10W		
R49 R50 R52 -54 R55 R56			RK73FB2A223J RK73FB2A124J RK73FB2A473J RK73FB2A471J RK73FB2A104J	CHIP R 221 CHIP R 122 CHIP R 47 CHIP R 47 CHIP R 10	OK J K. J O J	1/10W 1/10W 1/10W 1/10W 1/10W		
R57 R59 R60 R61 R62			RK73FB2A105J R92-0670-05 RK73FB2A103J RK73FB2A471J R92-0670-05	CHIP R 0 CHIP R 10 CHIP R 47		1/10W 1/10W 1/10W		1
R63 ,64 R65 ,66 R67 R68 R69			RK73FB2A222J R92-0670-05 RK73FB2A122J RK73FB2A220J RK73FB2A102J	CHIP R 2. CHIP R 0. CHIP R 1. CHIP R 22 CHIP R 1.	0HM 2K J J	1/10W 1/10W 1/10W 1/10W		
R71 R73 R74 R75 R76 ,77			R92-0670-05 RK73FB2A104J R92-0679-05 RK73FB2A392J R92-0670-05	CHIP R 10 CHIP R 0 CHIP R 3.	0HM 0K J 9K J 9K J	1/10W 1/10W		
R78 R79 ,80 R81 R82 R83 -86			R92-1213-05 RK73FB2A223J RK73FB2A471J R92-0699-05 R92-0670-05	CARBON 10 CHIP R 22 CHIP R 47 SOLID 10 CHIP R 0	K J O J	1/2W 1/10W 1/10W 1/2W		
R89 R90 R91 R92 ,93			RK73FB2A332J RK73FB2A221J RK73FB2A473J RK73FB2A104J RK73FB2A223J	CHIP R 22 CHIP R 47	K J OK J	1/10W 1/10W 1/10W 1/10W 1/10W		
R99 R100 R101 VR1 VR2			RK73FB2A103J R92-0670-05 RK73FB2A102J R12-6429-05 R12-6427-05		OHM OK J OK	1/10W 1/10W		
VR3 ,4			R12-6423-05	TRIM POT. 10	К			
TS1			S79-0401-05	THERMAL SWITCH(95°C)			
DЗ			1SV164	DIODE				

A: TM-742 K, P, M, M2, E, E2, E3

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220M TX-RX UNIT (X57-3810-10)

Ref. No.	Address New		Description		e- ark:
参照番号	位置新		部品名/規格	仕 向 備	
D5 D7 D11 ,12 D13 D14		1SV164 1SV164 1SS184 DAN235(K) 1SS181	DIODE DIODE DIODE DIODE		
D15 D16 D17,18 D19 D20		MI407 MI308 1SS226 DSA3A1 1SV164	DIQDE DIQDE DIQDE DIQDE		
IC1 IC1 IC2 IC5 IC7		BU4094BF XRU4094BF LA5009M KCD04 KCA04	IC(SHIFT/STORE REGISTER) IC IC(LOE SATURATION REGULATOR) IC(FM IF) IC(MIC AMPLIFIER)		
IC8 IC9 IC10 IC11 91 ,2		KCB15 KCC04 M57774 KCH08 3SK184(S)	IC(DRIVE AMP (220M BAND)) IC(APC) IC(POWER MODULE/220-225MHZ) IC(220 PLL-VCO) FET		
03 010 011 012 013 ,14		2SC2714(Y) 2SA1362(Y) 2SB1119S DTC144WK 2SC2712(Y)	TRANSISTOR TRANSISTOR TRANSISTOR DIGITAL TRANSISTOR TRANSISTOR		
915 -17 918 919 920 921		DTC144EK 2SD1757(K) 2SK208(Y) 2SC2714(Y) 2SC2712(Y)	DIGITAL TRANSISTOR TRANSISTOR FET TRANSISTOR TRANSISTOR		
922 923 924		FMG1 2SD1902R 2SJ106(GR)	TRANSISTOR TRANSISTOR FET		
		UT	-28S		
300 303 305 309 311	1U 1T 1T 2U 1T	B41-0686-04 B42-2437-04 B42-2454-04 B42-3488-04 B62-0089-10	CAUTION LABEL(ADJUST) LABEL(S/NO,UNIT) LABEL(S/NO,ITEM CARTON BOX) LABEL(FREQUENCY) INSTRUCTION MANUAL		
313	2ป	E23-0657-04	TERMINAL		
315	10	G11-0665-04	SHEET(FAN CABLE)		
317 320 322 324 326	2T,1U 1T 2U 1T,1U 2T	H10-2726-03 H13-0855-04 H25-0029-04 H25-0760-04 H52-0130-04	POLYSTYRENE FOAMED FIXTURE PROTECTION BOARD PROTECTION BAG(60X110) PROTECTION BAG(200X350) ITEM CARTON BOX		
328	3T	H62-0110-04	OUTER PACKING CASE		
330	10	J69-0325-05	N RING		
335	10	N99-0355-15	SCREW SET		
340	1U,2T	X57-3790-01	TX-RX UNIT(28MHZ 50W)		

A: TM-742 K, P, M, M2, E, E2, E3

* New Parts

PARTS LIST

Parts without Parts No. are not supplied.
Les articles non mentionnes dans le Parts No. ne sont pas fournis.
Telle ohne Parts No. werden nicht gellefert.

UT-50S UT-220S UT-1200

Ref. No.	Address Ne	3	Description	Desti- Re-
号 番 照 參	位置新		部品名/規格	nation mark 仕 向 備考
	· · · · · · · · · · · · · · · · · · ·	UT-	50S	
300 303 305 309 311	1U 1T 1T 2U 1T	B41-0686-04 B42-2437-04 B42-2454-04 B42-3488-04 B62-0089-10	CAUTION LABEL(ADJUST) LABEL(S/NO,UNIT) LABEL(S/NO,ITEM CARTON BOX) LABEL(FREQUENCY) INSTRUCTION MANUAL	
313	2U	E23-0657-04	TERMINAL	
315	10	G11-0665-04	SHEET(FAN CABLE)	
317 320 322 324 326	1U,2T 1T 2U 1T,1U 2T	H10-2726-03 H13-0855-04 H25-0029-04 H25-0760-04 H52-0133-04	POLYSTYRENE FOAMED FIXTURE PROTECTION BOARD PROTECTION BAG(60X10) PROTECTION BAG(200X350) ITEM CARTON BOX	
328	3T	H62-0113-04	OUTER CARTON BOX	
330	10	J69-0325-05	Ø RING	
335	10	N99-0355-15	SCREW SET	
340	1U,2T	X57-3800-01	TX-RX UNIT(50M 50W)	
		UT-2	220S	
300 303 305 309 311	1U 1T 3T 2U 1T	B41-0686-04 B42-2437-04 B42-2454-04 B42-3488-04 B62-0089-10	CAUTION LABEL(ADJUST) LABEL(S/NO,UNIT) LABEL(S/NO,ITEM CARTON BOX) LABEL(FREQUENCY) INSTRUCTION MANUAL	
313	2U	E23-0657-04	TERMINAL	
315	10	G11-0665-04	SHEET(FAN CABLE)	
317 320 322 324 326	1U,2T 1T 2U 1T,1U 2T	H10-2726-03 H13-0855-04 H25-0029-04 H25-0760-04 H52-0136-04	POLYSTYRENE FOAMED FIXTURE PROTECTION BOARD PROTECTION BAG(60X110) PROTECTION BAG(200X350) ITEM CARTON BOX	
328	3Т	H62-0116-04	OUTER PACKING CASE	
330	10	J69-0325-05	© RING	
335	10	N99-0355-15	SCREW SET	
340	1U,2T	X57-3810-10	TX-RXUNIT(220MHZ 25W)	
		UT-1	1200	
300 303 305 309 311	1U 1T 1T 2U 1T	B41-0686-04 B42-2437-04 B42-2454-04 B42-3488-04 B62-0089-10	CAUTION LABEL(ADJUST) LABEL(S/NO) LABEL(S/NO.ITEM CARTON BOX) LABEL(FREQUENCY) INSTRUCTION MANUAL	
313	2U	E23-0657-04	TERMINAL	
315	1 U	G11-0665-04	SHEET(FAN CABLE)	
317 320 322	1U,2T 1T 2U	H10~2726-03 H13-0855-04 H25-0029-04	POLYSTYRENE FOAMED FIXTURE PROTECTION BOARD PROTECTION BAG(60X110)	

A: TM-742 K, P, M, M2, E, E2, E3

PARTS LIST

× New Parts

Parts without Parts No. are not supplied.

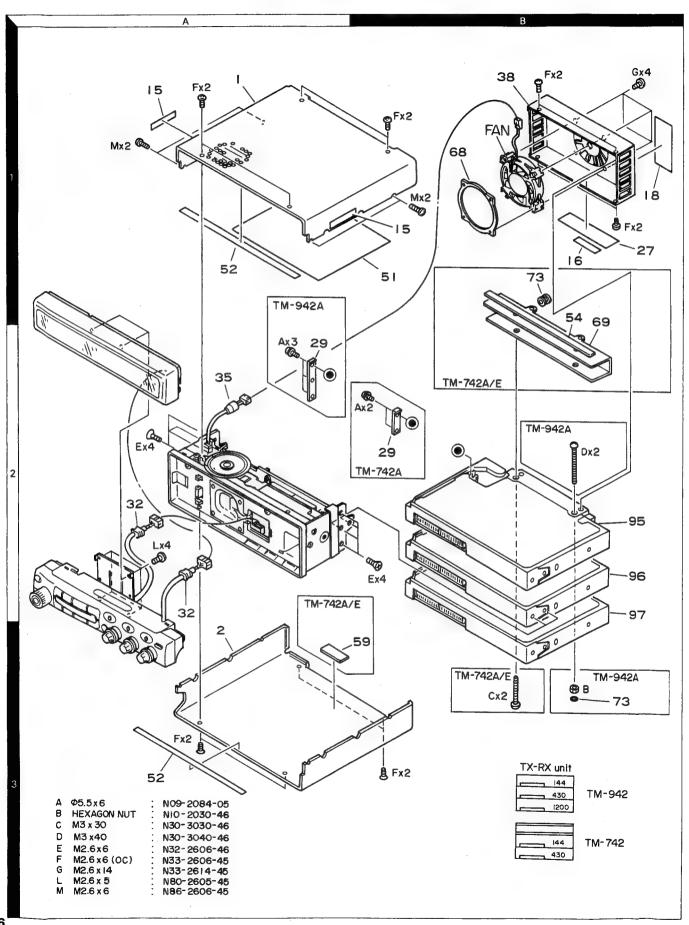
Les articles non mentionnes dans le Parts No. ne sont pas fournis.

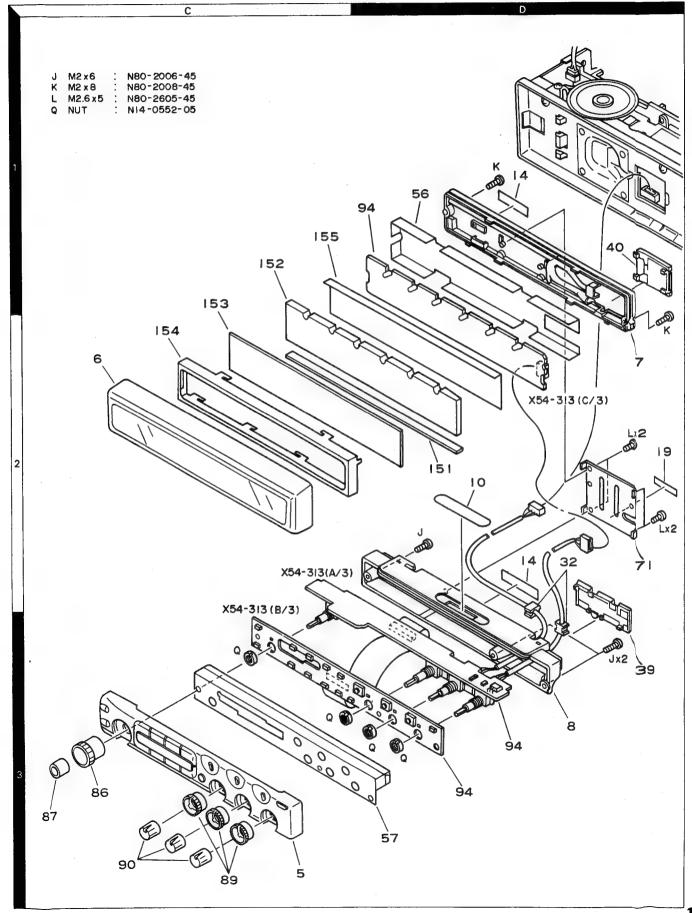
Teile ohne Parts No. werden nicht gellefert.

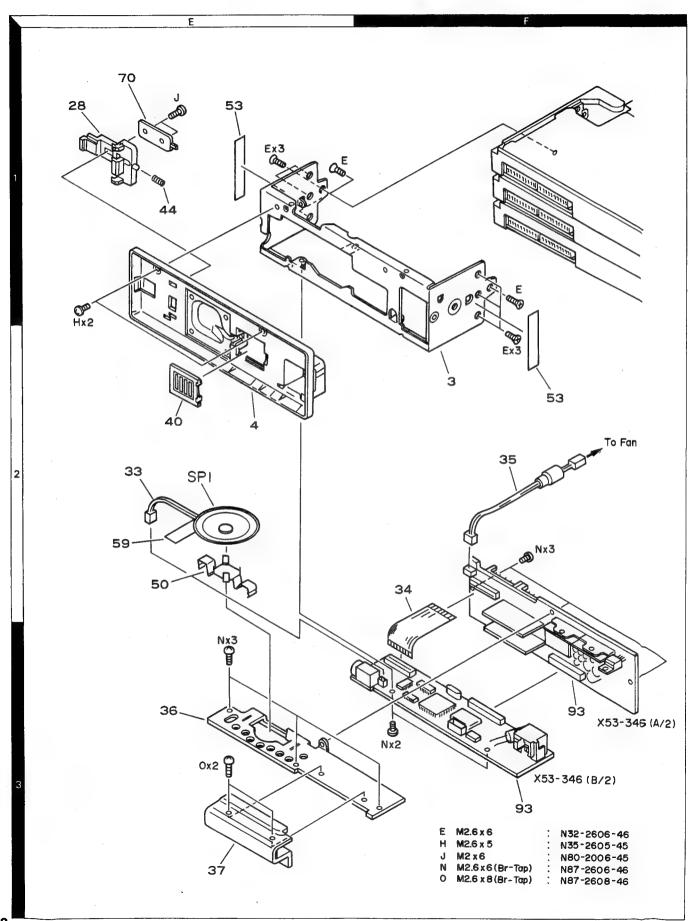
UT-1200

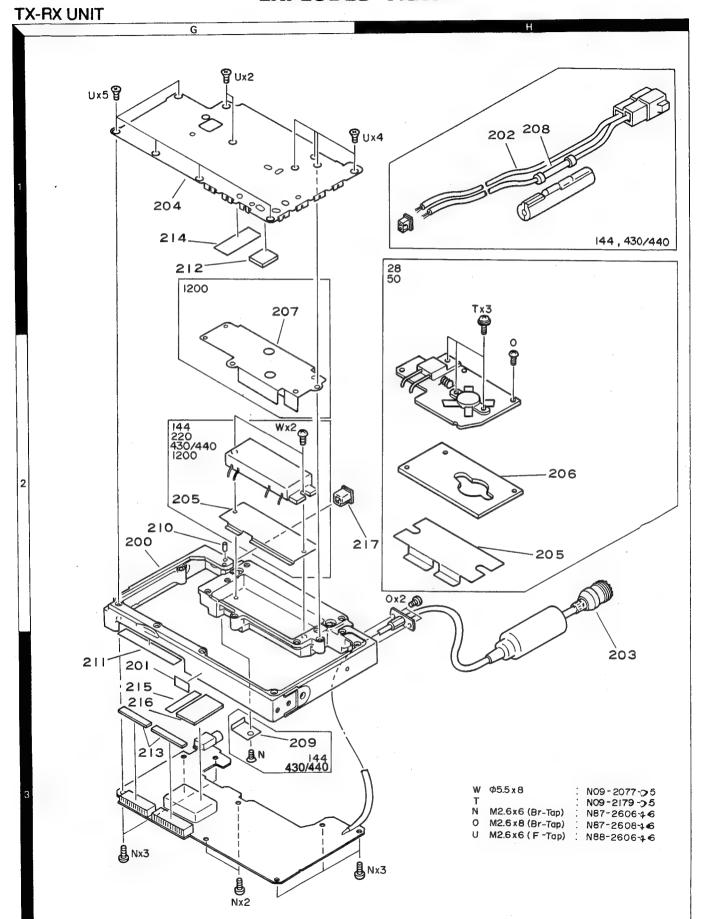
Ref. No.	Address New Parts		Description 45	nation	Re- mark
参照番号	位置新	部品番号	部品名/規格	仕 向	備考
324 326 328	1T,1U 2T 3T	H25-0760-04 H52-0112-04 H62-0101-04	PROTECTION BAG(200X350) ITEM CARTON BOX OUTER CARTON BOX		
330	10	J69-0325-05	0 RING		
335 340	1U 1U,2T	N99-0355-15 X57-3600-11	SCREW SET TX-RX UNIT (1200MHz 10W)		

A: TM-742 K, P, M, M2, E, E2, E3

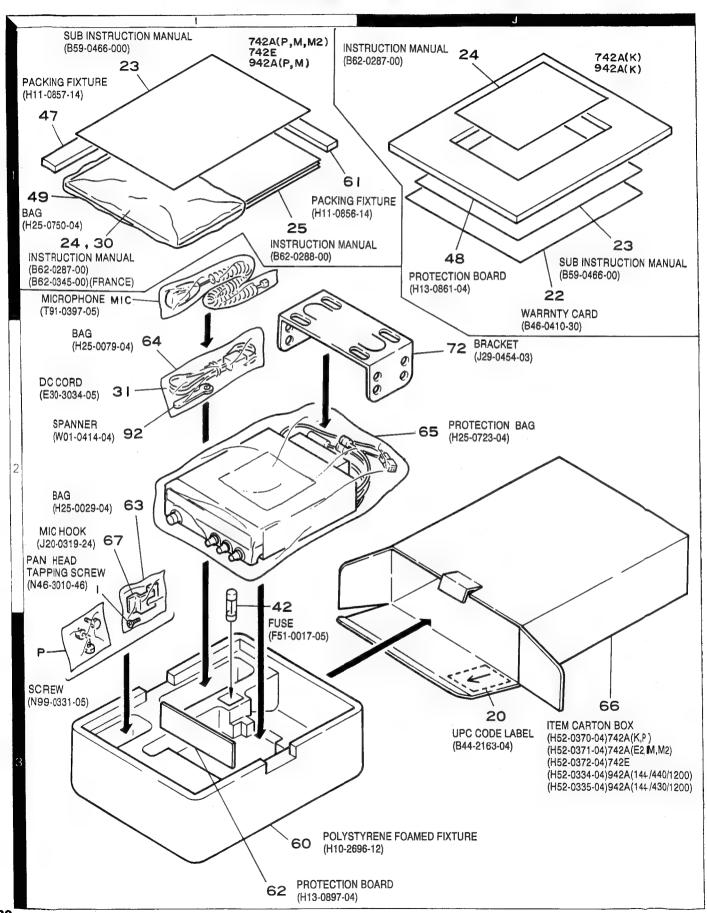




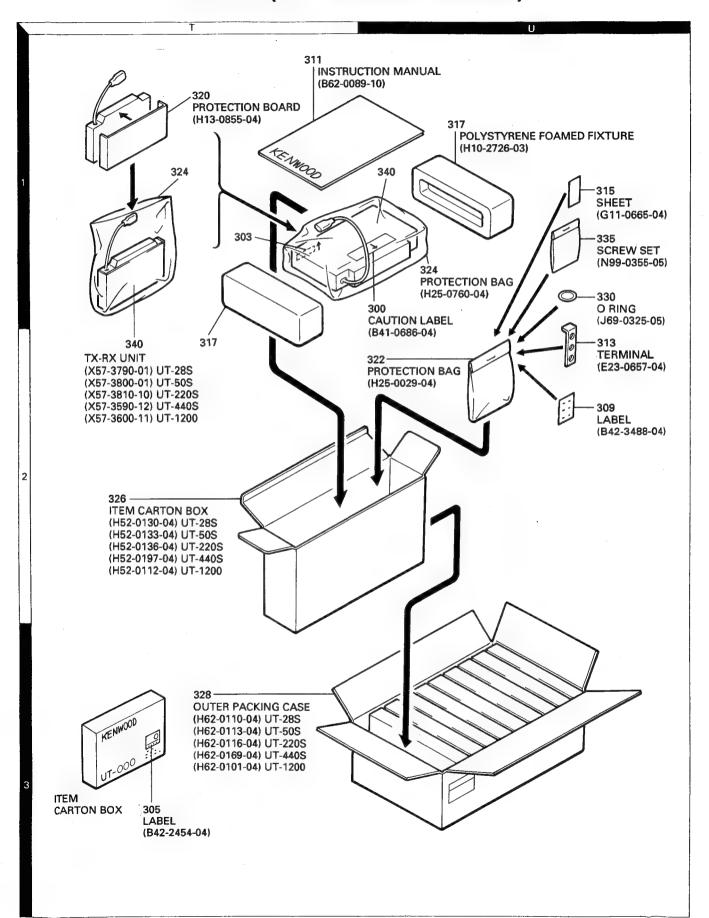




PACKING (UNIT)



TM-742 A/742 E/942 A PACKING (OPTIONAL BAND UNIT)



ADJUSTMENT

Required Test Equipment

Tester and DC V.M
 Use a tester with high input impedance.

2. RF VTVM (RF VM)

Input impedance: 1 M ohms or more, 2 pF or less Voltage range: FS = 10 mV to 300 V

Measurable frequency: 1,300 MHz (maximum)

Frequency counter (F counter)
 Input sensitivity: Approximately 50 mV
 Measurable frequency: 1,300 MHz or more

4. DC power supply

Voltage: 10 to 17 V (variable) Current: 12 A or more

5. Power meter

Power measurement ranges: 100 W, 50 W, and 15

W

Input impedance: 50 ohms Measurable frequency: 1,300 HMz

AF vacuum voltmeter (AF VM)
 Input impedance: 1 M ohms or more
 Voltage range: FS= 1 mV to 30 V
 Measurable frequency: 50 Hz to 10 kHz

7. AF generator (AG)

Output frequency: 100 Hz to 10 kHz Output voltage: 0.5 mV to 1 V

8. Linear detector

Measurable frequency: 1,300 MHz

Spectrum analyzer

Measurable frequency: 1,300 MHz

10. Directional coupler

11.Oscilloscope

Use a high-sensitivity oscilloscope with horizontal input socket.

12.SSG

Use an SSG that produces a frequency of 20 to 1,300 MHz with amplitude and frequency modulation.

Output level: 0.1 µV to 100 mV

13. Dummy resistor

Use an 8-ohm resistor exceeding the rated value in each band.

14. Noise generator

Use a noise generator whose output contains a high-frequency component of more than 1,300 MHz (near ignition noise).

15. Sweep generator

Use a sweep generator that can sweep the 1,300 MHz band.

16. Tracking generator

Preparation

 Set controls to the position shown in Table 23 unless otherwise specified.

POWER SW	OFF
AF VOL VR	MIN
SQL VOL VR	MIN

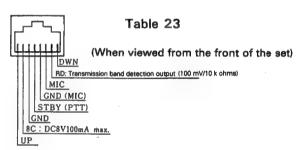


Fig. 55 Microphone Socket (on Front Panel)

- Use an insulated tool such as a plastic tool during adjustment (especially trimmer coil adjustment).
- For SSG protection, do not connect a microphone to the microphone socket during receiver block adjustment.
- Check that the power switch is off before the power cord is connected.
- The SSG output level is displayed at the release end.
 - After setting the various controls as shown in Table 23, make sure that the indications of the display and the LEDs are as shown in Figure 56 when the POWER switch is turned ON while pushing the MR key.

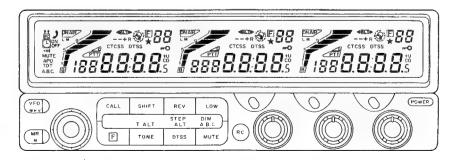


Fig. 56

ADJUSTMENT

• 144 MHz Band (TM-742 A/E, TM-942A) Common Section Adjustment

		Measurement point			Adjustment point				
Item	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification	
Lock voltage check	1. Frequency: 144.040MHz Receive	Digital voltmeter	TX-RX	TP2		1	Check the lock voltage.	1.8 ~ 3.0 V	

The DC power supply must be set to the rated voltage.

Receiver Section Adjustment

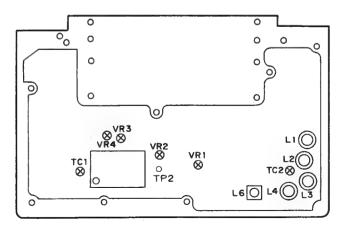
		Measure	ment p	oint		Adjust	ment point	
Item	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Bandpass filter (BPF) adjustment	1. Frequency: 144.040MHz SSG output: 0 dBµ Modulation: 1 KHz Deviation: 3 KHz Receive	Digital voltmeter SSG			TX-RX	L1-4	Adjust so that the voltmeter reading is maximum.	Voltmeter reading is maximum.
2. Receive sensitivity check	1. Frequency: 144.040 MHz 145.940 MHz 147.940 MHz SSG output: -9 dBµ Modulation: 1 KHz Deviation: 3 KHz	meter	Rear	EXT.SP			Check	12 dB SINAD or more
	2. AM sensitivity (K and P models only) Frequency: 118.040 MHz SSG output: 25 dBµ Modulation:1 KHz Deviation: 30%						Press the MHz key and check that the frequency is set to 118.040 with an encoder.	12 dB SINAD or more
	Press the MR key							·
3. Distortion factor adjustment	1. Frequency: 145.040 MHz SSG output: 40 dB _{\mu} Modulation: 1 KHz Deviation: 3 KHz AF output: 4V/8 ohms	Distortion factor Oscilloscope SSG	Rear panel	EXT.SP	TX-RX	L6	Minimize the distortion factor.	5% or less
4. Signal strength meter adjustment	1. Frequency: 145.040 MHz SSG output: 22dBµ Modulation: 1 KHz Deviation: 3 KHz	SSG			TX-RX	VR1	Adjust so that all LEDs go on, then one LED goes off.	
	2 SSG output 23 dBμ MOD: 1 kHz DEV: 3 kHz						Adjust the SSG output so that all signal strength meter LEDs go on.	The SSG outpuris 20 ± 6 dBµ
5. Squelch check	Frequency: 146.040 MHz SSG output: Off Modulation: 1 KHz Deviation: 3 KHz	SSG	Rear panel	EXT.SP			Set the SQL control to the closing position	Control position 8:00-11:00 BUSY should 30 out
	2 SSG output: -14dBμ MOD: 1 kHz DEV: 3 kHz							Squelch shoul open, and BUSY should light up
					1		SQL control fully clockwise	Noise should disappear
	3. SSG output: -3 dBμ							Squelch should open

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ADJUSTMENT

Transmitter Section Adjustment

		Measure	ment p	oint		Adjust	tment point	
Item	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Power adjustment (check)	1. Maximum power check Frequency: 136.000 MHz 145.980 MHz 147.980 MHz Transmit	Powermeter Ammeter	Rear Panel	ANT	TX-RX	VR3	Check	57 W or more
	High-power adjustment Transmit				TX-RX	VR3	Adjust. 54W	46 to 59 W (11.5 A or less)
	Medium-power adjust- ment Transmit				TX-RX	VR4	Adjust. 12W	10 to 14 W
	Low-power check Transmit						Check	3 to 8 W
2. Deviation adjustment (check)	1. Frequency: 145.980 MHz AG: 1 kHz, 50 mV (K, P, M) 28 mV (E) Filter: 25 15K Transmit	DC detector Oscilloscope	Rear Panel	ANT	TX-RX	VR2	Adjust (in the higher + or - direction). 4.2 KHz	± 4.0 to 5.0 KHz
	2. Frequency: 145.980 MHz AG: 1 KHz, 5.0 mV (K, P, M) 2.8 mV (E) Transmit						Check	±2.2 to 3 6 kHz
3. Tone check	1. Frequency: 144.980 MHz Tone On Transmit	DC detector Oscilloscope	Rear Panel	ANT			Check	± 0.5 to 1.5 kHz
4. Protection check	1. Frequency: 147.980 MHz Antenna: open Transmit	Ammeter					Check	12.0 A or less
5. Frequency adjustment	1. Frequency: 145.980 MHz Transmit	Frequency counter Powermeter			TX-RX	TC1	145.980 MHz	± 100 Hz



Note: Use an adjustment tool with a ceramic or plastic tip 1.5 mm square for L1 through L4.

Flg. 57 144 MHz band adjustment: Component layout (upper view)

ADJUSTMENT

• 430/440 MHz Band (TM-742A/E, TM-942A, UT-440S) Common Section adjustment

		Measurement point				Adjust	tment point		
ltem .	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification	
1. Lock voltage check	1. Frequency: 468.000 MHz Receive	Digital voltmeter	TX-RX	TP2			Check the lock voltage.	7.5 ~ 9.1 V (K, P) 7.0 ~ 9.5 V (E, M)	

Receiver Section Adjustment

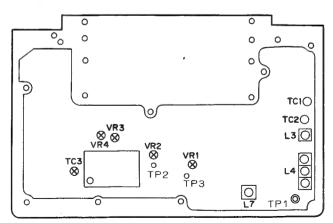
		Measure	ment p	oint		Adjus	tment point	
Item	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Helical scanning adjustment	1. Frequency: 445.050 MHz (K and P) 435.050 MHz (E, M) Spectrum analyzer: Center of above frequency Tracking generator: Output: -30 dBm	Digital voltmeter Spectrum analyzer Tracking generator			TX-RX	TC1, TC2, L3, L4X3	Adjust each frequer figure.	35 440 MHz (E, M, M2)
2. Receive sensitivity check	1. Frequency: 445.050 MHz (K and P) 435.050 MHz (E, M) SSG output: -9 dBµ Modulation: 1 KHz Deviation: 3 KHz	Distortion meter Millivoltmeter Oscilloscope SSG	Rear panel	EXT.SP			Check	12 dB SINAD or more
3. Distortion factor adjustment	1. Frequency: 445.050 MHz (K and P) 435.050 MHz (E, M) SSG output: 40 dBµ Modulation: 1 KHz Deviation: 3 KHz AF output: 4 V/8 ohms	Distorition meter Oscilloscope SSG	Rear panel	EXT.SP	TX-RX	L7	Minimize the distortion factor.	5% or less
4. Signal strength meter adjustment (check)	1. Frequency: 445.050 MHz (K and P) 435.050 MHz (E, M) SSG output: 23 dBµ Modulation: 1 KHz Deviation: 3 KHz	SSG			TX-RX	VR1		Adjust so that all LEDs go on, then one LED goes off.
	2. SSG output: 24 dBμ						Adjust the SSG output so that all signal strength meter LEDs go on.	The SSG output is 20 \pm 6 dB μ .
5. Squelch check	1. Frequency: 445.050 MHz (K and P) 435.050 MHz (E, M) SSG output: Off Modulation: 1 KHz Deviation: 3 KHz	SSG	Rear panel	EXT.SP			Set the SQL control to the closing position	Control position 8:00-11:00 BUSY should go out
	2. SSG output: -14 dBμ	· ·						Squelch should open, and BUSY should light up
							SQL control fully clockwise	Noise should disappear
	3. SGG output: -3 dBμ]			Squelch should open

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ADJUSTMENT

Transmitter Section Adjustment

		Measure	ment p	oint		Adjus	tment point	
ltem	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
1. Power adjustment (check)	Maximum power check Frequency: 445.000 MHz (K and P) 435.000 MHz (E, M) Transmit	Powermeter Ammeter	Rear panel	ANT	TX-RX	VR3	Check	38 W or more
	2. High power adjustment Frequency: 445,000 MHz (K and P) 435,000 MHz (E, M)				TX-RX	VR3	Adjust. 37W	31 to 42 W (10 A or less)
	3. Medium power adjustment Frequency: 445.000 MHz (K and P) 435.000 MHz (E, M) Transmit			-	TX-RX	VR4	Adjust. 13W	10 to 14 W
(K an 435.0 (E, 1) Transmit	Frequency: 445.000 MHz (K and P) 435.000 MHz (E, M)						Check	3 to 8 W
2. Deviation adjustment (check)	1. Frequency: 445.000 MHz (K and P) 435.000 MHz (E, M) AG: 1 kHz 50 mV (K, P M) 28 mV (E) Filter: 25 15K	DC detector Oscilloscope	Rear panel	ANT	TX-RX	VR2	Adjust (in the higher + or – direction), 4.2 KHz	± 4.0 to 5.0 KHz
	2. Frequency: 445.000 MHz (K and P) 435.000 MHz (E, M) AG: 1 KHz, 5.5 mV (K, P E, M) 2.8 mV (E) Transmit			·			Check	±2.2 to 3.6 kHz
3. Tone check	1. Frequency: 434.980 MHz (E, M) 448.200 MHz (K, P) Tone: On Transmit	DC detector Oscilloscope	Rear panel	ANT			Check	± 0.5 to 1.5 KHz
I. Protection check	1. Frequency: 449.980 MHz (K and P) 439.980 MHz (E, M) Antenna: Open Transmit	Ammeter					Check .	10 A or less
. Frequency adjustment	1. Frequency: 445.000 MHz (K and P) 435.000 MHz (E, M)	Frequency counter Powermeter			TX-RX	TC3	445.000 MHz K,P 435.000 MHz E, M, M2	± 500 Hz



1. The adjustment of the 430M BAND can be carried out by taking the 144M BAND unit out of the control unit.

Fig. 58 430 MHz band adjustment: Component layout (upper view)

ADJUSTMENT

• 1200 MHz Band (TM-942A, UT-1200)

Common Section Adjustment

		Measurement point			Adjustment point			
ltem	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Lock voltage check	1. Frequency: 1299.975 MHz Receive	Digital voltmeter	TX-RX	TP2	TX-RX IC11		Check the lock voltage.	6.1 ~ 6.9 V

Receiver Section Adjustment

		Measure	ment p	oint		Adjust	ment point	
ltem	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
1. ALT adjustment	1. Frequency: 1270.100 MHz	Digital voltmeter					Check the voltage.	AV
ŕ	The same as the above frequency. SSG: Off	SSG			TX-RX	VR2	Adjust so that the voltage is 0.1 V higher than above.	AV + 0.1 V
	3. The same as the above frequency. SSG output: 0 dBµ Modulation: 1 KHz Deviation: 3 KHz				TX-RX	L6	Check that the voltage is 0.2 V higher than above when ALT is on, then turn ALT off.	(A + 0.1) V + 0.2 V
2. Receive sensitivity check	1. Frequency: 1270.100 MHz SSG output: — 9 dBµ Modulation: 1 KHz Deviation: 3 KHz	Distortion meter Millivoltmeter Oscilloscope SSG	Rear panel	EXT.SP			Check	12 dB SINAD or more
3. Distortion adjustment	1. Frequency: 1270.100 MHz SSG output: 40 dBµ Modulation: 1 KHz Deviation: 3 KHz AF output: 4 V/8 ohms	Distortion meter Oscilloscope SSG	Rear panel	EXT.SP	TX-RX	L4	Minimize the distortion factor.	5% or less
4. Signal strength meter adjustment	1. Frequency: 1270.100 MHz SSG output: 24 dBµ Modulation: 1 KHz Deviation: 3 KHz	SSG			TX-RX	VR1		Adjust so that all LEDs go on, then one LED goes off.
(check)	2. SSG output: 25 dBµL						Adjust the SSG output so that all signal strength meter LEDs go on.	The SSG output is 20 \pm dB μ .
5. Squelch check	Frequency: 1270.100 MHz SSG output: Off Modulation: 1 KHz Deviation: 3 KHz	SSG	Rear	EXT.SP			Set the SQL control to the closing position	Control position 8:00-11:00 BUSY should go out
	2. SSG output: -14 dBμ MOD: 1 kHz DEV. 3 kHz							Squelch should open, and BUSY should light up
				l 			SQL control fully clockwise	Noise should disappear
	3. SSG output: -3 dBμ							Squelch should open

ADJUSTMENT

Transmitter Section Adjustment

		Measure	ement p	ooint		Adjus	tment point	
Item	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Power adjustment	1. Maximum power check Frequency: 1270.000 MHz Transmit	Powermeter Ammeter	Rear panel	ANT	TX-RX	VR4	Check	11 W or more
	2. High-power adjustment Frequency: 1270.000 MHz Transmit				TX-RX	VR4		8 to 14 W (6.5 A or less) the PTT switch is pressed. while after the PTT switch ops.)
	Low-power adjustment Frequency: 1270.000 MHz Transmit				TX-RX	VR5	Adjust 1 W	0.7 to 1.4 W
Deviation adjustment (check)	1. Frequency: 1270.000 MHz AG: 1kHz 50 mV (K, P M) 28 mV (E) Transmit	DC detector Oscilloscope	Rear panel	ANT	TX-RX	VR3	Adjust (in the higher + or – direction). 4.2 KHz	± 4.0 to 5.0 KHz
	2. Frequency: 1270.000 MHz AG: 1 KHz, 5.0 m v (K, P M) 2.8 mV (E) Transmit						Check	±2.2 to 3.6 kHz
3. Tone check	1. Frequency: 1279.98 MHz Tone: On Transmit	DC detector Oscilloscope	Rear panel	ANT			Check	± 0.5 to 1.5 KHz
4. Protection check	1. Frequency: 1240.000 MHz 1270.000 MHz 1299.980 MHz Antenna: Open Transmit						Check	8.5 A or less
5. Frequency check	1. Frequency: 1270.000 MHz Transmit	Frequency counter Powermeter					1270.000 MHz	± 1 KHz

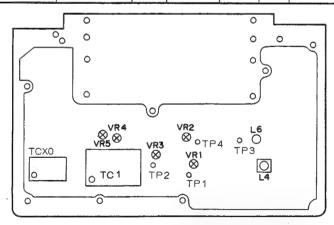


Fig. 59 1200 MHz band adjustment: Component layout (upper view)

The adjustment of the 12000MHz BAND can be carried out by taking the 144MHz BAND and 430MHz BAND units out of the control unit and by installing the 1200MHz BAND at the position of the 430MHz BAND (central part). Cord with alligator clip should be used to connect the power supply. Take care for the clip not to short-circuit with the casing.

ADJUSTMENT

28 MHz Band (UT-28S) Common Section Adjustment

		Measurement point Adjustment point						
Item	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Lock Voltage check	1. Frequency: 29.700MHz Receive	Digital voltmeter	TX-RX	TP3			Check the lock voltage	5.5 - 7.0 V

Receiver Section Adjustment

		Measure	ment p	point		Adjus	tment point	
Item	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Band pass filter (BPF) adjustment	1. Frequency: 29.700MHz SSG output: 0 dBµ Modulation: 1KHz Deviation: 3 KHz Receive	Digital voltmeter SSG	Rear panel	ANT	TX-RX	L1-4	Adjust so that the voltmeter reading is maximum	voltmeter reading is maximum
Distortion factor adjustment	1. Frequency: 28.890MHz SSG output: 60 dBµ Modulation: 1KHz Diviation: 3KHz	Distortion meter Oscilloscope SSG	Rear panel	EXT.SP	TX-RX	L5	Mınımize the distortion factor	5% or less
3. Receive sensitivity check	1. Frequency: 28.040MHz SSG output: -9 dBµ Modulation: 1KHz Deviation: 3 KHz	Distortion meter Millivoltmeter Oscilloscope SSG	Rear panel	EXT.SP			Check	12 dB SINAND or more
	2. Frequency: 29.700 MHz SSG output: -9 dBµ Modulation: 1KHz Deviation: 3 KHz		Rear	EXT.SP			Check	12 dB SINAND or more
	3. Frequency: 22.040 MHz SSG output: 20 dBµ Modulation: 1KHz Deviation: 3 KHz		Rear panel	EXT.SP			Check	12 dB SINAND or more
4. Signal strength meter adjustment	1. Frequency: 28.890 MHz SSG output: 24 dBµ Modulation: 1 KHz Deviation: 3 KHz	SSG			TX-RX	VR1	Adjust so that all LEDS go on, then one LED goes off.	
5. Signal strength meter check	2. Frequency: 28.890 MHz SSG output: 25 dBµ Modulation: 1 KHz Deviation: 3 KHz						Adjust the SSG output so that all signa strength meter LEDs go on.	The SSG output is 20 ± 6 dBµ
6. Squelch check	Frequency: 28.890 MHz SSG output: OFF	SSG	Rear panel	EXT.SP			Set the SQL control to the closing position	Control position 8:00-11:00 BUSY should go out
	2. Frequency: 28.890 MHz SSG output: -14 dBµ Modulation: 1 KHz Deviation: 3 KHz							Squelch should open, and BUSY should light up
							SQL control fully clockwise	Noise should disappear
	3. SSG. output: $-3 \text{ dB}\mu$							Squeich should open

ADJUSTMENT

Transmitter Section Adjustment

		Measure	ement p	oint		Adjus	tment point	
item	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Maximum power check	Frequency: 28.850 MHz Transmit	Powermeter Ammeter	Rear panel	ANT	TX-RX	VR3	Check	52 W or more
High-power adjustment (check)	Frequency: 28.850 MHz Transmit		TX	TX-RX	VR3	Adjust	50 W	
(CHECK)	2. Frequency: 28.000 MHz Transmit].					Check	44 W or more
	3. Frequency: 29.640 MHz Transmit						Check	44 W or more
3. Medium- power	Frequency: 28.850 MHz Transmit	Powermeter	Rear panel	ANT	TX-RX	VR4	Adjust	11.5 W
adjustment (check)	2. Frequency: 28.000 MHz Transmit						Check	9.5 W or more
	3. Frequency: 29.640 MHz Transmit						Check	9.5 W or more
4. Low-power check	1. Frequency: 28.850 MHz Transmit	Powermeter	Rear panel	ANT			Check	3.0 ~ 8.0 W
	2. Frequency: 28.000 MHz Transmit						Check	3.0 ~ 8.0 W
	3. Frequency: 29.640 MHz Transmit						Check	3.0 ~ 8.0 W
5. Deviation adjustment (check)	1. Frequency: 28.850 MHz AG: 1 kHz 50 mV (K, P M) 28 mV (E) Filter: 25 15K Transmit	DC detector Oscilloscope AG	Rear	ANT	TX-RX	VR2	Adjust 4.4 KHz	± 4.4 KHz ± 200 Hz
	2. Frequency: 28.050 MHz AG: 1 KHz, 5.0 mV (K, P M) 2.8 mV (E) Filter: 25 15K Transmit						Check	±22 to 3.6 kHz
6. Frequency adjustment	Frequency: 28.850 MHz Transmit	Frequency counter Powermeter	Rear panel	ANT	TX-RX	TC1	Adjust	28.850 MHz ± 20 Hz
7. Protection check	Frequency: 29.690 MHz Antenna: Open Transmit	Ammeter					Check	12A or less

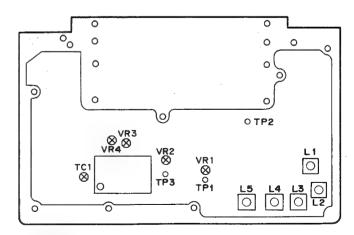


Fig. 60 28 MHz Band adjustment: Component layout (upper view)

ADJUSTMENT

• 50 MHz Band (UT-50S)

Common Section Adjustment

		Measure	ment p	oint	Adjustment point			
ltem	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Lock Voltage check	1. Frequency: 54.000 MHz Receive	Digital voltmeter	TX-RX	TP3			Check the lock voltage	6.0 - 7.6 V

Receiver Section Adjustment

		Measure	ment p	oint		Adjust	tment point	
ltem	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Bandpass filter (BPF) adjustment	1. Frequency: 52.040 MHz. SSG output: 0 dBµ Modulation: 1 KHz Deviation: 3 KHz Receive	Digital voltmeter SSG	Rear panel	ANT	TX-RX	L1~4	Adjust to that the voltmeter reading is maximum	voltmeter reading is maximum
2. Distortion factor adjustment	1. Frequency: 52.040 MHz SSG output: 60 dBµ Modulation: 1 KHz Deviation: 3 KHz	Distortion meter Oscilloscope SSG	Rear panel	EXT.SP	TX-RX	L5	Minimize the distortion factor	5% or less
3. Receive sensitivity check	1. Frequency: 53.940 MHz SSG output: -9 dBµ Modulation: 1 KHz Deviation: 3 KHz	Distortion meter Millivoltmeter Oscilloscope SSG	Rear panel	EXT.SP			Check	12 dB SINAND or more
	2. Frequency: 50.040 MHz SSG output: -9 dBµ Modulation: 1 KHz Deviation: 3 KHz	- 330	Rear panel	EXT.SP			Check	12 dB SINAND or more
	3. Frequency: 40.040 MHz SSG output: 20 dBµ Modulation: 1 KHz Deviation: 3 KHz		Rear panel	EXT.SP			Check.	12 dB SINAND or more
Signal strength meter adjustment	1. Frequency: 52.040 MHz SSG output: 24 dBµ Modulation: 1 KHz Deviation: 3 KHz	SSG			TX-RX	VR1	Adjust so that all LEDs go on, then one LED goes off.	
5. Signal strength meter check	2. Frequency: 52.040 MHz SSG output: 25 dBµ Modulation: 1 KHz Deviation: 3 KHz						Adjust the SSG output so that all signal strength meter LEDs go on.	The SSG output is 20 \pm 6 dB μ
6. Squelch check	Frequency: 52.040 MHz SSG output: Off	SSG	Rear panel	EXT.SP			Set the SQL control to the closing position	Control position 8:00-11:00 BUSY should go out
	2. Frequency: 52.040 MHz SSG output: -14 dB Modulation: 1 KHz Deviation: 3 KHz	-					·	Squelch should open, and BUSY should light up
	Ì						SQL control fully clockwise	Noise should disappear
	3. SSG output: -3 dBμ							Squelch should open

ADJUSTMENT

Transmitter Section Adjustment

	·	Measure	ment p	oint		Adjust	ment point	
ltem	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Maximum power check	1. Frequency: 52.000 MHz Transmit	Powermeter Ammeter	Rear Panel	ANT	TX-RX	VR3	Check	53W or more
High-power adjustment	Frequency: 52.000 MHz Transmit				TX-RX	∨R3	Adjust	51W
(check)	2. Frequency: 50.000 MHz Transmit						Check	45W or more
	3. Frequency: 53.940 MHz Transmit						Check	45W or more
3. Medium- power	Frequency: 52.000 MHz Transmit		Rear Panel	ANT	TX-RX	VR4	Adjust	11.5W
adjustment (check)	2. Frequency: 50.000 MHz Transmit						Check	9.5W or more
	3. Frequency: 53.940 MHz Transmit			ALIT			Check	9.5W or more
4. Low-power check	1. Frequency: 52.000 MHz Transmit	Powermeter	Rear Panel	ANT			Check	3.0 ~ 8.0W
	2. Frequency: 50.000 MHz Transmit				Check	3.0 ~ 8.0W		
	3. Frequency: 53.940 MHz Transmit						Check	3.0 ~ 8.0W
5. Deviation adjustment (check)	1. Frequency: 52.000 MHz AG: 1KHz, 50 mV (K, P M) 28 mV (E) Filter: 25 15K Transmit	DC detector Oscilloscope AG	Rear Panel	ANT	TX-RX	VR2	Adjust 4.4 KHz	±4.4 KHz ± 200 Hz
	2. Frequency: 52.000 MHz AG: 1KHz, 5.0 mV (K,P M) 2.8 mV (E) Filter: 25 15K Transmit						Check	±2.2 to 3.6 kHz
6. Frequency adjustment	1. Frequency: 52.000 MHz Transmit	Frequency counter Powermeter	Rear Panel	ANT	TX-RX	TC1	Adjust	52.000 MHz ± 20 Hz
7. Protection check	Frequency: 53.990MHz Antenna: Open Transmit	Ammeter					Check	12A or less.

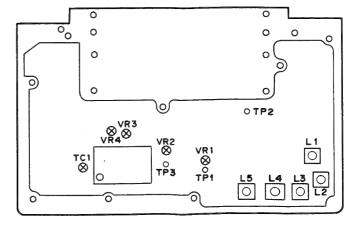


Fig. 61 50 MHz BAND adjustment; Component layout (upper view)

ADJUST MENT

TM-742 A/742 E/942 A **ADJUSTMENT**

• 220 MHz Band (UT-220S)

Common Section Adjustment

pecification

r more

r more

r more

or more

or more

1.0W

1.0W

3.0W

Hz ± 200 Hz

to 3.6 kHz

MHz ± 20 Hz

		Measurement point Adjustment point						
ltem	Condition	Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Lock voltage check	1. Frequency: 215.000 MHz Receive	Digital voltmeter	TX-RX	TP2			Check the lock voltage	1.2 ~ 2.6V

Receiver Section Adjustment

Item	Condition	Measurement point			Adjustment point			
		Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Bandpass filter (BPF) adjustment	1. Frequency: 222.540 MHz SSG output: 0dBµ Modulation: 1KHz Deviation: 3KHz Receive	Digital voltmeter SSG	Rear Panel	ANT.	TX-RX	L1~4	Voltmeter reading is maximum.	Voltmeter reading is maximum.
Distortion factor adjustment	1. Frequency: 222.540 MHz SSG output: 60dBµ Modulation: 1KHz Deviation: 3KHz	Distortion meter Oscilloscope SSG	Rear Panel	EXT. SP	TX-RX	L6	Minimize the distortion factor	5% or less
3. Receivie sensitivity check	1. Frequency: 222.540 MHz SSG output: -9dBµ Modulation: 1KHz Deviation: 3KHz	Distortion meter Millivoltmeter Oscilloscope SSG	Rear Panel	EXT. SP			Check	12dB SINAND or more
	2. Frequency: 215.040 MHz SSG output: 5dBµ Modulation: 1KHz Deviation: 3KHz	330	Rear panel	EXT. SP			Check	12dB SINAND or more
	3. Frequency: 229.980 MHz SSG output: -5dBµ Modulation: 1KHz Deviation: 3KHz		Rear panel	EXT. SP			Check	12dB SINAND or more
4. Signal strength meter adjustment	1. Frequency: 222.540 MHz SSG output: 21dBµ Modulation: 1KHz Deviation: 3KHz	SSG			TX-RX	VR1	Adjust so that all LEDs go on, then one LED goes off.	
5. Signal strength meter check	2. Frequency: 222.540 MHz SSG output: 22dBµ Modulation: 1KHz Deviation: 3KHz						Adjust the SSG output so that all signal strength meter LEDs go on.	The SSG output is 20 : 6 dBµ
6. Squelch check	Frequency: 222.540 MHz SSG output: OFF	SSG	Rear Panel	EXT. SP			Set the SQL control to the closing position	Control position 8:00-11:00 BUSY should go out
	2. Frequency: 222.540 MHz SSG output: -14dB Modulation: 1KHz Deviation: 3KHz						SQL control fully	Squelch should open and BUSY should Noise should
	3. SSG output: -3 dBμ						clockwise	disappear Squelch should
	o. oog output. o dop							open

Transmitter Section Adjustment

Item	Condition	Measurement point				Adjust	ment point	
		Test equipment	Unit	Terminal	Unit	Parts	Method	Specification
Maximum power check	Frequency: 222.500 MHz Transmit	Powermeter Ammeter	Rear Panel	ANT	TX-RX	VR3	Check	28W or more (reference)
High-power adjustment (check)	Frequency: 222.500 MHz Transmit				TX-RX	VR3	Adjust	26W
	2. Frequency: 222.000 MHz Transmit						Check	22W or more
	3. Frequency: 224.980 MHz Transmit						Check	22W or more
3. Medium- power adjustment (check)	Frequency: 222.540 MHz Transmit	Powermeter	Rear Panel	ANT	TX-RX	VR4	Adjust	11W
	2. Frequency: 222.000 MHz Transmit						Check	9W or more
	3. Frequency: 224.980 MHz Transmit						Check	9W or more
4. Low-power check	Frequency: 222.540 MHz Transmit	Powermeter	Rear Panel	ANT			Check	3.0 ~ 8.0W
	2. Frequency: 220.000 MHz Transmit						Check	3.0 ~ 8.0W
	3. Frequency: 222.980 MHz Transmit						Check	3.0 ~ 8.0W
5. Deviation adjustment (check)	1. Frequency: 222.500 MHz AG: 1 kHz, 50 mV Filter: 25 15K Transmit	DC detector Oscilloscope AG	Rear Panel	ANT	TX-RX	VR2	Adjust 4.4 KHz	±4.4KHz ± 200 Hz
	2. Frequency: 222.500 MHz AG: 1 kHz, 5.0 mV Filter: 25 15K Transmit						Check	±2.2 to 3.6 KHz
3. Frequency adjustment	Frequency: 222.500 MHz Transmit	Frequency counter Powermeter	Rear Panel	ANT	TX-RX	TC1	Adjust	222.500 MHz ± 2KHz
7. Protection check	Frequency: 224.980 MHz Antenna: Open Transmit	Ammeter					Check	7.5A or less

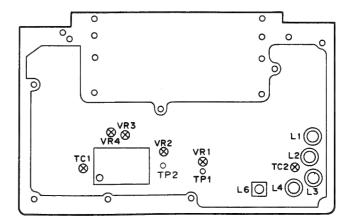
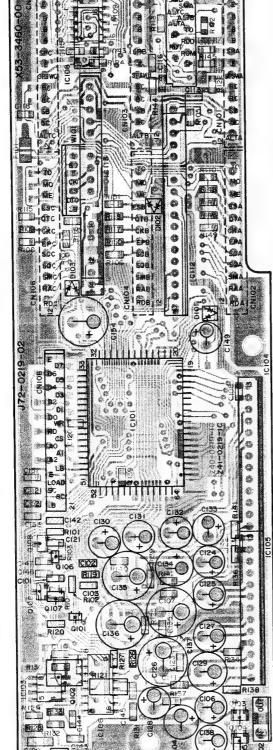


Fig. 62 220 MHz band adjustment: Component layout (upper view)



TC74HC133AF

136

B pattern

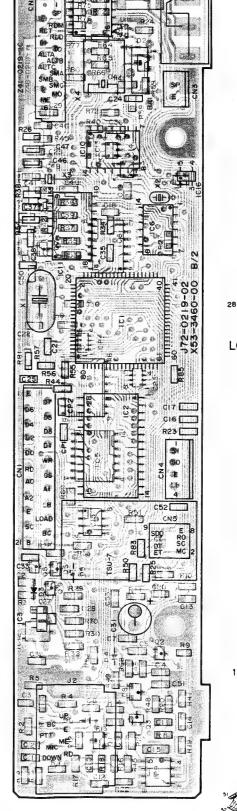
CONTROL UNIT (X53-346X-XX) 0-11: 742A (K, P), 0-21: 742A (M), 0-22: 742A (M2), PC BOARD VIEW Foil side view

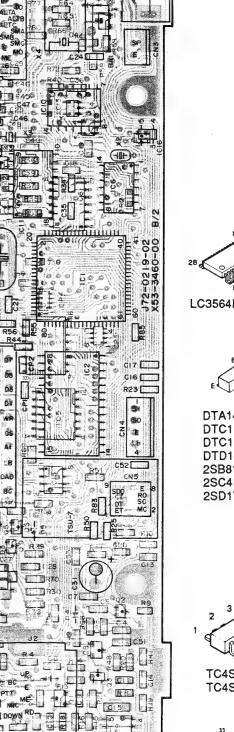
CKC 18109

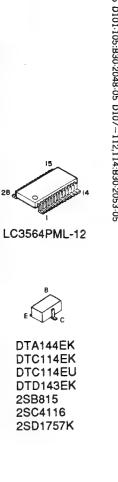
4 133 M29

A pattern

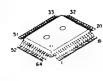
Foil side view







TC4S11F TC4S66F



L78LR05B-

135

HD6433388A03F

HD74HC165PF

⊞c16

_____R23

A pattern

RC DOWN CI

TC35219F

MO BISS

CKE BIT

BU4066BF S-3520CF

B pattern

CXD1095Q

137

PML-12

44EK 14EK 14EU 43EK

15

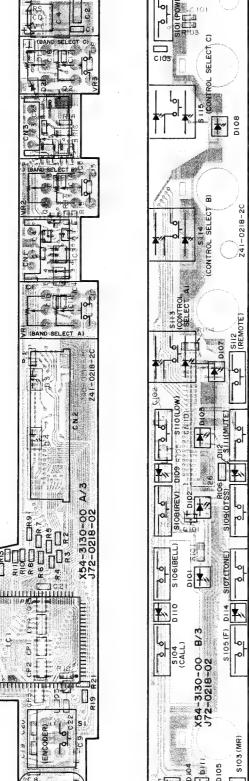
116 757K

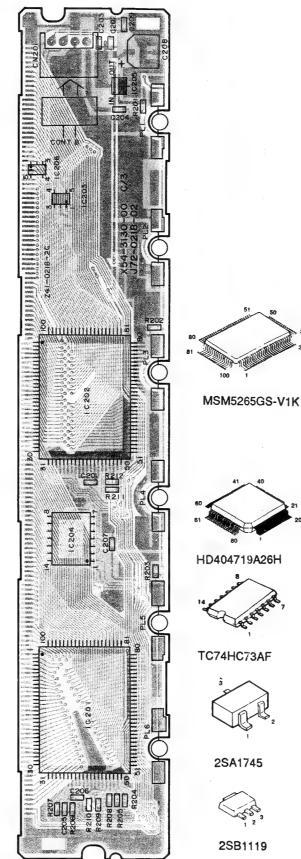
;11F ;66F

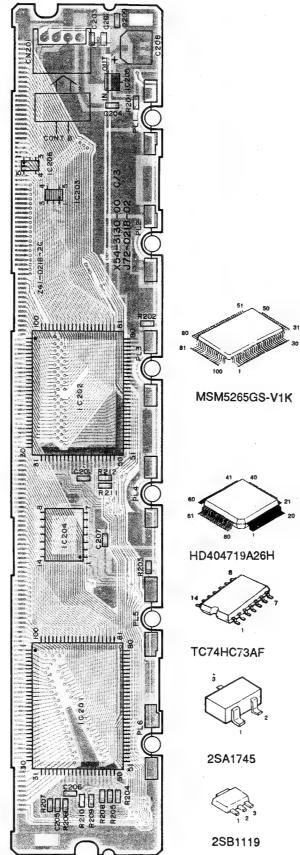
)95Q

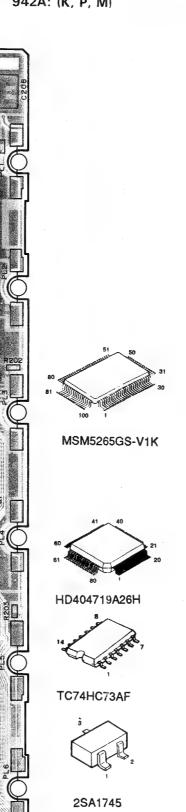
Component side view

IC1:HD404719A26H IC Q1:2SA1745(6,7) Q2:2 D1:MA112 D2:MA720

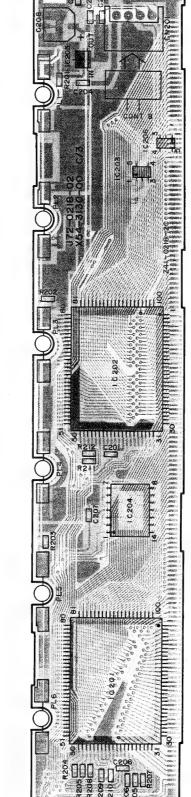




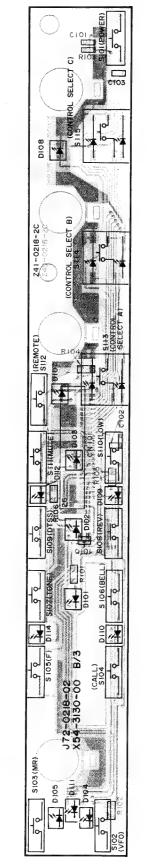




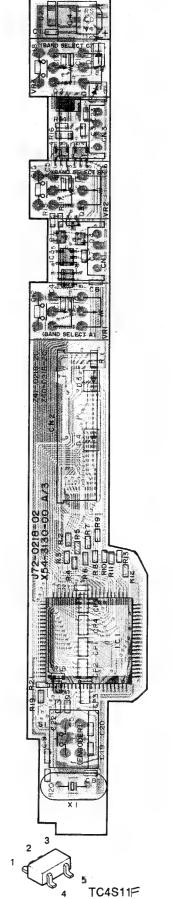
IC1:HD404719A26H IC2:L78LR05B.FA IC3~6.203,206:TC4S11F IC201,202:MSM5265GS.V1K IC204:TC74HC73AF Q1:2SA1745(6,7) Q2:2SB1119(S) Q3.101:DTC114EU Q4.5:DTC144EU D1:MA112 D2:MA720 D3,4:B30-2025-05 D101-105:B30-2048-05 D107~112,114:B30-2053-05



Foil side view



DISPLAY UNIT (X54-3130-11) 742A: (K, P, M, M2) 742E: (E, E2, E3) 942A: (K, P, M)









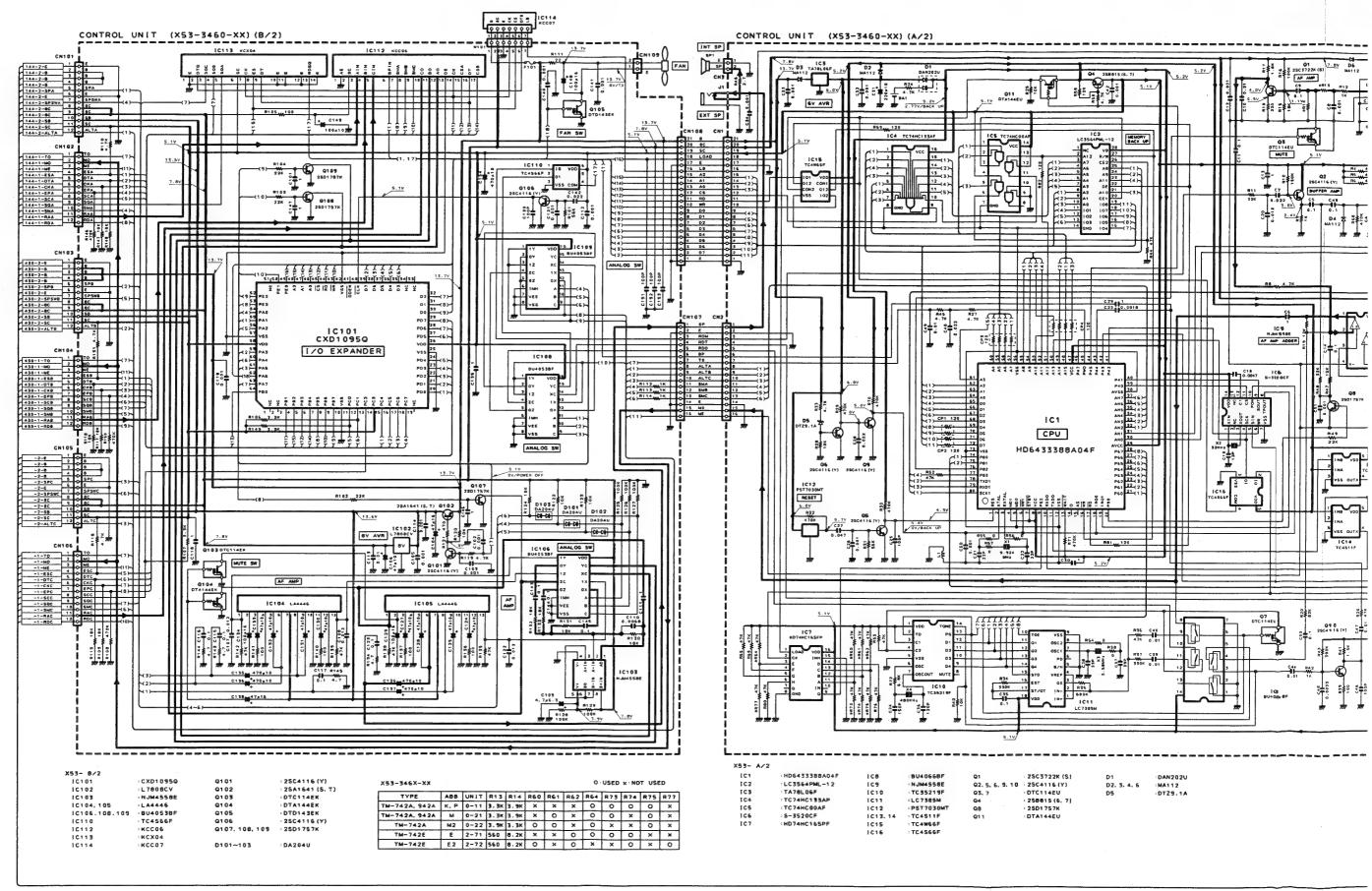
DTA144EU DTC114EU



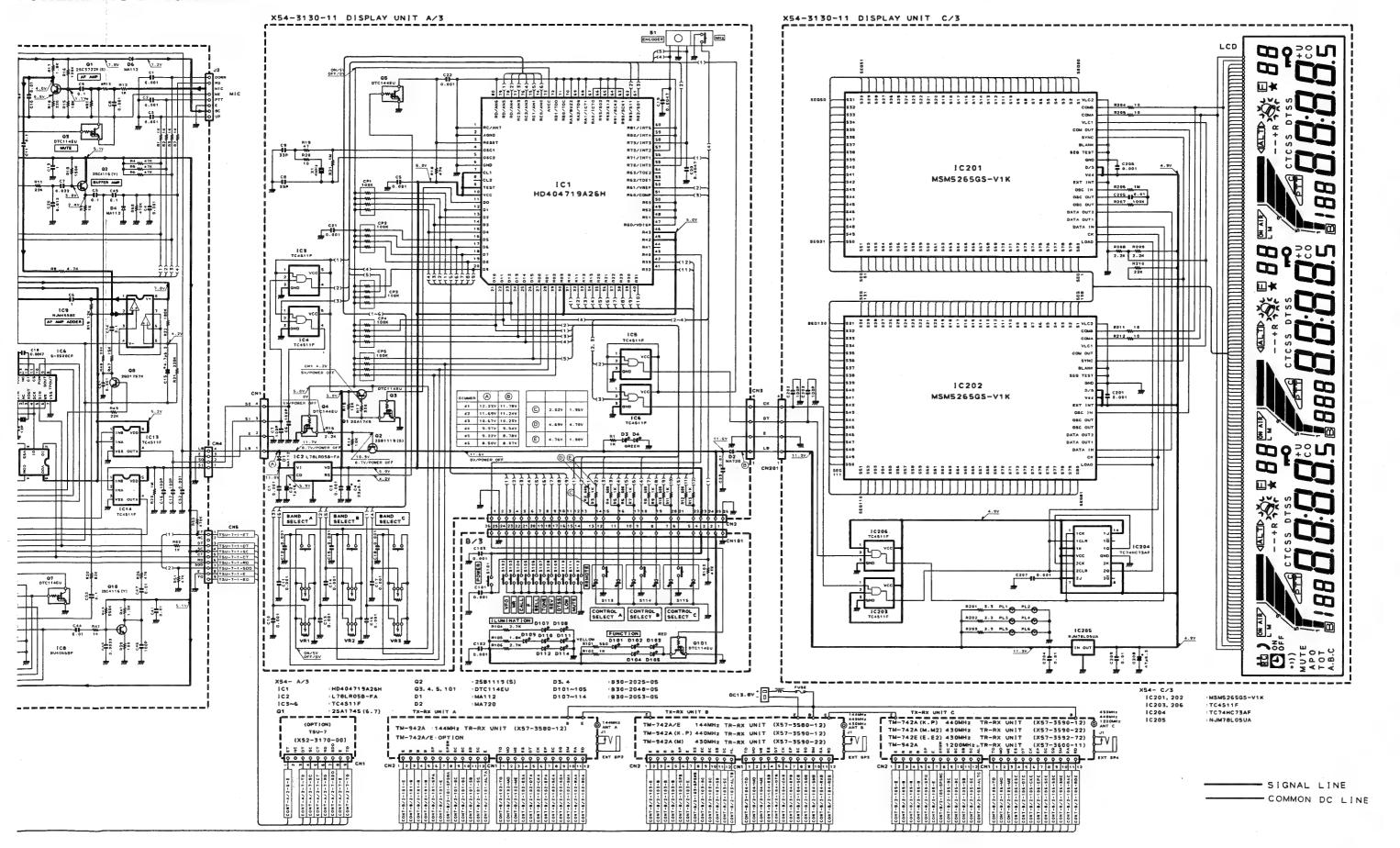
NJM78L05UA

L78LR05B-FA

SCHEMATIC D

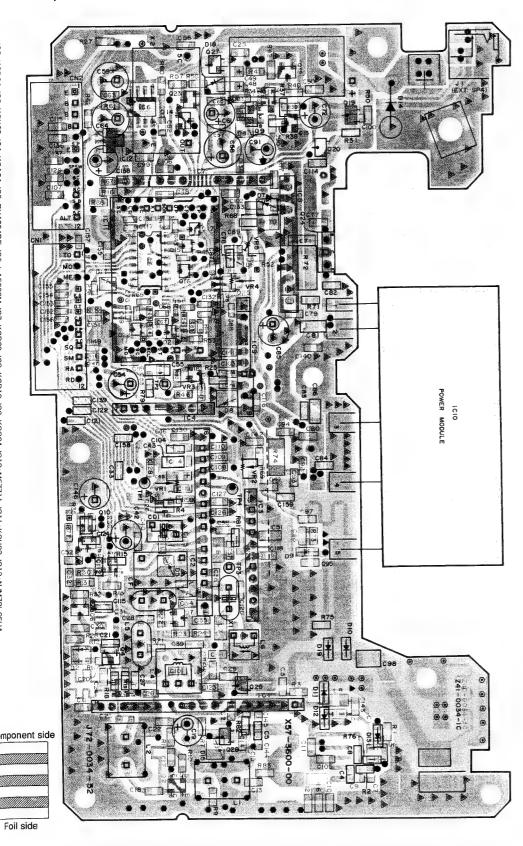


SCHEMATIC DIAGRAM



1200M TX-RX UNIT (X57-3600-11): UT-1200 (M)

Component side view



DTA114EK DTC124EK DTC144EU DTC144WK 2SA1362 2SC2712 2SC3120 2SC3356 2SD1757K



FMG1 FMW1

Connect A and B Connect A and C Connect A and D Connect B and C

Connect A and B, C Connect A and B, D

Connect A and C, D Connect B and C, D

Connect A and B, C, D

A Only

B Only 🛕 C Only

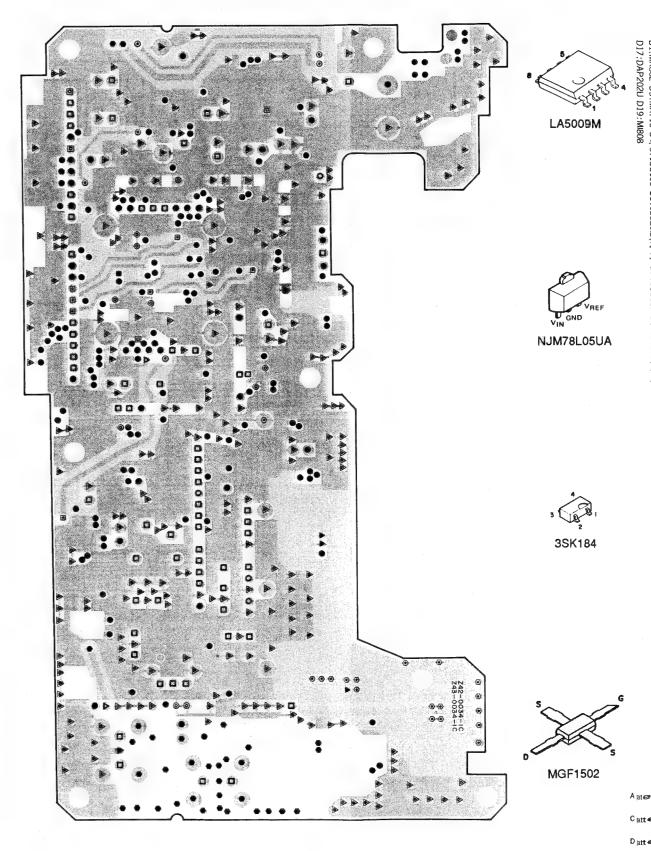
No mark does not Connected

144

PC BOARD VIEW

Foil side

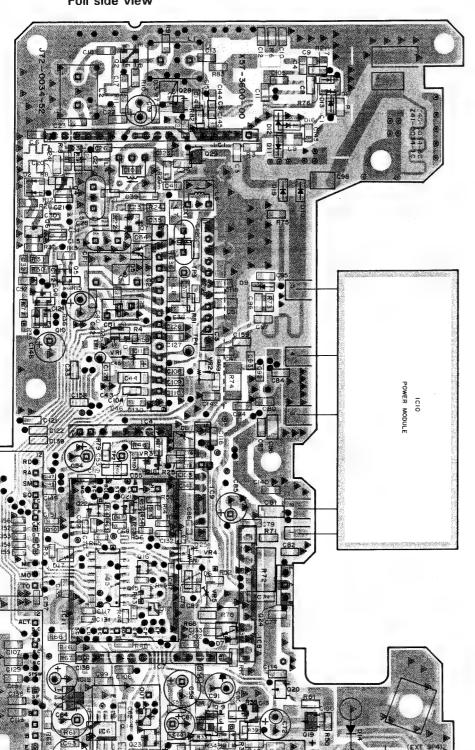
145

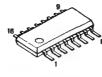


:BU4094BF IC6:LA5009M IC7:KCB09 IC8:KCB10 IC9:KCC04 3SK184(S) Q5:FMA5 Q6:2SC3356 Q7:2SC3120 Q8, 19:2SA 15~17:DTC144EU Q18:2SD1757(K) Q20:DTC124EK Q21, 22

D8:02CZ12(X, Y) D9:HSK151 D10~13:MI808 D14:DSA3A1 D15:02CZ3.6(Y, Z)

UA

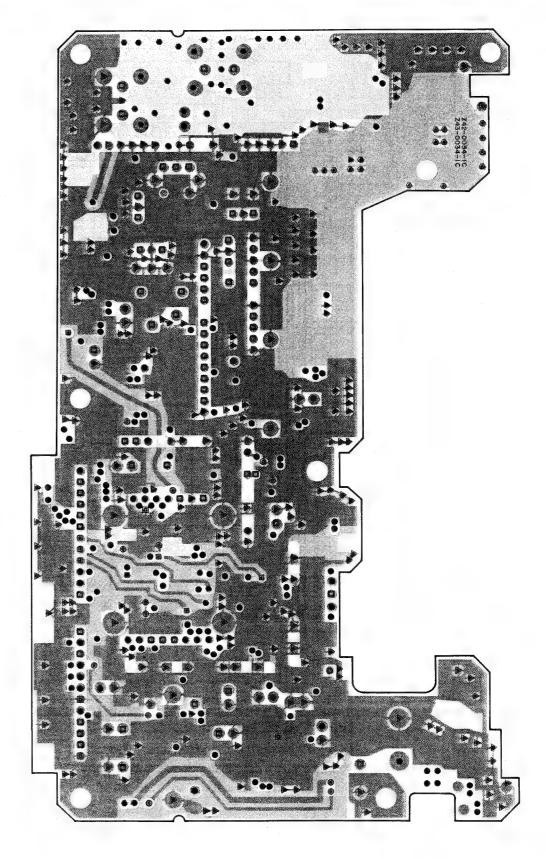






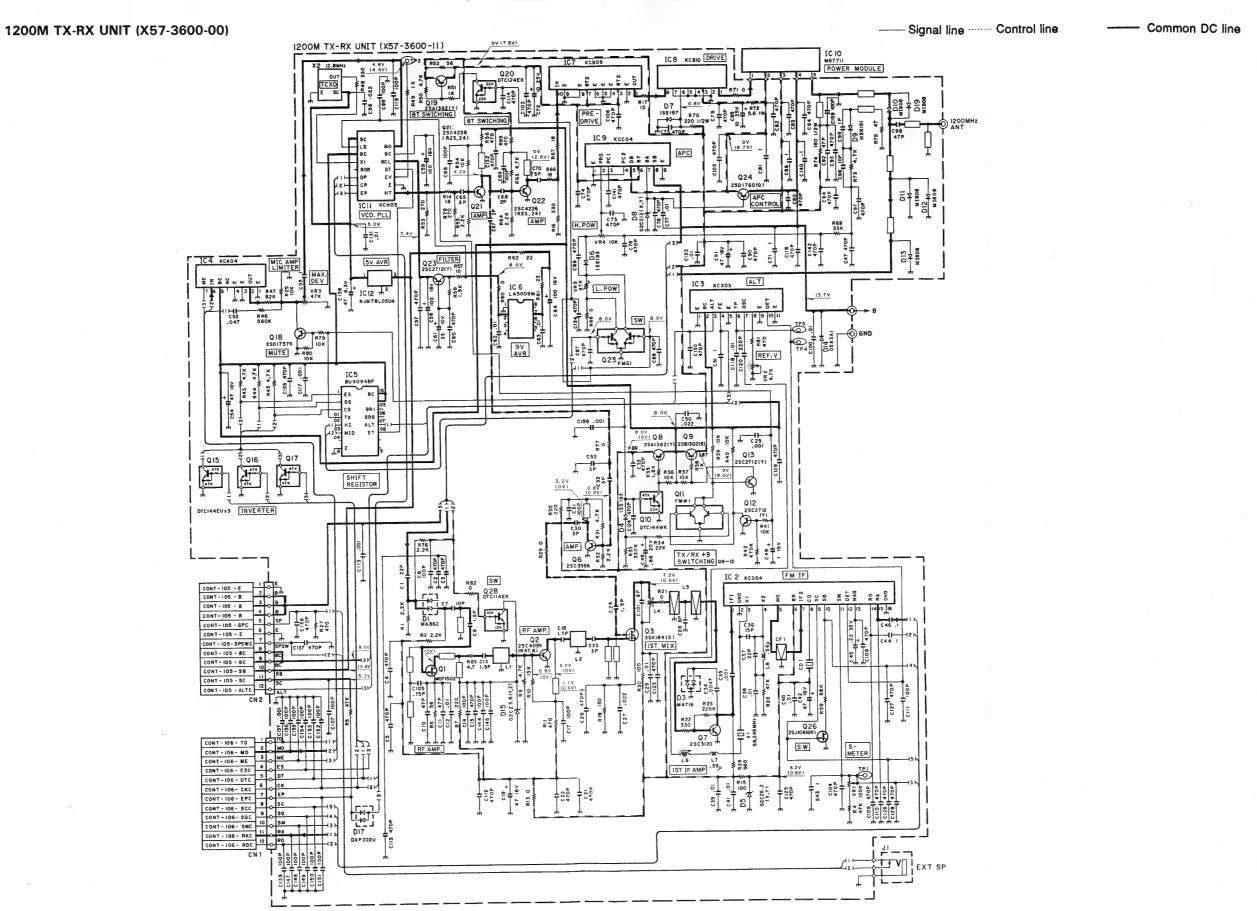
- Connect A and B
- Connect A and C Connect A and D
- Connect B and C
- Connect B and D
- Connect A and B, C
- Connect A and B, D Connect A and C, D
- Connect B and C, D
- A Only
- ☐ B Only
- △ C Only
 - No mark does not Connected

146



Foil side

SCHEMATIC DIAGRAM



430/440M TX-RX UNIT (X57-359X-XX)
0-12: 742A (K, P) 942A (M) 0-22: 742A (M, M2)
2-72: 742E (E, E2, E3) 942A (K, P)

Component side view

:KCD04 IC2:KCA04 IC3:BU4094BF IC4:LA5010M IC5:KCC04 IC6:KCB14 IC7:M57788M IC8:KCB12 IC9:KCB13 IC10:KCH07 3:3SK184(S) Q2:2SK582 Q4:DTC114EK Q5:2SC2714(Y) Q6, 7:FMA5 Q8:2SA1362(Y) Q9:DTC144WK Q10, 11, 17:2SC2712(Y) ::2SD1757(K) Q18:2SC3123 Q19:FMG1 Q20:2SD1760(Q) Q21:2SJ106(GR) HSK277 D2:1SV128 D3, 6, 7, 13:1SS184 D4, 15:MA862 D5:1SS181 D8:MI407 D9:MI308 D10, 11, 14:MA716 D12:DSA3A1

DTA114EK DTC144EK DTC144WK 2SA1362 2SC2712 2SC2714 2SC3123 2SD1757K

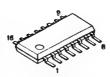


FMG1











A pattern

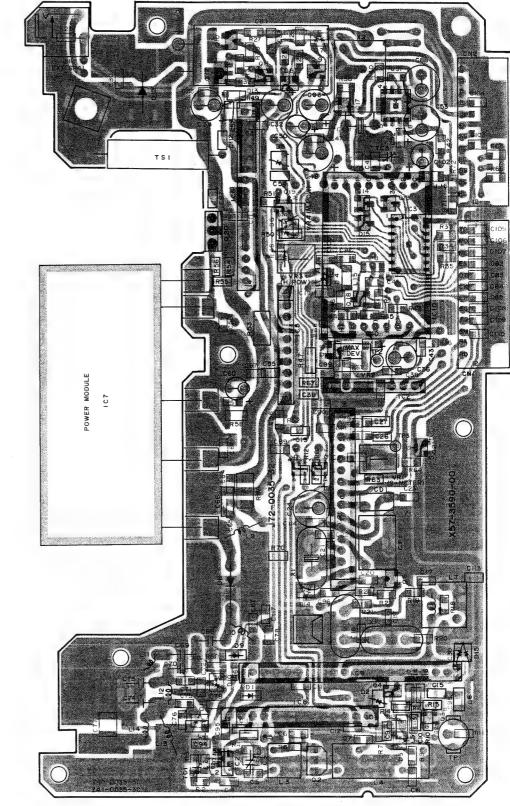
B pattern

430/440M TX-RX UNIT (X57-359X-XX) 0-12: 742A (K, P) 942A (M) 0-22: 742A (M, M2)

2-72: 742E (E, E2, E3) 942A (K, P)

Foil side view

КСВ13 IC10:КСН07 Q10, 11, 17:2SC2712(Y) Q12:2SB1119S Q13∼15:DTC144EH



A pattern

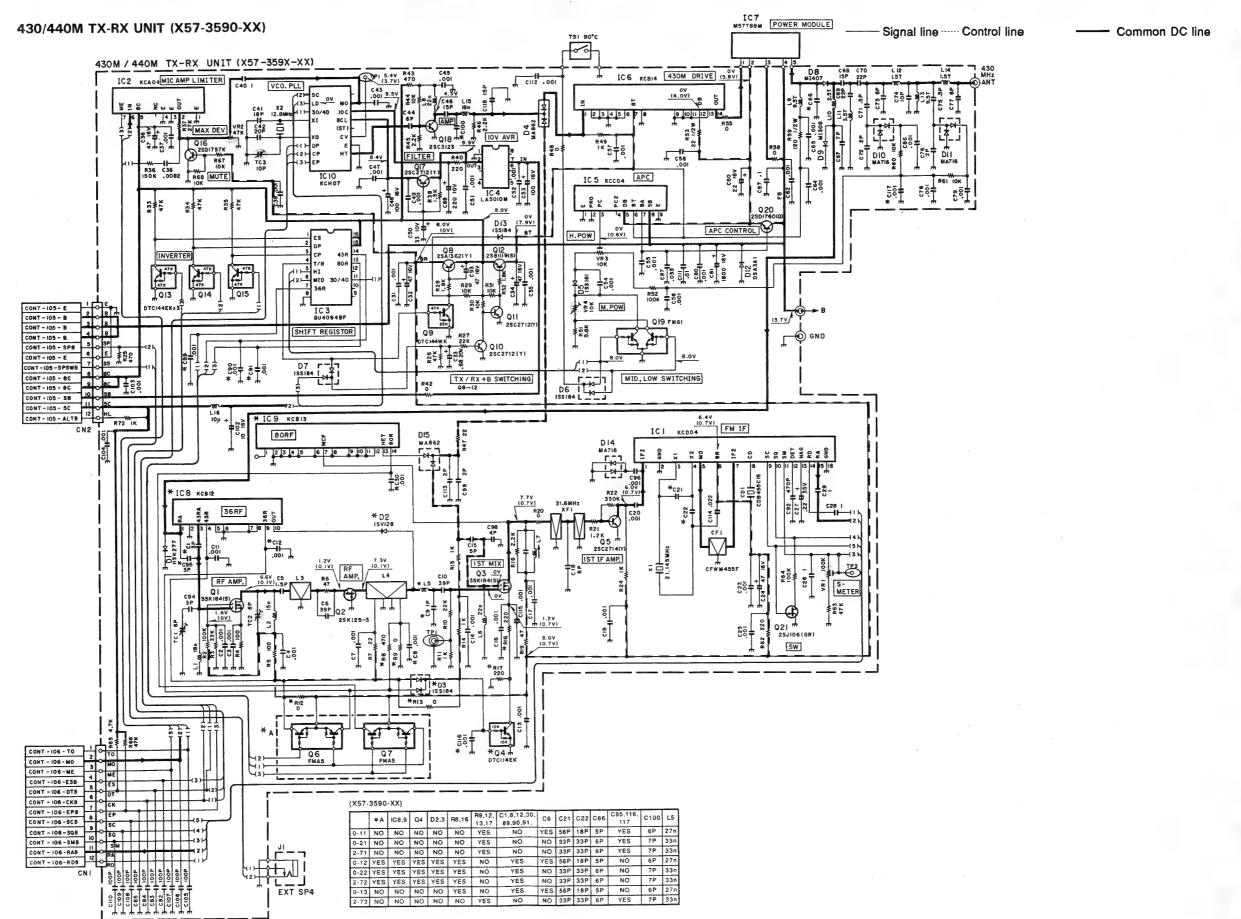








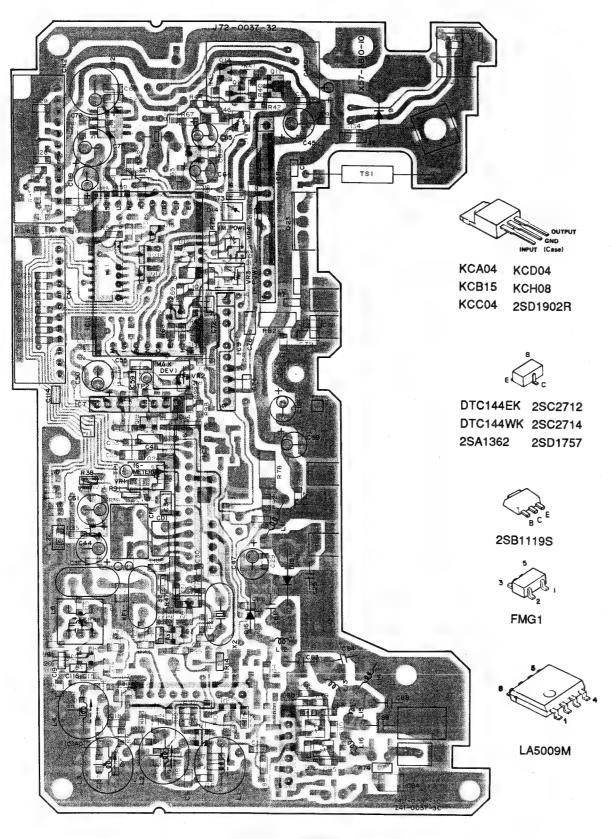
SCHEMATIC DIAGRAM

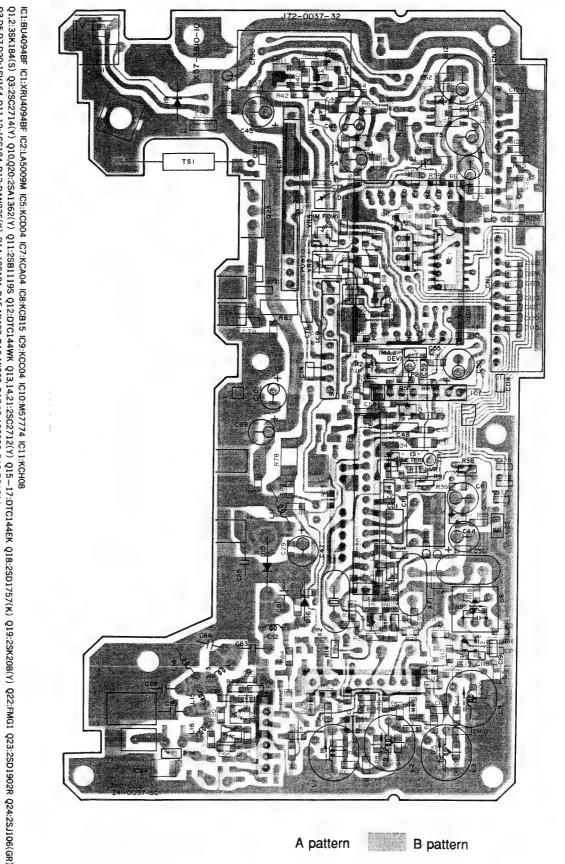


PC BOARD VIEW

220M TX-RX UNIT (X57-3810-10) Component side view

220M TX-RX UNIT (X57-3810-10) Foil side view







3SK184



BU4094BF



M57774

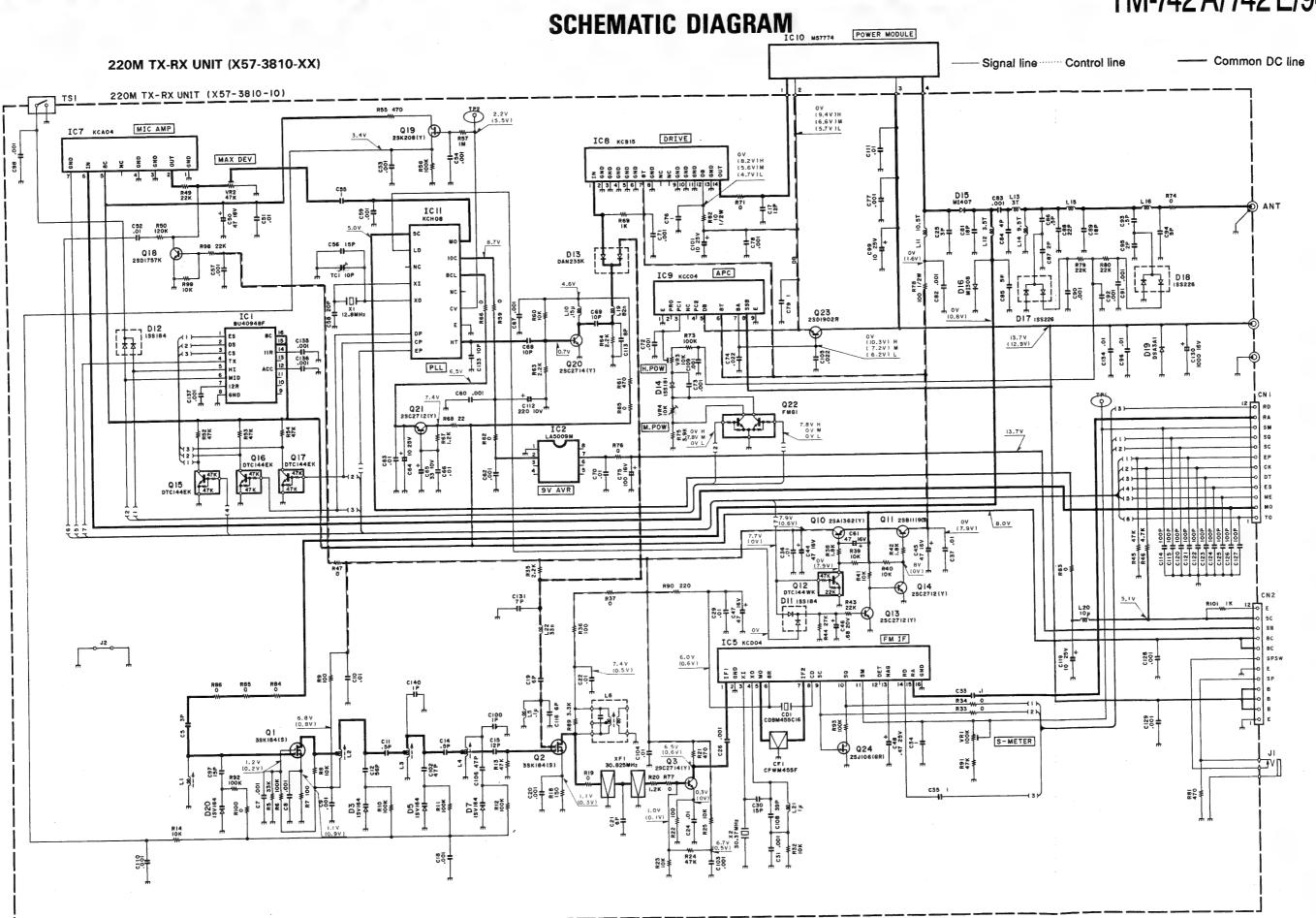


2SK208





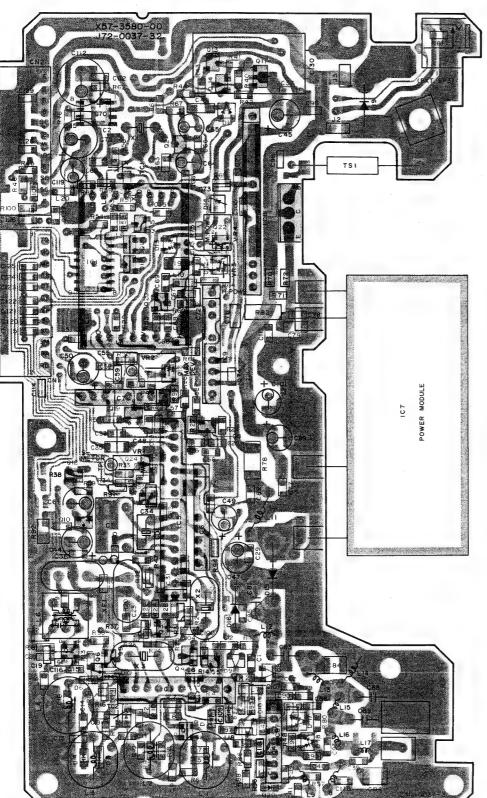
ICI:BU4094BF ICI:XRU4094BF IC2:LA5009M IC5:KCD04 IC7:KCA04 IC8:KCB15 IC9:KCC04 IC1:KCH08
Q1,2:35K184(S) Q3:25C2714(Y) Q10,Q20:25A1362(Y) Q11:25B1119S Q12:DTC144WK Q13,14,21:25C2712(Y) Q15-17:DTC144EK Q18:25D1757(K) Q19:25K208(Y) Q22:FMG1 Q23:25D1902R Q24:25J106(GR)
D3,D5,D7,D20:15V164 D11,12:15S184 D13:DAN235(K) D14:15S181 D15:MI407 D16:MI308 D17,18:15S226 D19:DSA3A1



144M TX-RX UNIT (X57-3580-XX) 0-11: 942A 0-12: 742 A/E (K, P, E, E2, E3, M, M2)

F IC2:LA5010M IC5:K() Q2:3SK131(V12) Q3 SC2712(Y) Q15~17:D V164 D2, 5, 7:1SV166 | :KCD04 IC6:KCD05 IC7:KCA04 IC8:KCB11 IC9:KCC04 IC10:S-AV17 IC11:KCH05
Q3 8, 20:2SC2714(Y) Q4:DTA114YK Q5, 6:DTC123JK Q7:DTC143EK Q10:2SA1362(Y) Q11:2SB1119S
::DTC144EK Q18:2SD1757(K) Q19:2SK208(Y) Q22:FMG1 Q23:2SD1902R Q24:2SJ106(GR)
6 D11, 12:1SS184 D13:DAN235(K) D14:1SS181 D15:MI407 D16:MI308 D17, 18:1SS226 D19:DSA3A1

Component side view



M57737 S-AV17

PC BOARD VIEW

144M TX-RX UNIT (X57-3580-XX) 0-11: 942A 0-12: 742 A/E (K, P, E, E2, E3, M, M2) Foil side view

DTA114YK DTA143EK DTC123JK DTC143EK DTC144WK 2SA1362 2SC2714 2SD1757K



FMG1 LA5010M





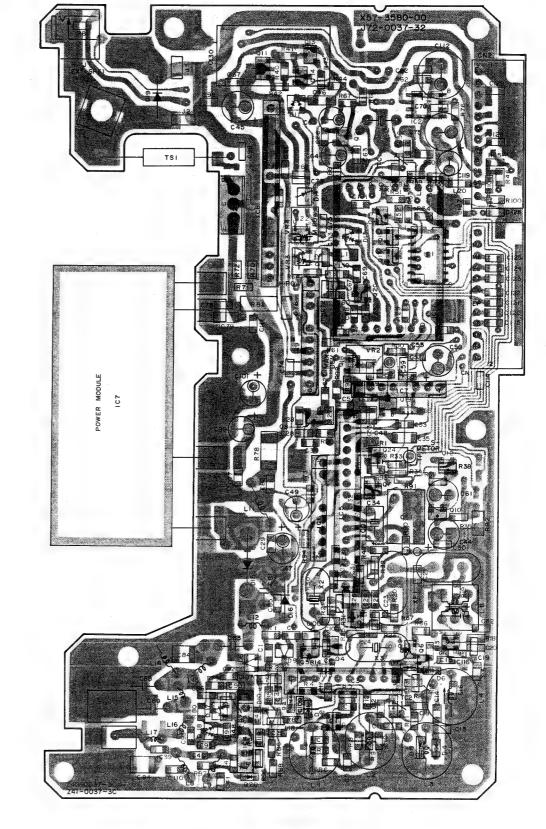
3SK131 3SK184

11 IC9:KCC04 IC10:S-AV17 IC11:KCH05 5,6:DTC123JK Q7:DTC143EK Q10:2SA1362(Y) Q11:2SB1119S Q12:DTC144WK 208(Y) Q22:FMG1 Q23:2SD1902R Q24:2SJ106(GR) :1SS181 D15:MI407 D16:MI308 D17, 18:1SS226 D19:DSA3A1



BU4094BF KCB11 KCD05 KCH04 KCN01

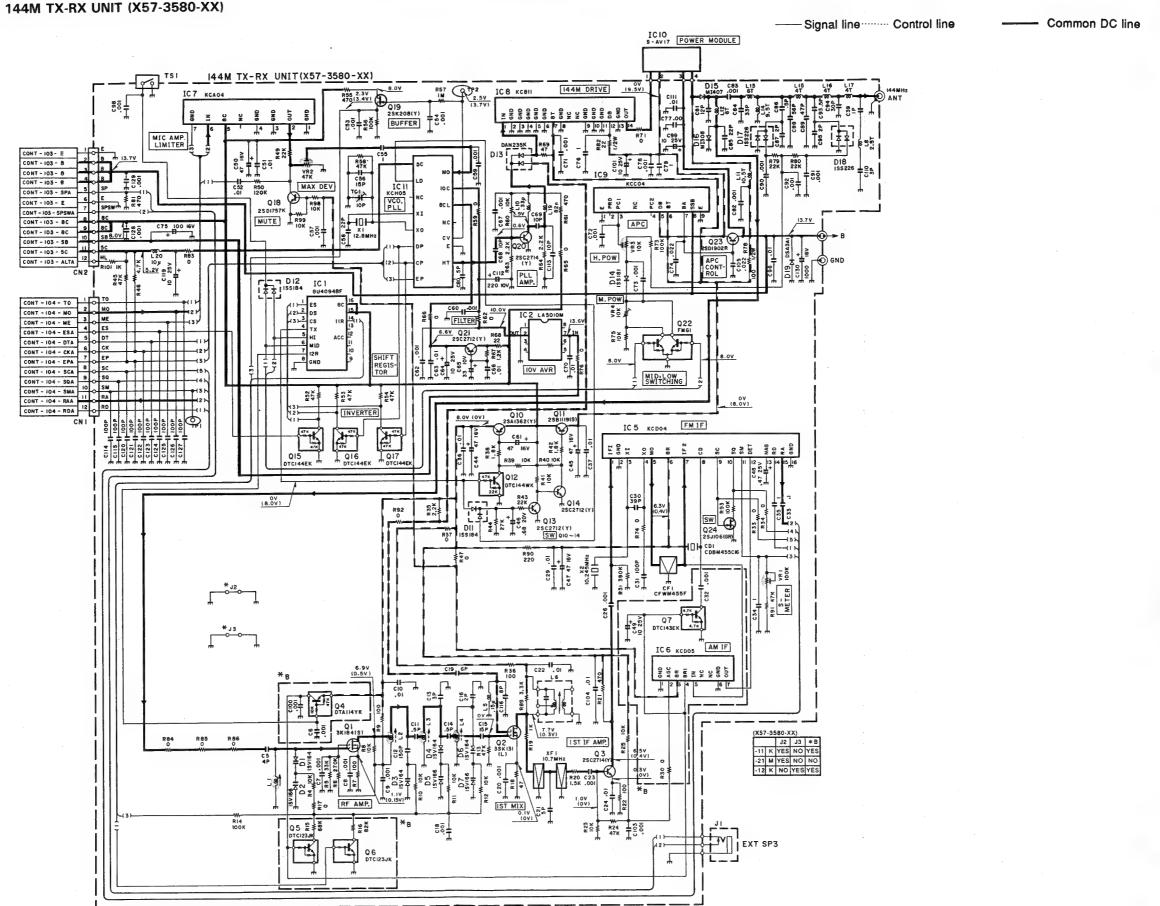




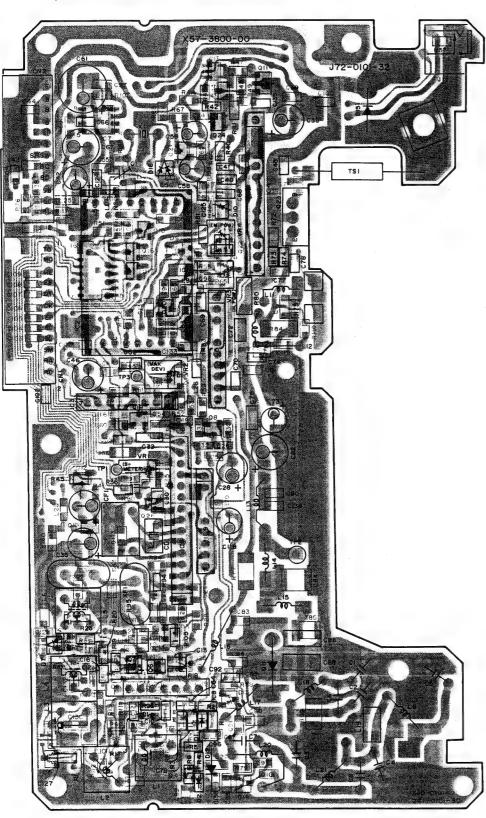
A pattern



B pattern



50M TX-RX UNIT (X57-3800-01) Component side view



PC BOARD VIEW

50M TX-RX UNIT (X57-3800-01) Foil side view



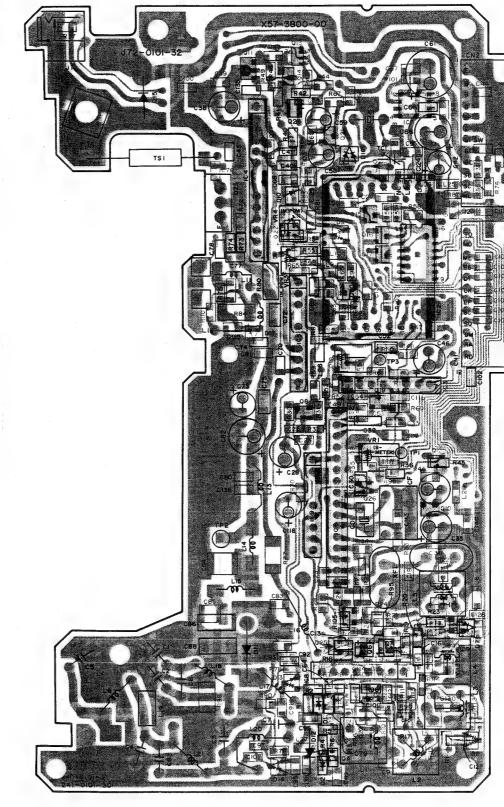








5(GR) Q10:2SA1362(Y) Q11:2SB1119S J3EK D15:DSA3A1



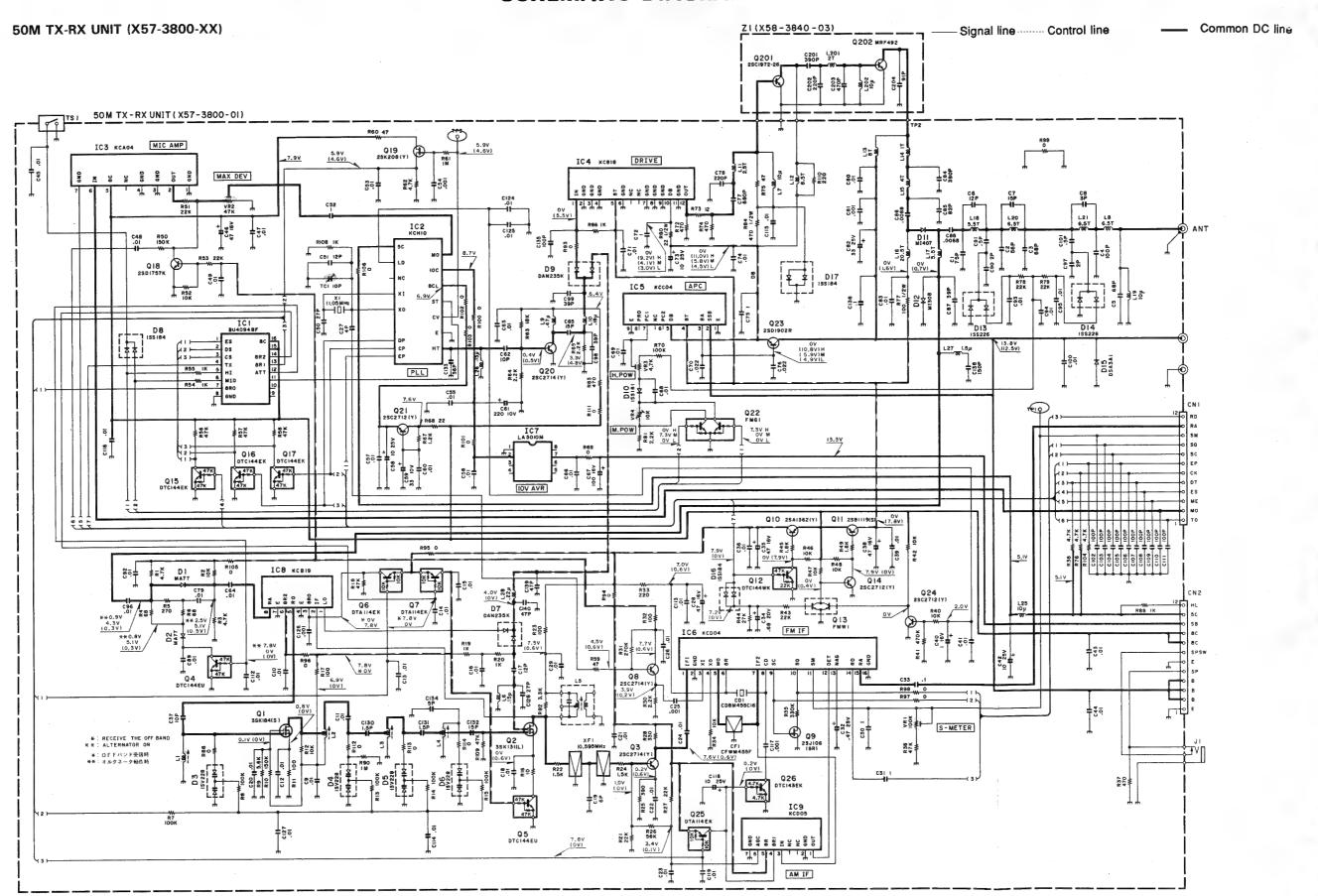
A pattern



A pattern

B pattern

IC1:BU4094BF/XRU4094BF IC2:KCH10 IC3:KCA04:KCB18 IC5:KCC04 IC6:KCD04 IC7:LA5010M IC8:KCB19 IC9:KCD05
Q1:35K184(S) Q2:35K131(V12) Q3, 8, 20:25C2714(Y) Q4, 15~17:DTC144EK Q5:DTC144EU Q6, 7, 25:DTA114K Q9:25J106(GR) Q10:25A1362(Y)
Q12:DTC144WK Q13:FMW1 Q14, 21, 24:25C2712(Y) Q18:25D1757K Q19:25K208(Y) Q22:FMG1 Q23:25D1902R Q26:DTC143EK
D1, 2:MA77 D3~6:15V228 D7, 9:DAN235(K) D8, 16, 17:15S184 D10:15S181 D11:M1308/M1407 D12:M1308 D13, 14:ISS226 D15:DSA3A1

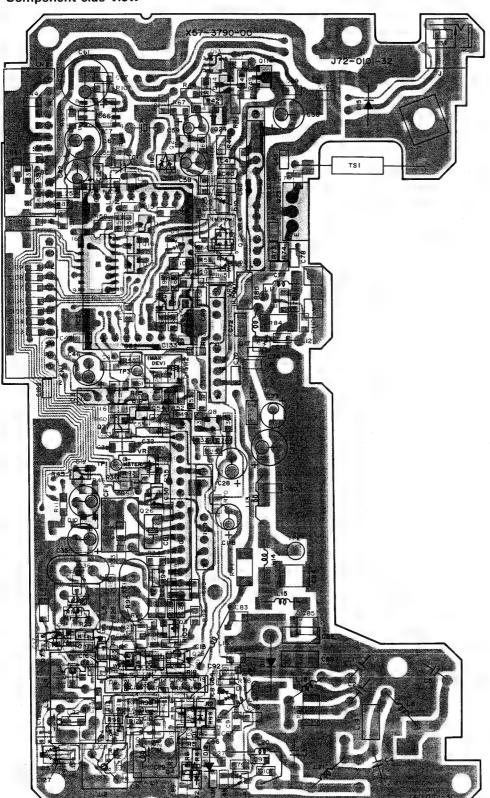


IC1:BU4094BF/XRU4094BFIC2:KCH09 IC3:KCA04 KA:KCB16 IC5:KCC04 IC6:KCD04 IC7:LA5009M IC8:KCB17 IC9:KCD05
Q1:35K179(L) Q2:35K131(V12) Q3:25C2714(Y) Q4:DTC144EK Q5:DTC144EU Q6, 7:DTA114EK Q8:25C2714(Y) Q9:25J106(GR) Q10:25A1362(Y) Q11:25B11195
Q12:DTC114WK Q13:FMW1 Q14:25C2712(Y) Q15—17:DTC144EK Q18:25D1757(K) Q19:25K208(Y) Q2d:25C2714(Y) Q21:25C2712(Y) Q22:FMG1 Q23:25D1902R
Q24:25C2712(Y) Q25:DTA114EK Q26:DTC143EK Q27:DTC144EK
Q14:25C2712(Y) Q25:DTA114EK Q26:DTC143EK Q27:DTC144EK
Q14:25C2712(Y) Q25:DTA114EK Q26:DTC143EK Q27:DTC144EK

PC BOARD VIEW

28M TX-RX UNIT (X57-3790-01)

Component side view



DTA114EK DTC143EK DTC144EK DTC144EU DTC144WK 2SA1362 2SC2712 2SC2714

2SD1757





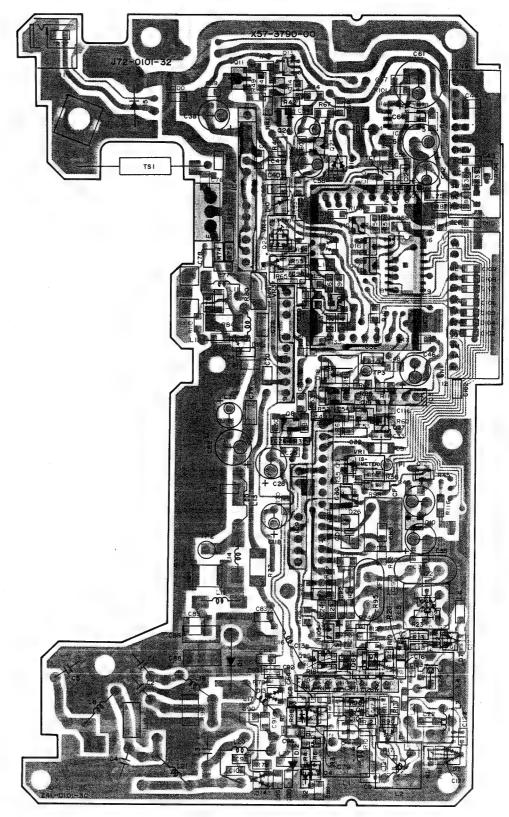


) Q11:2SB1119S 1 Q23:2SD1902R



28M TX-RX UNIT (X57-3790-01)

Foil side view

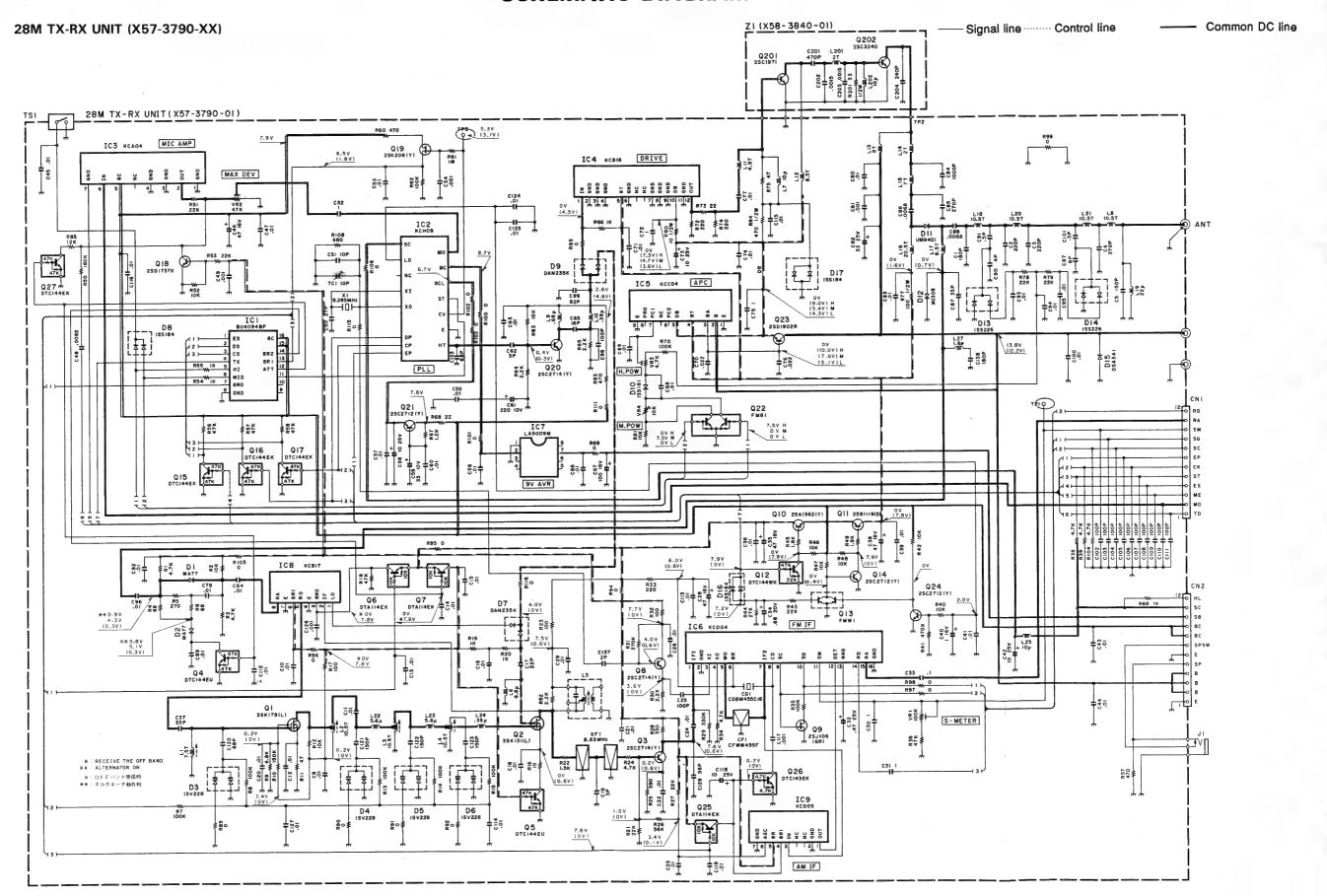


A pattern

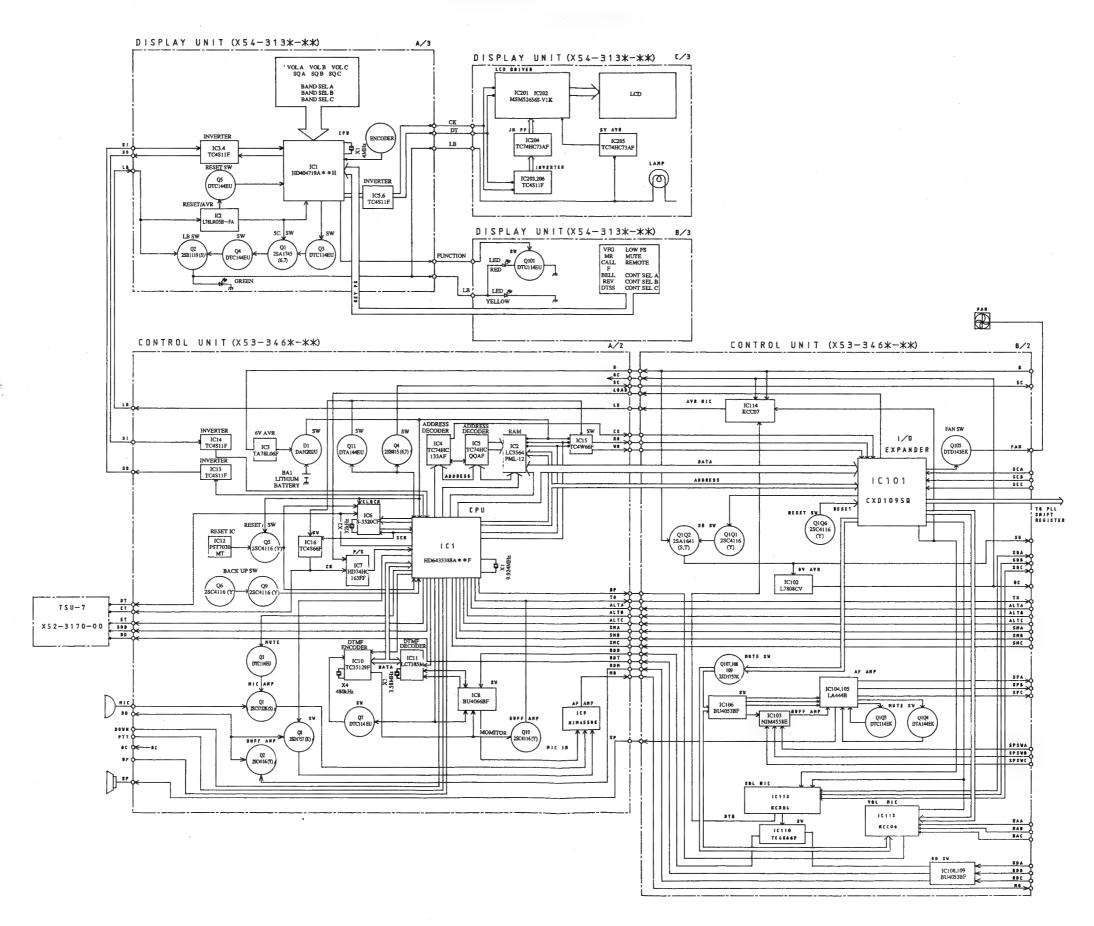


A pattern

B pattern

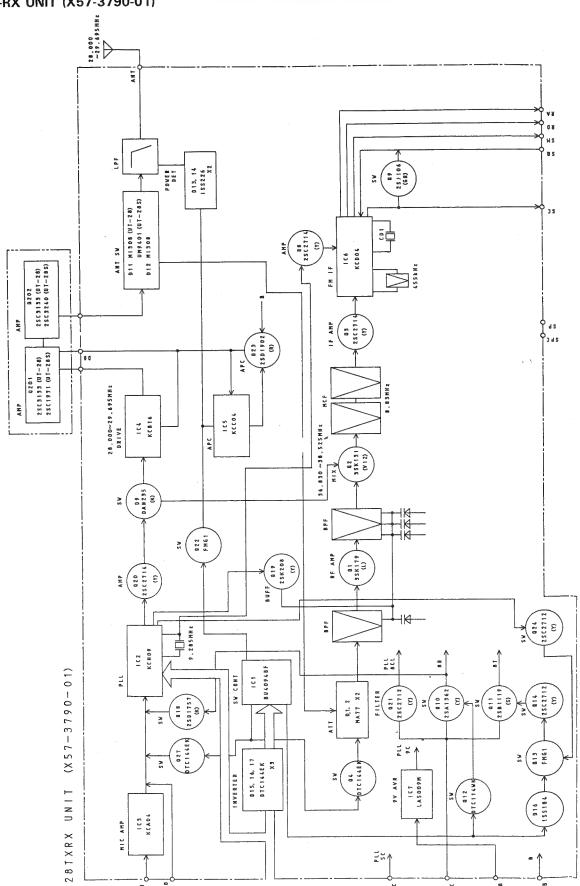


BLOCK DIAGRAM



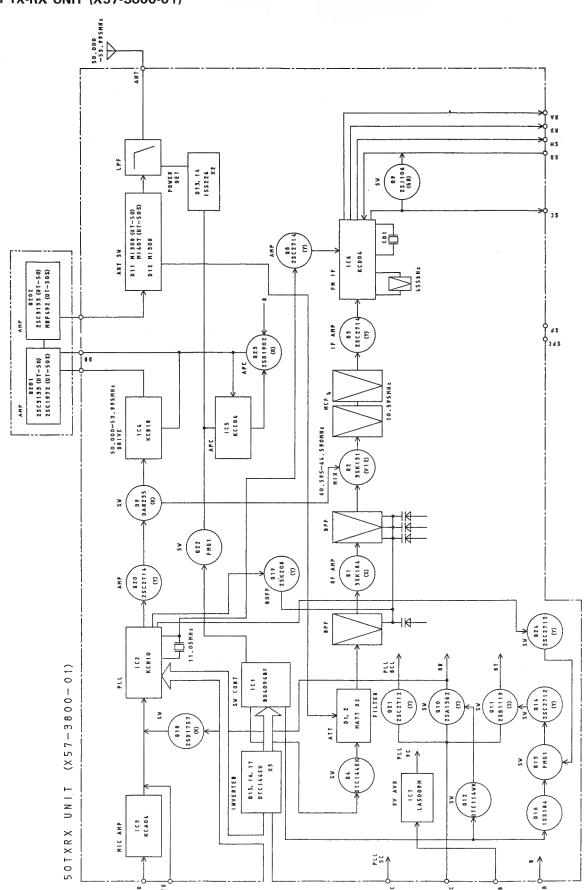
BLOCK DIAGRAM



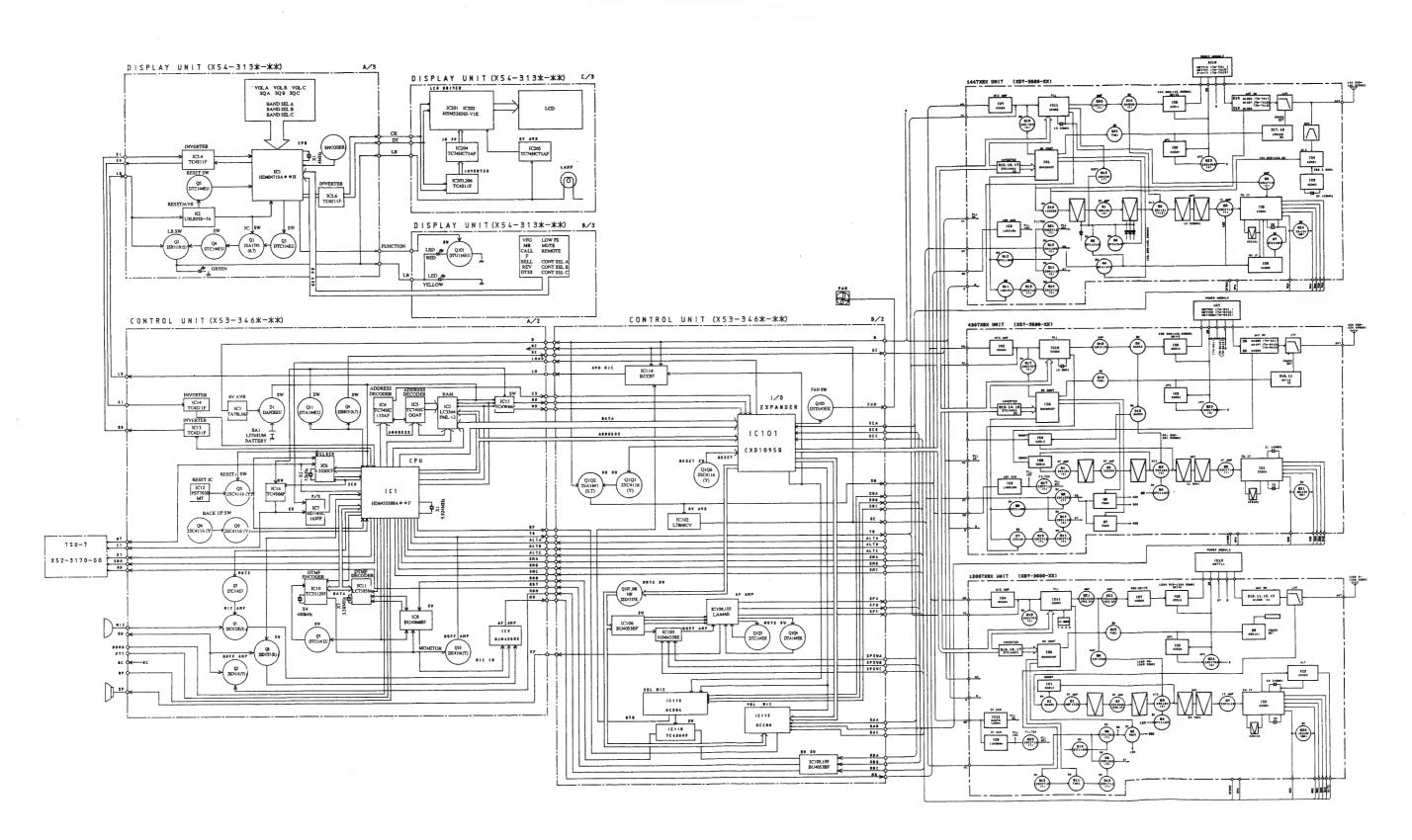


BLOCK DIAGRAM

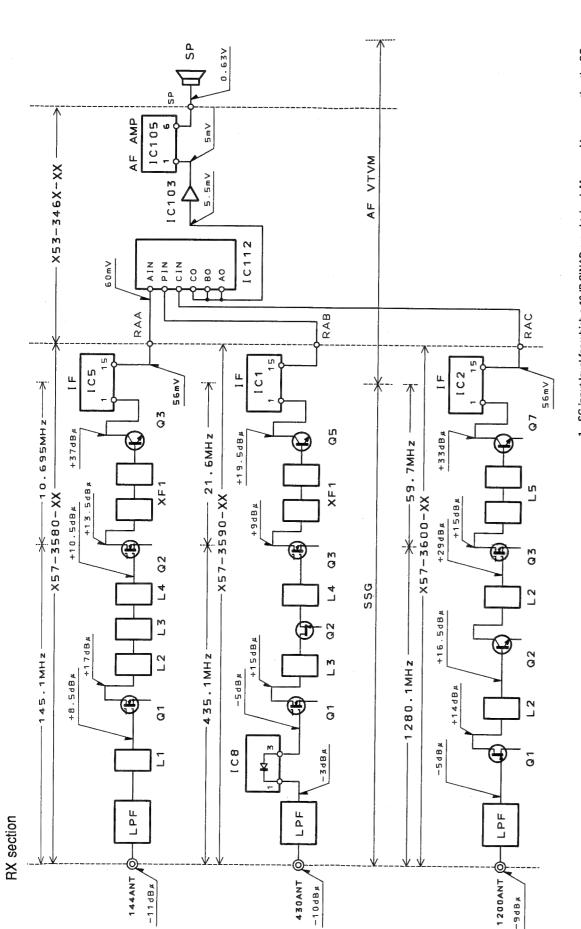
50M TX-RX UNIT (X57-3800-01)

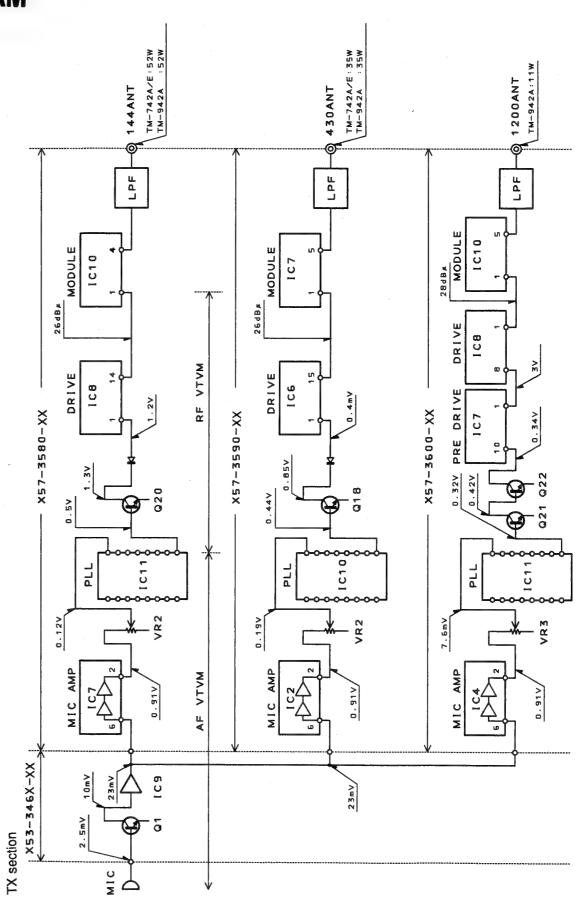


BLOCK DIAGRAM



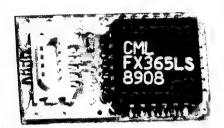
LEVEL DIAGRAM





TM-742 A/742 E/942 A TSU-7(CTSS UNIT)

TSU-7 PC BOARD VIEW



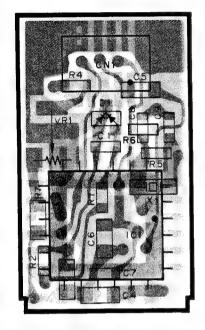
TSU-7 PARTS LIST

Ref. No	Address	Rart	Rarts No.	arts No. Description		Desti- nation	Re- marks	
		I	TSU-7 (X5:	2-3170-0	0)			
X1 IC1 D1 CN1 VR1 R1 R2 R4 R5 R6 C1 C2 C4-6 C7 C8. 9			G10-0692-04 H21-0704-04 L78-0062-05 FX365LS DAN202U E40-5341-05 R12-6526-05 RK73BG1J274J RK73BG1J103J RK73BG1J105J RK73BG1J473J CK73GB1H471K C92-0521-05 CK73FB1E104K CK73GB1H471K	CUTTION CUTTION STAL (1MHz) IC DIODE TRIM POT. (47M) CHIP R CHIP R CHIP R CHIP R CHIP C CHIP TAN CHIP C CHIP C CHIP C	J J J K K	270K 820K 10K 1M 47K 470pF 20WV 0. 1UF 470pF 220pF		

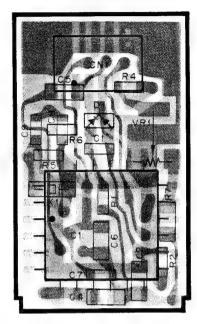
TSU-7(CTCSS UNIT)

PC BOARD VIEWS

(Component side view)



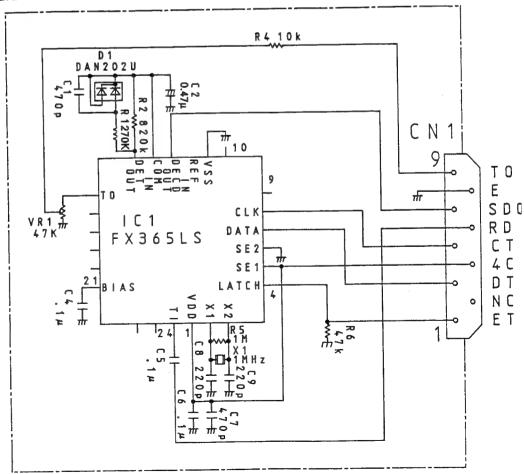
(Foil side view)



: Component side pattern

: Foil side pattern

CIRCUIT DIAGRAM



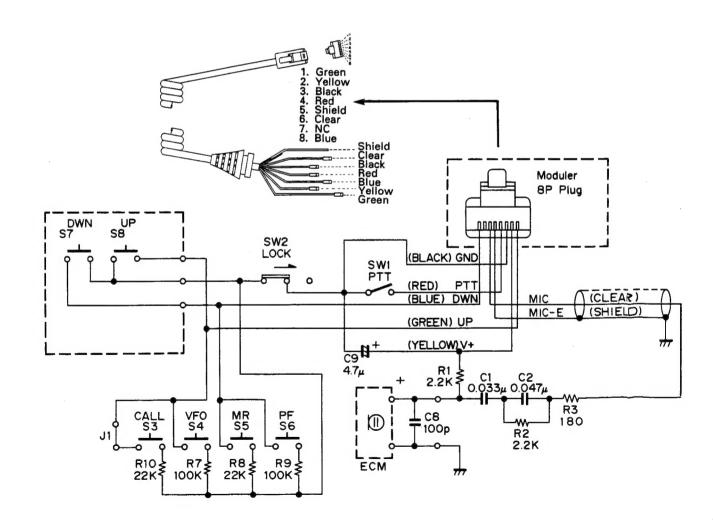
MC-45 (MULTI FUNCTION MICROPHONE)

EXTERNAL VIEW



PARTS LIST

Ref. No.	Address	New Parts	Parts No.	Description	Desti- nation	Re- marks
			A02-0896-08	CASE (FRONT)		
		1	A02-0900-08	CASE (REAR)		
			E30-3006-08	CURL CORD ASSY		
			G13-0933-08	CUSHION (UP, DWN)		
			K29-3165-08	KNOB PTT		
			K29-3168-08	KNOB UP		1
			K29-3169-08	KNOB DWN		
			K29-3170-08	KNOB CALL, VFO, MR, PF		
			S59-1409-28	SWITCH ASSY UP, DWN		
S3-6			S40-1431-08	TACT SWITCH CALL, VFO,		
				MR, PF		1
S7,8			S40-1437-08	TACT SWITCH UP, DWN		
SW1			S50-1431-08	MICRO SWITCH LOCK		
SW2			S31-1422-08	SLIDE SWITCH LOCK		
			T91-0383-08	MICROPHONE ELEMENT		



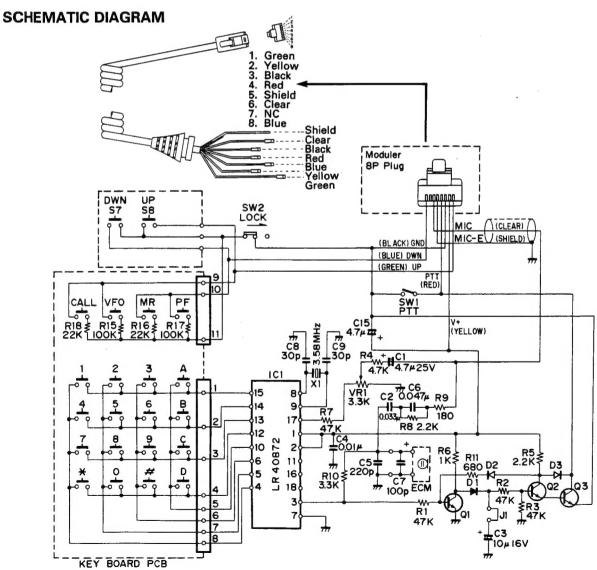
MC-45DM (MULTI FUNCTION MICROPHONE WITH AUTOPATCH)

EXTERNAL VIEW

PARTS LIST



Ref. No. Address		New Parts	Parts No.	Description	Desti- nation	Re- marks
			A02-0898-08 A02-0901-08	CASE (FRONT) CASE (REAR)		
			E30+3006-08	CURL CORD ASSY		
			G13-0933-08	CUSHION (UP, DWN)		
			K29-3165-08 K29-3167-08 K29-3168-18 K29-3169-18			
S7,8 SW1 SW2			\$59-1409-28 \$40-1437-08 \$50-1431-08 \$31-1422-08	TACT SWITCH UP, DWN MICRO SWITCH PTT		
			т91-0393-08	MICROPHONE ELEMENT		



UT-28S/50S/UT-220S/1200 SPECIFICATION

			UT-28S	UT-50\$	UT-220S	UT-1200		
GENE	Frequency range (MHz)		28 ~ 29.7	50 ~ 54	220~225	1240 ~ 1300		
	Mode		F3(FM)					
	Antenna impedance		50Ω					
	Operating temperature		-20°C ~+60°C					
	Power requirements		DC13.8V ±15% (11.7 ~ 15.8V)					
R	Ground		Negative					
A	Frequency stability			Less than ±3ppm				
-		Transmit mode	Less than 11.5A		Less than 7.0A	Less than 6.5A		
	Current drain	Receiver mode	Less than 1.2A					
T		HI	50W 25		25W	10W		
R	Output Power	MID	10W			-		
Ñ		LOW	Approx 5W 1					
S	Modulation		Reactance modulation					
M	Spurious radiation		Less than −60dB (※) Less tha					
Ť	Maximum frequency deviation		±5kHz					
Ţ	Audio distortion (at 60°	% modulation)	Less than 3%					
E R	Microphone impedanc	e	600Ω					
	Circuitry		Double conversion superheterodyne					
_	Intermediate frequency 1st/2nd		8.83MHz	10.595MHz	30.825MHz/455kHz	59.7MHz		
R E			455kHz					
C	Sensitivity (12 dB SINAD)		Less than 0 16μV(–16dBμ)					
E I V E R	Selectivity -6 dB		More than 10kHz	fore than 10kHz More than 12kHz				
	Selectivity -60 dB		Less than 24kHz Less than 36kHz					
	Squelch sensitivity		Less than 0.1μV(-20dBμ)					
	Output (5% distortion)		More than 2W(8Ω load)					
	External speaker impe	dance	8Ω					

Circuit and ratings are subject to change without notice, due to advancements in technology.
 Recommended duty cycle: 1 minute Transmit, 3 minutes Reception.

(※) Hi Power position: Less than -70dB

SPECIFICATIONS

				144 MHz Band	430/440 MHz Band	1200 MHz Band		
	Frequency range (MHz)			144 ~ 148	430 ~ 440/438 ~ 450	1240 ~ 1300		
GENERAL	Mode			F3E(FM)				
	Antenna impedance			1000	50 Ω			
	Operating temperature			-20 °C ~ +60 °C (-4 °F ~ +140 °F)				
	Power requirements			13.8 VDC ± 15 % (11.7 ~ 15.8 V)				
-	Ground			Negative				
		Transmit mode		Less than 11.5 A	Less than 10.0 A	Less than 6.5 A		
;	Current drain	Receiv	ver mode	Less than 1.2 A	Less than 1.2 A	Less than 1.2 A		
-	Frequency stability			± 10 ppm				
I	Dimensions (W x H x D)			150 x 50 x 175 mm				
١	Weight			TM-74	12A/742E: 1.5 kg TM-942A:	2E: 1.5 kg TM-942A: 1.8 kg		
1		HI		50 W	35 W	10 W		
.	Output power	MID		10 W	10 W	and the second		
		LOW		Approx. 5 W	Approx. 5 W	1 W		
	Modulation			Reactance modulation				
IRANSIMILIEN	Spurious radiation			Less tna - 60 dB Less than - 50 dB				
	Maximum frequency deviation			±5 kHz				
2	Audio distortion (at 60% modulation)			Less than 3%				
	Microphone impedance			600 Ω				
	Circurity				Double conversion superheterodyne			
Ī	Intermediate frequency		1st	10.7 MHz	21.6 MHz	59.7 MHz		
			2nd	455 kHz				
5	Sensitivity (12 dB SINAD)			Less than 0 16 μV (-10 dBμ) *				
	Selectivity -6 dB			More than 12 kHz				
RECEIVER	Selectivity -60 dB			Less than 24 kHz Less than 36 kHz				
-	Squelch sensitivity			Less than 0.1 μV (-14 dBμ)				
	Output (5% distortion)			More than 2 W (8 Ω load)				
Ī	External speaker imped	ance		8 Ω				

^{*1240} MHz to 1260 MHz

KENWOOD CORPORATION
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KENWOOD U.S.A. CORPORATION
COMMUNICATIONS & TEST EQUIPMENT GROUP
P.O. BOX 22745, 2201 East Dominguez St., Long Beach, CA 90801-5745, U.S.A. KENWOOD ELECTRONICS DEUTSCHLAND GMBH Rembrücker Str. 15, 6056 Heusenstamm, Germany TRIO-KENWOOD U.K. LIMITED KENWOOD House, Dwight Road, Watford, Herts., WD1 8EB United Kingdom KENWOOD ELECTRONICS BENELUX N.V. Mechelsesteenweg 418 B-1930 Zaventem, Belgium TRIO-KENWOOD FRANCE S.A. 13, Boulevard Ney, 75018 Paris, France KENWOOD LINEAR S.P.A. 20125, Milano-via Arbe, 50, Italy KENWOOD ELECTRONICS AUSTRALIA PTY. LTD. P.O. Box 504, 8 Figtree Drive, Australia Centre, Homebush, N.S.W. 2140, Australia KENWOOD & LEE ELECTRONICS, LTD.
Wang Kee Building, 5th Floor, 34-37, Connaught Road, Central, Hong Kong KENWOOD ELECTRONICS CANADA INC. P.O. BOX 1075, 959 Gana Court, Mississauga, Ontario, Canada L5S 1N9

Less than 0.22 μ V (-7 dB μ)

^{1.} Circuit and ratings are subject to change without notice due to advancements in technology.

² Recommended duty cycle: 1 minute Transmit, 3 minutes Reception.